

SHARP SERVICE MANUAL

CODE: 00ZPC4641SM-E



PERSONAL COMPUTER

PC-4641**MODEL PC-4602**

CONTENTS

| | |
|--|----|
| CHAPTER 1. OVERVIEW | 1 |
| CHAPTER 2. GENERAL INFORMATION | 1 |
| CHAPTER 3. MAIN BOARD OPERATION | 5 |
| CHAPTER 4. LCD UNIT | 21 |
| CHAPTER 5. HARD DISK INTERFACE & HARD DISK DRIVE | 23 |
| CHAPTER 6. POWER SUPPLY CIRCUIT | 31 |
| CHAPTER 7. APPENDICES (EXPLANATION OF LSI) | 33 |
| CHAPTER 8. CIRCUIT DIAGRAM & PARTS POSITION | 53 |
| PARTS LIST & GUIDE | |

CHAPTER 1. OVERVIEW

1. Scope

This manual is covered for PC4602 and PC4641 CPU and hard disk drive.

For detailed information on other auxiliary equipment and options (list following), please refer to the separate service manuals provided for each devices.

- Service-man Diagnostic Manual
- CRT adaptor (CE-451A)
- EP-ROM card (CE452B)
- MODEM card (CE451M)
- MFD unit (CE452F)
- EMS card (CE453B)
- Floppy disk drive (FD-235F)

2. Special service tools

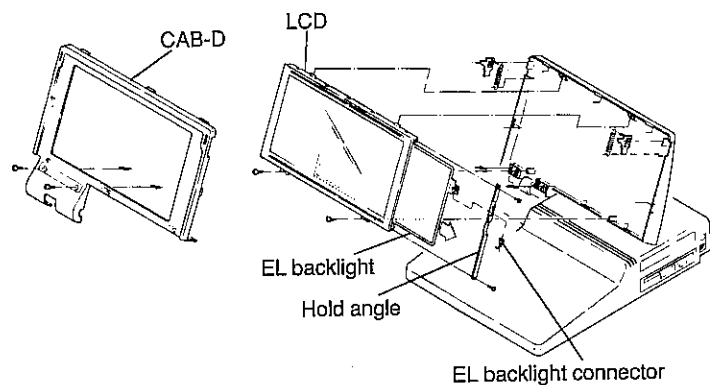
| | Part code | Price Rank | Tool name |
|---|---------------|------------|------------------------------|
| 1 | UKOGC3045CSZZ | BF | Service-man Diagnostic media |
| 2 | 00G1490051603 | CP | Alignment media |
| 3 | 00G1490051701 | CE | Level disk |
| 4 | UKOG-1055ACZZ | AV | Extension cable for FDD unit |

3. Service method

1) Replacing the EL backlight

NOTE: The POWER switch must be turned off before replacing the EL backlight. Pay attention that a high voltage is on the EL backlight.

1. Remove the cosmetic sheet, then the CAB-D holding two screws.
2. Unfasten the cabinet-D from the cabinet-C after releasing latches at seven locations.
3. Unfasten the EL backlight connector.
4. Remove the LCD from the CAB-C (2 screws).
5. Remove the bracket from the LCD.
6. Slide the EL backlight towards right to remove. Then, replace it with a new one.



NOTE: Do not use the cosmetic sheet once removed. Be sure to use the new one.

2) HD INTERFACE AND HD DRIVE

The interface board and the HD drive unit can be replaced only in whole unit, but not in part. When they are diagnosed to be defective by the diagnostic program (UKOGC3045CSZZ), replace the whole unit of them.

4. Cautions

- 1) Although the CE-451A CRT adaptor board is an option for the PC-4600, it comes standard for the US version PC-4600. For more information about the wiring schematics and parts layout, refer to the CE-451A Service Manual (00ZCE451ASM-E).
- 2) Cosmetic sheet
Do not use the cosmetic sheet once removed. Be sure to use the new one.
- 3) Deposit of a paint dust on the back of the cabinet may fall on the PWB when the machine is disassembled and re-assembled for servicing and it may then cause a machine malfunction. To avoid this, the machine internal must be cleaned whenever the machine is disassembled.

CHAPTER 2. GENERAL INFORMATION

1. General information

PC-4600 series are compact and lightweight laptop computers. They pack the power and sophistication of desk-top models into the laptop size.

In order to attain the high performance, this computer accommodates large and high contrast Supertwist LCD with the EL backlight, 3-1/2" floppy disk drive, 3-1/2" hard disk drive, and well-packed 90-key full keyboard. The display provides clear text and graphics in 640 by 400 dots especially by supporting 4-shades of gray (tiling) and 8 x 16 dots (character box) characters.

Further, PC-4641 incorporates a 40MB hard disk drive in its unit and accomplish battery operation. The full-size step-sculptured keyboard provides 90 keys, enhancing the ease of use with separate numeric keypad, separate function and cursor keys.

The main unit includes i80188 compatible CPU running at 10MHz, socket for coprocessor, 640KB RAM standard expandable to 1.6MB, a serial interface, a parallel printer interface, an external FDD interface. The internal options include modem card with a serial interface (for US/Canada only), color/monochrome CRT adaptor, ROM disk card, and 1MB EMS memory card. The external expansions include 5-1/4" 360KB floppy disk drive unit and carrying case.

The newly revised original BIOS assures the execution of numerous applications with the combination of MS-DOS 3.3 operating system.

PC-4600 series consists of the following 2 models:

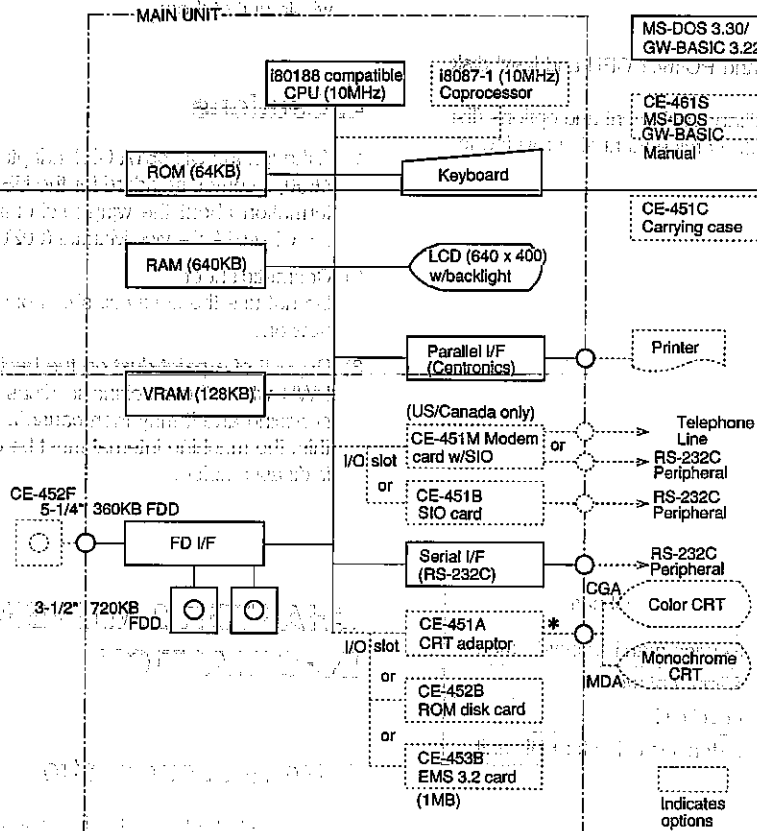
*PC-4602: 640KB RAM; two 3-1/2" 720KB FDDs; display w/ backlight; 90-key keyboard; serial interface; parallel interface; external 5-1/4" FDD (360KB) interface; MS-DOS 3.30/GW-BASIC 3.22

*PC-4641: 640KB RAM; a 3-1/2" 720KB FDD; a 40MB HDD; display w/ backlight; 90-key keyboard; serial interface; parallel interface; external 5-1/4" FDD (360KB) interface; MS-DOS 3.30/GW-BASIC 3.22

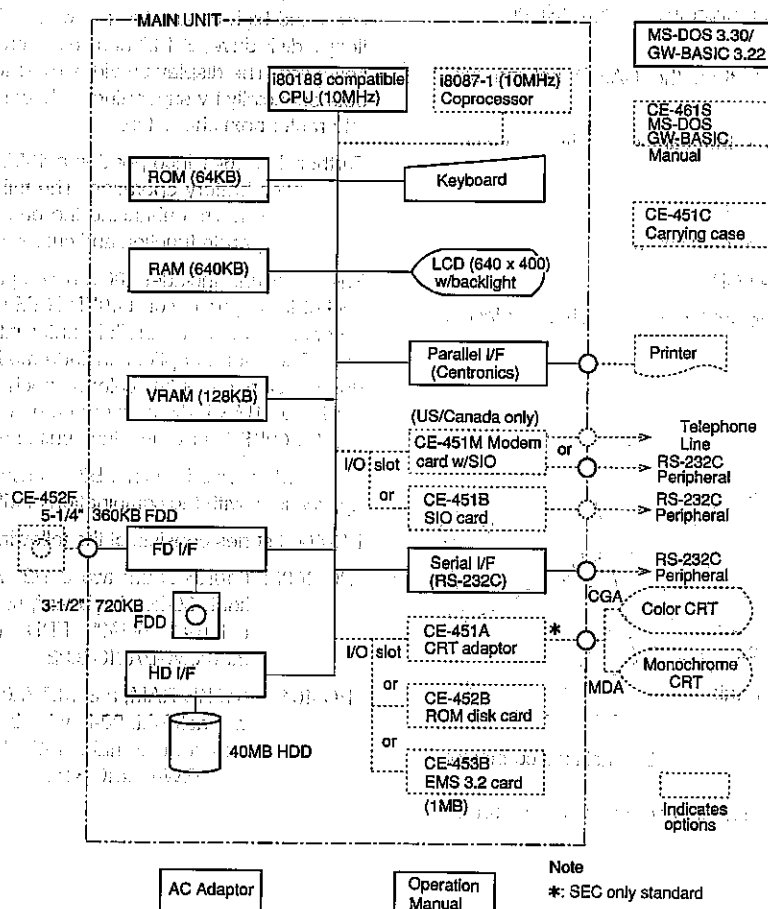
2. System Configuration

2-1. System block diagram

2-1-1. PC-4602



2-1-2. PC-4641



2-2. Specification

2-2-1. Main unit

CPU : NEC V40 (i80188 compatible)
 CPU clock speed – 10MHz (7.16MHz when coprocessor is installed.)
 System speed – Standard/Slow selectable on set-up menu

Coprocessor : Socket for i8087-1 (10MHz version)
 NOTE: CPU clock speed is changed to 7.16MHz automatically when coprocessor is installed.
 When it is removed, CPU clock speed is changed to 10MHz automatically.

Memory : ROM – 64KB
 including BIOS, set-up functions, CG, self check, etc
 512K bits EP-ROM (27C512 type) x 1 piece
 RAM – 640KB standard
 256K bits (64K x 4 bits) DRAM x 20 pieces without parity
 expandable up to 1.6MB with the optional 1MB EMS memory card (EMS 3.2)
 VRAM – 128KB

Display : full-size large supertwist LCD with EL backlight
 Text – 80 char. x 25 lines, 8 x 16 dots char. Box
 Graphics – 640 x 400 pixels, 4-shades of gray (tiling)
 Aspect ratio – 1:1
 Emulation – CGA/MDA/AT&T 640 x 400 Graphics
 Screen size – 233(w) x 147(h) mm
 LCD active area – 230(w) x 144(h) mm
 LCD contrast and backlight brightness are adjustable by each volume
 Not detachable
 90 – 129 degrees tilt angle adjustment
 EL backlight
 – white color
 – life: Approx. 2,000 hours (until luminescent brightness becomes half)
 – can be replaced by service man (service parts)

Data storage : PC-4602 – two side-mounted 3-1/2" 720KB FDD
 upper: A drive, lower: B drive
 PC-4641 – one side-mounted 3-1/2" 720KB FDD
 one internal 3-1/2" 40MB HDD
 upper: HDD (C drive), lower: FDD (A drive)
 (FDD/HDD on the same side)
 HDD – average access time: 45 msec
 power save management:
 can be set "Time-Out" on set-up menu
 Always ON/2 minutes/5 minutes/10 minutes
 *: spindle motor of HDD will be controlled by the value of "Time-Out"

Keyboard : full-size 90-key step-sculpture keyboard
 separate numeric keypad (with numeric +/- key)
 separate cursor keys
 10 programmable function keys
 LEDs for Num Lock, Scroll Lock, and Caps Lock
 Set-Up key for pop-up set-up menu
 Cylindrical keytop
 With click mechanism
 Not detachable

Interface : Serial (RS-232C) x 1 port (D-SUB 9 pin, male connector)
 Parallel (Centronics) x 1 port (D-SUB 25 pin, female connector)
 External 5-1/4" FDD (360KB) x 1 port (D-SUB 25 pin, female connector)

I/O slot : Sharp proprietary slot x 2
 – 1 slot for color/monochrome CRT adaptor, ROM disk card or
 1MB EMS memory card (EMS 3.2)
 – 1 slot for modem/SIO card (for US/Canada only) or SIO card

Power Supply : Rechargeable lead battery
 – low battery warning
 low battery indicator
 alarm

AC adaptor

PC-4602/4641: EA-452V
 IN : local voltage
 OUT : DC 9V, 2.5A
 Dimension : 115(w) x 67(d) x 55(h) mm
 Weight : Approx. 425g

Volume : LCD contrast volume
 Backlight brightness volume

Switch : Power ON/OFF button (software switch)
 5 dip switches

| Dip Switch Label | Feature | Initial setting |
|------------------|---|-----------------|
| 1 | System all reset ON/OFF | OFF |
| 2 | Not used | OFF |
| 3 | Speaker Volume LOW/HIGH | OFF (HIGH) |
| 4 | Speaker Control (without alarm) ON/OFF | ON |
| 5 | Alarm Control (Low Battery/Shut off Alarm) ON/OFF | ON |

NOTE: User cannot use dip switches in PC-4600 for SEEG.
 (for SEMKO, System all reset: Remove the lead battery)
 Shut off alarm switch (alarm when upper cabinet is shut during power on.)

LED indicator : Power (green); low battery (red);
 PC-4602 – drive A (green); drive B (green)
 PC-4641 – floppy disk (green); hard disk (green)
 Caps Lock (green); Num Lock (green); Scroll Lock (green)

Other : Carrying handle; speaker; display lock slide-switch x 2

Dimension : 12-1/8(w) x 13-3/4(d) x 3-1/4(h) inch
 307(w) x 348(d) x 81(h) mm
 (high: cushion rubber on the bottom cabinet included, without cushion rubber: 78mm)
 NOTE: Above dimension is equal to PC-4500 series.
 (with cushion rubber: 81(h) mm, without cushion rubber: 76(h) mm)

Weight : PC-4602 – 4.9kg (SEC) or 4.85kg (except for SEC)
 PC-4641 – 5.5kg (SEC) or 5.45kg (except for SEC)
 (with battery, without AC adaptor)
 battery: Approx. 800g
 AC adaptor (EA-452V): Approx. 425g

Software : MS-DOS 3.30/GW-BASIC 3.22
Manual : Operation Manual (MS-DOS/GW-BASIC quick reference included)
 Optional MS-DOS and GW-BASIC manuals

2-2-2. Option

Internal Options:

- CE-451A color/monochrome CRT adaptor
 - color/monochrome 2 modes supported
 - color: CGA (640 x 200 pixels)
 - monochrome: MDA (720 x 350 pixels)
 - color/monochrome mode is selected by set-up functions.
- 2 character sets (CG1/CG2) supported
- CG1: general
- CG2: Denmark/Norway
- CG1/CG2 is selected by short-pin switch on the card.

CE-451B SIO card

- Serial (RS-232C) x 1 port (D-SUB 25pin, male connector)
- dealer option

NOTE: Max. SIO 2 ports available when CE-451B installed.

1. Standard SIO (D-SUB 9pin, male connector)
2. SIO on the optional CE-451B SIO card (D-SUB 25pin, male connector)

CD-452B ROM disk card

- used as max. 768KB ROM disk
- 6 sockets for 1M bits EP-ROM
- 1M bits EP-ROM available on the market
- EP-ROM program in VAR
- utility software and technical document supplied by SHARP
- 2 types of EP-ROM (mask ROM compatible or JEDEC type) available on the market
- switchable by the slide-switch on the CE-452B card
- the following EP-ROM chips can be used;

| | Mask-ROM compatible | JEDEC |
|------------|---------------------|---------------------|
| Toshiba | TC571001D-20 | TC571000D-20 |
| NEC | μ PD27C1000D-20 | μ PD27C1001D-20 |
| Fujitsu | MBM27C1000-20 | MBM27C1001-20 |
| Mitsubishi | M5M27C100K-20 | M5M27C101K-20 |

- with installation instructions

CE-453B EMS memory card

- 1MB EMS 3.2 memory card and EMS 3.2 software
- with operation manual

CE-451M modem card (for US/Canada only)

- mode/SIO 2 functions supported
- mode: 300/1200 BPS; Bell 103/212A;
- Hayes compatible command set
- SIO: RS-232C x 1 port (D-SUB 25 pin, male connector)
- modem/SIO function is selected by set-up functions
- dealer option
- with installation instructions

NOTE: Max. SIO 2 ports available when CE-451M is installed and used as a SIO.

1. Standard SIO (D-SUB 9 pin, male connector)
2. SIO on the optional CE-451M modem card (D-SUB 25 pin, male connector)

External options:

CE-452F 5-1/4" FDD unit (without SEEG)

- 5-1/4" FDD (360KB) x 1
- AC power
- with I/F cable

CE-451C carrying case

- soft case with shoulder strap

Manual:

CE-461S MS-DOS/GW-BASIC manual set

- MS-DOS 3.3 manual
- GW-BASIC 3.2 manual
- SEEG options:

CE-460KE/F/W/M/S key top kit

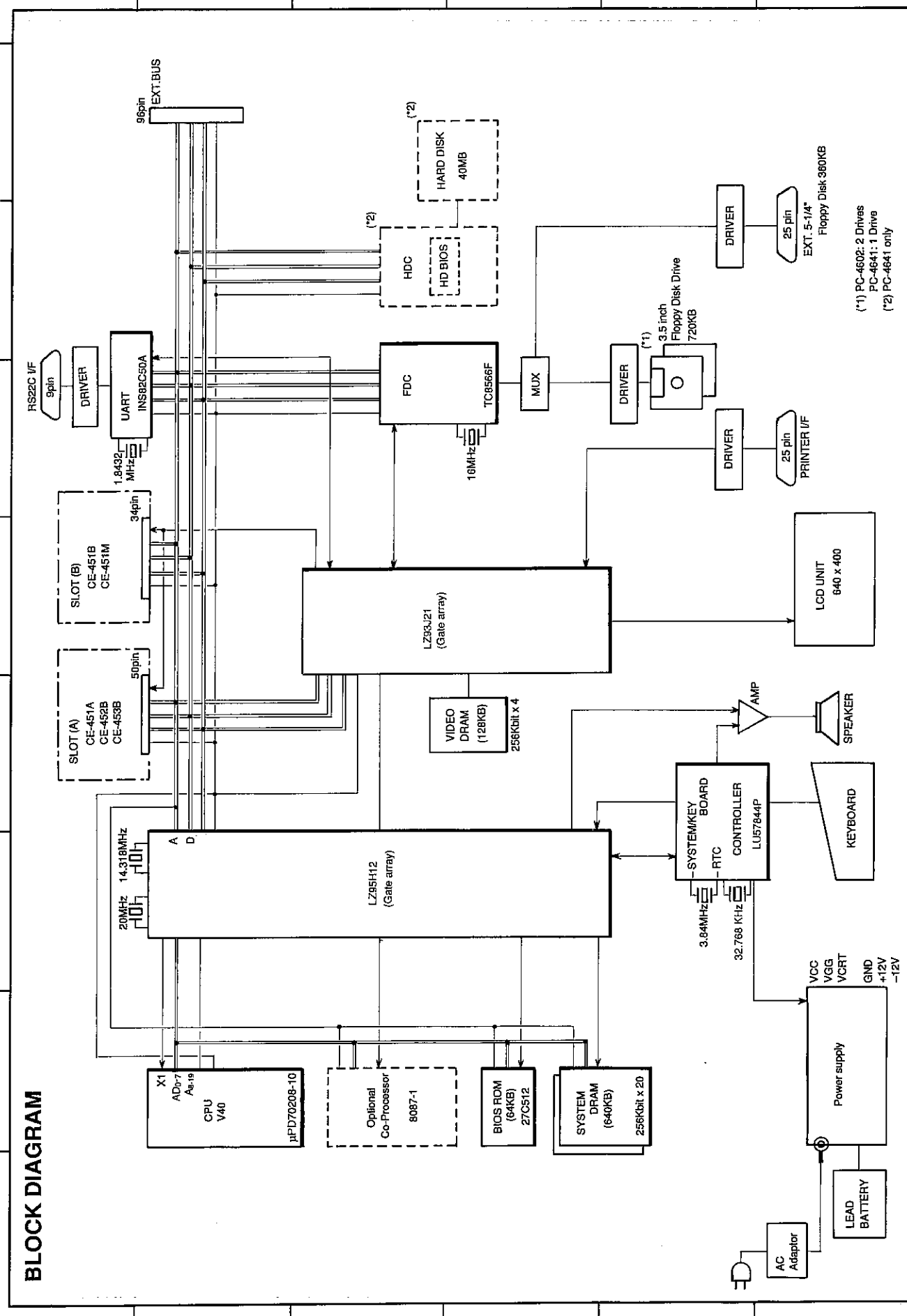
- key top (E: 20, F: 25, W: 21, M: 21, S: 26 pieces)
- tool for pulling up the key top

CE-460SE/F/G/I operation manual

- PC-4602/4641 operation manual

(E: English, F: French, G: German, I: Italian)

NOTE: CE-451A Color/monochrome CRT adaptor (CE-451A) is a standard for SEC only.



3-1. Memory and I/O map

3-1-1. Memory map for the PC-4600 system

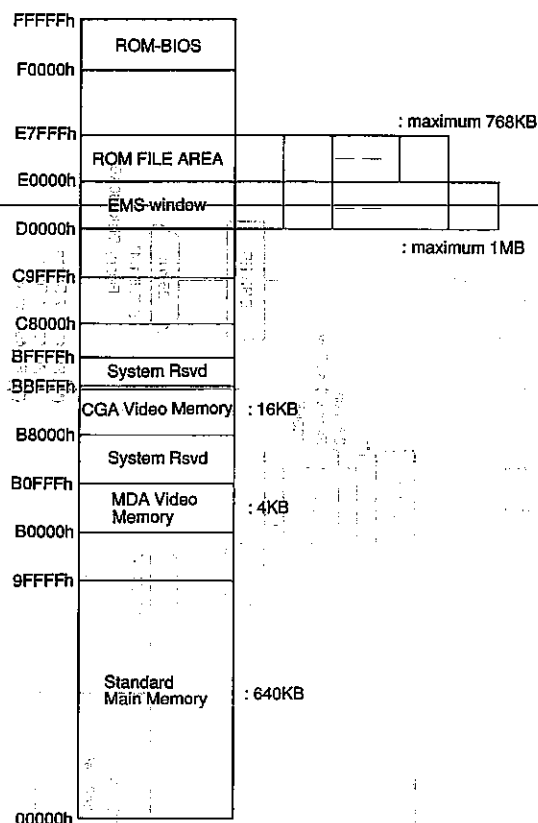


Fig. 3-1 Overall memory map

3-1-2. IO/MAP

| Register | IO Address |
|--|--------------|
| Emulated DMA Controller | 00H..0FH |
| V40DMA Controller | 10H..1FH |
| Interrupt Controller | 20H..3FH |
| System Timer | 40H..5FH |
| PPI | 60H..62H |
| NMI Mask | A0H..BFH |
| Asynchronous Communication (Secondary) | 2F8H..2FFH |
| Hard Disk | 320H..323H |
| Parallel Port | 378H..37FH |
| Parallel Port | 3BCH..3BEH |
| VIDEO IO | 3B0H..3BBH |
| VIDEO IO | 3BFH |
| VIDEO IO | 3C0H..3CFH |
| VIDEO IO | 3D0H..3DFH |
| FLOPPY DISK IO | 3F0H..3F7H |
| Asynchronous Communication (Primary) | 3F8H..3FFFH |
| V40 System IO | FFF0H..FFFFH |

3-2. Clock generator

The clock generator is included in LZ95H12, and connected with two crystal oscillators of 14.31818MHz and 20MHz.

The two clocks pass through the clock select circuit in LZ95H12; and one of them is outputted from X1 terminal to V40 X1 terminal. The details are shown in Fig. 3-2.

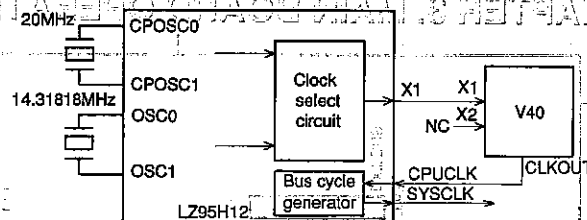


Fig. 3-2 Overall clock generate circuit

The frequency of the clock supplied from LZ95H12 X1 terminal to V40 is determined according to the states of bit 3 (OSCSPD1) and bit 2 (OSCSPD0) of the IO port (7BH) in LZ95H12 as shown below.

IO 7BH (R/W)

| | | | | | | | |
|---|---|---|---|---|---|---|---|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| X | X | X | X | | | X | X |

OSCSPD1 OSCSPD0 frequency of X1

| | | |
|---|---|-------------|
| X | 0 | 14.31818MHz |
| 0 | 1 | 20MHz |

Assertion of the RESET signal will reset OSCSPD [0:1]. IF 8087 is not installed, ROM-BIOS sets OSCSPD0.

When setting OSCSPD0, the shift to frequency of 10MHz is made with no glitches, thus avoiding the need to reset the system.

3-3. Reset circuit

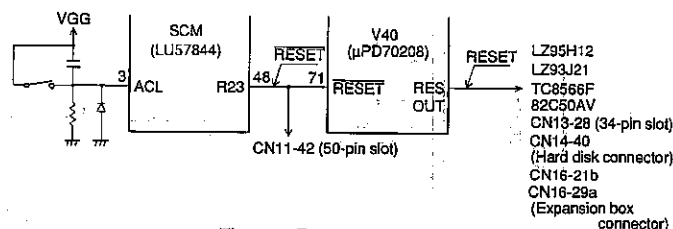


Fig. 3-3 Reset control circuit

The SCM can be reset in one of the following two ways.

1. When VGG turns on, a high state of signal is sent to the line ACL of the SCM from the differentiation circuitry composed of a capacitor and resistor.
2. When the dip switch-1, located at the lower side of the machine, set ON, it causes the ACL input high to reset the SCM. Operation starts when it turned off.

With depression of the ON/OFF switch while the machine is off or a hardware reset is given (simultaneous depression of CTRL, ALT, SETUP keys), VCC is turned active and RESET is forced high. The V40 synchronizes an async signal RESET with the internal clock and sends it out as an active high signal.

The former (RESET) is sent to the V40 and 50-pin slot, and the latter (RESET) to the LZ95H12, LZ93J21, TC8566F, 82C50AV, 34-pin slot, hard disk controller, and the expansion box connector to reset with.

3-4. Interrupt control

Eight maskable interrupts and one non-maskable interrupt are provided.

- NMI is set high by the LZ95H12 when a specific I/O is accessed.
- Maskable interrupt may be caused in one of the following:

| Number | Usage | Originating device |
|--------|---|----------------------|
| 1 | Keyboard | LZ95H12 |
| 3 | Asynchronous communication (Secondary) | INS82C50A |
| 4 | Asynchronous communication (Primary) | |
| 5 | Hard disk | Hard disk controller |
| 6 | Floppy disk | TC8566F |
| 7 | Parallel printer | LZ93J21 |

3-5. Bus configuration

The PC-4600 system uses the following two buses.

- 1) CPU (AD) bus
- 2) System Data (SD) bus

The bus configuration is shown in Figure 3-4.

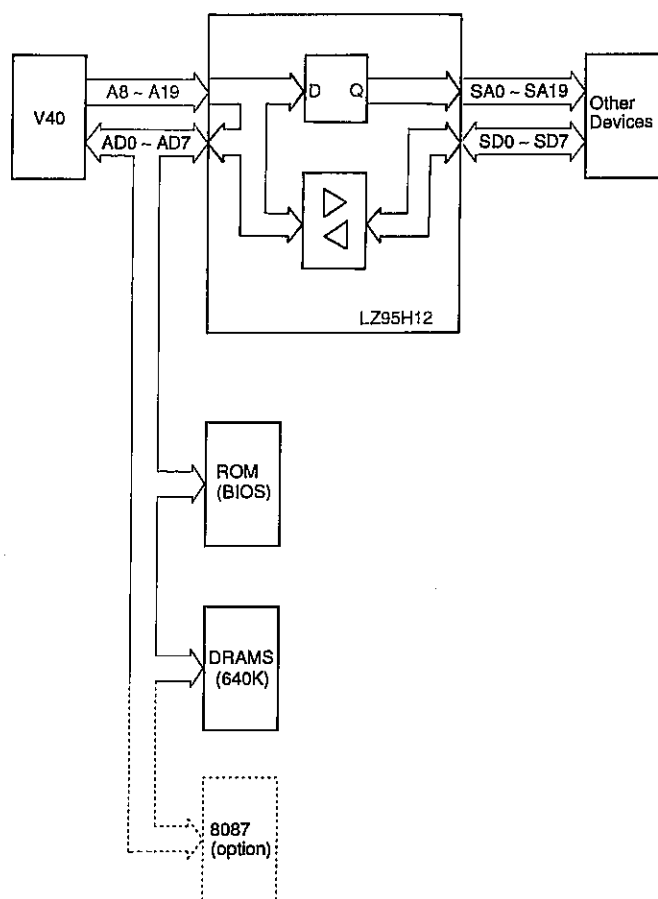


Fig. 3-4 Bus configuration

3-6. Memory

3-6-1. Block diagram

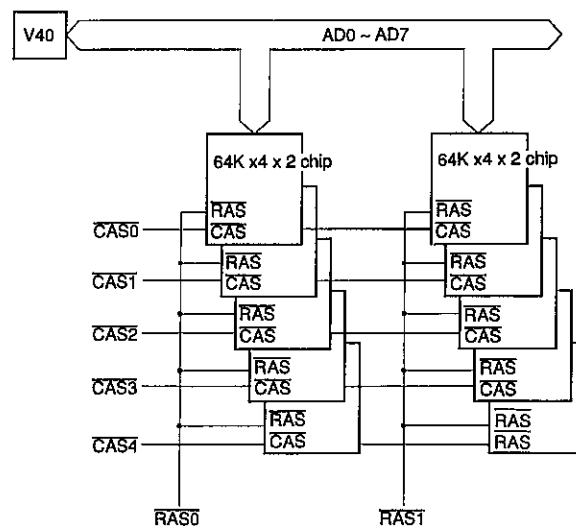


Fig. 3-5 RAM section block diagram

3-6-2. LZ95H12 address assignment

RAS and CAS are generated from LZ95H12. RAS0 is set active if RAS is even address or RAS1 active if RAS is odd address.

CAS signal is assigned to CAS0 ~ CAS4 as shown in Table 3-1.

Table 3-1

| Input | | | | | | Output | | | | | | | | |
|-------|-----|-----|-----|----|-------|--------|------|------|------|------|------|------|-------|--------------------|
| A19 | A18 | A17 | A16 | A0 | REFRQ | RAS0 | RAS1 | CAS0 | CAS1 | CAS2 | CAS3 | CAS4 | ROMCE | |
| X | X | X | X | X | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | REFRESH |
| 1 | 1 | 1 | 1 | X | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | F0000H-FFFFFH |
| 0 | 0 | 0 | X | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 00000H-1FFFFH even |
| 0 | 0 | 0 | X | 1 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 00000H-1FFFFH odd |
| 0 | 0 | 1 | X | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 1 | 1 | 20000H-3FFFFH even |
| 0 | 0 | 1 | X | 1 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 20000H-3FFFFH odd |
| 0 | 1 | 0 | X | 0 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 1 | 40000H-5FFFFH even |
| 0 | 1 | 0 | X | 1 | 1 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 1 | 40000H-5FFFFH odd |
| 0 | 1 | 1 | X | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | 60000H-7FFFFH even |
| 0 | 1 | 1 | X | 1 | 1 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 60000H-7FFFFH odd |
| 1 | 0 | 0 | X | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 80000H-9FFFFH even |
| 1 | 0 | 0 | X | 1 | 1 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 80000H-9FFFFH odd |

3-6-3 Memory access timing

① Normal DRAM access

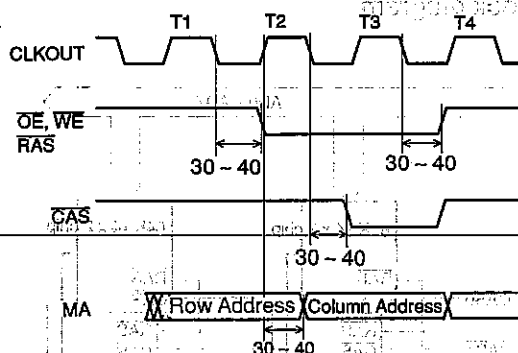
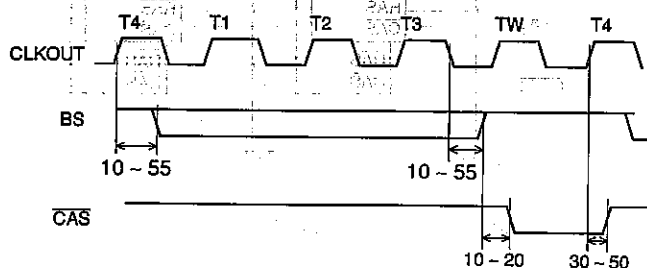


Fig. 3-6 DRAM access timing (normal)

② At DMA memory write



Same as ① for the timing of \overline{OE} , \overline{WE} , \overline{RAS} , and \overline{MA} .

Fig. 3-7 DRAM access timing (DMA memory write)

③ ROM access

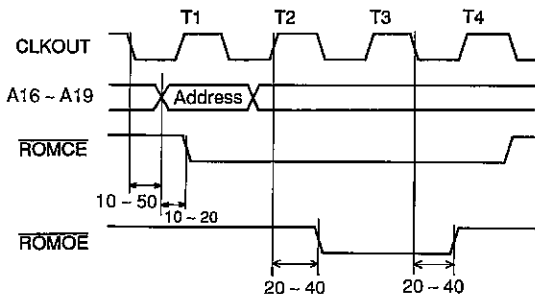


Fig. 3-8 ROM access timing

3-7. 8087 interface

The interface log of 8087 is stored in LZ95H12. The signal connection is shown in Fig. 3-9.

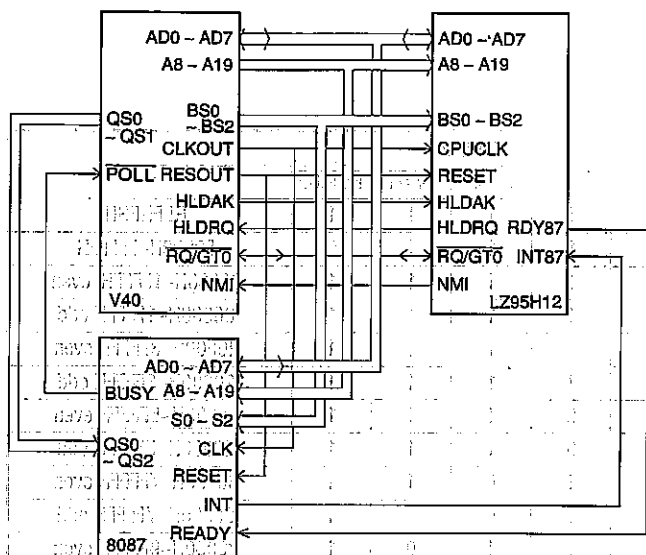


Fig. 3-9 8087 interface signal connection

3-8. READY control circuit

The signal $\overline{RDYV40}$ for V40 is controlled by LZ95H12. LZ95H12 and LZ95J21 control EXT, EXTIO, SLOCYC, and READY signals for the devices accessed. LZ95H12 determines the bus cycle according to these signals, to control $\overline{RDYV40}$. The block diagram is shown in Fig. 3-10.

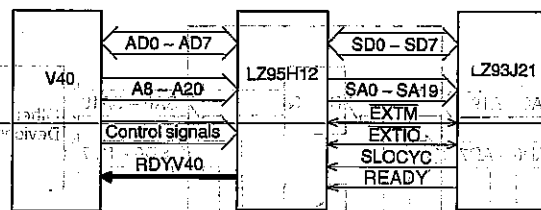


Fig. 3-10 Overall ready control signals

3-9. DMA control

Although the V40 has four DMA channels, two channels are used. DRQ2 and $\overline{DACK2}$ are used for controlling the floppy.

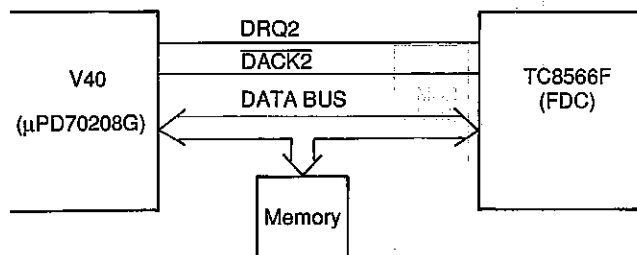


Fig. 3-11 Overall DMA control signals

When the V40 starts to DMA after setting the TC8566F register, the TC8566F sets DRQ2 high. After the V40 receives this signal, $\overline{DACK2}$ is set low to perform DMA transfer between the TC8566F and the memory.

DRQ3 and $\overline{DACK3}$ are used for controlling the hard disk. DRQ3 is supplied from the LSI in the hard disk controller. When DRQ3 becomes high, V40 makes $\overline{DACK3}$ low to perform DMA transfer between with the controller.

3-10. Bus cycle generator (including LZ95H12)

3-10-1. General

The LZ95H12 bus cycle generator produces the SYSCLK, ALE, STC, SMRD, SMWR, SIORD and SIOWR signals. It interprets the \overline{RDY} signal and drives the $\overline{RDYV40}$ signal to control the number of wait states. The LZ95H12 determines the speed of the devices involved in the transfer. Devices are grouped into three speed categories:

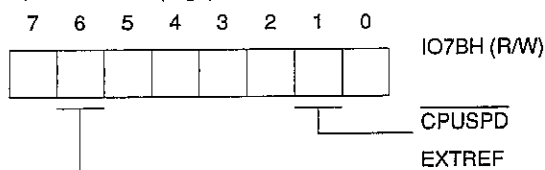
1. fast AD bus devices;
2. fast SD bus devices; and
3. slow SD bus devices.

Fast AD devices are the V40, the 8087, the LZ95H12, the system ROM, the system DRAM. Fast SD bus devices are those devices which are controlled by the LZ95J21 for which the SLOCYC signal is not asserted. This signal is sampled at the start of first T-cycle following the assertion of the SMRD, SMWR, SIORD or SIOWR. At 7.16MHz, this occurs at the start of T3. At 10 MHz this occurs at the start of the first TW. All other devices are slow SD bus devices.

There are three speeds of non-refresh cycles: fast, medium and slow. Fast speed cycle execute with no wait states, except for IO NMI trapping cycles, which take nine T-cycles. Medium speed cycles may also insert wait states in response to a reset \overline{RDY} signal. A special extended medium speed cycle that drives SYSCLK from CPUCLK is also implemented. At 7.16 MHz, the minimum medium speed cycle takes 5 T-cycles. At 10 MHz, the minimum medium speed cycle takes 6 T-cycles. Medium and slow speed cycles have the same timing until SLOCYC is sampled.

If the $\overline{\text{CPUSPD}}$ (IO7BH bit 1) bit is set, the bus cycle generator will only generate slow speed memory cycles. This is done to accommodate programs using software timing loops. Assertion of the RESET signal will reset $\overline{\text{CPUSPD}}$. If $\overline{\text{CPUSPD}}$ is reset, then speed of the cycle is dependent on the slowest device involved. If the slowest device is a fast AD bus device then a fast speed cycle is generated. If the slowest device is a fast SD bus device, then a medium speed cycle is generated. Otherwise, a slow speed cycle is generated. When "speed: slow" is selected in the set up menu, $\overline{\text{CPUSPD}} = 1$ (High)

There are two speeds for refresh cycle-fast and slow. If the EXTREF (IO7BH bit 6) bit is set, the bus cycle generator will generate a slow speed cycle. Thus DRAM on the SD bus may be refreshed. If EXTREF and $\overline{\text{CPUSPD}}$ are reset, then the bus cycle generator will generate a fast speed cycle. Thus any DRAM on the SD bus must provide its own refresh. Resetting EXTREF may result in as much as a 5% increase in system throughput. Assertion of the RESET signal will reset EXTREF. When the optional EMS card (CE-453B) is installed, EXTREF = 1 (High).



3-10-2. SYSCLK Generation

For 7.16 MHz cycles, CLKOUT drives SYSCLK.

For 10 MHz fast speed cycles, SYSCLK is set during T2 and is reset during the rest of the cycle. For 10 MHz medium speed cycles, SYSCLK is set during T2, the first TW and T4 and is reset during the rest of the cycle. For 10 MHz extended medium speed cycles, SYSCLK is set during T2 and driven by CPUCLOCK for the rest of the cycle. For 10 MHz slow speed cycles, SYSCLK is set during T2, during the odd TW's and during T4 and is reset during the rest of the cycle. There are always an even number of TW's in a 10 MHz slow speed cycle. For 10 MHz cycles, SYSCLK is always reset during TI's and interrupt acknowledge cycles.

3-10-3. $\overline{\text{SMRD}}$, $\overline{\text{SMWR}}$, $\overline{\text{SIORD}}$ and $\overline{\text{SIOWR}}$ Generation

$\overline{\text{SMRD}}$ and $\overline{\text{SMWR}}$ are not asserted during non-refresh cycles that access fast AD bus memory devices. $\overline{\text{SIORD}}$ and $\overline{\text{SIOWR}}$ are not asserted during non-refresh cycles that access LZ95H12 internal IO devices or V40 internal private IO devices. $\overline{\text{SIORD}}$ and $\overline{\text{SIOWR}}$ are asserted during accesses to emulated MDA/CGA IO addresses. $\overline{\text{SMRD}}$ and $\overline{\text{SIOWR}}$ are not asserted during fast refresh cycles.

For 7.16 MHz cycles, the $\overline{\text{SMRD}}$ and $\overline{\text{SIORD}}$ signals may be reset during T2, T3 and TW. These signals are set during the rest of the cycle. The same is true for $\overline{\text{SMWR}}$ and $\overline{\text{SIOWR}}$ during non-refresh, non-DMA cycles. For DMA memory write cycles, the $\overline{\text{SMWR}}$ signal may be reset during T3 and TW. $\overline{\text{SIOWR}}$ is set during the rest of the cycle. For refresh and DMA memory read cycles, the $\overline{\text{SIOWR}}$ signal may be reset during T3 and TW. $\overline{\text{SIOWR}}$ is set during the rest of the cycle.

For 10 MHz fast speed cycles, the $\overline{\text{SMRD}}$, $\overline{\text{SMWR}}$, $\overline{\text{SIORD}}$ and $\overline{\text{SIOWR}}$ signals are set during the cycle. For 10 MHz medium speed cycles, the $\overline{\text{SMRD}}$ and $\overline{\text{SIORD}}$ signals may be reset during T3 and TW. They are set during the rest of the cycle. The same is true for $\overline{\text{SMWR}}$ and $\overline{\text{SIOWR}}$ during non-refresh, non-DMA cycles. For DMA memory write cycles, the $\overline{\text{SMWR}}$ signal may be reset during all TW's except the first half of the first TW. $\overline{\text{SMWR}}$ is set during the rest of the cycle. For refresh and DMA memory read cycles, the $\overline{\text{SIOWR}}$ signal may be reset during all TW's except the first half of the first TW. $\overline{\text{SIOWR}}$ is set during the rest of the cycle. For 10 MHz slow speed cycles, the $\overline{\text{SMRD}}$ and $\overline{\text{SIORD}}$ signals may be reset during T3 and all TW's except the last TW. They are set during the rest of the cycle. The same is true for $\overline{\text{SMWR}}$ and $\overline{\text{SIOWR}}$ during non-refresh, non-DMA cycles. For DMA memory write cycles, the $\overline{\text{SMWR}}$ signal may

be reset during all TW's except the first TW and last TW. $\overline{\text{SMWR}}$ is set during the rest of the cycle. For refresh and DMA memory read cycles, the $\overline{\text{SIOWR}}$ signal may be reset during all TW's except the first TW and last TW. $\overline{\text{SIOWR}}$ is set during the rest of the cycle.

3-10-4. READY Interpretation and RDYV40 Generation

During fast speed cycles RDYV40 is set. RDYV40 is set during T1 and T1.

For 7.16 MHz medium speed cycles, RDYV40 is reset during T2 and then READY drives RDYV40 during the rest of the cycle. For 7.16 MHz slow speed CPU/COP memory cycles, RDYV40 is reset during T2 and T3 and then RDYV40 is driven by READY during the rest of the cycle. For 7.16 MHz slow speed IO, refresh and DMA cycles, RDYV40 is reset during T2, T3 and the first two TW's and then RDYV40 is driven by READY during the rest of the cycle.

For 10 MHz medium speed cycles, RDYV40 is reset during T2 and T3 and then RDYV40 is driven by READY during the rest of the cycle. For 10 MHz slow speed CPU/COP memory cycles, RDYV40 is reset during T2, T3 and the first two TW's. READY is sampled at the start and the end of the odd TW's starting with the first TW. If READY is reset for either sample, then RDYV40 remains reset for two more T-cycles and READY is again sampled. If READY is set for both samples, then RDYV40 remains reset for two more T-cycles and is then set for the rest of the cycle. For 10 MHz slow speed CPU/COP IO, refresh and DMA cycles, RDYV40 is reset during T2, T3 and the first four TW's. READY is sampled at the start and the end of the odd TW's starting with the third TW. If READY is reset for either sample, then RDYV40 remains reset for two more T-cycles and READY is again sampled. If READY is set for both samples, then RDYV40 remains reset for two more T-cycles and is then set for the rest of the cycle.

3-10-5. STC Generation

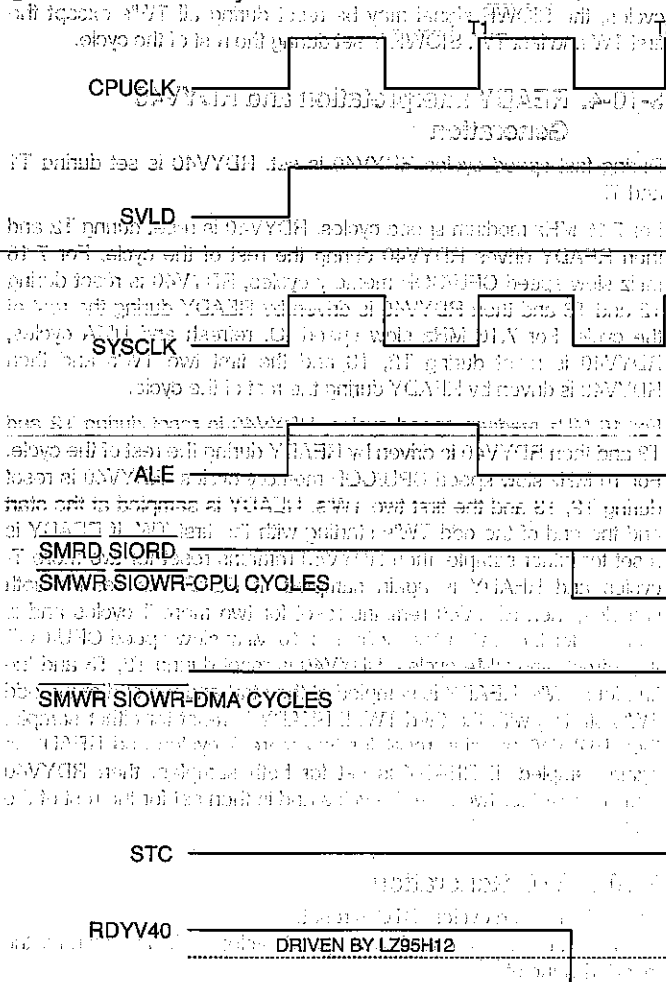
During fast speed cycles, STC is reset.

For 7.16 MHz medium and slow speed cycles, STC is driven by the inverted value of $\overline{\text{TC}}$.

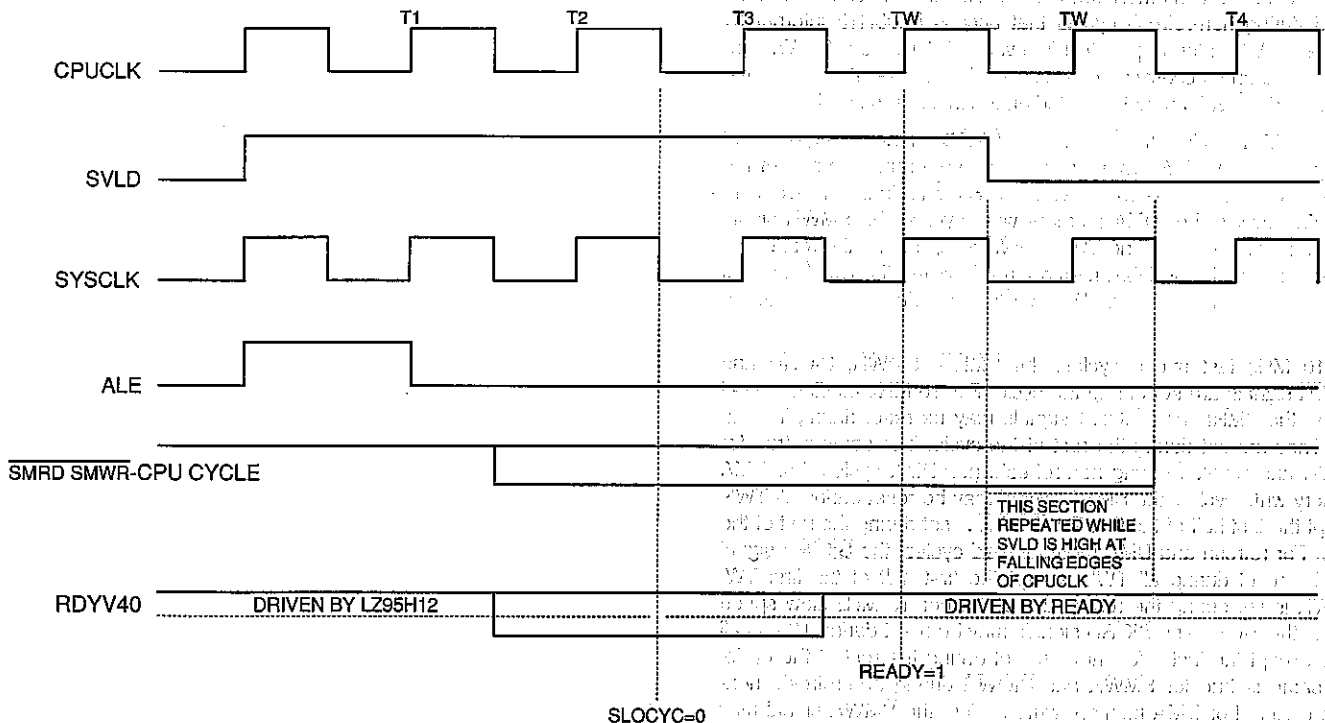
For 10 MHz medium speed cycles, STC is set during the second and subsequent TW's and during T4 while $\overline{\text{TC}}$ is reset. For 10 MHz slow speed cycles, STC is set during the third and subsequent TW's and during T4 while $\overline{\text{TC}}$ is reset. STC is reset during the rest of the cycle.

3-10-6: Timing chart

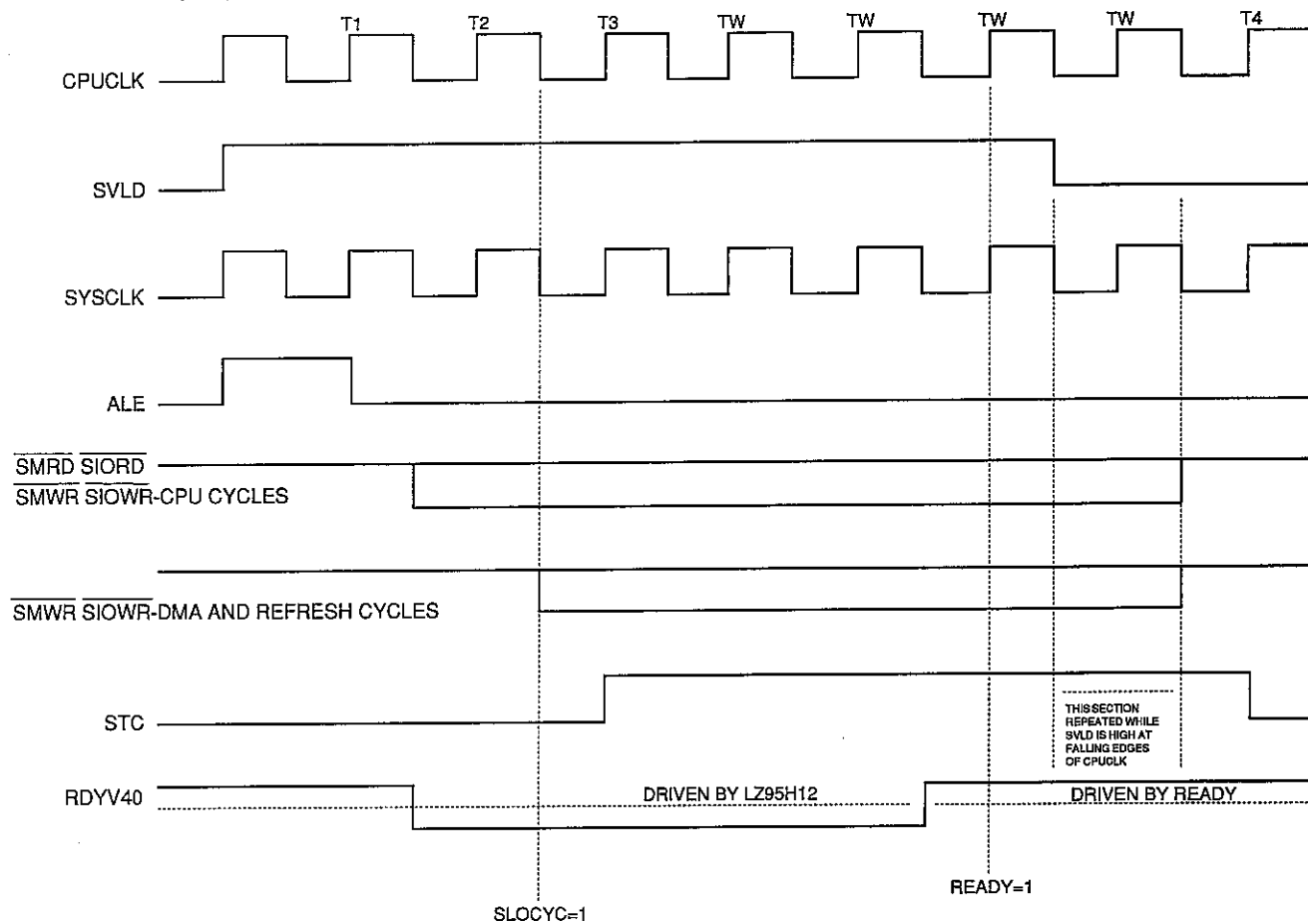
⑦ 7.16 MHz MEDIUM cycle



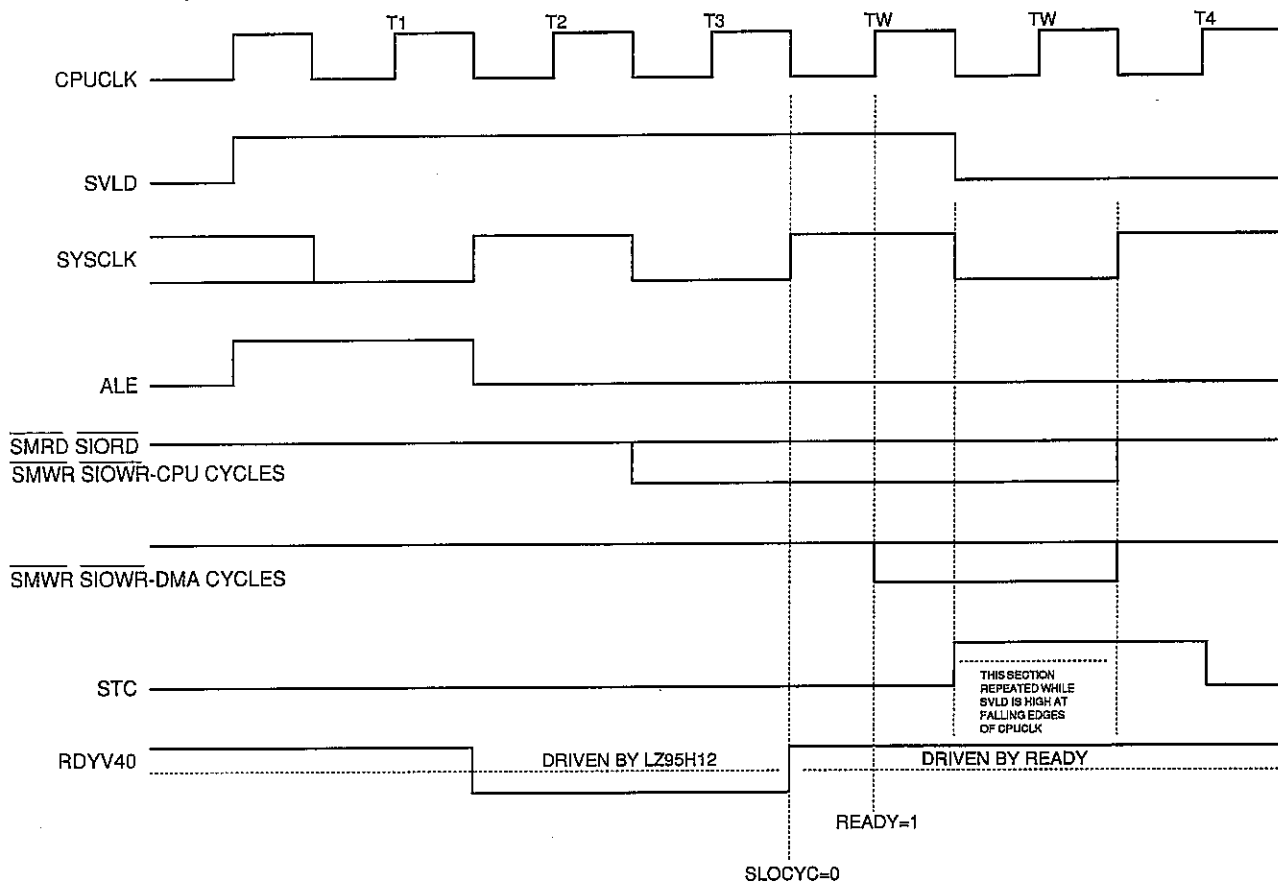
⑦ 7.16 MHz SLOW cycle (CPU-MEMORY cycle)



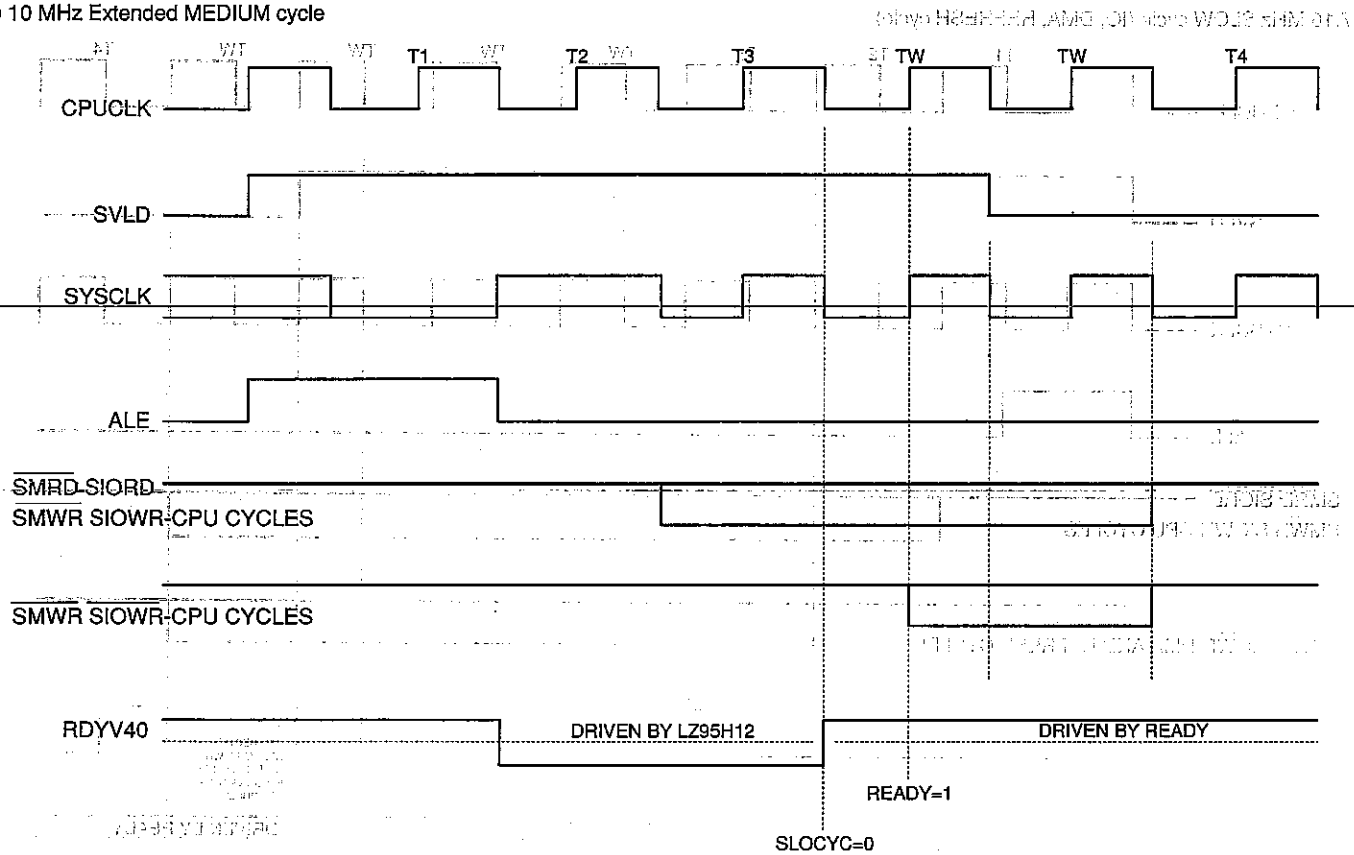
③ 7.16 MHz SLOW cycle (IO, DMA, REFRESH cycle)



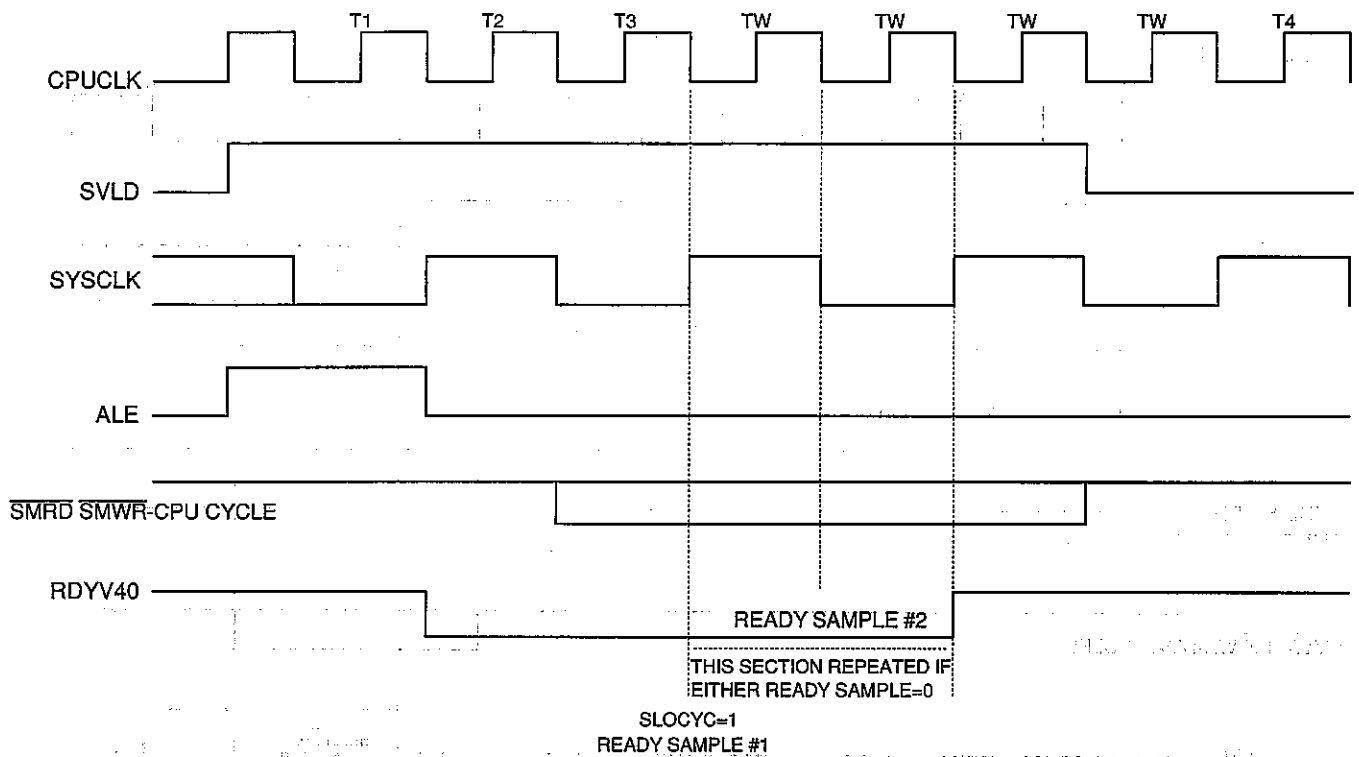
④ 10 MHz MEDIUM cycle



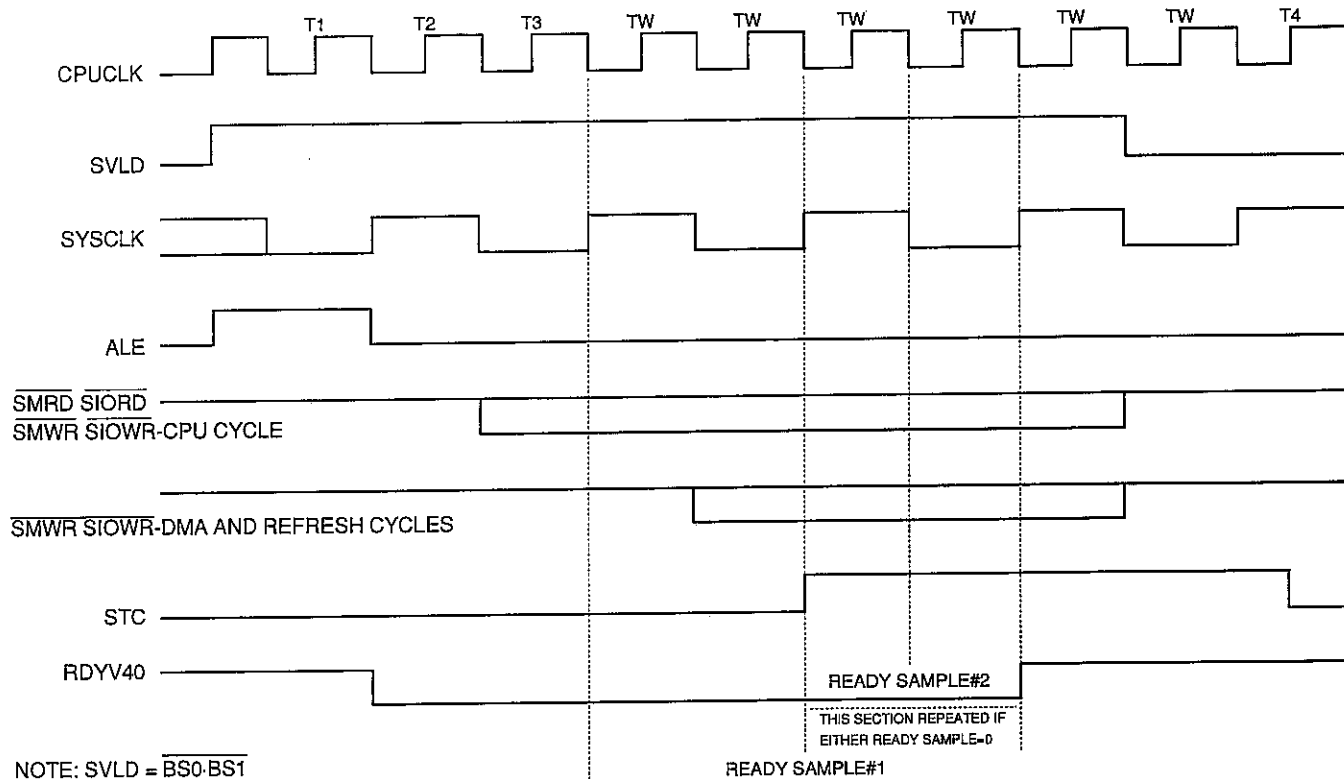
⑤ 10 MHz Extended MEDIUM cycle



⑥ 10 MHz SLOW cycle (CPU-MEMORY cycle)



⑦ 10 MHz SLOW cycle (IO, DMA, REFRESH cycle)



3-11. Printer interface

Fig. 3-12 shows a functional block diagram of the printer interface circuit. This circuit consists of the print data register, printer status port and printer control register.

The print data register, which is assigned at the I/O address 378H or 3BCH, stores data to be sent to the printer. The contents of this register can be read by the CPU at the I/O address 378H or 3BCH via the buffer.

The printer status port reads status information sent from the printer. This port is assigned at the I/O address 379H or 3BDH.

The printer control register stores control codes to be sent to the printer. This register assigned at the I/O address 37AH or 3BEH. Bit 4 of this register determines whether the ACK signal from the printer makes enable or disable as the CPU interrupt signal. When this bit is HIGH, interruption is enabled.

The contents of this register can be read by the CPU at the I/O address 37AH or 3BEH.

Assignment of the printer interface I/O address to either 37XH or 3BXH is dependent on the state of PPSEL (parallel port select bit 4) of the PC-4600 register CFR (Configuration Register) which is assigned to the I/O address 7FH. If PPSEL is 0, the printer interface I/O address is assigned to 3BXH. If PPSEL is 1, the address is assigned to 37XH.

It is possible to disable the standard printer adaptor by resetting PPS (bit 1) of the PCR (Planar Control Register) I/O address 65H which is normally set on.

Table 3-2 shows the printer I/O address definition.

Fig. 3-13 shows the printer timing chart.

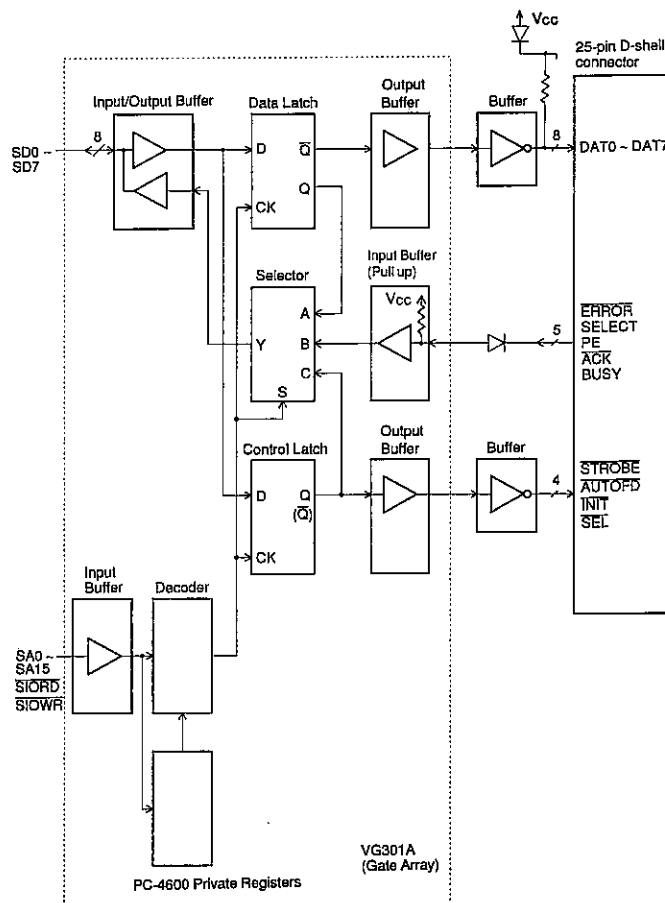


Fig. 3-12 Function block diagram

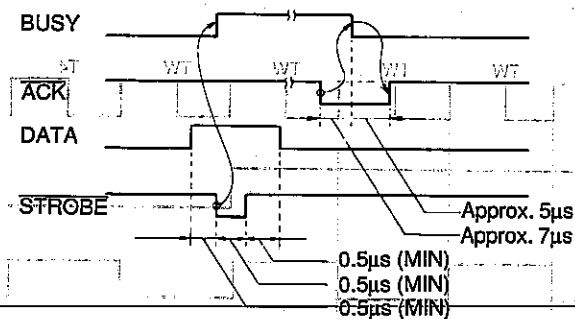


Fig. 3-13 Timing chart

| I/O Address | Read/Write | Bit | Description |
|-------------|------------|-----|--|
| 65H | R/W | 1 | PPS. 1: Enables the standard printer adaptor (normally set 1). |
| 7FH | R/W | 4 | PPSEL (Parallel Port Select) 0: Printer adaptor I/O address is assigned to 36XH. 1: Printer adaptor I/O address is assigned to 37XH. |
| 3BCH | PPSEL 0 | 0 | Print data 0 (LSB) |
| | | 1 | Print data 1 |
| | | 2 | Print data 2 |
| | | 3 | Print data 3 |
| | | 4 | Print data 4 |
| 378H | 1 | 5 | Print data 5 |
| | | 6 | Print data 6 |
| | | 7 | Print data 7 (MSB) |
| 3BDH | PPSEL R | 0 | Not used (0 read) |
| | | 1 | Not used (0 read) |
| | | 2 | 0 or 1 read |
| | | 3 | ERROR read |
| | | 4 | SELECT read |
| | | 5 | PE read |
| | | 6 | ACK read |
| | | 7 | BUSY read |
| 3BEH | PPSEL R/W | 0 | STROBE written |
| | | 1 | AUTOFD written |
| | | 2 | INIT written |
| | | 3 | SEL written |
| 37AH | 1 | 4 | IRQENA, 1: Enables interrupt request. |
| | | 5 | Not used (0 read) |
| | | 6 | Not used (0 read) |
| | | 7 | Not used (0 read) |

Table 3-2 I/O address definition

3-12. Serial interface

As a standard, the PC-4600 has a serial interface which is assigned at the I/O address 3F8H through 3FFH or 2F8H through 2FFH.

Assignment of the serial interface I/O address to 3FXH or 2FXH is determined by the SCM (LU57832) output signal COM1/2. When COM1/2 is at a low, the serial interface I/O address is assigned to 3FXH. If high, the address is assigned to 2FXH.

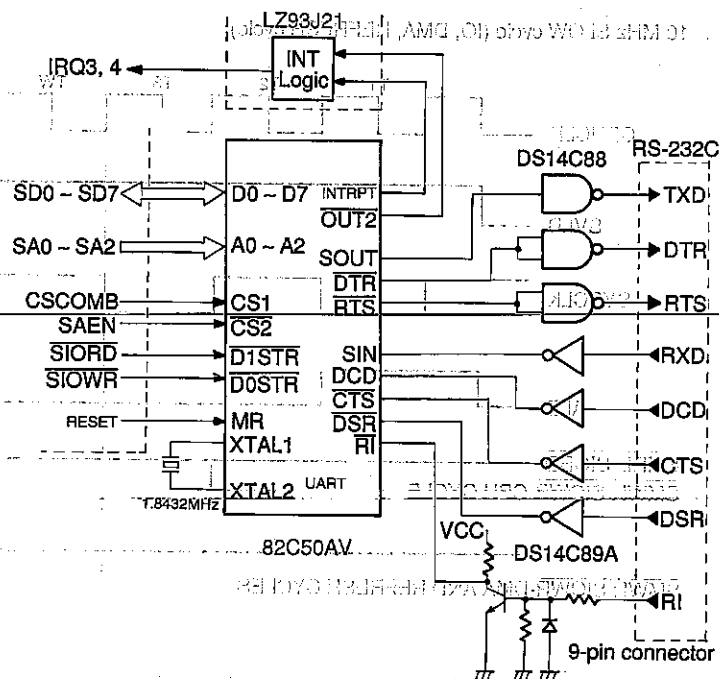


Fig. 3-14 Serial interface circuit

The serial interface circuit consists of transmitter DS14C88, receivers DS14C89A and the UART (INS82C50A). The convert TTL compatible signals sent from the UART to -12V to +12V signals conforming to the EIA standard, and output them via the RS-232C connector. The convert the EIA level reception signal to the TTL level and send it to the UART. The functional configuration of the UART is programmed by software via the data bus.

The UART performs a serial-to-parallel conversion of data characters received from a peripheral device or a MODEM, and a performs a parallel-to-serial conversion of data characters received from the CPU. The CPU can read the complete status of the UART any time during the functional operation. Status information includes the type and condition of the transfer operations performed by the UART, and provides error conditions (parity, overrun, framing, or break interrupt).

The UART includes a programmable baud rate generator. Also the UART has a complete modem control capability and a processor-interrupt system that minimizes the computing time for handling the communications link.

When the CPU assigns one of the address 3F8H thru 3FFH or 2F8H thru 2FFH as an I/O address, the HIGH level CSCOMB signal sent from the VG801A (Gate Array) is emitted to the UART. The UART then selects the internal register to be ZORC connected to the data bus according to the state of the DLAB (Divisor Latch Access Bit). The DLAB is bit 7 of the line control register. Table lists the state of registers indicates at each I/O address, and the table lists the bit assignment of each register.

| I/O Address | A2 | A1 | A0 | SIORD | SIOWR | DLAB | Register |
|--------------|----|----|----|-------|-------|------|-----------------------------------|
| 3F8H or 2F8H | L | L | L | L | H | X | Receive buffer register |
| 3F8H or 2F8H | L | L | L | H | L | X | Transmit holding register |
| 3F8H or 2F8H | L | L | L | * | * | 1 | Divisor latch LSB |
| 3F9H or 2F9H | L | L | H | * | * | 1 | Divisor latch LSB |
| 3F9H or 2F9H | L | L | H | * | * | 0 | Interrupt enable register |
| 3FAH or 2FAH | L | H | L | * | * | X | Interrupt identification register |
| 3FBH or 2FBH | L | H | H | * | * | X | Line control register |
| 3FCH or 2FCH | H | L | L | * | * | X | Modem control register |
| 3FDH or 2FDH | H | L | H | * | * | X | Line status register |
| 3FEH or 2FEH | H | H | L | * | * | X | Modem status register |

*: SIORD becomes LOW at read operation

SIOWR becomes LOW at write operation

X: Not applicable.

| I/O Address | Bit | Description |
|---|-----|--|
| 3F9H or 2F9H Interrupt enable register | 0 | H: Enable data |
| | 1 | H: Enable TX holding register empty interrupt |
| | 2 | H: Enable receive line status interrupt |
| | 3 | H: Enable modem status interrupt |
| | 4-7 | Always LOW |
| 3FAH or 2FAH Interrupt identification register | 0 | H: No interrupt pending |
| | 1 | Interrupt identification bit 0 |
| | 2 | Interrupt identification bit 1 |
| | 3-7 | Always LOW |
| 3FBH or 2FBH Line control register | 0 | Word length select bit 0 |
| | 1 | Word length select bit 1 |
| | 2 | Number of stop bit |
| | 3 | Parity enable |
| | 4 | Even parity select |
| | 5 | Stuck parity |
| | 6 | Set break |
| | 7 | Divisor latch access bit (DLAB) |
| 3FCH or 2FCH Modem control register | 0 | Data terminal ready (DTR) |
| | 1 | Request to send (RTS) |
| | 2 | Out 1 |
| | 3 | Out 2 |
| | 4 | Loopback |
| | 5-7 | Always LOW |
| 3FDH or 2FDH Line status register | 0 | Data ready (DR) |
| | 1 | Overrun error (OR) |
| | 2 | Parity error (PE) |
| | 3 | Framing error (FE) |
| | 4 | Break interrupt (BI) |
| | 5 | Transmit holding register empty (THRE) |
| | 6 | TX Shift empty (TSRE) |
| | 7 | Always LOW |
| 3FEH or 2FEH Modem status register | 0 | Delta clear to send (DCTS) |
| | 1 | Delta data set ready (DDSR) |
| | 2 | Trailing edge ring indicator (TERI) |
| | 3 | Delta data carrier detect (DDCD) |
| | 4 | Clear to send (CTS) |
| | 5 | Data set ready (DSR) |
| | 6 | Ring indicator (RI) |
| | 7 | Delta carrier detect (DCD) |

3-13. Speaker interface

A small, permanent magnet speaker is used in the sound system. The speaker can be driven from one or two of sources. It also can be driven by the SCM, CE-451M (modem).

- An LZ95H12 output bit
- A timer clock channel, output programmable within the function of the V40 timer. The timer gate can also be controlled by the LZ95H12 PPI output port.

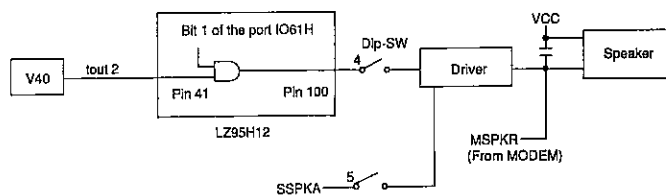


Fig. 3-15 Speaker control circuit

3-14. RTC/CMOS RAM circuit

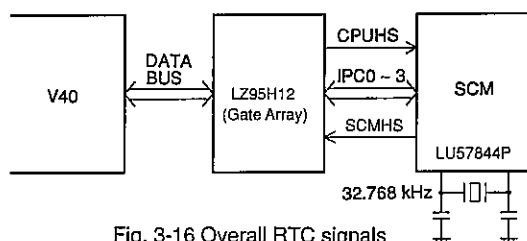


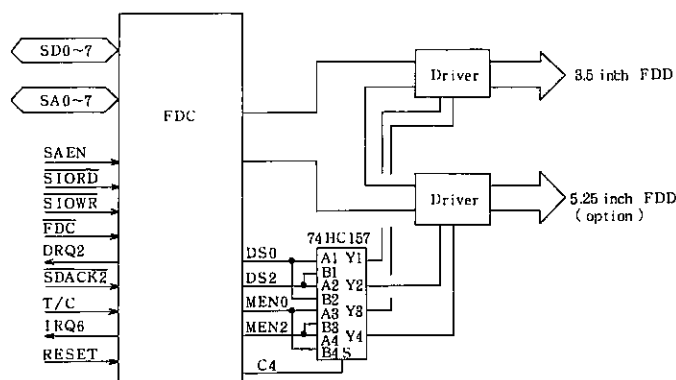
Fig. 3-16 Overall RTC signals

The SCM has a 32.768KHz crystal oscillator for the timer clock besides the program executing oscillator, and divided to cause an interrupt to the SCM itself at the given interval. Timer clock is counted in this interrupt routine and stored in the internal RAM (C-MOS RAM). This value can be read by the V40 via the LZ95H12 by means of handshaking.

For setup data are contained in SCM internal RTC and others, they can be read and written from V40 via LZ95H12 as handshaked with SCM, similar as RTC.

3-15. FDD interface circuit

The FDD interface circuit supports two floppy disk units at a maximum. Fig. 3-16 shows the block diagram. A TC8566F floppy disk controller is used to interface the floppy disk units with the CPU.



NOTE: The 74HC157 is used to select between the built-in 3.5 inch FDD and optional 5.25 inch FDD for drive A in the set-up menu.

Fig. 3-16 FDD interface block diagram

3-15-1. TC8566F floppy disk controller

The TC8566F floppy disk controller contains a VFO and peripheral logic circuit on a single chip.

Two control registers, main status register, and data register are on the chip. Table 3-3 shows the relation between address line and registers.

| AEN | CS | A7 | A6 | A5 | A4 | A3 | A2 | A1 | A0 | Function |
|-----|----|----|----|----|----|----|----|----|----|----------------------|
| H | X | X | X | X | X | X | X | X | X | No selection |
| X | H | X | X | X | X | X | X | X | X | |
| X | X | L | X | X | X | X | X | X | X | |
| X | X | X | L | X | X | X | X | X | X | |
| X | X | X | X | L | X | X | X | X | X | |
| X | X | X | X | X | L | X | X | X | X | |
| X | X | X | X | X | X | H | X | X | X | |
| L | L | H | H | H | H | L | L | L | L | |
| L | L | H | H | H | H | L | L | L | H | Prohibit |
| L | L | H | H | H | H | L | L | H | L | Control register-0 |
| L | L | H | H | H | H | L | L | H | H | Control register-1 |
| L | L | H | H | H | H | L | H | L | L | Main status register |
| L | L | H | H | H | H | L | H | L | H | Data register |
| L | L | H | H | H | H | L | H | H | L | No selection |
| L | L | H | H | H | H | L | H | H | H | |

Table 3-3

3-15-1-1. Control register-0

This is an 8-bit write only register.

| Bit position | Symbol | Name | Significance |
|--------------|--------|--------------------------|--|
| D7 | MEN3 | Motor enable-3 | Control bit to control the motor in the No. 3 drive unit. |
| D6 | MEN2 | Motor enable-2 | Control bit to control the motor in the No. 2 drive unit. |
| D5 | MEN1 | Motor enable-1 | Control bit to control the motor in the No. 1 drive unit. |
| D4 | MEN0 | Motor enable-0 | Control bit to control the motor in the No. 0 drive unit. |
| D3 | ENID | Enable INT & DMA request | Used to set INTRQ and DRQ2 into effect. When this bit is at a low, INTRQ and DRQ2 stay inactive. |
| D2 | FRST | Not FDC reset | Used to reset the internal FDC. When this bit is 0, the FDC block is reset. |
| D1 | DSB | Drive select B | Used to select FDC. |
| D0 | DSA | Drive select A | The following is selected with DSB and DSA. (0, 0): No. 0 drive unit (0, 1): No. 1 drive unit (1, 0): No. 2 drive unit (1, 1): No. 3 drive unit But, if CDS is low, those bits are not in effect and the internal FDC select signal becomes effective. All bits will be cleared when RESET is set high. |

All bits will be cleared when RESET is set high.

Table 3-4

3-15-1-2. Control register-1

This is an 8-bit write only register.

| Bit position | Symbol | Name | Significance |
|--------------|--------|----------------------|--|
| D3 | C3 | Control-5 | These bits are open to user. Bit state appears on C5 and C4. If C4 is connected with MIN, for instance, the mini-floppy disk can be changed to the standard floppy disk by means of software. |
| D4 | C4 | Control-4 | |
| D2 | SBM | Standby mode | This bit indicates standby mode. Standby mode would not occur when this bit is at 0. |
| D0 | FDCTC | FDC terminal counter | Used to control the FDC terminal count. When data transfer is terminated in the non-DMA mode, the terminal count is sent to the internal FDC block in reference to this bit. |

Table 3-5

All bits will be cleared when RESET is set high. For data bus, D7-D5, D3, D1, are bit enable signal for D6, D4, D2, and D0, it is possible to change bit independently. For instance, writing 03H changes only FDCTC to 1 without changing the contents of C6, C4, and SBM.

3-15-2. Interfacing the FDC register with CPU

Interfacing the FDC register with CPU

The FDC has two registers which can be accessed by the main system processor. The one is main status register and the other is data register. The main status register indicates the FDC status information and can be accessed at any time. The 8-bit data register stores data, command, parameter, and FDD status. Data byte is written in the data register or read from the data register for programming or to obtain the results after command execution. The main status register is read only to facilitate data transfer between the FDC and the processor. The following shows the relation among the main status register, data register, IOR, IOW, and CS.

Condition: A7=A6=A5=A4=A2=1, A3=A1=0, AEN=0

| CS | A0 | IOR | IOW | Function |
|-----|------|------|------|---------------------------|
| Low | Low | Low | Low | Prohibited |
| Low | Low | Low | High | Main status register read |
| Low | Low | High | Low | Prohibited |
| Low | High | Low | Low | Prohibited |
| Low | High | Low | High | Data register read |
| Low | High | High | Low | Data register write |

Table 3-6

Each main status register bit is defined as in Table 3-7.

The main status register bits, RQM and DIO, indicate whether the data register is ready or which direction data are on the data bus.

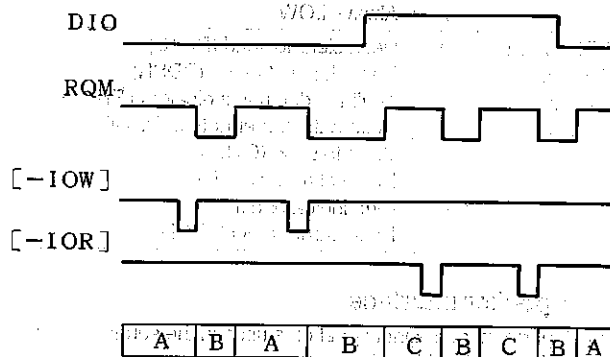


Fig. 3-17 Main status register timing

A (DIO=low, RQM=high): Data register is enabled to write by the processor.
B (RQM=low)
Data register is not ready.
C (DIO=high, RQM=high)
Data register is read by the processor and a next data byte is already on.

| Bit Position | Symbol | Name | Significance |
|--------------|--------|--------------------|--|
| D7 | RQM | Request for master | Indicates that data are sent to the processor from the data register, or it is ready to receive data from the processor. |
| D6 | DIO | Data input/output | Indicates data transfer direction when transferring data between the data register and the processor. A high on this line indicates that data are transferred from the data register to the processor. A low on this line indicates that data are transferred from the processor to the data register. |
| D5 | NDM | Non-DMA mode | Indicates that the FDC is in the non-DMA mode. This bit can be active only in the execution phase of the non-DMA mode. A low on this line indicates that the execution phase has been completed. |
| D4 | CB | FDC busy | This bit is set when a read-write related command is in execution or during execution of command phase or result phase. |
| D3 | D3B | FDD3 busy | Indicates that the NO. 3 drive is in the seek mode. |
| D2 | D2B | FDD2 busy | Indicates that the NO. 2 drive is in the seek mode. |
| D1 | D1B | FDD1 busy | Indicates that the NO. 1 drive is in the seek mode. |
| D0 | D0B | FDD0 busy | Indicates that the NO. 0 drive is in the seek mode. |

Table 3-7. Main status register

The FDC may execute 15 different commands. Execution takes place with a multiple byte transfer by the processor, and results after command execution is indicated after multiple byte transfer to the processor. For multiple number of bytes are transferred between the FDC and the processor, it may be assumed to constitute the following blocks.

Command phase:

The FDC receives from the processor information required for the given operation.

Execution phase:

The FDC executes the given command.

Result phase:

After completion of the operation, the result status information are sent to the processor.

During execution of command phase and result phase, the processor needs to read the main status register before the byte information is written in the data register or read byte information from the data register. In order to write command and parameter bytes in the FDC, the main status register bit D7 must be high and bit D5 low. For majority of commands requires a multiple bytes, the main status register must be read before transferring bytes to the FDC. Also, the main status register bits D7 and D5 must be high before reading bytes from the data register during execution of the result phase. For the command phase and result phase, the main status register must be read before transferring bytes to the FDC, but may not be required necessarily for the execution phase. When the FDC is in the non-DMA mode, receive of data bytes (when the FDC is reading data from the FDD), INT (INT=1) is caused. If IOR (IOR=0) is issued, it not

only send data on the data bus, INT may also be reset. However, if the processor may not be fast enough to handle the interrupt (within 13μs in the MFM mode), the main status register is interrogated. The bit D7 (RQM) function as INT. In the same manner, INT may be reset with IOW while write command is in execution.

INT is not issued while the execution phase is being executed when the FDC is in the DMA mode. The FDC issues DRQ (DMA request) when data bytes are ready, to which the controller set DAC low (DMA acknowledge) and IOR low to respond to it. DRQ is reset when DMA acknowledge is set low for a read related command. For a write related command, IOW functions the same as IOR. An interrupt is request upon completion of the execution phase (TC received) which indicates the start of the result phase. After reading the first data byte in the result phase, INT is forced to reset. In the result phase, all data bytes shown in the command list must be read. For instance, in the result phase of read data command, there are seven data bytes. In order to finish the read data command, these all seven data bytes must be read. Otherwise, the FDC may not receive a new command. For other commands, all data bytes must have been read in the result phase. The FDC has five status registers. The above mentioned main status register may be read at any time by the processor. Four result status registers (ST0, ST1, ST2, ST3) can be used only in the result phase and can be read at the termination of command. Size of the result status register depends on the command executed. Sequence of data bytes sent to the FDC in the command phase and data bytes read from the FDC in the result phase is as shown in the command list. In other words, a command code must be first sent, to be followed by other bytes in the given order. So, nothing could be short for the command phase and the result phase. When the last data byte of the command phase is sent to the FDC, the execution phase takes place automatically. Similarly, after reading the last data byte in the result phase, the command automatically terminates and the FDC becomes ready to accept a next command.

3-16. Keyboard interface

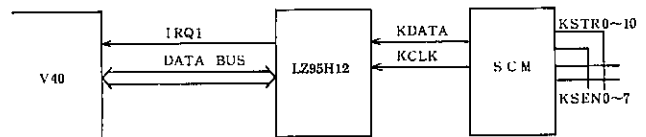
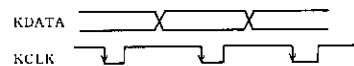


Fig. 3-18 Overall key signals

The SCM issues strobe through KSTR0~10 at every 6ms to scan the level on KSEN0~7 to sense key depression. The code is sent to the LZ95H12 on KDATA with a clock on KCLK. The following shows its timing.



After receiving the code in the shift register, the LZ95H12 turns IRQ1 high with which the V40 read the data from the LZ95H12.

(2) Keyboard LEDs (CAPS LOCK, NUM LOCK, SCRL LOCK)

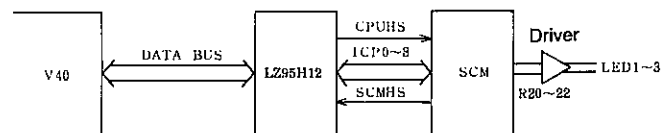
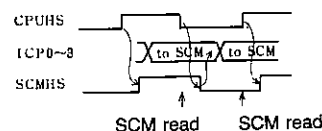


Fig. 3-19 Keyboard LEDs

LED is activated after the SCM receives the command sent from the V40 via the LZ95H12. Communication between the LZ95H12 and the SCM is carried out by handshaking. The data are sent on four bidirectional bus ICP0~3. The signal CPUHS is used from the LZ95H12 for handshake control and SCMHs from the SCM. The figure below shows an example of data transfer.



3-17 LCD control circuit

3-17-1: I/O mapping

The table below shows the I/O address assignment of the MDA and ATT (CGA).

| I/O Address | Read/Write | Bit | Description |
|---|------------|-----|--|
| 77H (ATT=0) 78H (ATT=1) | R/W | 0 | ATT (CGA/MDA). 1: ATT (CGA) Mode, 0: MDA Mode |
| 79H | R/W | 4 | RVVD (Reverse video) 1: Reverse video enable |
| 78H | R/W | 4 | CURBLK0, 1 (Cursor Blink Rate 0, 1) 0: Steady 1: 1/64 S blink 2: 1/32 S blink 3: 1/16 S blink |
| 79H | R/W | 6 | ATTBLK0, 1 (Attribute blink Rate 0, 1) 0: Steady 1: 1/64 S blink 2: 1/32 S blink 3: 1/16 S blink |
| Index Register 3B4H (ATT=0) 3D4H (ATT=1) | W | 0 | IDX0 (Index Address 0) |
| | | 1 | IDX1 (Index Address 1) |
| | | 2 | IDX2 (Index Address 2) |
| | | 3 | IDX3 (Index Address 3) |
| | | 4 | IDX4 (Index Address 4) |
| | | 5 | Not used |
| | | 6 | Not used |
| | | 7 | Not used |
| Data Register 3B5H (ATT=0) 3D5H (ATT=1) (Register Address=0AH) | W | 0 | CSSL0 (Cursor Start Scan Line 0) |
| | | 1 | CSSL1 (Cursor Start Scan Line 1) |
| | | 2 | CSSL2 (Cursor Start Scan Line 2) |
| | | 3 | CSSL3 (Cursor Start Scan Line 3) |
| | | 4 | CSSL4 (Cursor Start Scan Line 4) |
| | | 5 | CSSL5 (Cursor Start Scan Line 5) |
| | | 6 | CSSL6 (Cursor Start Scan Line 6) |
| | | 7 | Not used |
| Data Register 3B5H (ATT=0) 3D5H (ATT=1) (Register Address=0BH) | W | 0 | CESL0 (Cursor End Scan Line 0) |
| | | 1 | CESL1 (Cursor End Scan Line 1) |
| | | 2 | CESL2 (Cursor End Scan Line 2) |
| | | 3 | CESL3 (Cursor End Scan Line 3) |
| | | 4 | CESL4 (Cursor End Scan Line 4) |
| | | 5 | CESL5 (Cursor End Scan Line 5) |
| | | 6 | CESL6 (Cursor End Scan Line 6) |
| | | 7 | Not used |
| Data Register 3B5H (ATT=0) 3D5H (ATT=1) (Register Address=0CH) | W | 0 | DSA8 (Display Start Address 8) |
| | | 1 | DSA9 (Display Start Address 9) |
| | | 2 | DSA10 (Display Start Address 10) |
| | | 3 | DSA11 (Display Start Address 11) |
| | | 4 | DSA12 (Display Start Address 12) |
| | | 5 | DSA13 (Display Start Address 13) |
| | | 6 | Not used |
| | | 7 | Not used |
| Data Register 3B5H (ATT=0) 3D5H (ATT=1) (Register Address=0DH) | W | 0 | DSA0 (Display Start Address 0) |
| | | 1 | DSA1 (Display Start Address 1) |
| | | 2 | DSA2 (Display Start Address 2) |
| | | 3 | DSA3 (Display Start Address 3) |
| | | 4 | DSA4 (Display Start Address 4) |
| | | 5 | DSA5 (Display Start Address 5) |
| | | 6 | DSA6 (Display Start Address 6) |
| | | 7 | DSA7 (Display Start Address 7) |
| Data Register 3B5H (ATT=0) 3D5H (ATT=1) (Register Address=0EH) | R/W | 0 | CSA8 (Cursor Address 8) |
| | | 1 | CSA9 (Cursor Address 9) |
| | | 2 | CSA10 (Cursor Address 10) |
| | | 3 | CSA11 (Cursor Address 11) |
| | | 4 | CSA12 (Cursor Address 12) |
| | | 5 | CSA13 (Cursor Address 13) |
| | | 6 | Not used |
| | | 7 | Not used |

| I/O Address | Read/Write | Bit | Description |
|---|------------|-----|---|
| Data Register 3B5H (ATT=0) 3D5H (ATT=1) (Register Address=0FH) | R/W | 0 | CSA0 (Cursor Address 0) |
| | | 1 | CSA1 (Cursor Address 1) |
| | | 2 | CSA2 (Cursor Address 2) |
| | | 3 | CSA3 (Cursor Address 3) |
| | | 4 | CSA4 (Cursor Address 4) |
| | | 5 | CSA5 (Cursor Address 5) |
| | | 6 | CSA6 (Cursor Address 6) |
| | | 7 | CSA7 (Cursor Address 7) |
| 3B8H (ATT=0) | W | 0 | Not used |
| | | 1 | Not used |
| | | 2 | Not used |
| | | 3 | 0: Video disabled, 1: Video enabled |
| | | 4 | Not used |
| | | 5 | MSB of attribute is 0: intensity, 1: blink |
| | | 6 | Not used |
| | | 7 | Not used |
| 3D8H (ATT=1) | W | 0 | 0: 40 x 25 Alpha, 1: 80 x 25 Alpha |
| | | 1 | 0: Character Mode, 1: Graphics Mode |
| | | 2 | Not used |
| | | 3 | 0: Video disabled, 1: Video enabled |
| | | 4 | Not used |
| | | 5 | MSB of attribute is 0: intensity, 1: blink |
| | | 6 | Not used |
| | | 7 | Not used |
| 3B8H (ATT=0) | R | 0 | Horizontal sync |
| | | 1 | Not used (0 read) |
| | | 2 | Not used (0 read) |
| | | 3 | Black/white video |
| | | 4 | Not used (0 read) |
| | | 5 | Not used (0 read) |
| | | 6 | Not used (0 read) |
| | | 7 | Not used (0 read) |
| 3D8H (ATT=1) | R | 0 | Display enable |
| | | 1 | Not used (0 read) |
| | | 2 | Not used (0 read) |
| | | 3 | Vertical sync |
| | | 4 | Not used (1 read) |
| | | 5 | Not used (1 read) |
| | | 6 | Not used (1 read) |
| | | 7 | Not used (1 read) |
| 3DEH (ATT=1) | W | 0 | 640 x 200 APA 0: two 16K alpha pages, 1: one 32K alpha page |
| | | 1 | Not used |
| | | 2 | Not used |
| | | 3 | 0: Select low page, 1: select high page |
| | | 4 | Not used |
| | | 5 | Not used |
| | | 6 | 0: underline disabled, 1: underline enabled |
| | | 7 | Not used |

3-17-2: VRAM mapping

The LCD control circuit has four 256K-bit (64 x 4-bit) DRAM chips which are used for VRAM, character generator table, and system work area. A 4KB area is used as a VRAM (display buffer) in the MDA mode, or 16KB in the CGA mode, or 32KB in the ATT mode. The ATT mode is an expanded version of the CGA mode which supports 640 x 400 APA mode.

The figure next shows the display buffer memory allocation in each mode.

The 4Kbytes monochrome adapter display buffer is mirrored into eight different address 4Kbytes address ranges. The 16Kbytes graphics adapter display buffer is mirrored into two 16Kbytes address ranges.

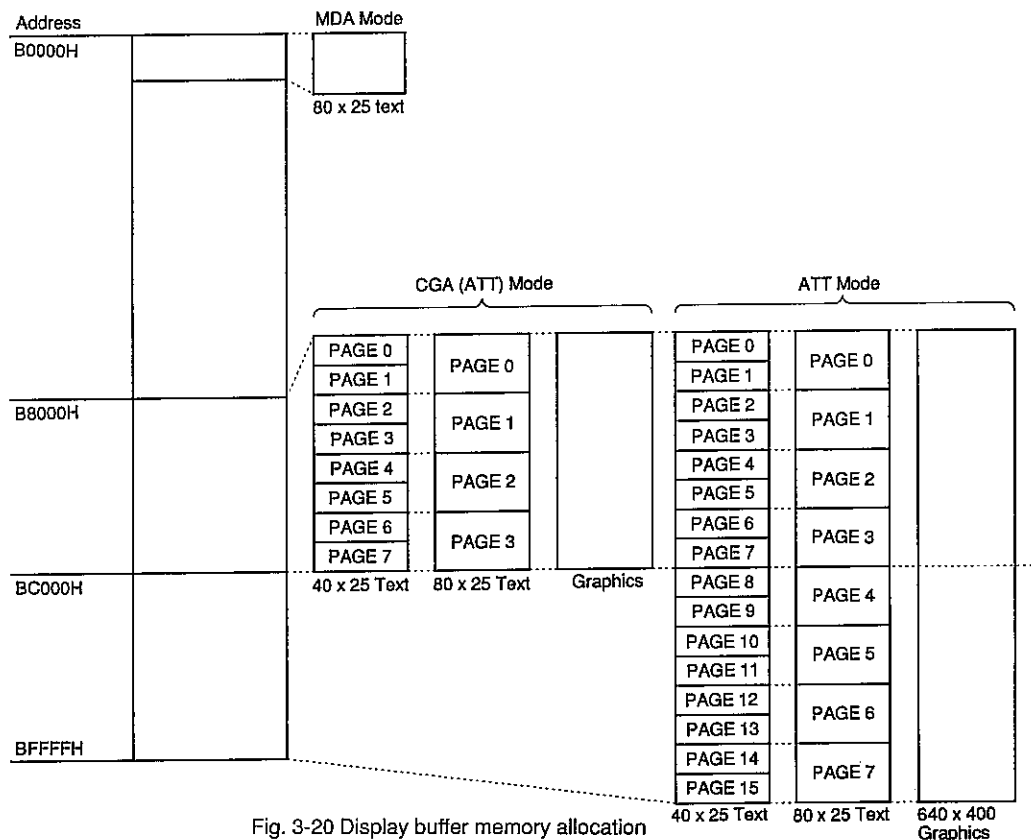


Fig. 3-20 Display buffer memory allocation

3-17-2-1. Text mode

- 80 x 25 text (MDA)
- 80 x 25 text (CGA/ATT)
- 40 x 25 text (CGA/ATT)

The LCD control circuit supports the text 80 x 25 MDA alphanumeric mode and 80 x 25/40 x 25 CGA/ATT alphanumeric mode.

Every character to be displayed has one byte of character code with one byte of attribute. The attribute has four functions described next.

| Background | | | Foreground | | | Display mode |
|------------|---|---|------------|---|---|-----------------|
| R | G | B | R | G | B | |
| 0 | 0 | 0 | 0 | 0 | 0 | Non display |
| 0 | 0 | 0 | 0 | 0 | 1 | With underline |
| 0 | 0 | 1 | 1 | 1 | 1 | Normal display |
| 1 | 1 | 1 | 0 | 0 | 0 | Reverse display |

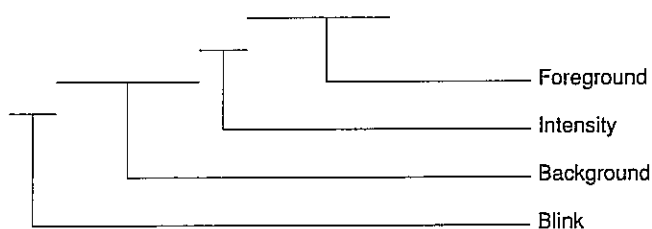
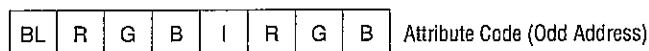
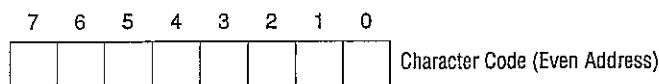


Fig. 3-21 Attribute assignment

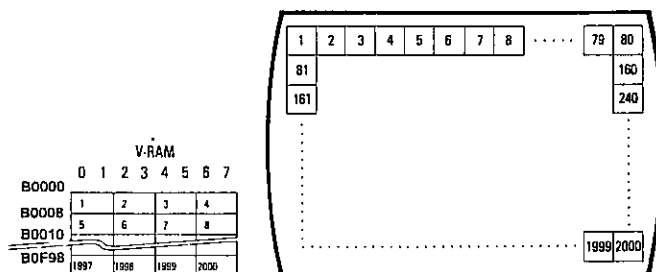


Fig. 3-22 VRAM map in the 80 x 25 text mode (MDA)

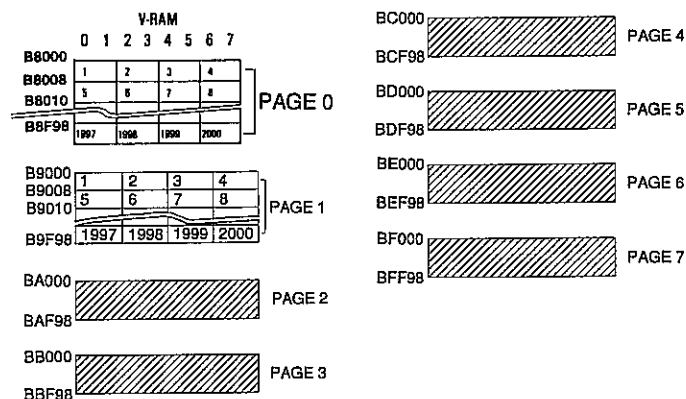
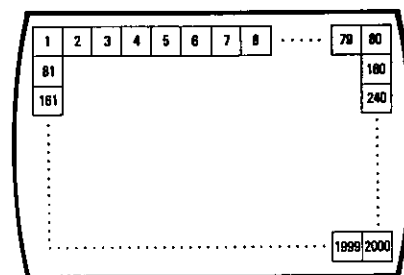


Fig. 3-23 V-RAM map in the 80 x 25 text mode (ATT)

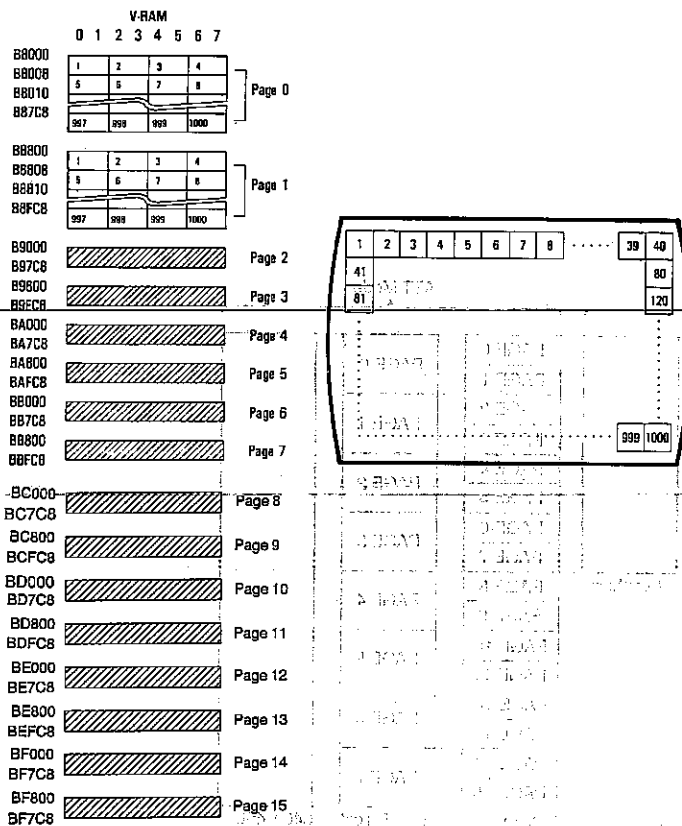


Fig. 3-24 V-RAM map in the 40 x 25 text mode (ATT)

3-17-2-2. Graphics mode

- 320 x 200 graphics (ATT)
- 640 x 200 graphics (ATT)
- 640 x 400 graphics (ATT)

The LCD circuit supports the 320 x 200 graphics mode, 640 x 200 graphics mode, and 640 x 400 graphic mode.

And this circuit uses black for the foreground color and white for the background color in both 640 x 200 and 640 x 400 graphics modes. Each pixel in the 320 x 200 graphics mode is presented by a 2 x 2 block of LCD screen pixels.

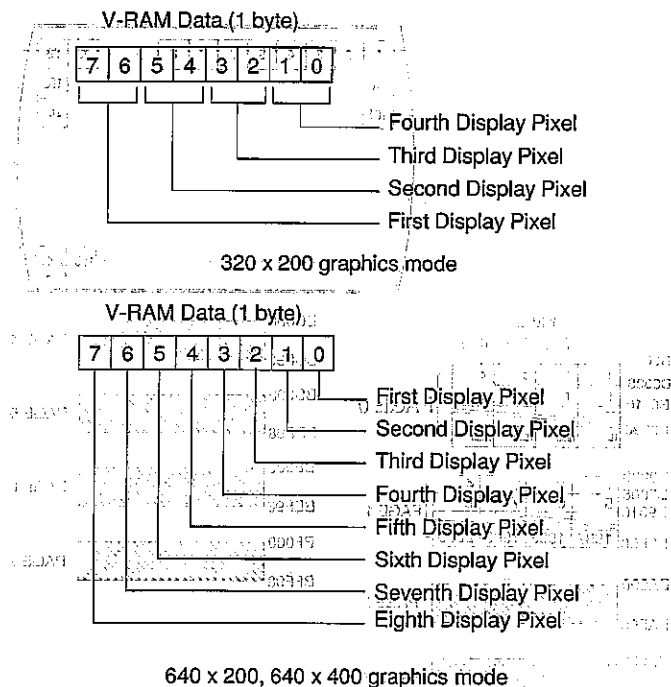


Fig. 3-25 Bit assignment

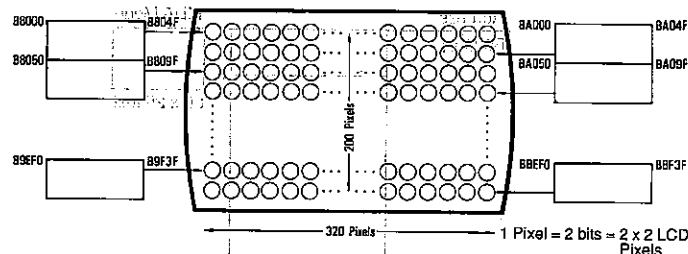


Fig. 3-26 V-RAM map in the 320 x 200 graphics mode

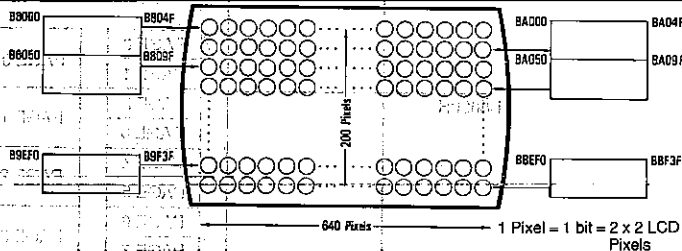


Fig. 3-27 V-RAM map in the 640 x 200 graphics mode

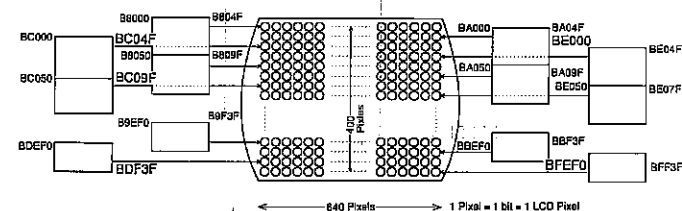
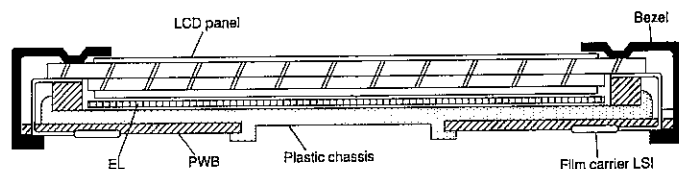


Fig. 3-28 V-RAM map in the 640 x 400 graphics mode.

CHAPTER 4. LCD UNIT

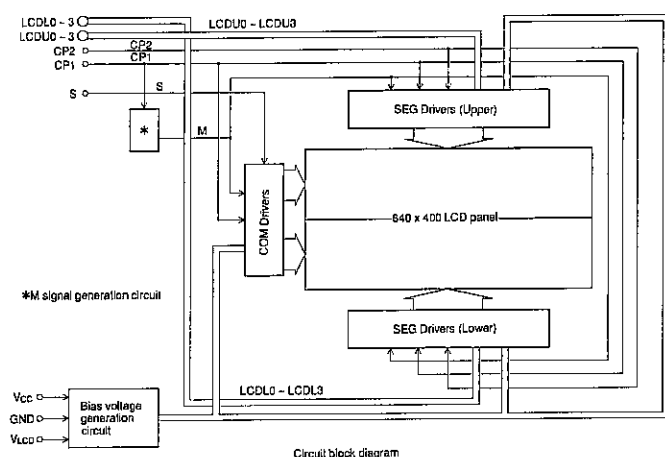
4-1. Structure

A 640 x 400 full dot graphics display unit is employed for the LCD unit which consists of a printed circuit board that contains the LCD panel and its electronic circuits, an electrically connected film carrier LSI chip, and a mechanically held plastic chassis, and a bezel.



4-2. Operational theory

Circuit block diagram and interface signals are shown in the figure next.



Interface signals

| Pin NO. | Symbol | Description | Active signal level |
|---------|--------|----------------------------------|---------------------|
| 1 | S | Scan start signal | "H" |
| 2 | CP1 | Input data latch signal | H → L |
| 3 | CP2 | Data input clock signal | H → L |
| 4 | Vcc | Logic circuit power supply (+5V) | — |
| 5 | GND | Ground | — |
| 6 | VLcd | Liquid crystal drive power (—) | — |
| 7 | LCDU0 | Display data signal (upper half) | H(ON), L(OFF) |
| 8 | LCDU1 | " | " |
| 9 | LCDU2 | " | " |
| 10 | LCDU3 | " | " |
| 11 | LCDL0 | Display data signal (lower half) | H(ON), L(OFF) |
| 12 | LCDL1 | " | " |
| 13 | LCDL2 | " | " |
| 14 | LCDL3 | " | " |

The display screen of this unit is configured of 640 x 400 dots two screens, each screen driven with 1/200 duty.

An 80-pin LSI is used for the LCD driver that consists of a shift register, latch, and LCD drive circuit.

Data are inputted for each line (640 dots) of the screen. From the left side of the screen, 4-bit parallel data are sent one at a time via the shift register with the clock pulse CP2. When the 640 dots data have been received for one display line, the data are latched as a parallel data with respect to the 640 signal electrodes at a high to low transition of the latch signal CP1 to send the drive signal by the drive circuit to the corresponding electrodes.

For the scan start signal S has been transferred at the first line to display the data by the combination of the LCD scan electrode and the signal electrode address voltage.

While the first line data are being displayed, the second line display data are received. Upon completing transfer of 640 data, it will then be latch at a high to low transition of CP1 to change it to display the second line.

In this way, data input are repeated to the 200th line from top to bottom using the multiplexed method. After completion of one screen (one frame), data are then received from the first line again. The scan start signal S is the scan signal to drive horizontal electrode.

For it causes the liquid crystal elements to deteriorate because of chemical reaction if DC voltage is added to the LCD panel, the drive signal waveform must be inverted at every screen in order to avoid generation of DC voltage. The circuit employed to do this is the async M signal circuit from which generated the drive waveform AC signal M.

Because of the characteristics of the CMOS driver LSI, power consumption increases as CP2 clock frequency increases. Therefore, it incorporates four shift registers to transfer the 4-bit parallel data via these shift registers to decrease the CP2 clock data transfer speed. In this circuit, a 4-bit display data (LCDU0 ~ 3 for upper half screen and LCDL0 ~ 3 for lower half screen) are supplied through the data input lines.

To further abate the power consumption, it also has a data input bus line system which comes operating only when appropriate data are received.

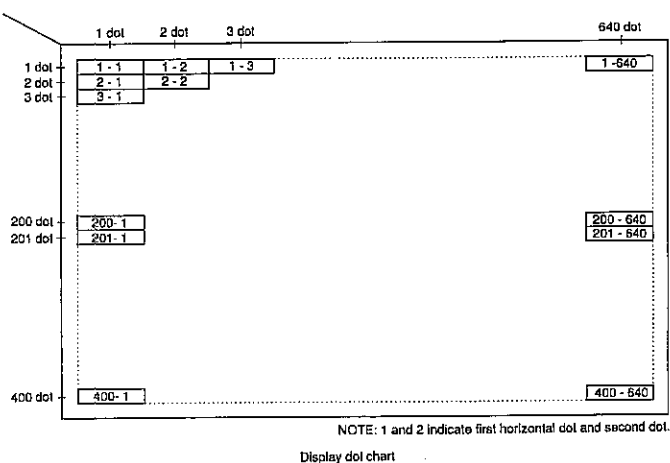
The following shows the screens signal electrode data inputs vs. driver LSI chip select signal.

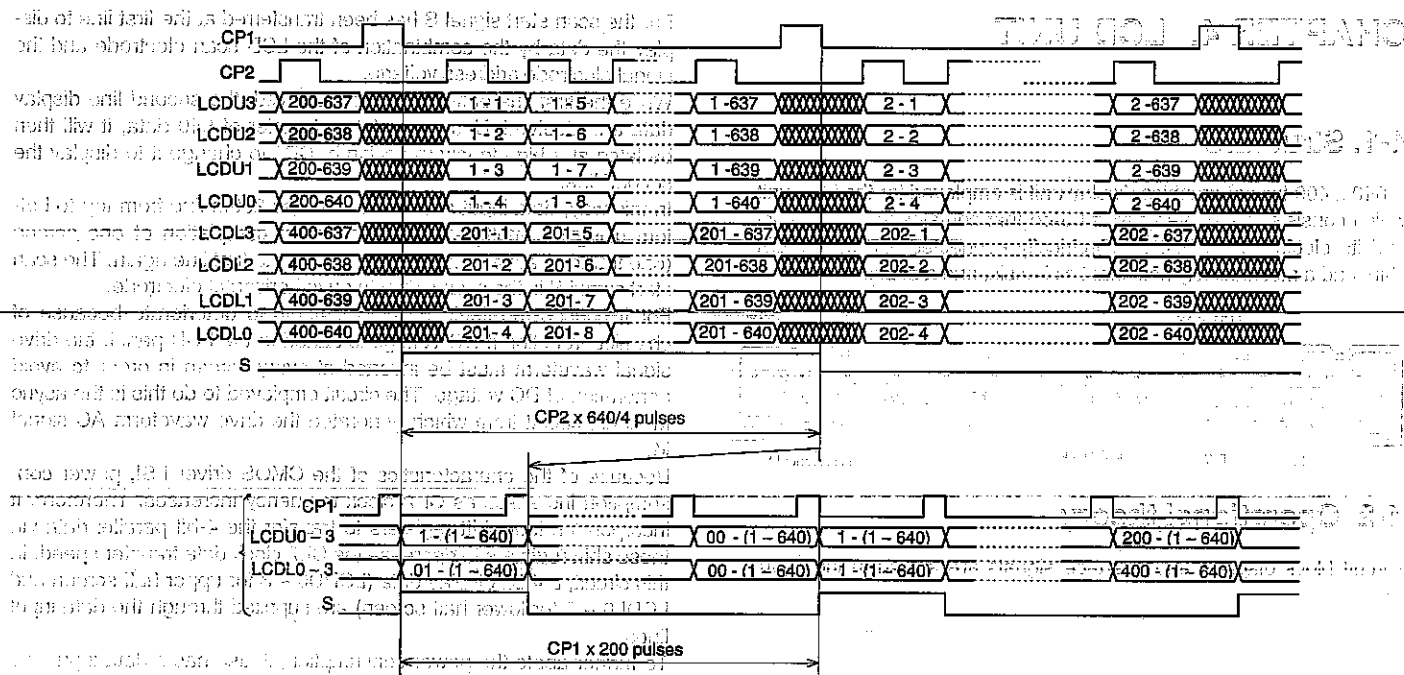
The driver LSI of the left end screen is first elected. When the 80-dot data (20CP2) has been supplied, the driver LSI adjacent to right is then selected. This continues until the data are sent to the driver LSI at the screen right.

This process occurs simultaneously for signal electrode signal LSIs of both screens. In this manner, data of both screens are supplied via 4-bit bus line starting from the left end of the screen.

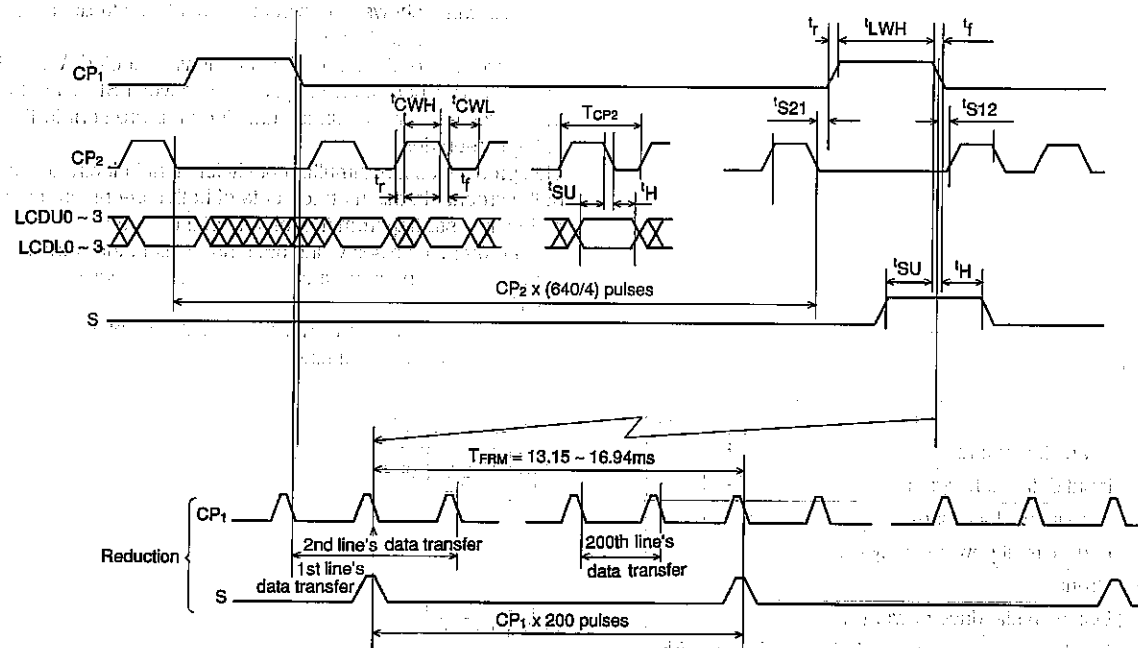
For the graphics display unit does not contain the refresh RAM, it becomes necessary to input the data and timing pulse when the screen is still.

The following shows the dot table of the display, data input timing chart, and input signal timing.





Data input timings



Interface timings

$V_{IH} = 0.8V_{CC}$
 $V_{IL} = 0.2V_{CC}$

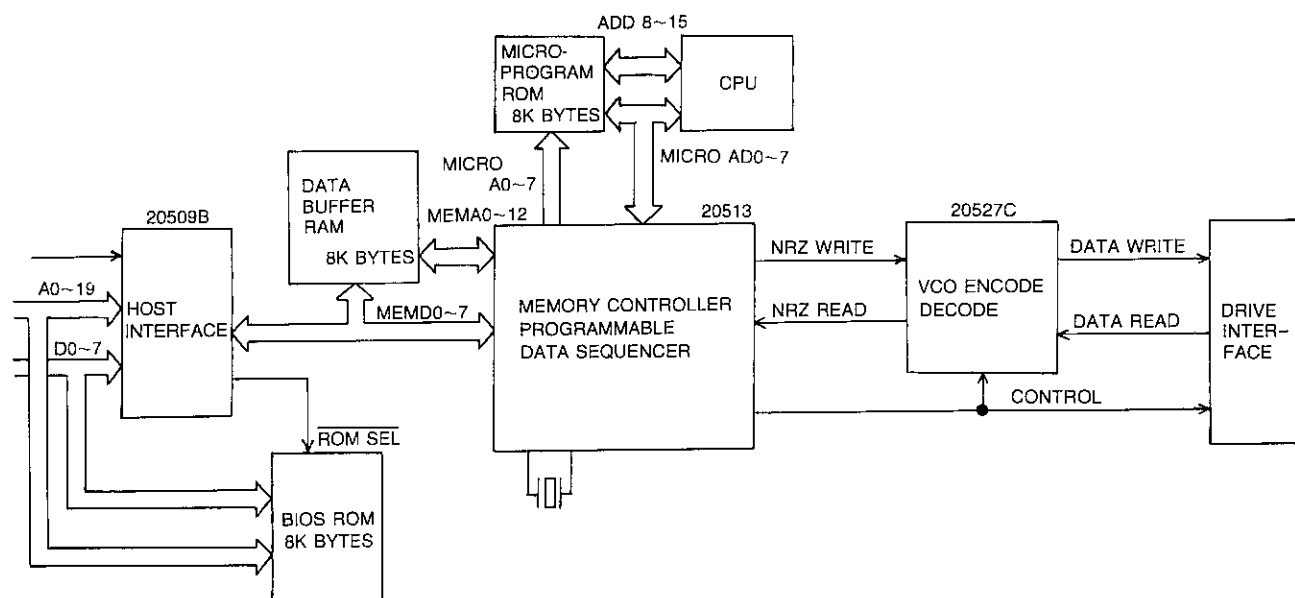
Rated interface timings

| Parameter | Symbol | Limits | | | Unit |
|--|------------|--------|-----|-------|------|
| | | MIN | TYP | MAX | |
| Frame cycle | T_{FRM} | 13.15 | | 16.94 | ms |
| Clock cycle | T_{CP2} | 342 | | | ns |
| "H" level clock width | t_{CWH} | 145 | | | ns |
| "L" level clock width | t_{CWL} | 145 | | | ns |
| "H" level latch clock width | t_{LWH} | 130 | | | ns |
| Data setup time | t_{SU} | 100 | | | ns |
| Data hold time | t_H | 100 | | | ns |
| Clock allowable time from CP2 ↓ to CP1 ↑ | t_{S21} | 0 | | | ns |
| Clock allowable time from CP1 ↓ to CP2 ↑ | t_{S12} | 0 | | | ns |
| Clock rise and fall time | t_r, t_f | | | 50 | ns |

CHAPTER 5. HARD DISK INTERFACE & HARD DISK DRIVE

1. HARD DISK INTERFACE

1-1. Block diagram



1-2. Host Interface (20509B)

The ECC/CRC block generates and checks the ECC or CRC bytes that are appended to the disk-sector ID and data fields.

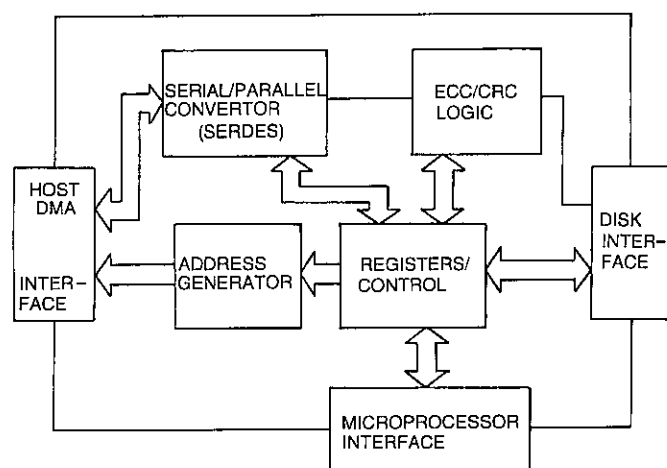
When the floppy format is selected, both ID and Data fields will use the serial implemented polynomial.

Four CRC and ECC polynomials are available depending on the setting of internal register's bit.

The Host/Buffer Interface consists of an 8-bit data bus a 13-bit address bus addressing up to 8K bytes external RAM and various control signals.

The Microprocessor Interface consists of an 8-bit multiplexed address/data bus, and 8-bit demultiplexed address bus and various microprocessor bus control signals.

The Drive Interface contains the serial data lines to and from the disk (or encode/decode circuitry) and various control signals needed during reading and writing.



BLOCK DIAGRAM

1-3. Memory controller/programmable data sequencer (20531)

The figure above illustrates a conceptual block diagram of the Memory Controller/Programmable Data Sequencer. It includes the main internal logic blocks and the interface blocks. Each of these is described below.

The Registers/Control block contains 2 groups of 8-bit internal control registers and associated control logic.

One group of registers is used for the Memory Controller section of the chip, the other group is used for the Programmable Data Sequencer section. Some of these registers may be individually written to by the microprocessor to initialize the parameters that control data transfer, and to initiate the data transfer command. The other registers may be individually read by the microprocessor to obtain status information about command execution.

The Address Generator block outputs addresses to the RAM buffer memory during the transfer of data between buffer & host, and between buffer and disk. The Address Generator automatically increments the address value to point to the next location in the buffer after each byte of data has been transferred.

The Serial/Parallel Data Converter block translates between the serial NRZ form of data used to and from the disk drive, and the byte-parallel form used on the host memory bus. High speed shift registers are used to perform the conversion.

1-4. RLL modulation and demodulation (20527)

The RLL modulator/demodulator modulates the NRZ serial data into 2-7 code serial data transferred from the 20513, to create data to be written on the disk.

On the contrary, the 2-7 code read from the disk are demodulated into the NRZ serial data to be transferred to the 20513.

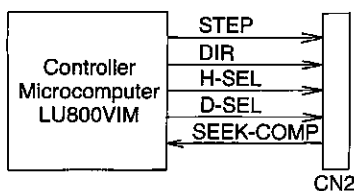
20527 includes VCO to select data demodulation VFO control and clock.

Shown below is the table for the NRZ and 2-7 code conversion.

| NRZ DATA | 2-7 CODE |
|----------|----------|
| 01 | 0100 |
| 00 | 1000 |
| 111 | 000100 |
| 100 | 001000 |
| 101 | 100100 |
| 1101 | 00100100 |
| 1100 | 00001000 |

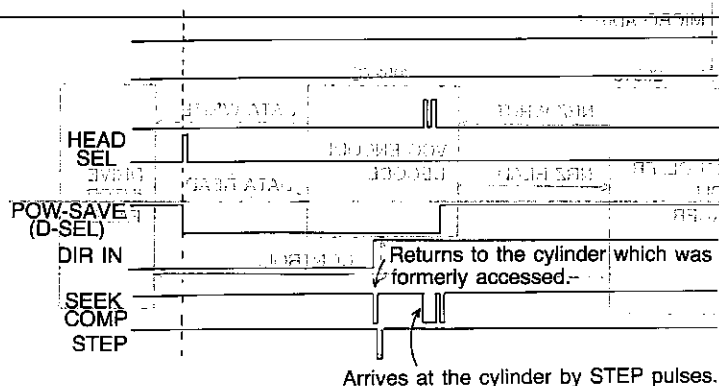
TABLE

1-5. SEEK operation

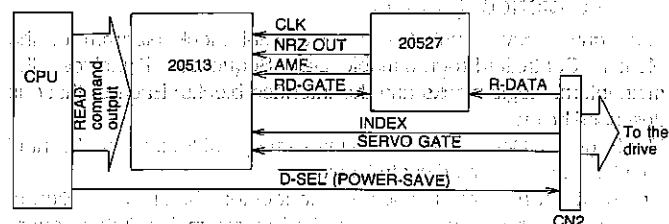


When D-SEL becomes low with the head locating in the shipping zone, the drive returns to the cylinder which was formerly accessed. When the process is completed, the SEEK-COMP is made low. The microcomputer confirms this signal to set DIR IN for instructing the moving direction of the head. After setting DIR IN, STEP pulses are applied in accordance to the movement of the cylinder. When the SEEK COMP becomes low, the SEEK operation of the cylinder is completed.

(Note) The HEAD SEL which selects HEAD 0 or 1 is specified almost simultaneously with the D-SEL.

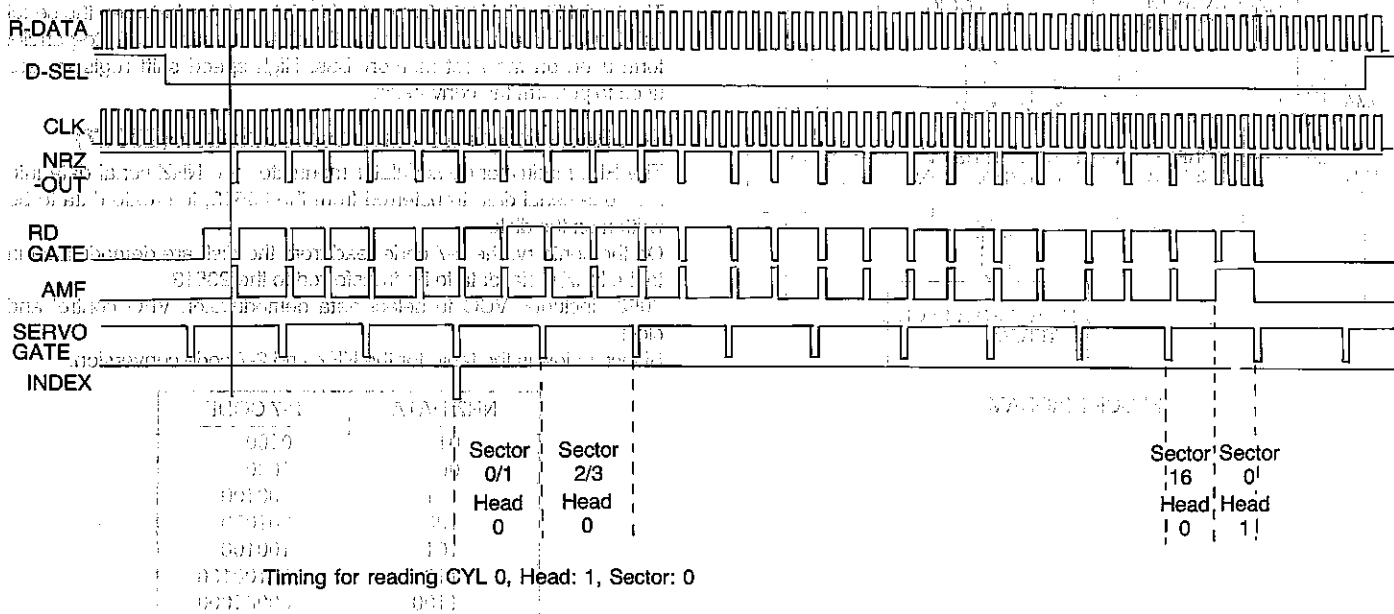


1-6. READ operation

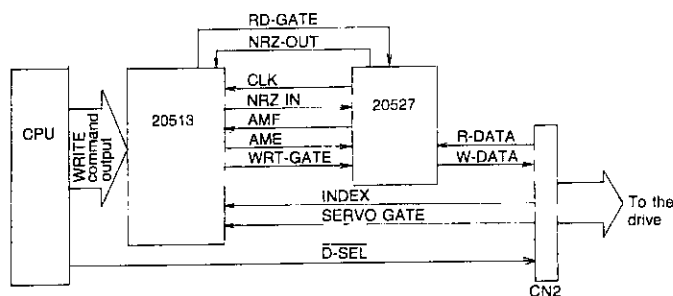


After seeking the cylinder when S-SEL becomes low, the RD-GATE becomes high and the serial data from NRZ OUT are converted into 8-bit data. This operation is repeated until the target sector is found. When the target sector is found, 512-byte data is input to make D-SEL high, completing READ operation.

- R-DATA : Written data are output in the 2-7 system from the drive.
- DF-SEL : Signal to access the drive.
- CLK : Data output obtained by converting 2-7 data into binary codes. (Supplied at CLK rising edge.)
- RD-GATE : Validates CLK/NRZ-OUT data.
- AMF : Becomes high when detecting 8T missing pulse, and becomes low at RD-GATE falling edge.
- SERVO GATE : 17 units are provided for one cylinder, and 2 sectors for 1 pulse.
- INDEX : Indicates the head of the cylinder.



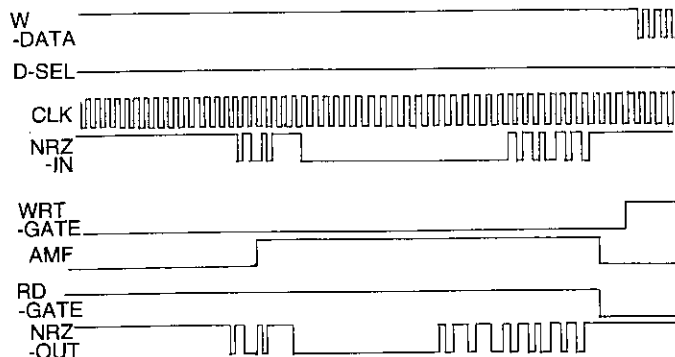
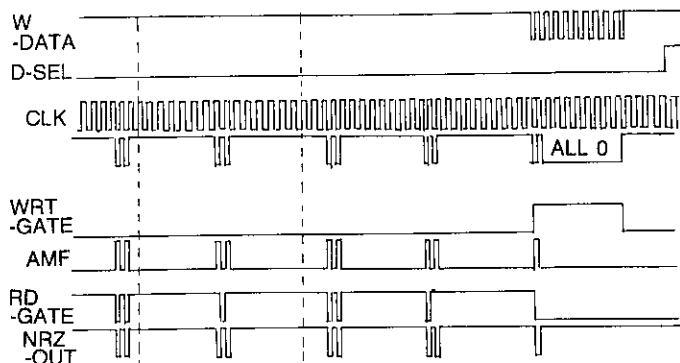
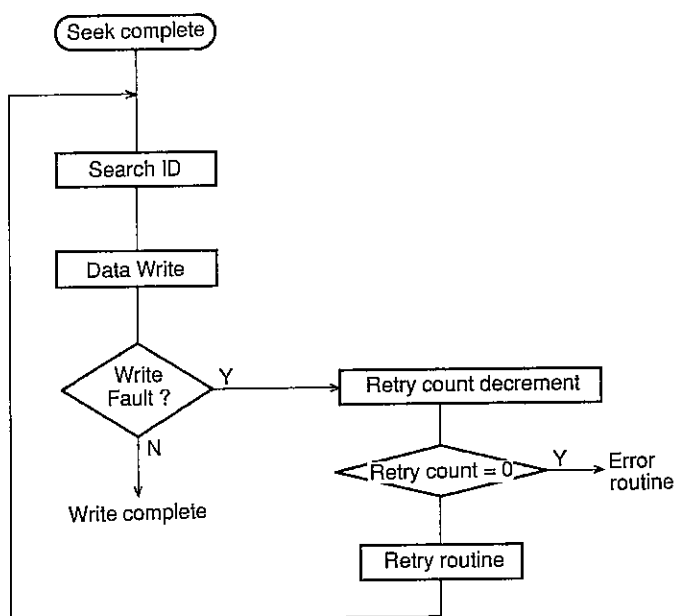
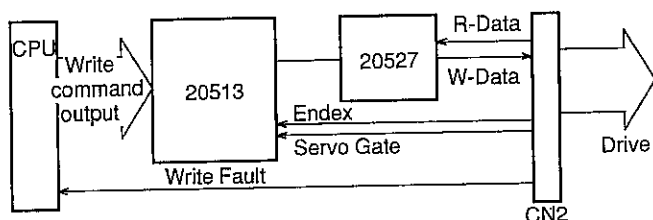
1-7. WRITE operation



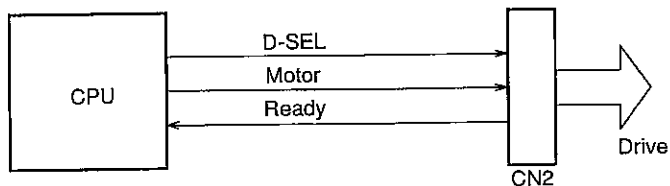
- When the target cylinder and sector are found by READ operation, WRT-GATE become high to write data.
- CLK : Binary data are synchronized with CLK falling edge NRZ-IN to provide 20527 input.
- WRT-GATE : Validates data supplied from NRZ-IN.

1-8. Write retry

With the JD-3848H0S0 40M hard disk, a write fault is asserted immediately after the servo gate signal against vibration and impact received during write. On the other hand, the controller makes a maximum eight retrials against a write fault.



1-9. Motor on/off command



(1) Fig.1 shows the motor on/off sequence.

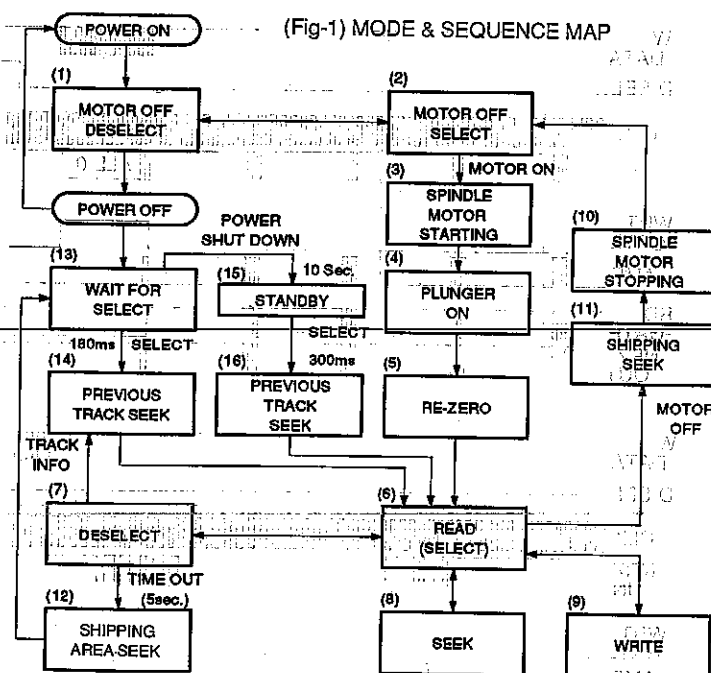
Motor startup timing is discussed next.

- When the motor is at halt, a maximum 10 seconds are required before the drive becomes ready; the time before the motor on command completion status is received after the motor on command was issued.
- If the motor off command was issued continuously along with the motor on command while the motor is running, a maximum 15 seconds are required before the motor on completion status is obtained after the motor on command was issued.

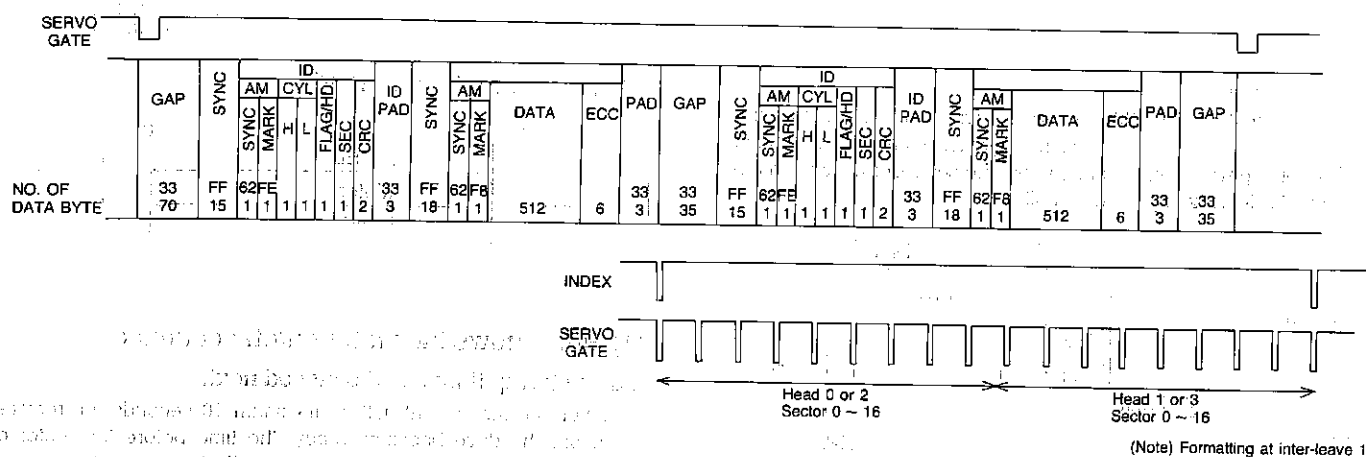
(2) Motor auto-off timer

- The auto-off timer can be programmed from 5 to 2 minutes 15 seconds (01~FF hex) in an increment of 5 seconds. When "00" is given, the timer is set infinitive, that is, the auto-off mode turns invalid.
- When a command that deselects the drive such as read and write is issued, the auto-off times is started to decrement upon the time the deselect is commanded.

(Fig-1) MODE & SEQUENCE MAP



1-10. Formatting chart



2. HARD DISK DRIVE

2-1. Hard disk drive unit specifications

2-1-1. Parts number of the drive

JD3848H00

2-1-2. Disks

Disks 2 (2 spares)
Cylinders 165+1 (spare)
Total tracks 2460+2 (spare)

2-1-3. Head

| | |
|----------|---------|
| Physical | 4 heads |
| Logical | 8 heads |

2-1-4. Maximum storage capacity

| | |
|-------------|--------------|
| Unformatted | 53.26M bytes |
| Formatted | 42.89M bytes |

2-1-5. Recording method

| | |
|---------------------|---------------|
| Method | 2-7 RLL |
| Data transfer speed | 7.5M bits/sec |
| Recording density | 25610 BPI |
| Recording density | 17073 FCPI |
| Track density | 941 TPI |

2-1-6. Spindle motor

| | |
|----------------|--------------|
| Revolutions | 2592.6 rpm |
| Mean wait time | 11.57 msec |
| Startup time | 10 sec. max. |

2-1-7. Format

| | |
|------------------------------------|-----------|
| (Physical sectors/physical tracks) | 17 |
| Formatted sectors/physical tracks | 34 |
| Formatted sector size | 512 bytes |

2-1-8. Access time (average at 25°C, rated voltage including settling time)

18 ms, track to track
45 ms, average
75 ms, full stroke

2-1-9. Operating environments

Operating temperature (small temperature controlled chamber)

0~50°C (55°C maximum at the top plate of the drive), or 65°C maximum subject to test conditions given in separate page.

Non-operating temperature

—20~60°C

Storage condition (packaged)

-20~60°C, within 1,000 hrs

Cycle storage (packaged)

Within 1 hour, 5 cycles at limited temperatures

Temperature slope

15°C/H maximum when operating or 20°C/H maximum when not operating

Operating humidity

20~80%RH (wet ball at 29°C, maximum), without moisture condensation

Non-operating humidity

10~80%RH (wet ball at 29°C, maximum), without moisture condensation

Environmental air

Must be free from corrosive gas and salt.

Noise

40dB maximum during standby (A), slow

50dB maximum during seek (A) slow

NOTE: Measuring direction 1 meter above the drive unit
 Measuring conditions Room temperature, room humidity, rated voltage

2-1-10. Reliability

| | |
|-------------------|-------------------------------------|
| MTBF | 20,000 hrs |
| MTTR | 30 minutes |
| P.M. | None |
| Life | 5 years |
| CSS | 20,000 start/stop |
| Media defects | 27 maximum excluding the cylinder 0 |
| Defect size | 11 bits maximum |
| Error rate | |
| Soft error (NOTE) | 10 ⁻¹⁰ maximum |
| Hard error | 10 ⁻¹² maximum |
| Seek error | 10 ⁻⁶ maximum |

NOTES: (1) Recoverable after 4 retries for a soft error.
 (2) Unrecoverable after 4 retries for a hard error.
 (3) Above retrieval errors are on the same cylinder without including recal.

2-1-11. Shock resistance**Operating**

During write 5G, 10 ms (all axial directions) (half sinusoidal waveform) (without hard error)

During read 5G, 10 MS 10 ms (all axial directions) (half sinusoidal waveform) (without hard error)

Non-operating 70G, 10 ms (all axial directions) (half sinusoidal waveform)

2-1-12. Vibration resistanceOperating 5~10Hz, 1.0mm, full amplitude
10~500Hz, 0.2G, peakNon-operating 5~10Hz, constant deviation, 10.16 mm
(all directions) 10~500Hz, 2.0G, peak

Sweep speed 1 Oct./minute

2-1-13. Altitude

Operating 0~2400 meters

Non-operating 0~7600 meters

2-1-14. Weight

(Shield cover inclusive) 790 grams, typical

2-1-15. Physical dimensions

Attachment-1

2-1-16. DC power (HDD only)

| | Allowable error | Allowable ripple | Consumption current (max.) |
|-------------|-----------------|------------------|----------------------------|
| +12V | ±0.6V | 100mVp-p | 150mA (200mSec.) |
| +5V (MOTOR) | ±0.5V | 200mVp-p | 1,300mA |
| +5V (LOGIC) | ±0.25V | 100mVp-p | 150mA |

* Ripples are sinusoidal waveform of 20Hz to 120Hz and white noise of 10Hz to 1MHz.

* Ripple is included in the allowable error.

2-1-17. Power consumption (25°C ±2°C, rated voltage)

| | | (Maximum) |
|----------------------|---------|-------------------|
| Motor on: | Read | 2.5W |
| | Wrote | 2.8W |
| | Seek | 5.1W (7.7W, peak) |
| | Waiting | 1.9W |
| | Standby | 1.2W |
| Motor starting | | 7.9W Peak |
| (5 seconds, maximum) | | |

1-18. Format**(1) Physical format**

Cylinders 0 to 614 are physically formatted.

For the hard sectors, hard track format is done for each physical head.

(Cylinder 0 is not included)

(2) Sector interleave 1 (See attached drawing, Sector interleave)

NOTES: • The format is done according to JD-C3848H0S0 controller board.
 • The cylinder 615 (spare cylinder) is for use of the vendor only.
 • Cylinders 0, 1, 2, and 3 are for defect free cylinders.

2-1-19. Connector specification

The following connector or its equivalent will be used.

Drive side" D50226-B002JL (Sumitomo 3M), black

Compatible connector: 50126-B000EL (Sumitomo 3M), strain relief, 3448-50126

2-1-20. Hard disk drive interface specification

| PIN | I/O | SIGNAL | PIN | I/O | SIGNAL |
|-----|-----|--------------|-----|-----|---------------|
| 1 | | GND | 2 | O | R. DATA |
| 3 | | GND | 4 | I | W. DATA |
| 5 | | GND | 6 | I | HEAD SELECT 1 |
| 7 | I | POWER SAVE | 8 | O | (SHIP READY) |
| 9 | | GND | 10 | I | READ/WRITE |
| 11 | I | MOTOR ON | 12 | I | HEAD SELECT 0 |
| 13 | I | DIRECTION IN | 14 | I | STEP |
| 15 | O | WRITE FAULT | 16 | O | SEEK COMPLETE |
| 17 | O | SERVO GATE | 18 | O | INDEX |
| 19 | O | TRACK 000 | 20 | O | READY |
| 21 | | GND (LOGIC) | 22 | | +5V (LOGIC) |
| 23 | | GND (MOTOR) | 24 | | +5V (MOTOR) |
| 25 | | GND | 26 | | +12V |

NOTE-1: See the list below for the logic of pin 6 head select 1 and pin 12 head select 0.

| | HEAD SELECT 0 | HEAD SELECT 1 |
|--------|---------------|---------------|
| HEAD 0 | "H" | "H" |
| HEAD 1 | "L" | "H" |
| HEAD 2 | "H" | "L" |
| HEAD 3 | "L" | "L" |

NOTE-2: The pin-6 is not connected because it is used for the factory only.

NOTE-3: Output on the pin-8 goes low when the head moved over the shipping position, which can drive the red LED. Becomes valid when READY become low.

NOTE-4: I/O except for the pin-8 are 74HC compatible (2K pullup attached for input)

2-1-21. Drive margin

± 9 nsec. or above

Measuring condition: 50°C without moisture within a small temperature controlled chamber, rated voltage.

Has random pattern and write compensation.

2-1-21. Installing direction

The hard drive should normally be installed horizontal (label facing up) or transverse (label and connector facing side). Need discussion if to be installed with tilt.

Never install it with the connector facing up or down.

HDD temperature and moisture assurance test conditions

(1) Temperature and moisture assurance limits

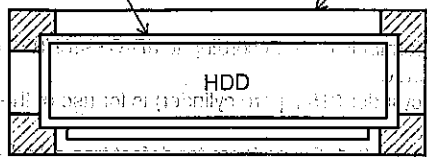
1-1 Operation 0°C~65°C (10%~80%RH, non-condensing)

(2) According to the temperature test conditions.

Temperature test point (top plate)

Shield housing

Cushion

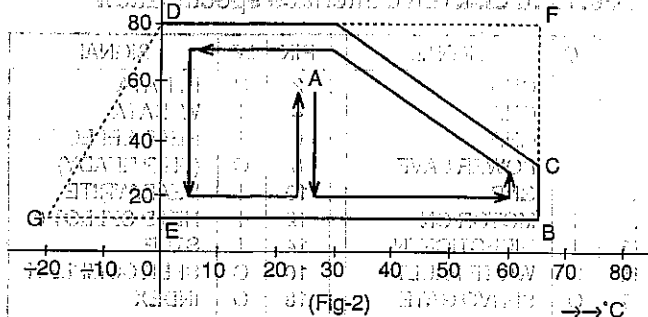


(Fig-1)

(2) Humidity test condition

2-1

RH (%)



(Fig-2)

Solid line: assured operation range.

2-2 Temperature change

1) Operation: 15°C/H, maximum

2) Storage: 20°C, maximum

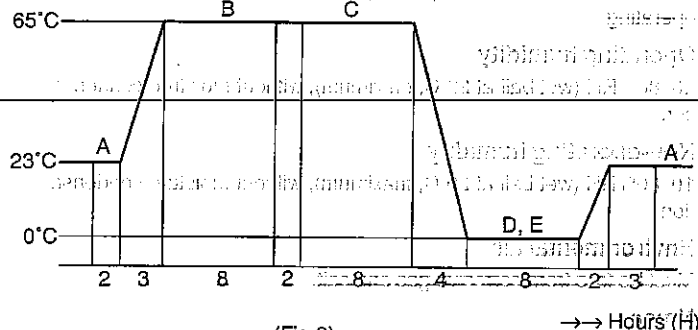
3) Maximum wet ball humidity: 29°C

(3) Operating test method

3-1 Humidity can be any under 0°C.

3-2 The test will take place in the order of temperature change, starting from the room temperature of 23°C (arrowhead)

3-3 Cyclic temperature and humidity operating test (temperature at the top plate as shown in Fig.1)



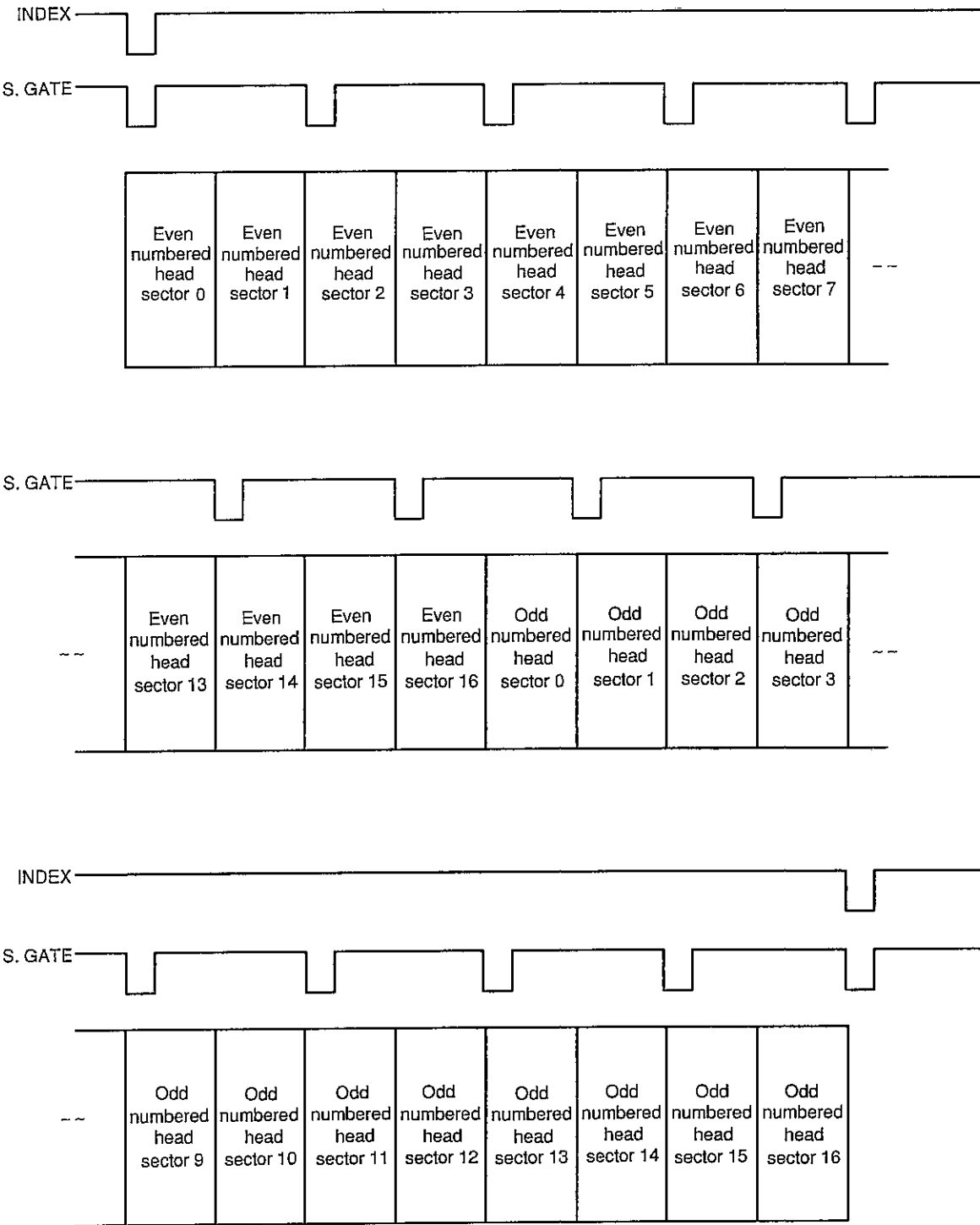
(Fig-3)

3-4 The above temperature/humidity test comprises a cycle.

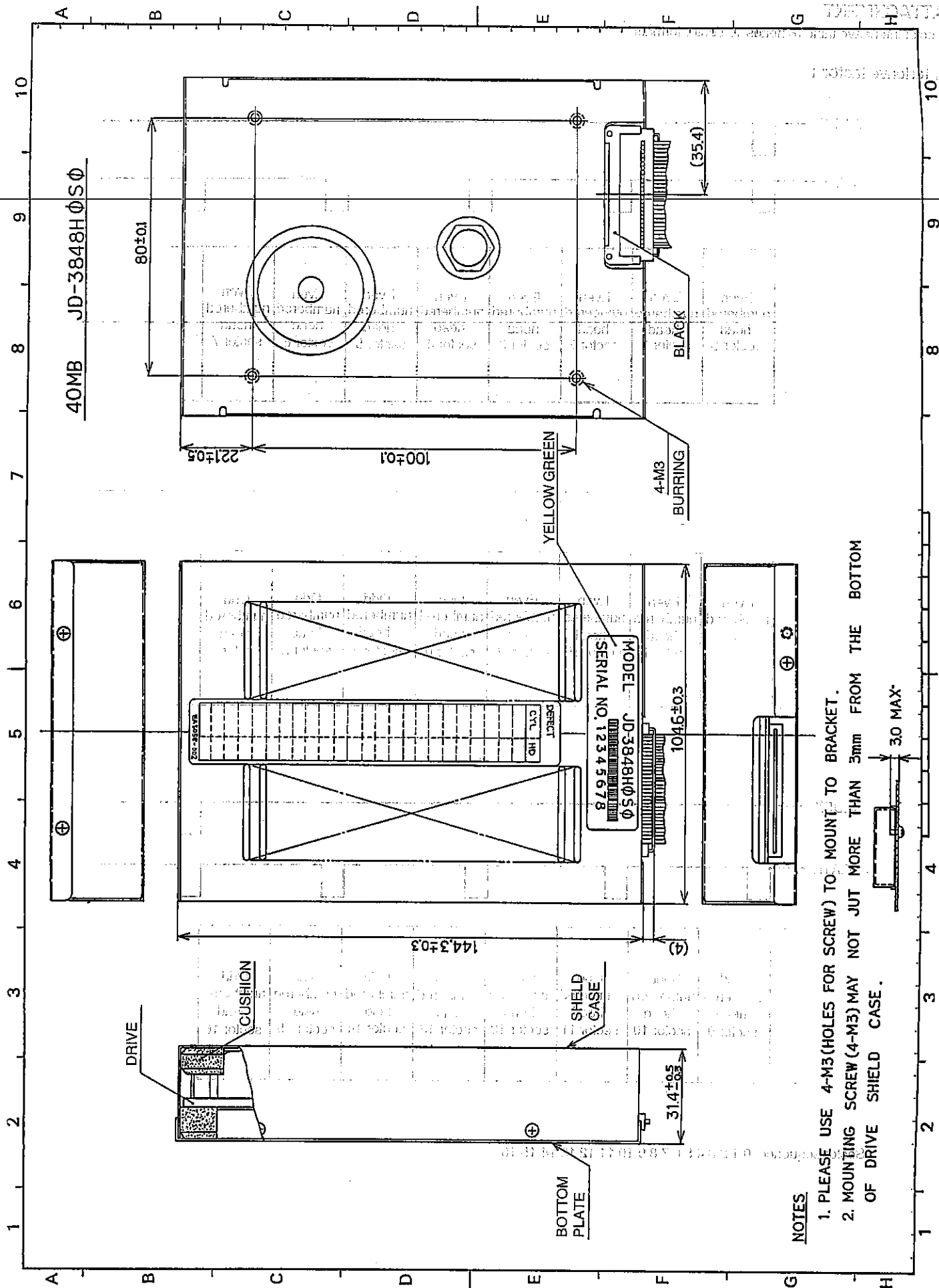
ATTACHMENT

Sector interleave table (8 heads/17 sector formats)

Interleave factor 1



Sector sequence: 0 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16



CHAPTER 6. POWER SUPPLY CIRCUIT

6-1. Block diagram

Fig. 6-1 shows the block diagram.

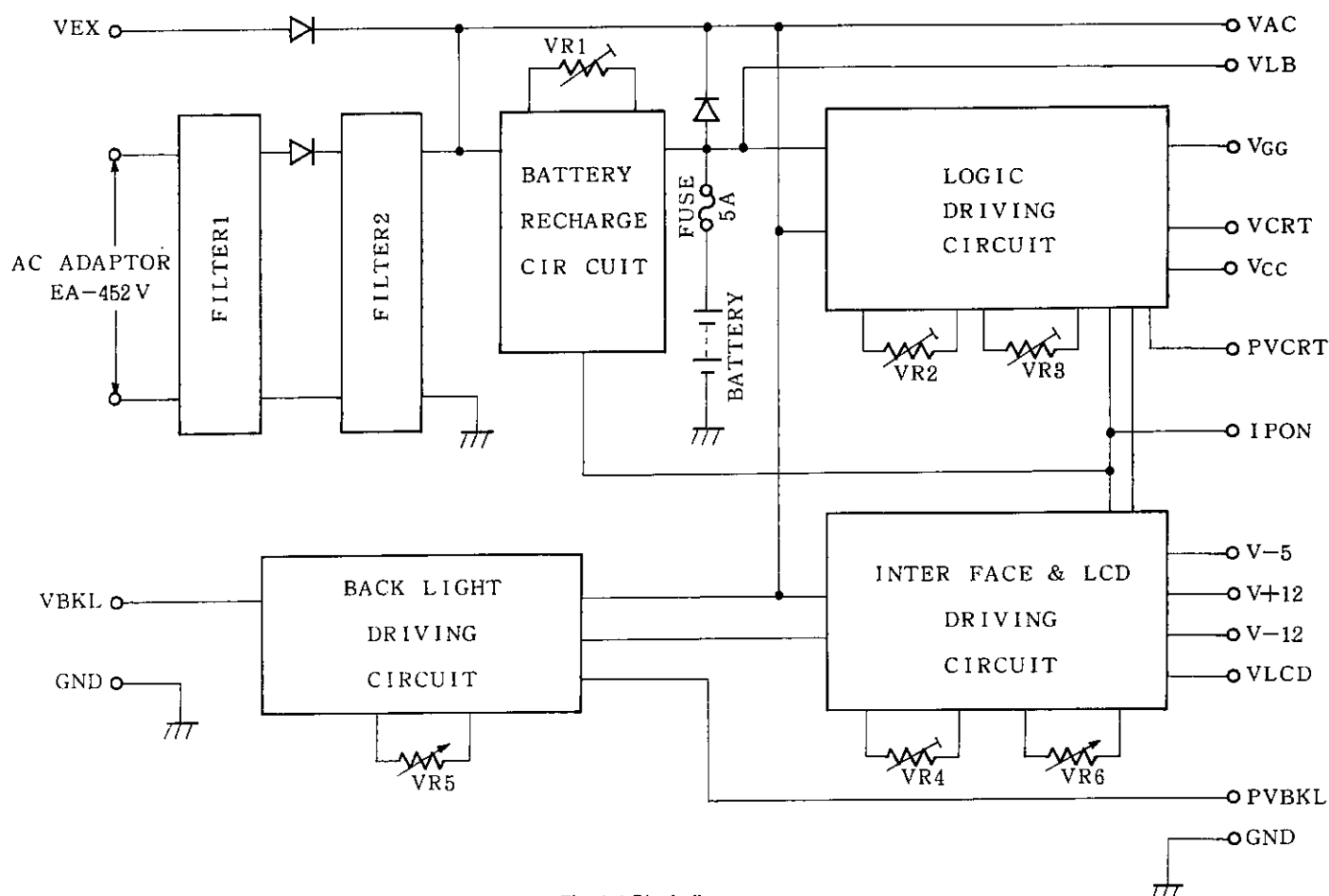


Fig. 6-1 Block diagram

6-2. Electric characteristics

(1) Input voltage

This power supply unit could be operated by using one of the following input voltage and the combination of them.

- | | |
|---------------------------------|-----------------|
| a. AC adaptor (CE-452V) | 9.0V±0.5V 2.5A |
| b. Lead battery (UBATZ1003ACZZ) | 5.0V–6.5V 4.2Ah |
| c. External input | 9.0V±0.5V 2.5A |

(2) Non-load current

Table 6-2 shows the input current from the battery connector when all outputs are non-load with 6.3V input from battery connector without using AC adaptor.

| IPON | CURRENT |
|------|-----------------|
| Low | less than 500μA |
| High | less than 200mA |

Table 6-1

(3) Monitoring output

The power supply unit outputs the following 2 monitoring outputs.

a. VLB

The VLB tells the battery voltage to the system.

The output connect the battery terminal through the diode equal of RK13.

b. VAC

The VAC tells whether the AC adaptor is connected or not.

The output should be more than 6.5V while the AC adaptor is connected.

(4) Battery voltage detection

When VLB voltage is changed according to the value in table 6-2 without connecting AC adaptor, the VGG output voltage satisfies the value in the table 2.

(IPON is set to low. VGG load is adjusted to 1mA.)

| VLB voltage (V) | VGG voltage (V) |
|-----------------|-----------------|
| from 0 to 4.0 | less than 0.3 |
| from 0 to 5.1 | 4.75 – 5.25 |
| from 6.0 to 4.8 | 4.75 – 5.25 |
| from 6.0 to 4.0 | less than 0.3 |

Table 6-2

(5) Output voltage

The power supply unit could supply the following outputs by either the inputs of AC adaptor, battery, or external input.

The converting efficiency should be more than 70% when using the battery as the input.

a. VGG (+5V±0.25V)

The VGG output is always supplied to the logic ICs on the Main PCB.

b. VCC (+5V±0.25V)

The VCC output is supplied to the logic ICs on the Main PCB, LCD unit, FDD unit, and HDD unit while the control signal IPON is high.

c. V+12 (+12V±0.6V)

The V+12 output is supplied to the ICs, the HDD unit and fan while the IPON is high.

d. V-12 (-12V±1.0V)

The V-12 output is supplied to the ICs while the IPON is high.

e. V-5 (-5V±0.25V)

The V-5 output is supplied to the optional MODEM unit while the IPON is high.

f. VLCD (-11.5V ~ -20.7V)

The VLCD output is supplied to the LCD unit while the IPON is high. The output could be changed by the volume to adjust the contrast of the LCD.

The output shouldn't be beyond -26.0V.

g. VCRT (+5V±0.25V)

The VCRT output is supplied to the optional CRT adaptor while the control signals IPON and PVCRT are high.

h. VBKL (AC 35V ~ 100V)

The VBKL output is supplied to the EL panel while the control signals IPON and PVBKL are high.

The output could be changed by the volume to adjust the brightness of the backlight.

The maximum brightness of the EL panel should be 80nt.

The frequency of this output should be from 700Hz to 800Hz.

The following table is output characteristics of all outputs.

| OUTPUT | CONDITION | VOLTAGE (V) | CURRENT (mA) | RIPPLE (mVp-p) |
|--------|-----------------------------|---------------------------|--------------|----------------|
| VGG | | 5.0±0.25 | 0.1~15 | less than 100 |
| VCC | IPON = High IPON = Low | 5.0±0.25 less than 0.3 | 300 ~ 2800 | less than 100 |
| V+12 | IPON = High IPON = Low | 12.0±0.6 0±0.3 | 0 ~ 200 | less than 150 |
| V-12 | IPON = High IPON = Low | -12.0±1.0 0±0.3 | 0 ~ -20 | less than 150 |
| V-5 | IPON = High IPON = Low | -5.0±0.25 0±0.3 | 0 ~ -20 | less than 100 |
| VCRT | PVCRT = High PVCRT = Low | 5.0±0.25 less than 0.3 | 0 ~ 120 | less than 100 |
| VLCD | IPON = High IPON = Low | -20.7 ~ -11.5 0±0.3 | -10 ~ -25 | less than 200 |
| VBKL | PVBKL = High PVBKL = Low | AC 35 ~ 100 0 | | |

Table 6-3

- NOTES
- 1) The control signals are from the CMOS IC powered by VGG, and the range of high is 4.0 to 5.25V, low is less than 0.5V.
 - 2) PVCRT = High, PVBKL = High means IPON = High too.
 - 3) The currents of the VCC is the peak current. It is continuously supplied less than 1.6A.

(6) Input current of IPON, PVCRT, PVBKL

When IPON, PVCRT, PVBKL is high level (+4.0V) at on mode, the input current of them satisfy the Table 6-4.

| | Input current |
|-------|---------------|
| IPON | less than 1mA |
| PVCRT | less than 1mA |
| PVBKL | less than 1mA |

Table 6-4

6-3. Battery recharge circuit

When the AC adapter or Vex is supplied, if IPON is at low (the set is OFF), the charging characteristic of the battery is as shown in Fig. 6-2. To check the operation, provide a dummy resistor to the battery connector and check points A ~ D in Fig. 6-2 and Table 6-5.

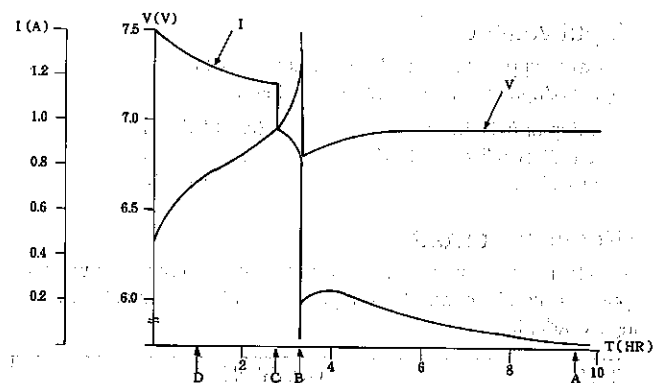


Fig. 6-2 Recharge characteristic

Table 6-5 Recharge circuit test point

| Point | Voltage | Current | Remarks |
|-------|------------|----------|--|
| A | 6.85±0.05V | 10mA | IPON at low, control with VR1. |
| B | 7.5±0.2V | 0.8~1.0A | Voltage/current are changed around this point. |
| C | 6.85±0.1V | 1~1.3A | Current reduces around this point. |
| D | 6.5±0.2V | 1.1~1.4A | Current is constant though voltage is varied. |

Time required for charging the battery is about 8 hours when the set is OFF (IPON is at low), and 20 to 30 hours when the set is ON (IPON is at high).

CHAPTER 7. APPENDICES

7-1. μ PD70208G Main CPU (V-40)

1. Features

1-1. High-performance 8-bit CPU

- 1M-byte memory space and 64K-byte I/O space
- Abundant memory addressing modes
- Fourteen 16-bit register sets
- Instruction set with 101 types of powerful instructions
- Bit field manipulation instructions
- Packed BDC arithmetic operation instructions
- Memory-memory high-speed block transfer instructions
- High-speed multiplication and division instructions by exclusive hardware
- High-speed effective address calculation by exclusive hardware
- A wealth of interrupt process functions
- μ PD8080AF emulation mode
- Standby mode

1-2. Internal clock generator

1-3. Programmable wait function

1-4. Dynamic RAM refresh function

1-5. Timer/counter unit

- Three 16-bit counters
- Six programmable count modes
- binary/BCD count
- Multiple-latch commands

1-6. Serial control unit

- Asynchronous serial communication
- Clock rate: Baud rate $\times 16$, $\times 64$
- Baud rate: DC to 48.4k bits/sec.
- Character length: 7/8 bits
- Transfer stop bit: 1/2 bits

1-10. IEEE-796 bus compatible interface

1-11. CMOS

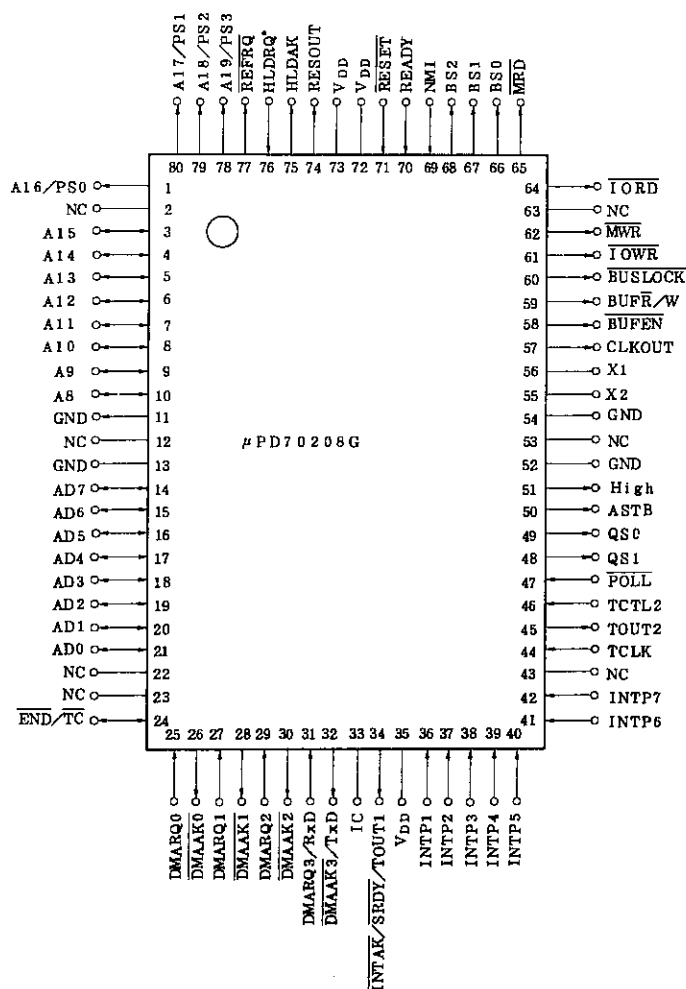
1-12. Low power consumption

1-13. Single power supply

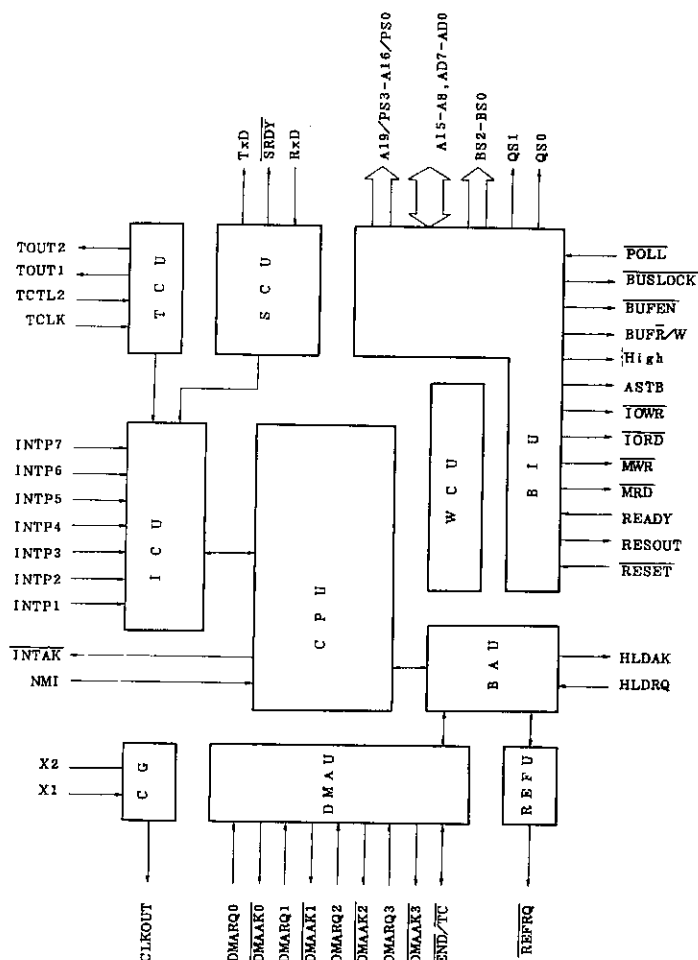
1-14. 10-MHz clock

2. μ PD70208G Pin Configurations

- 80-pin Plastic Flat Package (Top View)



3. μ PD70208G Block Diagram



NOTE: For μ PD70208G, pins 3 to 10 are output only.

4. Pin Function

4-1. AD7 to AD0 (address/data bus) ... 3-state input/output

These pins constitute a multiplexed address/data bus that outputs the lower 8 bits of 20-bit address information and inputs/outputs 8-bit data on a time-division basis. These pins function as the address bus during T1 state of the bus cycle, and as the data bus during T2, T3, TW, and T4 states.

These pins become high impedance during hold acknowledge.

4-2. A15 to A8 (address bus) ... 3-state output

These pins output the middle 8 bits of 20-bit address information. These pins become high impedance during hold acknowledge.

4-3. A19/PS3 to A16/PS0 (address bus/processor status) ... 3-state output

These are time-multiplexed output pins that output addresses and processor status signals.

These pins function as an address bus during T1 state of the bus cycle. They output processor status signals during T2, T3, TW, and T4 states.

When functioning as an address bus, these pins output the higher 4 bits of address information. All these pins output 0 during I/O access. The processor status signal is output during both the memory and I/O accesses. The PS3 pin outputs 0 in native mode and when the cycle is neither DMA nor refresh; otherwise, it outputs 1. The PS2 pin outputs the content of the interrupt enable flag (IE). The PS1 and PS0 pins indicate which segment is used by the current bus cycle.

Processor Status

| A17/PS1 | A16/PS0 | Segment |
|---------|---------|----------------------|
| 0 | 0 | Data segment 1 (DS1) |
| 0 | 1 | Stack segment (SS) |
| 1 | 0 | Program segment (PS) |
| 1 | 1 | Data segment 0 (DS0) |

These pins become high impedance during hold acknowledge.

4-4. REFRQ (refresh request) ... Output

This is an output pin that outputs an active-low signal during T2, T3 and TW states of the refresh cycle.

4-5. HLDRQ (hold request) ... Input

This pin inputs a high-level signal when an external device requests that the address bus, address/data bus, and control bus be released. The priority of this signal is as follows: REFU (highest priority) > DMAU > HLDRQ > CPU > REFU (lowest priority).

4-6. HLDK (hold acknowledge) ... Output

This signal indicates that the μ PD70208/70216 has acknowledged the hold request signal (HLDRQ) and set the buses to the high-impedance state. When this signal is at the high level, therefore, the address bus, address/data bus, and control bus of 3-state output system become high-impedance state.

If a refresh request or DMA request with higher priority than the HLDK signal occurs during hold acknowledge, HLDK becomes inactive. Then the μ PD70208G requests that the bus control be returned to it provided that the HLDRQ signal becomes inactive at the same time.

4-7. RESET (reset) ... Input

This is an active-low reset input pin and takes the precedence over all the other operations. The reset operation affects not only the CPU but also the on-chip peripherals. After the reset input is released, the CPU starts executing the program from address FFFF0H. The RESET input is also used to release the standby mode of the CPU.

4-8. RESOUT (reset output) ... Output

This pin synchronizes the asynchronous signal input to the RESET pin with the internal clock and then outputs it as an active-high signal. This signal can also be used as a system reset signal.

4-9. READY (ready) ... Input

The basic bus cycle of the μ PD70208G requires four clocks. However, when the READY signal goes low (inactive) a wait state (TW) is inserted between T3 and T4 states and thus the bus cycle is extended. This function is used for memory or I/O whose access time is slow.

This signal is internally synchronized with the clock and supplied to each block. Then it is checked during T3 and TW states. Other than by this signal, TW state can be also inserted by programmable wait function.

4-10. NMI (nonmaskable interrupt) ... Input

This pin inputs an interrupt request signal that cannot be masked by software.

This input signal is rising-edge triggered and is sampled in each clock cycle. When the current instruction has been executed, an interrupt assigned with No.2 vector is generated.

This interrupt is also used to release the standby mode of the CPU.

4-11. MRD (memory read) ... 3-state output

This signal becomes active (low level) when data is read from the memory. This signal also becomes active when the memory is refreshed by the on-chip refresh control unit or when data are transferred from the memory to I/O by the on-chip DMA control unit.

The MRD signal becomes active during T2, T3, and TW states of the bus cycle.

This pin becomes high impedance during hold acknowledge.

4-12. MWR (memory write) ... 3-state output

This signal becomes active (low level) when data are written to the memory. This signal also becomes active when data are transferred from the I/O to memory by the on-chip DMA control unit. When data are processed by the CPU, the MWR signal becomes active during T2, T3, and TW states. However, when data are processed by the DMA unit, the MWR signal becomes active during T3 and TW states. This pin becomes high impedance during hold acknowledge.

4-13. IORD (I/O read) ... 3-state output

This signal becomes active (low level) when data are read from the I/O. However, if the I/O to be accessed is on the chip, it will not become active. The IORD signal also becomes active when data are transferred from the I/O to the memory by the on-chip DMA control unit. This signal becomes active during T2, T3 and TW states of the bus cycle.

This pin becomes high impedance during hold acknowledge.

4-14. IOWR (I/O write) ... 3-state output

This signal becomes active (low level) when data are written to the I/O. However, if the I/O to be accessed is on the chip, it will not become active. The IOWR signal also becomes active when data are transferred from the memory to I/O by the on-chip DMA control unit.

This signal becomes active during T2, T3, and TW states when data are processed by the CPU. However, when data are processed by the DMAU, the IOWR signal becomes active during T3 and TW states for normal write timing; T2, T3, and TW states for extended write timing.

This pin becomes high impedance during hold acknowledge.

4-15. ASTB (address strobe) ... Output

This signal is an active-high strobe signal that externally latches address information. This signal becomes active while the clock (CLKOUT) in T1 state of the bus cycle is at low level.

This pin outputs low-level signal during hold acknowledge.

4-16. $\overline{\text{BUSLOCK}}$ (bus lock) ... 3-state output

This signal is used to request the other master CPUs in the multi-processor system not to use the system bus while the instruction following the $\overline{\text{BUSLOCK}}$ prefix is being executed or during interrupt acknowledge cycles.

During bus lock (i.e. $\overline{\text{BUSLOCK}}$ is active), hold request and DMA request are ignored, while refresh request is hold off.

This pin becomes high impedance during hold acknowledge.

4-17. $\overline{\text{POLL}}$ (poll) ... Input

The signal input to the $\overline{\text{POLL}}$ pin is checked by the $\overline{\text{POLL}}$ instruction. If the signal is at the low level, the program execution proceeds to the next instruction. If the $\overline{\text{POLL}}$ pin is at the high level, it is checked every five clocks until the $\overline{\text{POLL}}$ input goes low. These functions are used to synchronize the CPU program with the operations of external devices.

4-18. $\overline{\text{BUFR/W}}$ (buffer read/write) ... 3-state output

This signal is output to determine the data transfer direction of an external bidirectional data buffer. If it is high level, data are output from the $\mu\text{PD70208G}$ to the external device. If the signal is low level, data are input from the external device to the $\mu\text{PD70208G}$.

This pin becomes high impedance during hold acknowledge.

4-19. $\overline{\text{BUFEN}}$ (buffer enable) ... 3-state output

This signal is active low signal and is used as an output enable signal for the external bidirectional data buffer.

During T2 through T4 states of the read cycle and interrupt acknowledge cycle, it becomes active (low level). This signal also becomes active during T1 through T4 states of the write cycle.

However, the $\overline{\text{BUFEN}}$ pin will not become active when the internal I/O on the chip is accessed.

This pin becomes high impedance during hold acknowledge.

4-20. X2 and X1 (clock) ... Input

To use the internal clock generator, a crystal must be connected across the X2 and X1 pins. The oscillation frequency of the crystal to be connected should be 2 times the operating frequency.

If an external clock generator is to be used, the square wave of 2 times the operating frequency must be input to the X1 pin and the inverted signal of the X1 to the X2 pin.

4-21. CLKOUT (clock out) ... Output

This pin outputs the square wave clock that has one half the frequency of crystal frequency or X1 input frequency.

4-22. BS2 to BS0 (bus status) ... 3-state output

These pins output status signals that inform the external bus controller of the current bus cycle.

These signals become active during T1 and T2 states and are encoded as indicated in the table below. By decoding these encoded signals, the external bus controller can generate control signals by which to access the memory or I/O.

Only when CPU enters halt state, BS2 to BS0 indicates the CPU passive state one clock earlier than normal states.

| BS2 | BS1 | BS0 | Bus cycle |
|-----|-----|-----|------------------------------------|
| 0 | 0 | 0 | Interrupt acknowledge |
| 0 | 0 | 1 | I/O read |
| 0 | 1 | 0 | I/O write |
| 0 | 1 | 1 | Halt |
| 1 | 0 | 0 | Program prefetch |
| 1 | 0 | 1 | Memory read* |
| 1 | 1 | 0 | Memory write (including DMA cycle) |
| 1 | 1 | 1 | CPU passive state |

* In addition to the CPU read cycle, the "memory read cycle" includes the DMA cycle, DMA verify, and refresh cycle.

These pins become high impedance during hold acknowledge.

4-23. QS1 to QS0 (queue status) ... Output

These signals inform an external device (floating-point operation chip) of the CPU's internal instruction queue status.

The "queue status" means a status in which the execution unit (EXU) in the CPU accesses an instruction queue. The contents output to the QS1 and QS0 pins are valid only during one clock cycle immediately after the EXU has accessed the instruction queue.

| QS1 | QS0 | Instruction queue status |
|-----|-----|--|
| 0 | 0 | No operation (no changing queue) |
| 0 | 1 | The first byte of an instruction is fetched. |
| 1 | 0 | The queue is empty. |
| 1 | 1 | The second or latter byte of the instruction is fetched. |

The status signals are provided so that the floating-point operation chip can monitor the program execution status of the CPU and performs processing in synchronization with the CPU when the control is given to the chip by the FPO (floating point operation) instruction.

4-24. TOUT2 (timer output) ... Output

This is the output pin of the internal timer/counter unit (TCU). Of the three counters of the TCU, the result of the TCT#2 is output to this pin.

4-25. TCTL2 (timer control) ... Input

This is the control input pin of the internal timer/counter unit (TCU). Of the three counters, the TCT#2 is controlled by this input.

4-26. TCLK (timer clock) ... Input

This is the clock input pin of the internal timer/counter unit. However, the clock actually input to each counter is selected by software from either the clock input to this pin or the operating clock of the $\mu\text{PD70208G}$ on which frequency division has been performed.

4-27. INTP7 to INTP1 (interrupt request from peripheral) ... Input

These seven pins input asynchronous interrupt requests to the internal interrupt control unit (ICU). Either edge-triggering (at the rising edge) or level-triggering (high level) of these input signals can be selected. These interrupt request inputs can be also used to release the standby mode of the CPU.

These pins have internal pull-up resistors.

4-28. $\overline{\text{INTAK}}/\overline{\text{SRDY}}/\text{TOUT1}$ (interrupt acknowledge/serial ready/timer output) ... Output

This is a shared output pin for interrupt acknowledge signal, serial ready signal, and timer output (TCT#1). The interrupt acknowledge signal $\overline{\text{INTAK}}$ becomes active (low level) during T2, T3, and TW states of the interrupt acknowledge cycle of the CPU. The $\overline{\text{SRDY}}$ signal is output from the internal serial control unit (SCU) and becomes active (low level) when the receiver is enabled to receive data.

The TOUT1 signal is output from the internal timer/counter unit (TCU). Of the three counters, a result of the TCT#1 is output to this pin. The functions of this pin is selected by controlling the OPCN (on-chip peripheral connection) register in the $\mu\text{PD70208G}$ by software.

4-29. $\overline{\text{DMAAK3}}/\text{TxD}$ (DMA acknowledge/transmit data) ... Output

This is a shared pin and outputs the acknowledge signal for channel 3 of the DMA unit and serial data from the serial control unit (SCU).

The $\overline{\text{DMAAK3}}$ signal is active-low.

When this pin functions as the TxD pin, it becomes high level (marking) if there is no transmit data. When transmit data is set, the start bit (low level) is automatically output and then the set data is serially output. A parity bit and a stop bit (high level) are appended to the end of the each data. Whether to append the parity bit can be specified by program.

The μ PD70208G's internal OPCN (on-chip peripheral connection) register controls the function of this pin (refer to 12.1.1 System I/O Area).

4-30. DMARQ3/RxD (DMA request/receive data) ... Input

This is a shared pin that inputs the request signal for channel 3 of the DMA unit and the serial data of the SCU.

The DMARQ3 signal is active-high.

When this pin functions as the RxD pin, a high-level (marking) signal is input to it when no data is transmitted. The RxD pin starts receiving data at the falling edge of the start bit.

The three pins described in Sections 4-28 through 4-30 can be specified in the following four ways by controlling register OPCN (on-chip peripheral connection) of the μ PD70208G by software.

| Pin election | DMAAK3/TxD | DMARQ3/RxD | INTAK/SRDY/TOUT1 |
|--------------|------------|------------|------------------|
| 1 | DMAAK3 | DMARQ3 | INTAK |
| 2 | DMAAK3 | DMARQ3 | TOUT1 |
| 3 | TxD | RxD | INTAK |
| 4 | TxD | RxD | SRDY |

4-31. DMAAK2 to DMAAK0 (DMA acknowledge) ... Output

These pins output the DMA acknowledge signals from channels 2 through 1 of the DMA unit.

These signals are active-low.

4-32. DMARQ2 to DMARQ0 (DMA request) ... Input

These pins input the DMA request signals to channels 2 through 0 of the DMA unit.

These signals are active-high.

4-33. END/TC (end/terminal count) ... Input/output

This active-low pin controls termination of data transfer by DMA when the data transfer is performed by the DMA unit. When a low-level pulse (END) is input to this pin during the DMA transfer, the DMA unit will terminate the ongoing DMA servicing. Also, when the number of DMA transfers specified for each channel is complete, this pin outputs a low-level pulse (TC).

Because this pin is an open-drain, a pull-up resistor must be externally connected.

4-34. VDD (power supply)

This is a positive power supply pin.

4-35. GND (ground)

This is a ground pin (0V).

4-36. IC (internally connected)

Don't connect any signal with this pin and must be left open.

5. Functional Blocks

5-1. CPU (central processing unit)

The CPU consists of two independent processing units: BCU (bus control unit) and EXU (execution unit). Each of these two units performs the following function.

BCU Prefetches instructions using instruction queues (the instruction queue is 4-byte for the μ PD70208G).

EXU Processes data (executes microprograms).

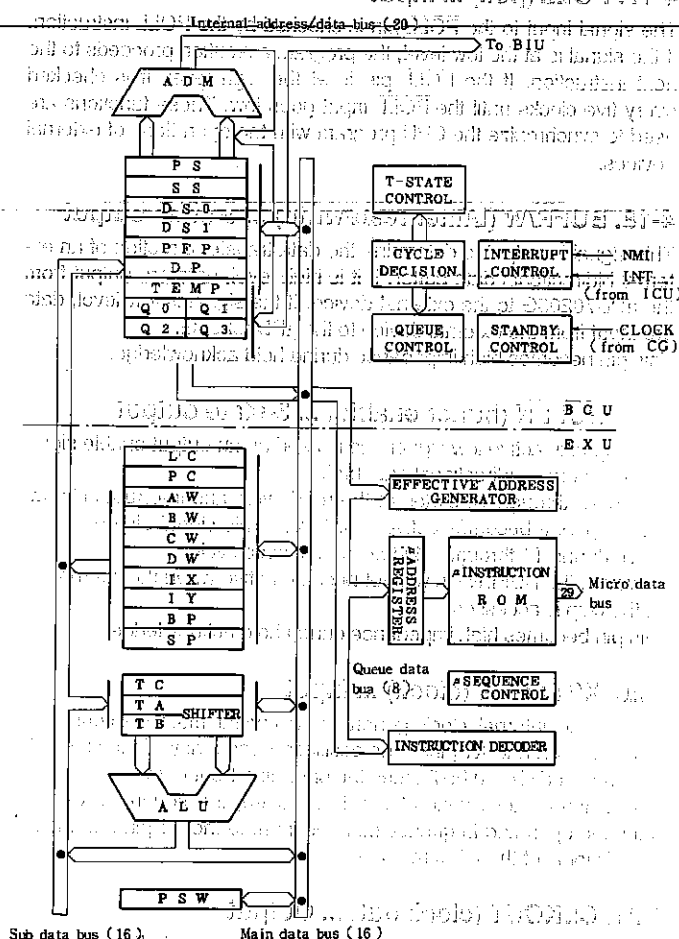


Fig. 5-1 μ PD70208G CPU block diagram

5-2. BIU (bus interface unit)

The BIU controls the pins constituting the data bus, address bus, and control bus. These buses are used by three functional blocks: the CPU, DMAU (DMA control unit), and REFU (refresh control unit). The BIU synchronizes the RESET and READY inputs using the clock signal generated by the clock generator. The synchronized reset signal is active-high that is used in the μ PD70208G as well as supplied to an external device via the RESOUT pin. The synchronized READY signal is supplied to the internal CPU, DMAU, and REFU.

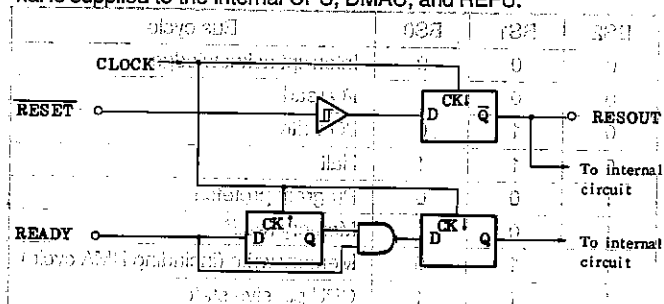


Fig. 5-2 Synchronization of RESET and READY

5-3. BAU (bus arbitration unit)

The BAU performs the bus control arbitration. The bus control priority is as follows:

REFU (highest priority) > DMAU > HLDQ > CPU > REFU (lowest priority)

The REFU can take either the highest or lowest priority depending on the pending status of the refresh request. Even when a bus is used by a bus master, if another bus master with the higher priority requests the bus control, the BAU requests the current bus master to return the bus control by inactivating the acknowledge signal (i.e., bus acknowledge signal to the CPU, DMAU, or REFU, or the HLDQ signal to an external device). When the bus request signal (i.e., bus request signal from the CPU, DMAU, or REFU, or the HLDQ signal from an external device) becomes inactive in response to this bus relinquish request, the BAU gives the bus control to the bus master with the higher priority.

When the bus control is sent between the internal bus masters, bus control request, acknowledge, relinquish request, and relinquish are efficiently performed.

5-4. CG (clock generator)

The CG generates clock signal one half the frequency of the crystal connected across the X1 and X2 pins and provides the clock to the CLKOUT pin and each functional block of the $\mu 70208G$. The duty cycle of the generated clock signal is 50%.

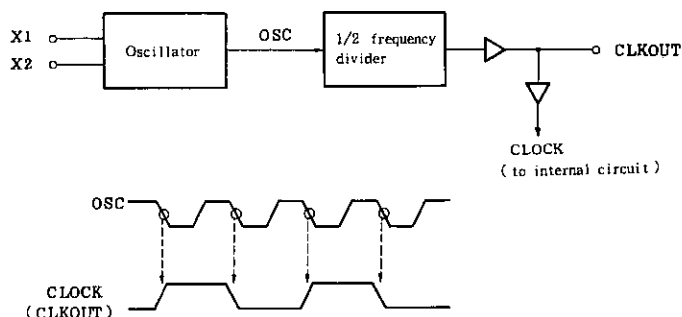


Fig. 5-3 Clock generator

5-5. REFU (refresh control unit)

The REFU generates refresh addresses and refresh request signals. By using these, the memory, if it is a dynamic RAM, can be refreshed.

5-6. WCU (programmable wait control unit)

The WCU has a function to insert up to three clocks of wait states TW to compensate for the process speeds of low-speed memories or I/O's. The number of clocks per wait state TW can be independently specified for CPU access, DMA access, and refresh access. Especially, when accessing the CPU, the memory space can be divided into three areas. These three areas and I/O can be independently specified.

5-7. TCU (timer/counter unit)

The TCU is a timer/counter unit. Three independent counters are provided in the TCU. The output signal of one of the counters is supplied to internal blocks whereas that of another one is supplied to external devices. The output of the last counter can be supplied to both internal and external devices.

5-8. SCU (serial control unit)

The SCU performs asynchronous serial communication.

5-9. ICU (interrupt control unit)

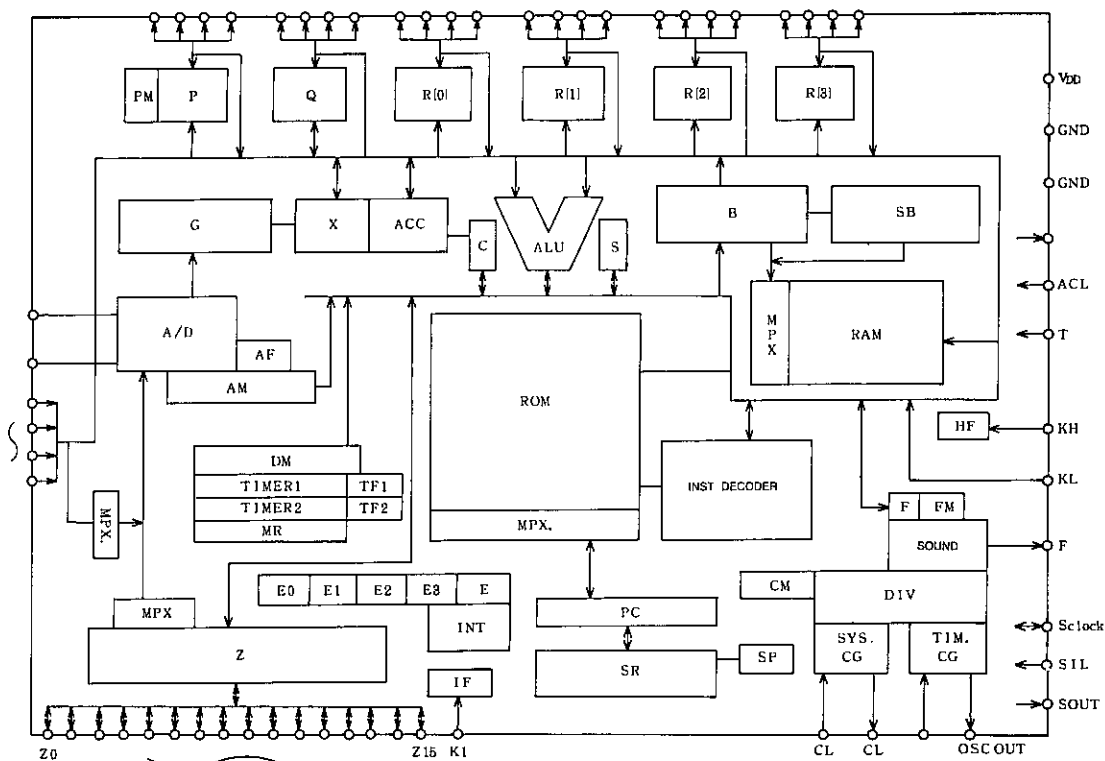
The ICU is an interrupt control unit, and arbitrates eight interrupt requests, generates an interrupt request that is to be sent to the CPU, and sends the interrupt vector number to the CPU. One of the eight interrupt request lines is not externally connected but it is connected to an output of the internal timer/counter.

5-10. DMAU (DMA control unit)

The DMAU is a DMA control unit and controls data transfer performed by using DMA (Direct Memory Access) between the memory and I/O.

7-2. LU57844P SUB CPU (SCM)

1) Block diagram



2) Sub CPU (SCM) pin description

| Signal name | Pin | In/Out | Function |
|-------------|------|------------|----------------------------------|
| IPC0 | P0 | In/Out | Bi-directions: Host I/F port |
| IPC1 | P1 | In/Out | |
| IPC2 | P2 | In/Out | |
| IPC3 | P3 | In/Out | |
| PVCRT | Q00 | Out | CRT Power switch |
| PVMDM | Q01 | Out | Not used |
| PON (PVCC) | Q02 | Out | VCC Power switch |
| KSTRA | R00 | In | Key strobe line |
| KSEN0 | R01 | In | Key sense line (0 thru 7) |
| KSEN1 | R02 | In | |
| KSEN2 | R03 | In | |
| KSEN3 | R10 | In | |
| KSEN4 | R11 | In | |
| KSEN5 | R12 | In | |
| KSEN6 | R13 | In | |
| KSEN7 | R20 | Out | Caps Lock LED |
| LED1 | R21 | Out | Num Lock LED |
| LED2 | R22 | Out | Scr Lock LED |
| LED3 | R23 | Out | System Reset (active low) |
| *RESET | R30 | Out | Not used |
| FDN0 (SW7) | R31 | Out | Not used |
| FDN1 (SW8) | R32 | Out | COM1/*COM2 select |
| COM1/2 | R33 | In | Ten-key-pad select switch (High) |
| TKPDEW | Z0 | Out | Key strobe line (0 thru 10) |
| KSTR0 | Z1 | Out | (KSTROBE0=SLP/RES key strobe) |
| KSTR1 | Z2 | Out | (KSTROBE1=ON SW strobe) |
| KSTR2 | Z3 | Out | |
| KSTR3 | Z4 | Out | |
| KSTR4 | Z5 | Out | |
| KSTR5 | Z6 | Out | |
| KSTR6 | Z7 | Out | |
| KSTR7 | Z8 | Out | |
| KSTR8 | Z9 | Out | (KSTROBE8, 9=Low Batt LED) |
| KSTR9 | Z10 | Out | (KSTROBE10=V-reference) |
| KSTR10 | Z11 | Out | Host hand shake signal |
| CPUHS | Z12 | Out | SCM hand shake signal |
| SCMHS | Z13 | Out | Back-light control |
| BKLIGHT | Z14 | Out | KEY I/F clock out |
| KCLKOUT | Z15 | Out | Low Battery Signal for HDD |
| LB | KI | In | KEY I/F clock in |
| KCLKIN | KH | In | ON SW sense |
| ON/OFF | KL | In | KEY I/F data in |
| KDATAIN | KC0 | An: Out/In | Low battery FATAL Level |
| LOWBAT0 | KC1 | An: Out/In | Low battery WARNING level |
| LOWBAT1 | KC2 | An: Out/In | AC adaptor |
| ACPOWER | KC3 | In | Ring indicator |
| *RI | SOUT | Out | KEY I/F data out |
| KDATAOUT | F | Out | Low Battery Beep. |
| SSPKR | SIN | In | Vcc check |
| VCCCHK | | | |

* means active low signal.

7-3. 8087

NUMERIC DATA COPROCESSOR

8087-1

- High Performance Numeric Data Coprocessor
- Adds Arithmetic, Trigonometric, Exponential, and Logarithmic Instructions to the Standard 8086/8088 and 80186/80188 Instruction Set for All Data Types
- CPU/8087 Supports 7 Data Types: 16-, 32-, 64-Bit Integers, 32-, 64-, 80-Bit Floating Point, and 18-Digit BCD Operands
- Compatible with IEEE Floating Point Standard 754
- Adds 8 x 80-Bit Individually Addressable Register Stack to the 8086/8088 and 80186/80188 Architecture
- 7 Built-In Exception Handling Functions
- MULTIBUS® System Compatible Interface

The 8087 Numeric Data Coprocessor provides the instructions and data types needed for high performance numeric applications, providing up to 100 times the performance of a CPU alone. The 8087 is implemented in N-channel, depletion load, silicon gate technology (HMOS III), housed in a 40-pin package. sixty-eight numeric processing instructions are added to the 8086/8088, 80186/80188 instruction sets and eight 80-bit registers are added to the register set. The 8087 is compatible with the IEEE Floating Point Standard 754.

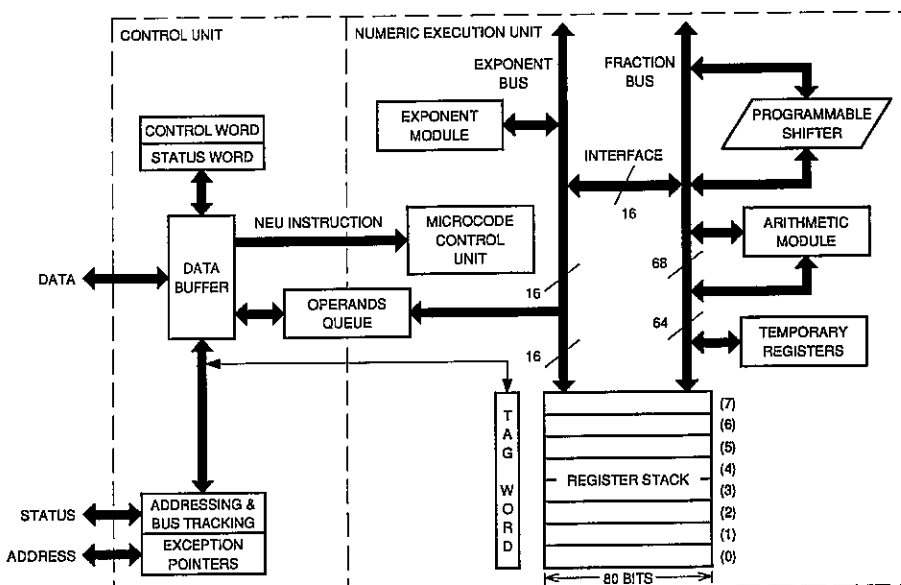


Figure 1. 8087 Block Diagram

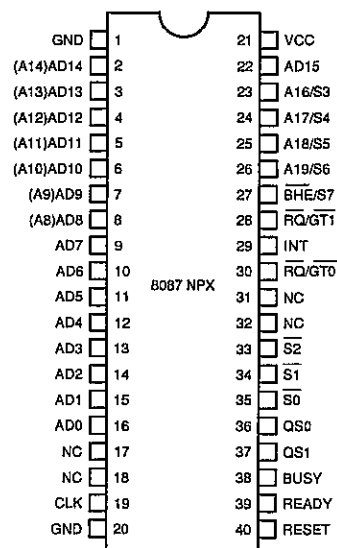


Figure 2. 8087 Pin Configuration

Table 1. 8087 Pin Description

| Symbol | Type | Name and Function | | | | | | | | | | | | | | | | | | | | | | | | |
|---|------|---|--------------|----|----|--|---------|---|---|--------|----------|---|---|--------|---|---|---|-------------|---|---|---|--------------|---|---|---|---------|
| AD15 – AD0 | I/O | ADDRESS DATA: These lines constitute the time multiplexed memory address (T ₁) and data (T ₂ , T ₃ , T _w , T ₄) bus. A0 is analogous to the BHE for the lower byte of the data bus, pins D7 – D0. It is LOW during T ₁ when a byte is to be transferred on the lower portion of the bus in memory operations. Eight-bit oriented devices tied to the lower half of the bus would normally use A0 to condition chip select functions. These lines are active HIGH, they are input/output lines for 8087-driven bus cycles and are inputs which the 8087 monitors when the CPU is in control of the bus. A15 – A8 do not require an address latch in an 8088/8087 or 80188/8087; the 8087 will supply an address for the T ₁ – T ₄ period. | | | | | | | | | | | | | | | | | | | | | | | | |
| A19/S6, A18/S5, A17/S4, A16/S3 | I/O | ADDRESS MEMORY: During T ₁ these are the four most significant address lines for memory operations. During memory operations, status information is available on these lines during T ₂ , T ₃ , T _w , and T ₄ . For 8087-controlled bus cycles, S6, S4, and S3 are reserved and currently one (HIGH), while S5 is always LOW. These lines are inputs which the 8087 monitors when the CPU is in control of the bus. | | | | | | | | | | | | | | | | | | | | | | | | |
| BHE/S7 | I/O | BUS HIGH ENABLE: During T ₁ the bus high enable signal (BHE) should be used to enable data onto the most significant half of the data bus, pins D15 – D8. Eight-bit-oriented devices tied to the upper half of the bus would normally use BHE to condition chip select functions. BHE is LOW during T ₁ for read and write cycles when a byte is to be transferred on the high portion of the bus. The S7 status information is available during T ₂ , T ₃ , T _w , and T ₄ . The signal is active LOW. S7 is an input which the 8087 monitors during the CPU-controlled bus cycles. | | | | | | | | | | | | | | | | | | | | | | | | |
| S2, S1, S0 | I/O | STATUS: For 8087-driven, these status lines are encoded as follows: <table><tr><th>S2</th><th>S1</th><th>S0</th><th></th></tr><tr><td>0 (LOW)</td><td>X</td><td>X</td><td>Unused</td></tr><tr><td>1 (HIGH)</td><td>0</td><td>0</td><td>Unused</td></tr><tr><td>1</td><td>0</td><td>1</td><td>Read Memory</td></tr><tr><td>1</td><td>1</td><td>0</td><td>Write Memory</td></tr><tr><td>1</td><td>1</td><td>1</td><td>Passive</td></tr></table> <p>Status is driven active during T₄, remains valid during T₁ and T₂, and is returned to the passive state (1, 1, 1) during T₃ or during T_w when READY is HIGH. This status is used by the 8288 Bus Controller (or the 82188 Integrated Bus Controller with an 80186/80188 CPU) to generate all memory access control signals. Any change in S2, S1, or S0 during T₄ is used to indicate the beginning of a bus cycle, and the return to the passive state in T₃ or T_w is used to indicate the end of a bus cycle. These signals are monitored by the 8087 when the CPU is in control of the bus.</p> | S2 | S1 | S0 | | 0 (LOW) | X | X | Unused | 1 (HIGH) | 0 | 0 | Unused | 1 | 0 | 1 | Read Memory | 1 | 1 | 0 | Write Memory | 1 | 1 | 1 | Passive |
| S2 | S1 | S0 | | | | | | | | | | | | | | | | | | | | | | | | |
| 0 (LOW) | X | X | Unused | | | | | | | | | | | | | | | | | | | | | | | |
| 1 (HIGH) | 0 | 0 | Unused | | | | | | | | | | | | | | | | | | | | | | | |
| 1 | 0 | 1 | Read Memory | | | | | | | | | | | | | | | | | | | | | | | |
| 1 | 1 | 0 | Write Memory | | | | | | | | | | | | | | | | | | | | | | | |
| 1 | 1 | 1 | Passive | | | | | | | | | | | | | | | | | | | | | | | |
| RQ/GT0 | I/O | REQUEST/GRANT: This request/grant pin is used by the 8087 to gain control of the local bus from the CPU for operand transfers or on behalf of another bus master. It must be connected to one of the two processor request/grant pins. The request/grant sequence on this pin is as follows: <ol style="list-style-type: none">1. A pulse one clock wide is passed to the CPU to indicate a local bus request by either the 8087 or the master connected to the 8087 RQ/GT1 pin.2. The 8087 waits for the grant pulse and when it is received will either initiate bus transfer activity in the clock cycle following the grant or pass the grant out on the RQ/GT1 pin in this clock if the initial request was for another bus master.3. The 8087 will generate a release pulse to the CPU one clock cycle after the completion of the last 8087 bus cycle or on receipt of the release pulse from the bus master on RQ/GT1. <p>For 80186/80188 systems the same sequence applies except RQ/GT signals are converted to appropriate HOLD, HLDA signals by the 82188 Integrated Bus Controller. This is to conform with 80186/80188's HOLD, HLDA bus exchange protocol. Refer to the 82188 data sheet for further information.</p> | | | | | | | | | | | | | | | | | | | | | | | | |

Table 1. 8087 Pin Description (Continued)

| Symbol | Type | Name and Function | | | | | | | | | | | | | | | |
|-----------------------------------|------|--|-----|-----|--|---------|---|--------------|---|---|----------------------------------|----------|---|-----------------|---|---|----------------------------|
| $\overline{\text{RQ}}/\text{GT1}$ | I/O | <p>REQUEST/GRANT: This request/grant pin is used by another local bus master to force the 8087 to request the local bus. If the 8087 is not in control of the bus when the request is made the request/grant sequence is passed through the 8087 on the $\overline{\text{RQ}}/\text{GT0}$ pin one cycle later. Subsequent grant and release pulses are also passed through the 8087 with a two and one clock delay, respectively, for resynchronization. $\overline{\text{RQ}}/\text{GT1}$ has an internal pullup resistor, and so may be left unconnected. If the 8087 has control of the bus the request/grant sequence is as follows:</p> <ol style="list-style-type: none"> 1. A pulse 1 CLK wide from another local bus master indicates a local bus request to the 8087 (pulse 1). 2. During the 8087's next T_4 or T_1 a pulse 1 CLK wide from the 8087 to the requesting master (pulse 2) indicates that the 8087 has allowed the local bus to float and that it will enter the "RQ/GT acknowledge" state at the next CLK. The 8087's control unit is disconnected logically from the local bus during "RQ/GT acknowledge." 3. A pulse 1 CLK wide from the requesting master indicates to the 8087 (pulse 3) that the "RQ/GT" request is about to end and that the 8087 can reclaim the local bus at the next CLK. <p>Each master-master exchange of the local bus is a sequence of 3 pulses. There must be one dead CLK cycle after each bus exchange. Pulses are active LOW.</p> <p>For 80186/80188 system, the $\overline{\text{RQ}}/\text{GT1}$ line may be connected to the 82188 Integrated Bus Controller. In this case, a third processor with a HOLD, HLDA bus exchange system may acquire the bus from the 8087. For this configuration, $\overline{\text{RQ}}/\text{GT1}$ will only be used if the 8087 is the bus master. Refer to 82188 data sheet for further information.</p> | | | | | | | | | | | | | | | |
| QS1, QS0 | I | <p>QS1, QS0: QS1 and QS0 provide the 8087 with status to allow tracking of the CPU instruction queue.</p> <table> <tr> <th>QS1</th><th>QS0</th><th></th></tr> <tr> <td>0 (LOW)</td><td>0</td><td>No Operation</td></tr> <tr> <td>0</td><td>1</td><td>First Byte of Op Code from Queue</td></tr> <tr> <td>1 (HIGH)</td><td>0</td><td>Empty the Queue</td></tr> <tr> <td>1</td><td>1</td><td>Subsequent byte from Queue</td></tr> </table> | QS1 | QS0 | | 0 (LOW) | 0 | No Operation | 0 | 1 | First Byte of Op Code from Queue | 1 (HIGH) | 0 | Empty the Queue | 1 | 1 | Subsequent byte from Queue |
| QS1 | QS0 | | | | | | | | | | | | | | | | |
| 0 (LOW) | 0 | No Operation | | | | | | | | | | | | | | | |
| 0 | 1 | First Byte of Op Code from Queue | | | | | | | | | | | | | | | |
| 1 (HIGH) | 0 | Empty the Queue | | | | | | | | | | | | | | | |
| 1 | 1 | Subsequent byte from Queue | | | | | | | | | | | | | | | |
| INT | O | <p>INTERRUPT: This line is used to indicate that an unmasked exception has occurred during numeric instruction execution when 8087 interrupts are enabled. This signal is typically routed to an 8259A for 8086/8088 systems and to INT0 for 80186/80188 systems. INT is active HIGH.</p> | | | | | | | | | | | | | | | |
| BUSY | O | <p>BUSY: This signal indicates that the 8087 NEU is executing a numeric instruction. It is connected to the CPU's $\overline{\text{TEST}}$ pin to provide synchronization. In the case of an unmasked exception BUSY remains active until the exception is cleared. BUSY is active HIGH.</p> | | | | | | | | | | | | | | | |
| READY | I | <p>READY: READY is the acknowledgement from the addressed memory device that it will complete the data transfer. The RDY signal from memory is synchronized by the 8284A Clock Generator to form READY for 8086 systems. For 80186/80188 systems, RDY is synchronized by the 82188 Integrated Bus Controller to form READY. This signal is active HIGH.</p> | | | | | | | | | | | | | | | |
| RESET | I | <p>RESET: RESET causes the processor to immediately terminate its present activity. The signal must be active HIGH for at least four clock cycles. RESET is internally synchronized.</p> | | | | | | | | | | | | | | | |
| CLK | I | <p>CLOCK: The clock provides the basic timing for the processor and bus controller. It is asymmetric with a 33% duty cycle to provide optimized internal timing.</p> | | | | | | | | | | | | | | | |
| Vcc | | <p>POWER: Vcc is the +5V power supply pin.</p> | | | | | | | | | | | | | | | |
| GND | | <p>GROUND: GND are the ground pins.</p> | | | | | | | | | | | | | | | |

NOTE: For the pin descriptions of the 8086, 8088, 80186 and 80188 CPUs, reference the respective data sheets (8086, 8088, 80186, 80188).

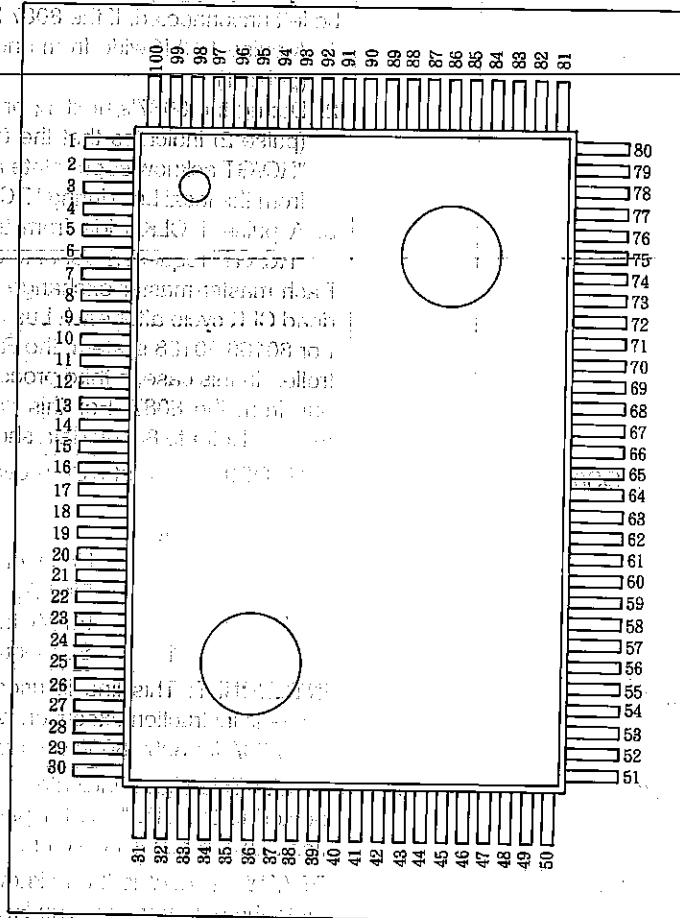
7-4. TC8586F Floppy Disk Controller

1) General

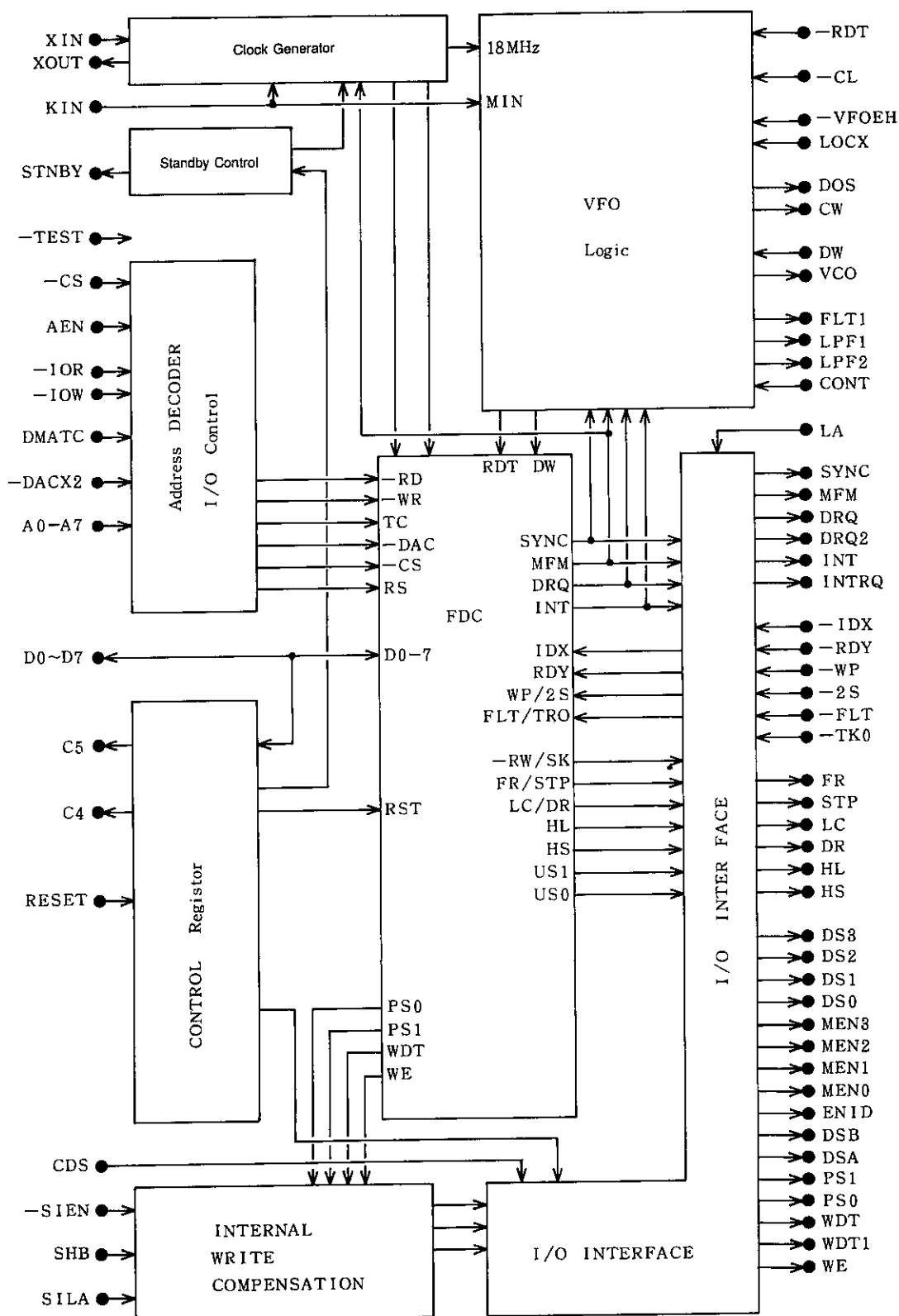
The TC8586F is a floppy disk control microchip designed to interface four floppy disk unit with the CPU. In this chip is implemented a high performance VFO circuitry and peripheral logic circuitry.

2) Features

- ☐ Silicon gate CMOS
- ☐ Single 5V supply
- ☐ 100-pin flat package
- ☐ Internal oscillator
- ☐ Internal VFO
- ☐ Internal standby circuit
- ☐ FD/MFD selection
- ☐ FM/MFM recording mode
- ☐ Internal write compensation
- ☐ Motor enable output control
- ☐ Internal I/O address decoder
- ☐ Multi-sector, multi-track
- ☐ Simultaneous seek, 4 drives
- ☐ Drive interface Schmitt trigger input
- ☐ Programmable step rate
- ☐ IBM compatible track format
- ☐ Internal CRC generation and check ($X16+X12+X5+1$)
- ☐ Programmable head load and unload time
- ☐ Data scan function
- ☐ DMA/non-DMA data transfer



3) TC8566F block diagram



4) Signal description

| Pin No. | Signal name | In/Out | Description |
|---------|--------------|--------|--|
| 1 | C6 | Out | Control register C6 output |
| 2 | IOR | In | Signal used to transfer data onto the data bus from the FDC. |
| 4 | IOW | In | Control signal to transfer data from the data bus to FDC. |
| 5 | A0 | In | Address signal |
| 6 | A1 | In | |
| 7 | A2 | In | |
| 8 | A3 | In | |
| 9 | A4 | In | |
| 10 | A5 | In | |
| 11 | A6 | In | |
| 12 | A7 | In | |
| 13 | CS | In | FDC chip select |
| 14 | AEN | In | Address enable from the CPU |
| 15 | D0 | In/Out | Bidirectional 8-bit data bus |
| 16 | D1 | In/Out | |
| 17 | D2 | In/Out | |
| 18 | D3 | In/Out | |
| 19 | D4 | In/Out | |
| 20 | D5 | In/Out | |
| 21 | D6 | In/Out | |
| 22 | D7 | In/Out | |
| 23 | DRQ2 | Out | DMA request. Output to delay DRQ. The signal is at a low level when the control register ENID bit is 0. |
| 24 | INTRQ | Out | Interrupt request issued by the FDC. The signal is at a low level when the control register ENID bit is 0. This signal stays low. |
| 25 | INT | Out | Interrupt request issued from the FDC. |
| 26 | DRQ | Out | DMA request |
| 27 | [VSS] | G | FDC digital ground |
| 28 | AG | G | VCO analog ground |
| 32 | DACK2 | In | DMA cycle becomes valid with a low state of this as input at DMA transfer. |
| 33 | DMATC | In | Indicates end of DMA during DMA transfer. |
| 34 | CONT | In | VCO control voltage input |
| 35 | TEST | In | Test input with a pullup resistance. Normally, not to be connected or fixed high. |
| 36 | VCO | In/Out | Test input in the test mode, but normally output. To be connected with the low gain side filter. |
| 37 | LPF2 | Out | Output connected to LPF of the PLL circuit. Selected after leading frequency. To be connected with the low gain side filter. |
| 38 | LPF1 | Out | Output connected to LPF of the PLL circuit. Selected after leading frequency. To be connected with the high gain side filter. |
| 39 | CW | Out | Test input. Not to be connected. |
| 40 | DW | In | Data window input signal required when using external VFO circuit. Normally, low or high fixed. |
| 41 | FLT | Out | Test input used to indicate filter switching. Not to be connected. |
| 42 | DOS | Out | Test input. Not to be connected. |
| 43 | LOCK | In | Test input with a pullup resistance. Normally, not to be connected or fixed high. |
| 44 | RDT (RDT) | In | Data read signal from the floppy disk drive. When the external VFO circuit is used, it is a data read signal (RDT) input from the external VFO circuit. |
| 45 | XOUT | Out | Crystal oscillator inverter amp output pin. |
| 46 | XIN | In | Crystal oscillator inverter amp input pin which is used for the 16MHz external clock. |
| 47 | VFOEN | In | Internal VFO select signal. Internal VFO is selected with a low state of signal and the external VFO is chosen with a high state of signal. |
| 48 | MIN | In | Used to select the standard floppy disk and mini-floppy disk. Low: Standard floppy disk High: Mini-floppy disk |
| 49 | MFM | Out | High: MFM mode Low: FM mode |
| 53 | CL | In | This pin incorporates a pullup resistance and is used to reset the internal clock generator and VFO flip-flop with a low state of signal. Normally, not to be connected or fixed high. |
| 54 | [VSS] | G | FDC digital ground |
| 55 | SYNC | Out | Indicates that the FDC is in reading action. |

| Pin No. | Signal name | In/Out | Description |
|---------|--------------|--------|--|
| 56 | WDT1 | Out | FDD write data compensation output signal. Active low when LA is high. |
| 57 | WE | Out | Used to direct the FDD to write data. Active low when LA is high. |
| 58 | HS | Out | Head 0 is selected with a low state of this signal when LA is at a low level. Head 1 is selected with a low state of this signal when LA is at a low level. |
| 59 | HL | Out | Used to direct the FDD to load the read/write head on the disk. Active low when LA is at a low level. |
| 60 | MEN3 | Out | Number 3 unit drive motor enable, active low when LA is at a high level. |
| 61 | MEN2 | Out | Number 2 unit drive motor enable, active low when LA is at a high level. |
| 62 | MEN1 | Out | Number 1 unit drive motor enable, active low when LA is at a high level. |
| 63 | MEN0 | Out | Number 0 unit drive motor enable, active low when LA is at a high level. |
| 64 | [VSS] | G | FDC digital ground |
| 65 | [VDD] | V | Single 5V supply. All VDD lines connected to +5V. |
| 66 | DS3 | Out | Indicates that the number 3 unit is selected, active low when LA is at a high level. |
| 67 | DS2 | Out | Indicates that the number 2 unit is selected, active low when LA is at a high level. |
| 68 | DS1 | Out | Indicates that the number 1 unit is selected, active low when LA is at a high level. |
| 69 | DS0 | Out | Indicates that the number 0 unit is selected, active low when LA is at a high level. |
| 70 | STP | Out | Used to deliver step pulse to move the head to another cylinder, active low when LA is at a high level. |
| 71 | FR | Out | Used to reset a fault of the FDD, active low when LA is at a high level. |
| 72 | LC | Out | Indicates that the read/write head is on the cylinder position after the 43rd cylinder, active low when LA is at a high level. |
| 73 | DR | Out | Indicates the direction of the head in the seek mode. Seeks towards disk periphery with a low state of this signal and disk center with a high state of this signal when LA is at a low level. Seeks towards the disk periphery with a high state of this signal and disk center with a low state of this signal when LA is at a high level. |
| 74 | [VSS] | G | FDC digital ground |
| 75 | [VDD] | V | Single +5V supply. All VDD lines are connected to +5V. |
| 76 | ID \bar{X} | In | Indicates the start point of track on the disk. |
| 77 | RDY | In | Indicates that the FDD is ready. |
| 80 | WP | In | Indicates that the disk is write protected. |
| 81 | 2S | In | Indicates the use of two-sided floppy disk. |
| 82 | FLT | In | Indicates that the FDD is at a fault. |
| 83 | TK0 | In | Indicates that the head is on track 0. |
| 84 | PS1 | Out | Indicates write compensation information in the MFM mode. |
| 85 | PS0 | Out | Late if PS0 is at a low and PS1 at a high. Early if PS0 is at a high and PS1 at a low. Normal if PS0 is at a low and PS1 at a low. |
| 86 | DSB | Out | FDD select signal. |
| 87 | DSA | Out | #0 drive: DSB=low, DSA=low #1 drive: DSB=low, DSA=high #2 drive: DSB=high, DSA=low #3 drive: DSB=high, DSA=high |
| 88 | LA | In | Determines logic of the drive side output. WDT1, WE, HG, HL, MEN0 ~ MEN3, DS0 ~ DS3, STP, FR, LC, DR are active low with a high state of this signal. |
| 90 | [VDD] | V | Single +5V supply. All VDD lines are connected to +5V. |
| 92 | CDS | In | Control register DSB and DSA are selected as drive select signal with a high state of this signal. Internal FDC block US1 and US0 are selected as drive select signal with a low state of this signal. |
| 93 | RESET | In | Resets the contents of control register. |
| 94 | SHB | In | Used to indicate rate of shift for the write. |
| 95 | SHA | In | Compensation circuit. 125ns when SHB is low and SHA low. 250ns when SHB is low and SHA high. 375ns when SHB is high and SHA low. 500ns when SHB is high and SHA high. One half of the above values is used for the standard floppy disk. |
| 96 | SHEN | In | Used to set SHB and SHA valid. Rate of shift becomes 0 for the write compensation circuit when the signal is at a high level. |
| 97 | STNBY | Out | Indicates that the FDC is at standby. WDT1, WE, HG, HL, MEN0 ~ MEN3, DS0 ~ DS3, STP, FR, LC, DR are active low when in the standby mode. |
| 98 | WDT | Out | FDD write data composed of clock bits and data bits. |
| 99 | ENID | Out | Control register ENID bit output. |
| 100 | C4 | Out | Control register C4 output. |

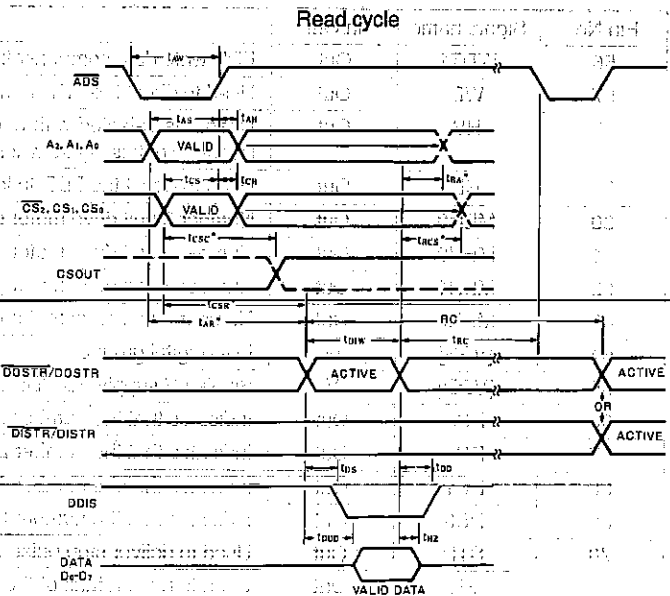
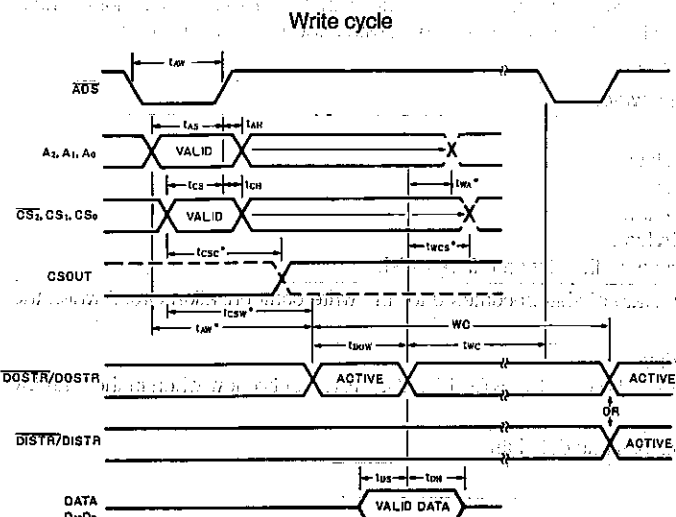
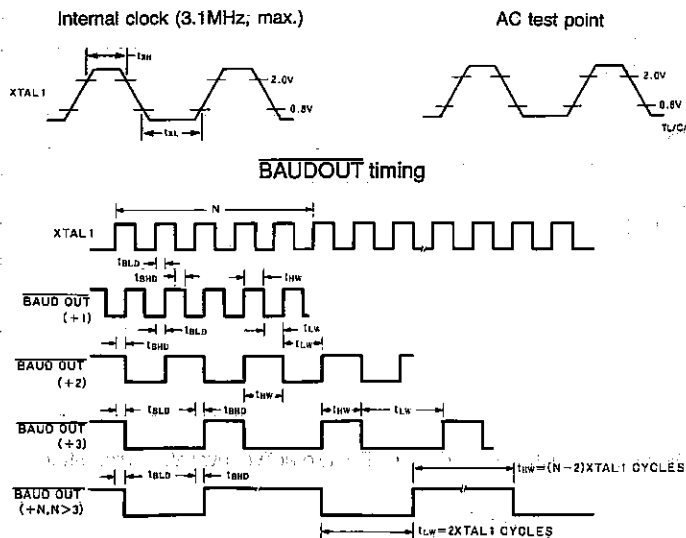
7-5. INS82C50A asynchronous communication element

1. General description and features

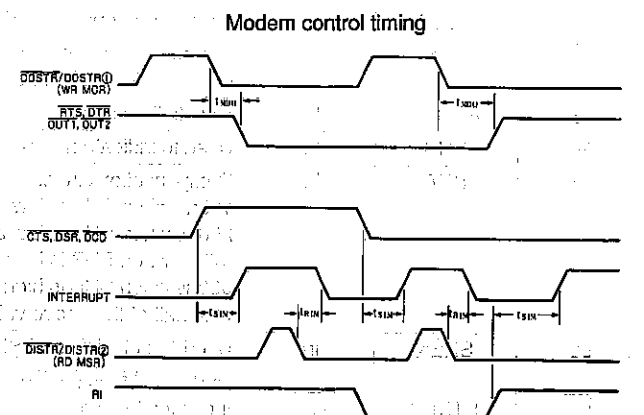
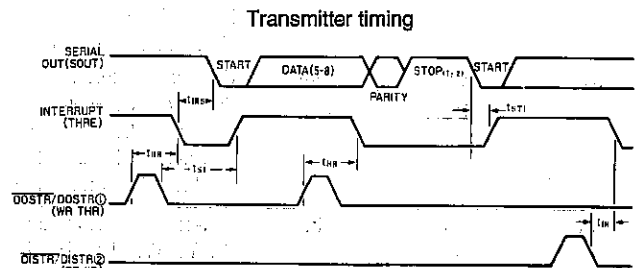
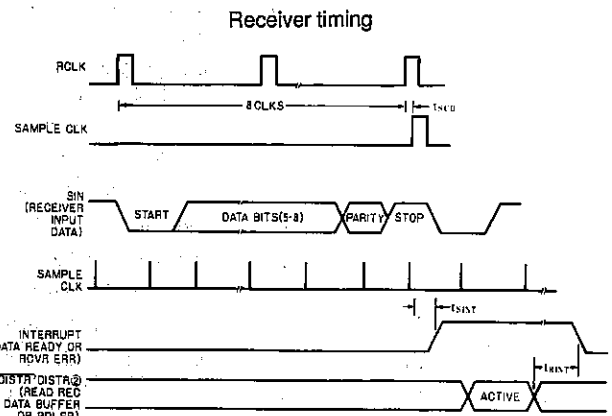
- Enhances interface with almost any microprocessor
- Add/delete of suffixed bit(s) (START, STOP, PARITY) for async communication
- Full double buffer method that does not require precise synchronization
- Independently controlled transmit, receive, line status, data set interrupts
- 1 - (216 - 1) divided programmable baud rate generator (internal 16 x clock generation)
- Independent receiver clock input
- Modem control functions (CTS, RTS, DSR, DTR, RI, DCD)
- Serial interface format full compatible
 - 5, 6, 7, 8 bits character size
 - Even, odd, non parity
 - 1, 1.5/2, stop bits
 - Baud rate generation (DC - 56K bauds)
- Illogical start bit detection
- Variety of status information
- Bidirectional data bus, control bus directly controlled tri-state TTL driver
- Start and detect of line break
- Internal self-diagnostics
 - Device internal loopback control
 - Break, parity, overrun, framing error simulation
- Interrupt controlled with priority

Timing waveforms

All waveforms are explained in reference to bit 0 and 1.



ADS fixed to low level for measurement



- ① : Refer to write cycle.
② : Refer to read cycle.

Ring Indicator 8-RI, pin-39)

A low on this line indicates that ring is detected by the modem or data set. For RI is a modem-control input, its state can be tested by referring to the bit 6 (RI) of the modem status register. The bit 2 (TERI) of the modem status register is set 1 when there was a change in the state of the RI input in the period that this register is read after the modem status register was read.

NOTE: An interrupt is caused when the modem status interrupt is enabled and that there was a change in the RI bit of the modem status register.

VCC: pin-40

+5V supply

VSS: pin-20

GND (0V), reference voltage ground

OUTPUT SIGNAL DESCRIPTION**Data terminal ready (DTR, pin-33)**

A low on this line indicates that the ACE is enabled to communicate with the modem or the data set. DTR turns active when the bit 0 (DTR) of the modem control register is set by the program. This output is set high level after the master reset is conducted. During the loopback mode, the signal is held high level.

Request to send (RTS, pin-32)

A low on this line indicates that the ACE is enabled to send data to the modem or the data set. RTS turns active when the bit 1 (RTS) of the modem control register is set by the program. This output is set high level after the master reset is conducted. During the loopback mode, the signal is held high level.

Output-1 (OUT1, pin-34)

A general purpose output line which goes active low when the bit 2 (OUT1) of the modem control register is set by the program. OUT1 is set high level after the master reset is conducted. During the loopback mode, the signal is held high level.

Output-2 (OUT2, pin-31)

A general purpose output line which goes active low when the bit 3 (OUT2) of the modem control register is set by the program. OUT2 is set high level after the master reset is conducted. During the loopback mode, the signal is held high level.

Chip select out (CSOUT, pin-24)

A high level signal is issued on this line when CS0, CS1, and CS2 are set high to select chip. Data are not sent out until CSOUT goes high.

Driver select out (DDIS, pin-23)

Goes low when ACE data are read by the CPU. When the CPU is reading other than data, the line is kept high. Used to disable an external data transceiver which is established on the data bus D7 ~ D0 between the CPU and the ACE.

Baud out (BAUDOUT, pin-15)

The 16 x clock used in the ACE transmitter circuitry is sent out. The clock frequency is the value the basic clock input is divided by the value set in the baud rate divisor latch. When the BAUDOUT output is connected to the RCLK input, it can also be used for the receiver clock.

Interrupt (INTRPT, pin-30)

Goes active when one of receiver error flag, receive data available, transmitter holding register empty, and modem status interrupts is requested. If the corresponding IER bit was set, the line goes high. The INTR output is reset low after the master reset is conducted or an adequate interrupt service is done.

Serial output (SOUT, pin-11)

Through this line is sent out the serial data to the communication link (modem or data set). The line is set high (MARK) when the master reset is conducted.

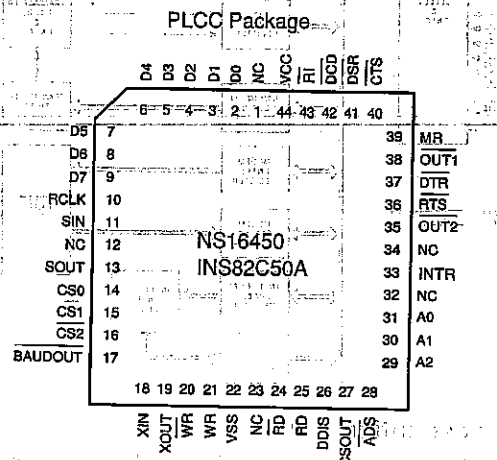
INPUT/OUTPUT PIN DESCRIPTION**Data bus (D7 ~ D0, Pin-1 to -8)**

An eight line tri-state input/output used to carry bidirectional data communication between the ACE and the CPU. Data, control word, and status information are transferred via this data bus.

External clock input/output (XTAL1, XTAL2, pin-16 and 17)

Connected to the basic clock input (crystal oscillator or external clock).

NOTE: Pin numbers described are for the dual in-line package.

Pin Configuration

Top view

7-6. LZ95H12 (Gate array)

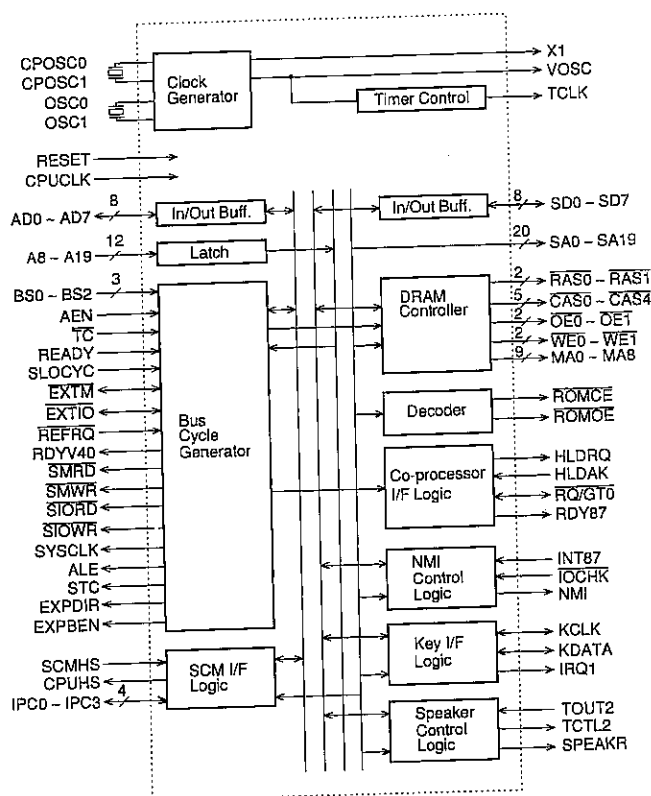
General

The LZ95H12 may be used together with a LZ93J21, a V40 and optionally, a 8087,

The LZ95H12 incorporates the following functions:

1. V40/system address bus interfacing;
2. V40/system data bus interfacing;
3. V40 oscillator selection;
4. bus cycle generator and IO channel interface;
5. 8087 interface;
6. system ROM interface;
7. DRAM control signal generation;
8. system timer clock generation;
9. speaker control;
10. keyboard interface;
11. configuration switch port;
12. NMI control and IO trapping;
13. SCM interface; and
14. internal I/O register interface.

LZ95H12 Block Diagram



LZ95H12

| No. | Signal name | I/O | Description |
|-----|-------------|-----|------------------------------------|
| 1 | WE1 | O | Not used |
| 2 | OE0 | O | DRAM output enable |
| 3 | OE1 | O | Not used |
| 4 | RESET | I | System reset signal input |
| 5 | ROMCE | O | ROM chip enable |
| 6 | ROMOE | O | ROM output enable |
| 7 | BS0 | I | Bus status 0 |
| 8 | BS1 | I | Bus status 1 |
| 9 | BS2 | I | Bus status 2 |
| 10 | AD0 | I/O | AD bus 0 |
| 11 | AD1 | I/O | AD bus 1 |
| 12 | AD2 | I/O | AD bus 2 |
| 13 | AD3 | I/O | AD bus 3 |
| 14 | AD4 | I/O | AD bus 4 |
| 15 | AD5 | I/O | AD bus 5 |
| 16 | Vcc | | |
| 17 | GND | | |
| 18 | AD6 | I/O | AD bus 6 |
| 19 | AD7 | I/O | AD bus 7 |
| 20 | A8 | I | CPU address 8 |
| 21 | A9 | I | CPU address 9 |
| 22 | A10 | I | CPU address 10 |
| 23 | A11 | I | CPU address 11 |
| 24 | A12 | I | CPU address 12 |
| 25 | A13 | I | CPU address 13 |
| 26 | A14 | I | CPU address 14 |
| 27 | A15 | I | CPU address 15 |
| 28 | A16 | I | CPU address 16 |
| 29 | A17 | I | CPU address 17 |
| 30 | A18 | I | CPU address 18 |
| 31 | A19 | I | CPU address 19 |
| 32 | RDY87 | O | Ready signal for 8087 |
| 33 | RDYV40 | O | Ready signal for V40 |
| 34 | REFRQ | I | Refresh request |
| 35 | RQ/GT0 | I/O | Request/Grant 0 |
| 36 | IRQ87 | I | Interrupt request from 8087 |
| 37 | HLD AK | I | Bus hold acknowledge |
| 38 | HLD RQ | O | Bus hold request |
| 39 | TCLK | O | Timer clock |
| 40 | TCTL2 | O | Timer 2 control |
| 41 | TOUT2 | I | Timer 2 output |
| 42 | IRQ1 | O | Interrupt 1 |
| 43 | NMI | O | Non-maskable interrupt |
| 44 | TC | I | Terminal count |
| 45 | CPUCLK | I | CPU clock |
| 46 | X1 | O | Connected with X1 pin of V40 |
| 47 | CPOSC0 | O | Connected with 20MHz crystal |
| 48 | CPOSC1 | I | |
| 49 | GND | | |
| 50 | Vcc | | |
| 51 | VOSC | O | Clock output for LZ93J21 |
| 52 | OSC0 | O | Connected with 14.31818MHz crystal |
| 53 | OSC1 | I | |
| 54 | AEN | I | DMA or refresh active signal |
| 55 | EXTM | I/O | External memory active signal |

| No. | Signal name | I/O | Description |
|-----|-------------|-----|------------------------------|
| 56 | EXTIO | I/O | External I/O active signal |
| 57 | SLOCYC | I | Signal to decide bus cycle |
| 58 | EXPDIR | O | Not used |
| 59 | EXPBEN | O | Not used |
| 60 | IOCHK | I | Not used |
| 61 | READY | I | Ready |
| 62 | STC | O | Terminal count output |
| 63 | SYSCLK | O | System clock |
| 64 | ALE | O | Address latch enable |
| 65 | SD0 | I/O | System data bus 0 |
| 66 | SD1 | I/O | System data bus 1 |
| 67 | SD2 | I/O | System data bus 2 |
| 68 | SD3 | I/O | System data bus 3 |
| 69 | SD4 | I/O | System data bus 4 |
| 70 | SD5 | I/O | System data bus 5 |
| 71 | SD6 | I/O | System data bus 6 |
| 72 | SD7 | I/O | System data bus 7 |
| 73 | SA0 | O | System address bus 0 |
| 74 | SA1 | O | System address bus 1 |
| 75 | SA2 | O | System address bus 2 |
| 76 | SA3 | O | System address bus 3 |
| 77 | SA4 | O | System address bus 4 |
| 78 | SA5 | O | System address bus 5 |
| 79 | SA6 | O | System address bus 6 |
| 80 | Vcc | | |
| 81 | GND | | |
| 82 | SA7 | O | System address bus 7 |
| 83 | SA8 | O | System address bus 8 |
| 84 | SA9 | O | System address bus 9 |
| 85 | SA10 | O | System address bus 10 |
| 86 | SA11 | O | System address bus 11 |
| 87 | SA12 | O | System address bus 12 |
| 88 | SA13 | O | System address bus 13 |
| 89 | GND | | |
| 90 | SA14 | O | System address bus 14 |
| 91 | SA15 | O | System address bus 15 |
| 92 | SA16 | O | System address bus 16 |
| 93 | SA17 | O | System address bus 17 |
| 94 | SA18 | O | System address bus 18 |
| 95 | SA19 | O | System address bus 19 |
| 96 | SMRD | O | System memory read |
| 97 | SMWR | O | System memory write |
| 98 | SIORD | O | System I/O read |
| 99 | SIOWR | O | System I/O write |
| 100 | SPEAKR | O | Speaker signal |
| 101 | KCLK | I/O | Key clock |
| 102 | KDATA | I/O | Key data |
| 103 | CPUHS | O | Signal for handshake CPU-SCM |
| 104 | SCMHS | I | Signal for handshake CPU-SCM |
| 105 | IPC0 | I/O | IPC bus 0 |
| 106 | IPC1 | I/O | IPC bus 1 |
| 107 | IPC2 | I/O | IPC bus 2 |
| 108 | IPC3 | I/O | IPC bus 3 |
| 109 | MA0 | O | Multiplexed DRAM address 0 |
| 110 | MA1 | O | Multiplexed DRAM address 1 |
| 111 | MA2 | O | Multiplexed DRAM address 2 |
| 112 | Vcc | | |

| No. | Signal name | I/O | Description |
|-----|-------------|-----|----------------------------|
| 113 | GND | | |
| 114 | MA3 | O | Multiplexed DRAM address 3 |
| 115 | MA4 | O | Multiplexed DRAM address 4 |
| 116 | MA5 | O | Multiplexed DRAM address 5 |
| 117 | MA6 | O | Multiplexed DRAM address 6 |
| 118 | MA7 | O | Multiplexed DRAM address 7 |
| 119 | MA8 | O | Multiplexed DRAM address 8 |
| 120 | GND | | |
| 121 | RAS0 | O | DRAM-RAS output |
| 122 | RAS1 | O | DRAM-RAS output |
| 123 | CAS0 | O | DRAM-CAS output |
| 124 | CAS1 | O | DRAM-CAS output |
| 125 | CAS2 | O | DRAM-CAS output |
| 126 | CAS3 | O | DRAM-CAS output |
| 127 | CAS4 | O | DRAM-CAS output |
| 128 | WE0 | O | DRAM write enable |

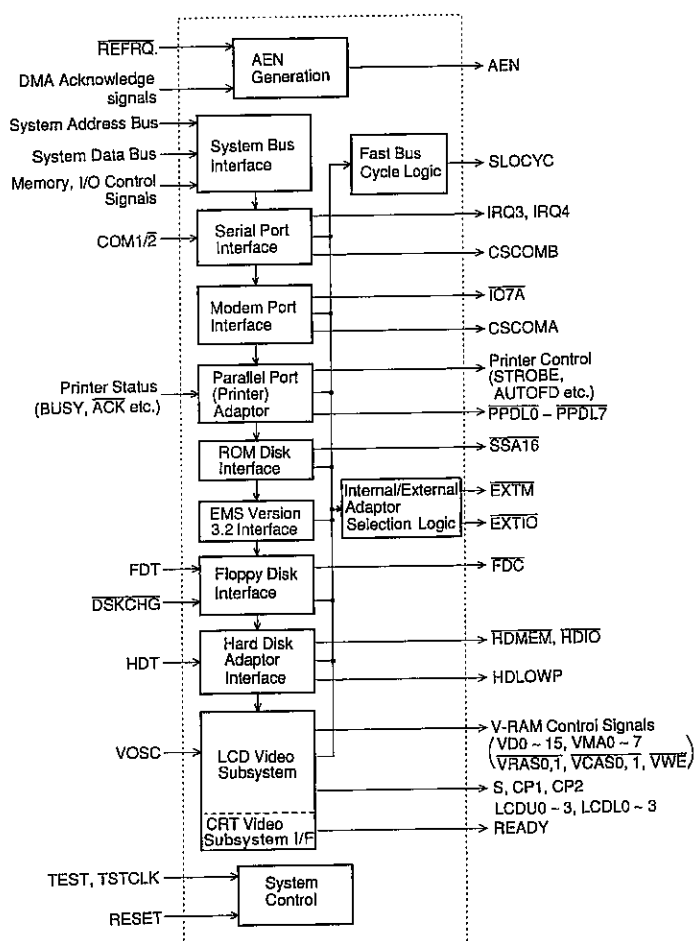
7-7. LZ93J21 (Gate array)

General

The LZ93J21 may be used together with a LZ95H12, a V40 and optionally. The LZ93J21 incorporates the following functions:

1. system bus interface;
2. AEN generation;
3. serial port interface;
4. modem port interface;
5. parallel port adapter;
6. ROM disk interface;
7. EMS Version 3.2 interface;
8. floppy disk adapter extension;
9. hard disk adapter interface;
10. CRT video subsystem interface;
11. LCD video subsystem;
12. fast bus cycle logic; and
13. internal/external adapter selection logic.

LZ93J21 Block Diagram



LZ93J21 signal description

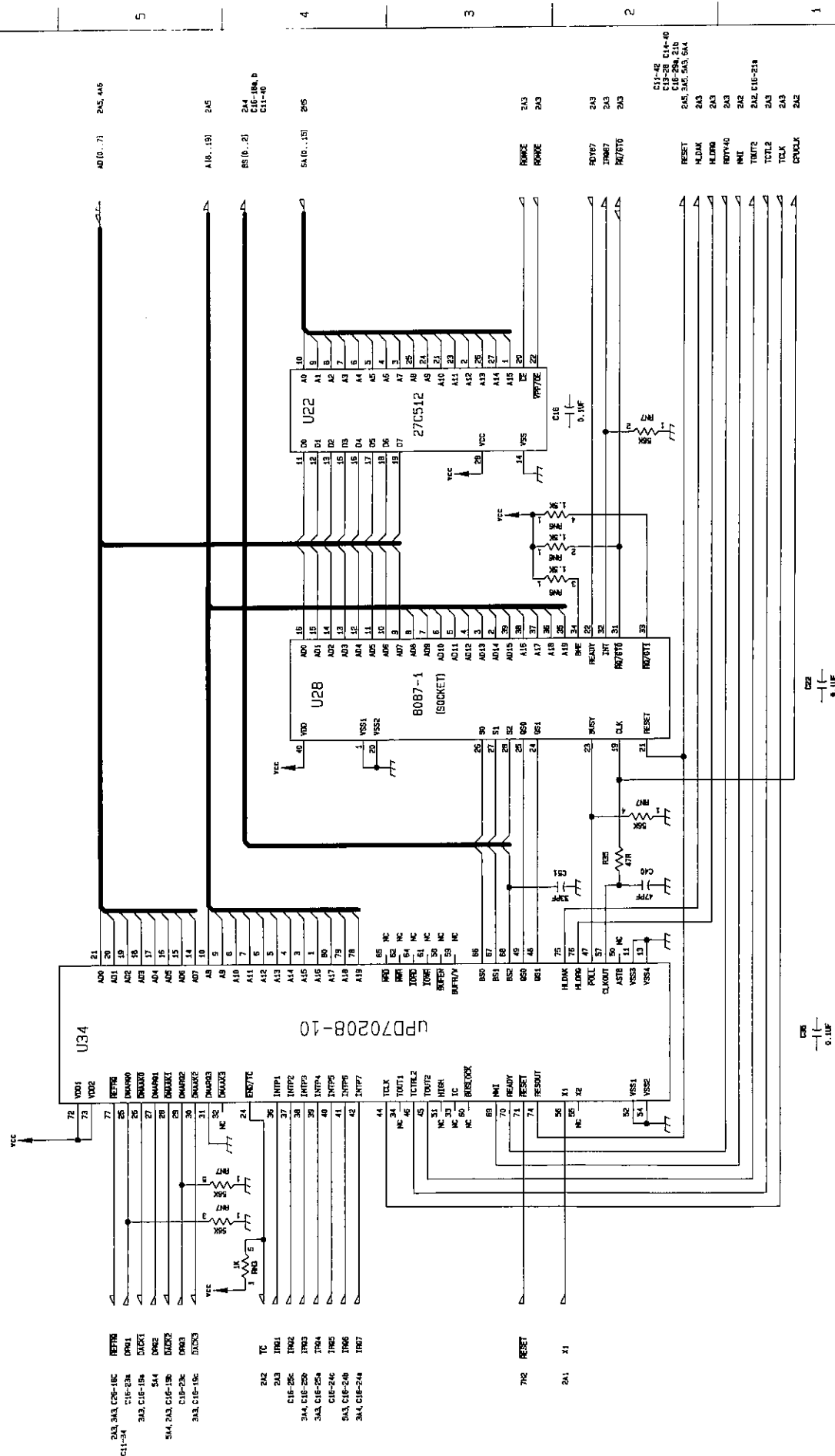
| No. | Signal name | I/O | Description |
|-----|-------------|-----|--|
| 1 | DACK1 | I | Input to V40 channel 0 DMA acknowledge |
| 2 | DACK2 | I | Input to V40 channel 1 DMA acknowledge |
| 3 | DACK3 | I | Input to V40 channel 2 DMA acknowledge |
| 4 | SMRD | I | Input to active low memory read signal |
| 5 | SMWR | I | Input to active low memory write signal |
| 6 | SIORD | I | Input to active low I/O read signal |
| 7 | SIOWR | I | Input to active low I/O write signal |
| 8 | VD0 | I/O | LCD VRAM data bus 0 |
| 9 | VD1 | I/O | LCD VRAM data bus 1 |
| 10 | VD2 | I/O | LCD VRAM data bus 2 |
| 11 | VD3 | I/O | LCD VRAM data bus 3 |
| 12 | VD4 | I/O | LCD VRAM data bus 4 |
| 13 | VD5 | I/O | LCD VRAM data bus 5 |
| 14 | VD6 | I/O | LCD VRAM data bus 6 |
| 15 | VD7 | I/O | LCD VRAM data bus 7 |
| 16 | Vcc | | +5V supply |
| 17 | GND | | 0V, ground |
| 18 | VD8 | I/O | LCD VRAM data bus 8 |
| 19 | VD9 | I/O | LCD VRAM data bus 9 |
| 20 | VD10 | I/O | LCD VRAM data bus 10 |
| 21 | VD11 | I/O | LCD VRAM data bus 11 |
| 22 | VD12 | I/O | LCD VRAM data bus 12 |
| 23 | VD13 | I/O | LCD VRAM data bus 13 |
| 24 | VD14 | I/O | LCD VRAM data bus 14 |
| 25 | VD15 | I/O | LCD VRAM data bus 15 |
| 26 | VMA0 | O | LCD VRAM address bus 0 |
| 27 | VMA1 | O | LCD VRAM address bus 1 |
| 28 | VMA2 | O | LCD VRAM address bus 2 |
| 29 | VMA3 | O | LCD VRAM address bus 3 |
| 30 | VMA4 | O | LCD VRAM address bus 4 |
| 31 | VMA5 | O | LCD VRAM address bus 5 |
| 32 | VMA6 | O | LCD VRAM address bus 6 |
| 33 | VMA7 | O | LCD VRAM address bus 7 |
| 34 | TEST | I | Test pin |
| 35 | VRA0 | O | LCD VRAM 0 row address select signal (active low) |
| 36 | VRA1 | O | LCD VRAM 1 row address select signal (active low) |
| 37 | VCAS0 | O | LCD VRAM 0 column address select signal (active low) |
| 38 | VCAS1 | O | LCD VRAM 1 column address select signal (active low) |
| 39 | VWE | O | LCD VRAM write enable signal (active low) |
| 40 | HDMEM | O | Hard disk memory select signal (active low) |
| 41 | HDIO | O | Hard disk I/O select signal (active low) |
| 42 | SSA16 | O | EMS memory card system address bus 16 |
| 43 | HDLOWP | O | Not used |
| 44 | HDT | I | 1: HD 0: FD |
| 45 | FDT | I | LOW. |
| 46 | READY | O | Bus cycle ready signal |
| 47 | SLOCYC | O | Slow bus cycle select signal |
| 48 | RESET | I | Reset signal input (active high) |
| 49 | GND | | |
| 50 | Vcc | | |
| 51 | IRQ3 | O | V40 channel 3 interrupt request signal |
| 52 | IRQ4 | O | V40 channel 4 interrupt request signal |

| No. | Signal name | I/O | Description |
|-----|-------------|-----|--|
| 53 | IRQ7 | O | V40 channel 7 interrupt request signal |
| 54 | EXTM | O | External memory active signal (active low) |
| 55 | EXTIO | O | External I/O active signal (active low) |
| 56 | FDC | O | Floppy disk controller select signal (active low) |
| 57 | DSKCHG | I | Input to disk change signal (active low) |
| 58 | HID | O | (active low) |
| 59 | IO7A | O | 7AH I/O port select signal (active low) |
| 60 | CSCOMA | O | COMA chip select signal (active high) |
| 61 | SIRQ | I | Input to 82C50 interrupt request signal |
| 62 | SINTEN | I | Input to 82C50 interrupt enable signal |
| 63 | CSCOMB | O | COMB chip select signal (active high) |
| 64 | COM1/2 | I | Input to COM 1, COM 2 select signal from the sub-CPU |
| 65 | BUSY | I | Input to printer busy signal |
| 66 | ACK | I | Input to printer acknowledge signal |
| 67 | PE | I | Input to printer paper empty signal |
| 68 | SELECT | I | Input to printer select signal |
| 69 | ERROR | I | Input to printer error signal |
| 70 | SEL | O | Printer select signal |
| 71 | INIT | O | Printer initialize signal |
| 72 | AUTOFD | O | Printer linefeed enable signal |
| 73 | STROBE | O | Printer strobe signal |
| 74 | PPDL0 | O | Data output 0 to printer |
| 75 | PPDL1 | O | Data output 1 to printer |
| 76 | PPDL2 | O | Data output 2 to printer |
| 77 | PPDL3 | O | Data output 3 to printer |
| 78 | PPDL4 | O | Data output 4 to printer |
| 79 | PPDL5 | O | Data output 5 to printer |
| 80 | Vcc | | +5V supply |
| 81 | GND | | 0V, ground |
| 82 | PPDL6 | O | Data output 6 to printer |
| 83 | PPDL7 | O | Data output 7 to printer |
| 84 | TSTCLK | I | Test clock input |
| 85 | S | O | LCD scan start signal |
| 86 | CP1 | O | LCD data latch signal |
| 87 | CP2 | O | LCD data shift clock |
| 88 | LCDU0 | O | Upper row LCD data 0 |
| 89 | LCDU1 | O | Upper row LCD data 1 |
| 90 | LCDU2 | O | Upper row LCD data 2 |
| 91 | LCDU3 | O | Upper row LCD data 3 |
| 92 | LCDL0 | O | Lower row LCD data 0 |
| 93 | LCDL1 | O | Lower row LCD data 1 |
| 94 | LCDL2 | O | Lower row LCD data 2 |
| 95 | LCDL3 | O | Lower row LCD data 3 |
| 96 | VOSC | I | LCD controller clock input |
| 97 | SD0 | I/O | System data bus 0 |
| 98 | SD1 | I/O | System data bus 1 |
| 99 | SD2 | I/O | System data bus 2 |
| 100 | SD3 | I/O | System data bus 3 |
| 101 | SD4 | I/O | System data bus 4 |
| 102 | SD5 | I/O | System data bus 5 |
| 103 | SD6 | I/O | System data bus 6 |
| 104 | SD7 | I/O | System data bus 7 |
| 105 | SA0 | I | System address bus 0 |
| 106 | SA1 | I | System address bus 1 |
| 107 | SA2 | I | System address bus 2 |

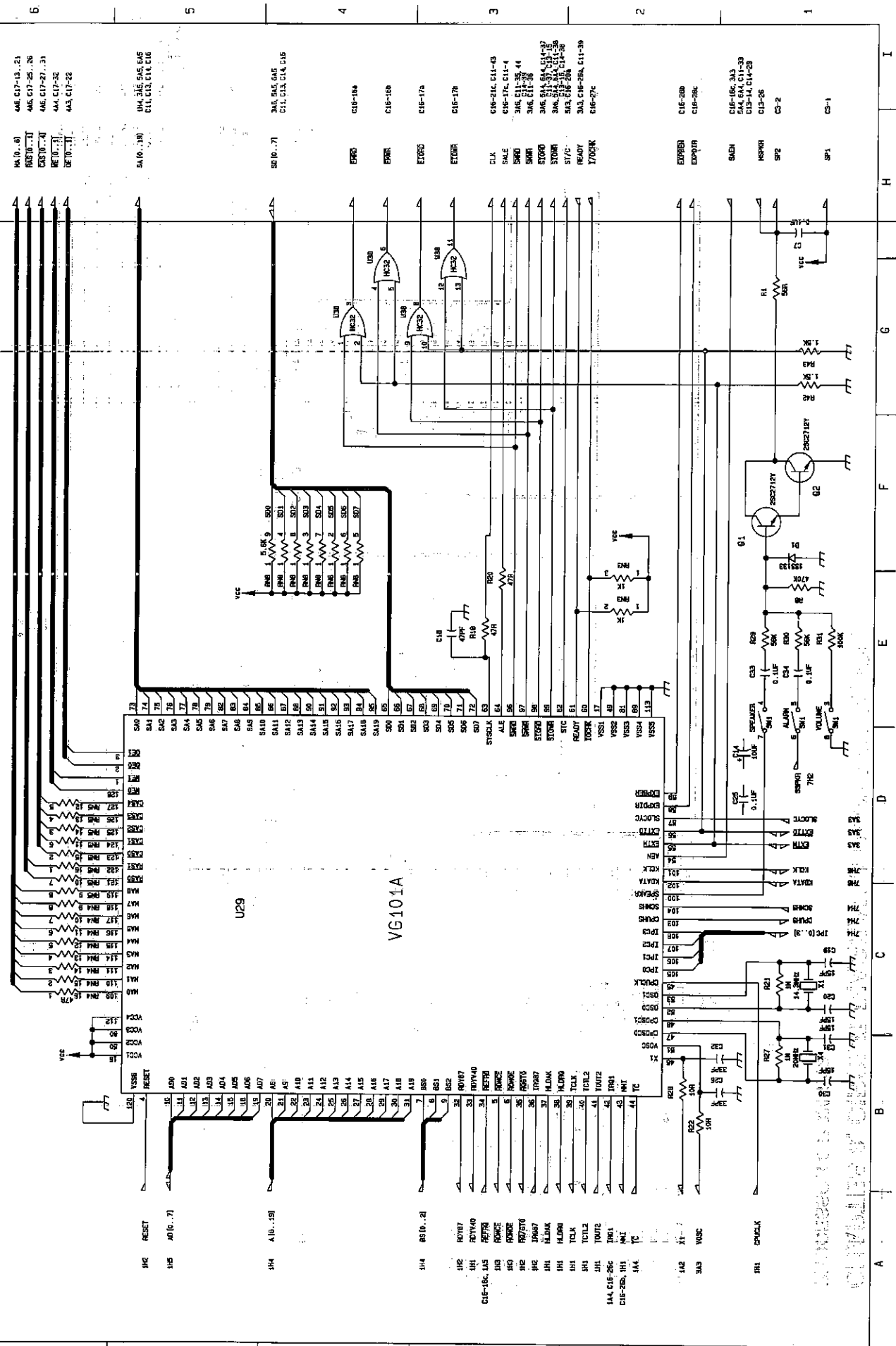
| No. | Signal name | I/O | Description |
|-----|-------------|-----|--|
| 108 | SA3 | I | System address bus 3 |
| 109 | SA4 | I | System address bus 4 |
| 110 | SA5 | I | System address bus 5 |
| 111 | SA6 | I | System address bus 6 |
| 112 | Vcc | | +5V supply |
| 113 | GND | | 0V, ground |
| 114 | SA7 | I | System address bus 7 |
| 115 | SA8 | I | System address bus 8 |
| 116 | SA9 | I | System address bus 9 |
| 117 | SA10 | I | System address bus 10 |
| 118 | SA11 | I | System address bus 11 |
| 119 | SA12 | I | System address bus 12 |
| 120 | SA13 | I | System address bus 13 |
| 121 | SA14 | I | System address bus 14 |
| 122 | SA15 | I | System address bus 15 |
| 123 | SA16 | I | System address bus 16 |
| 124 | SA17 | I | System address bus 17 |
| 125 | SA18 | I | System address bus 18 |
| 126 | SA19 | I | System address bus 19 |
| 127 | AEN | O | DMA refresh active signal |
| 128 | REFRQ | I | Input to refresh request signal from V40 |

CHAPTER 8. CIRCUIT DIAGRAM & PARTS POSITION

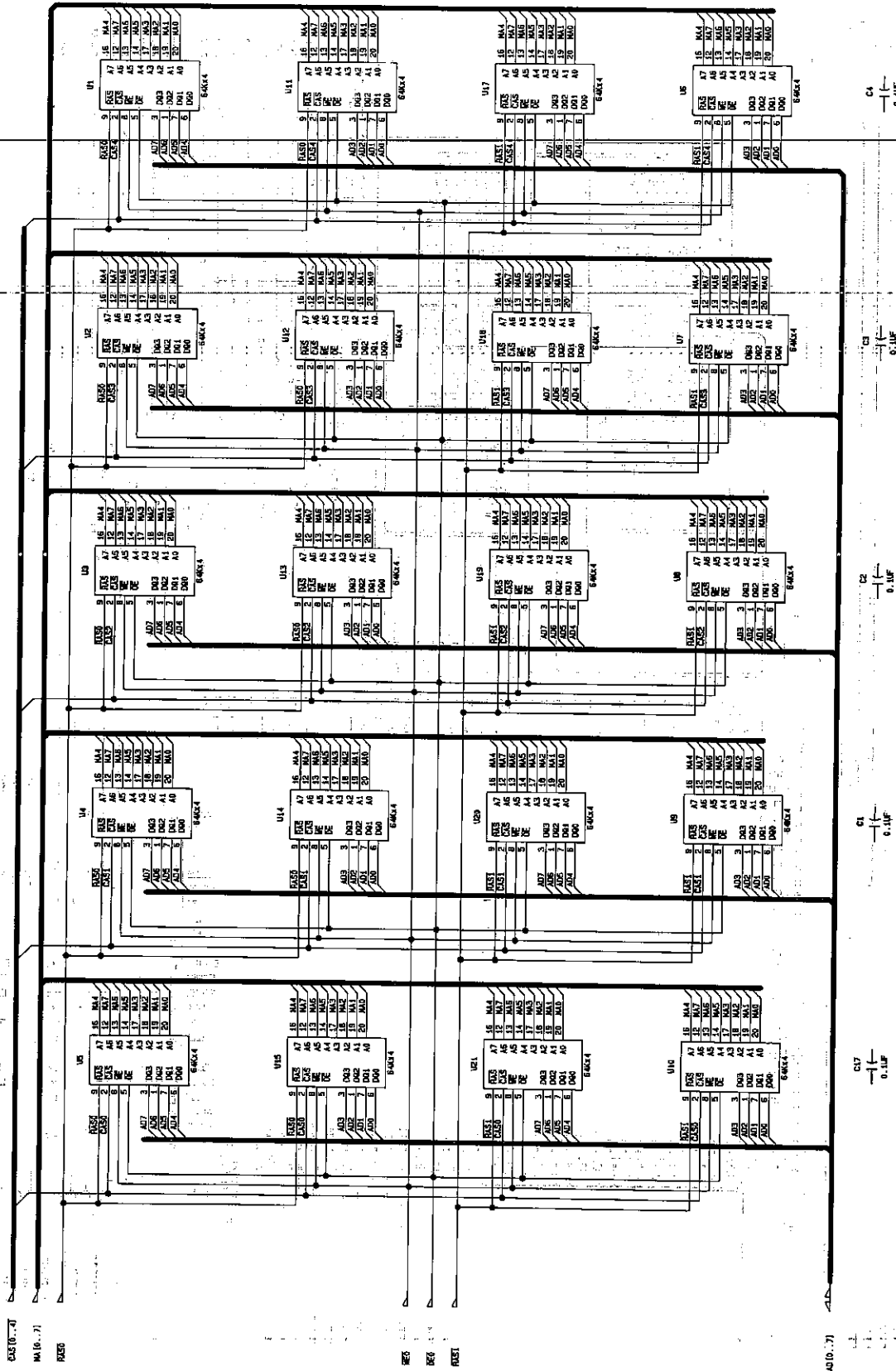
PROCESSOR & ROM 1/12



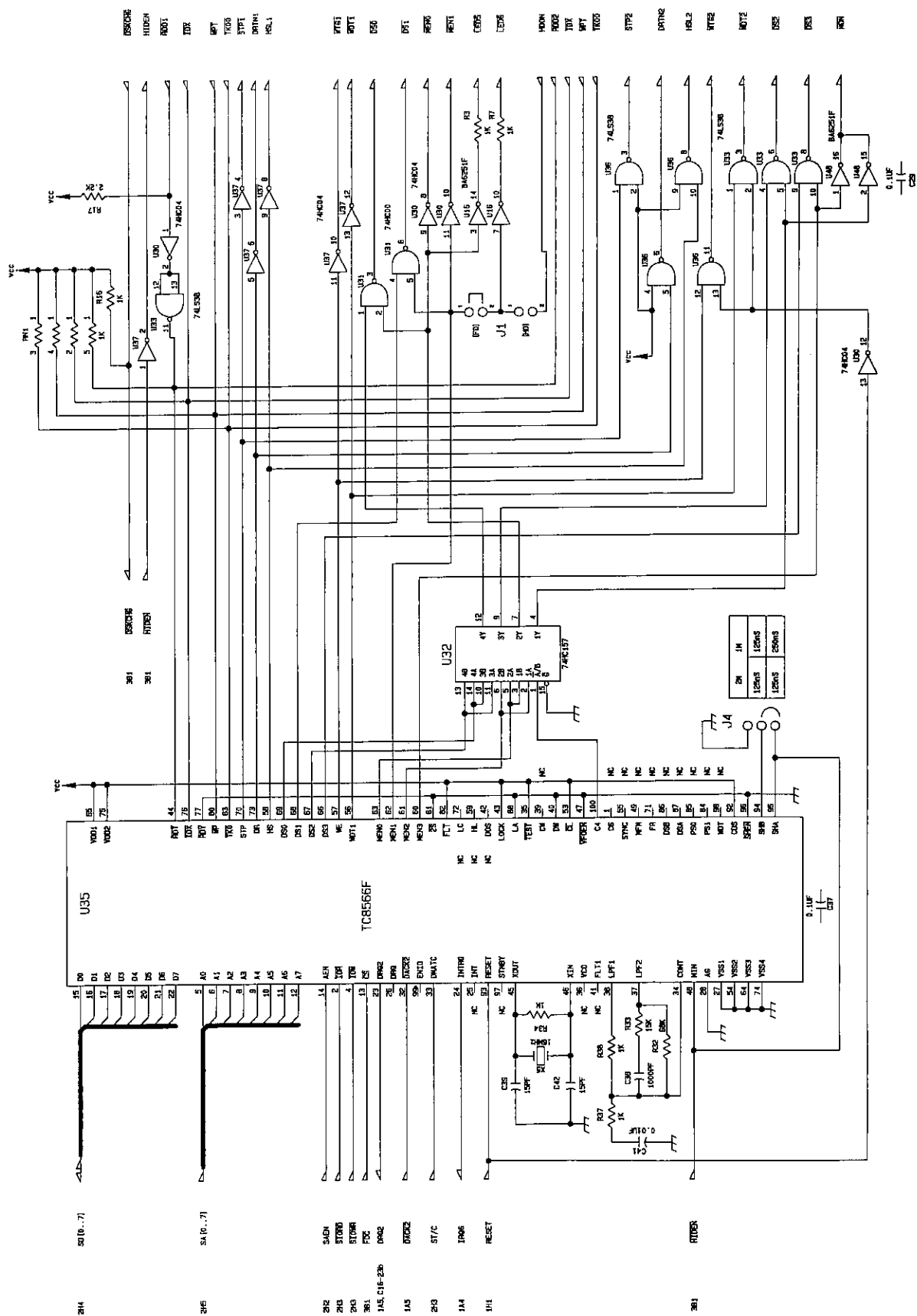
SYSTEM CONTROLLER (BUS I/F, MEMORY I/F, SPEAKER I/F) 2/12



MAIN MEMORY (640K) 4/12

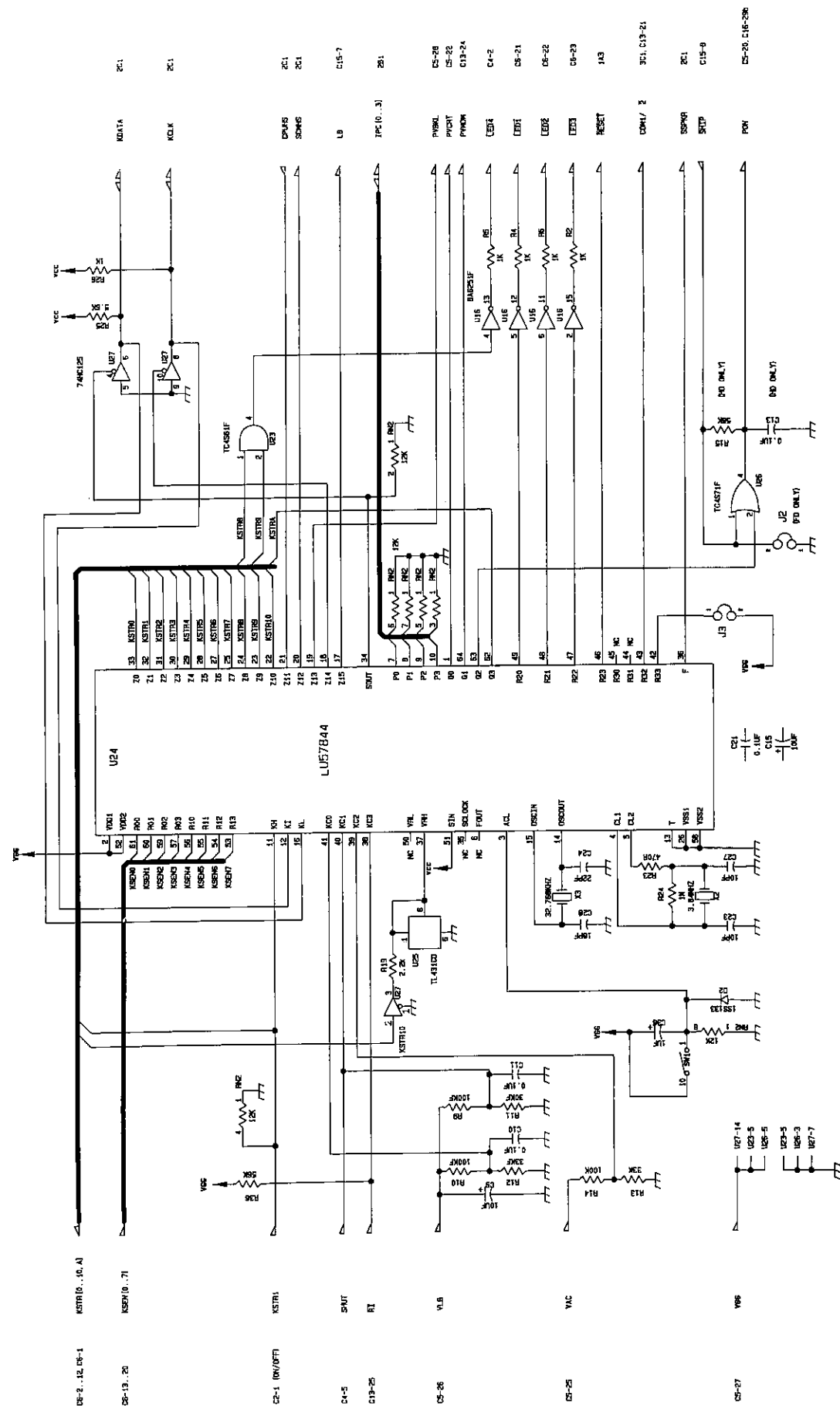


FLOPPY DISK CONTROLLER & I/F 5/12



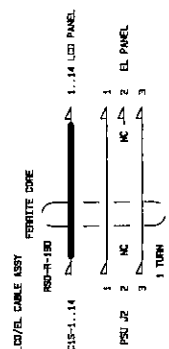
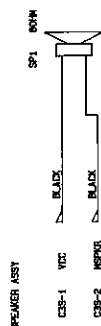
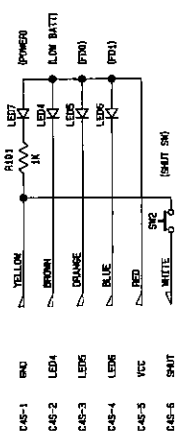


SUB-CPU (KEYBOARD, SYSTEM POWER, RTC) 7/12

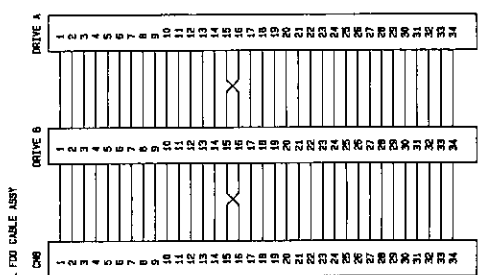
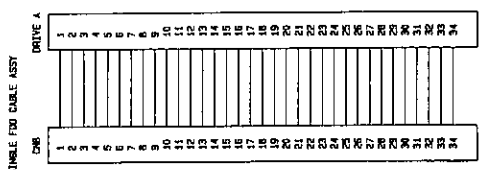
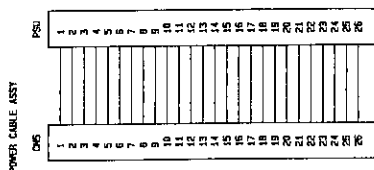
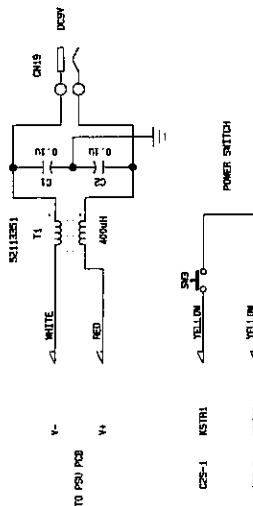


SUB ASSEMBLIES 9/12

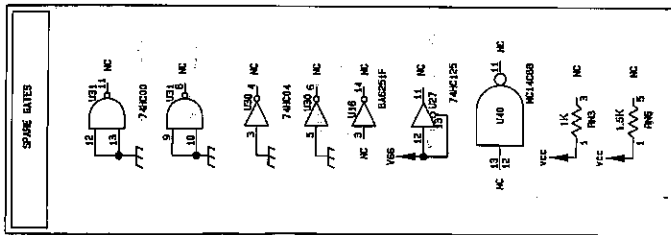
LED PCB



AC ADAPTOR & SWITCH PCB



10/12



| DESTINATION | |
|-------------|----------|
| LAST USE | NOT USED |
| C50 | |
| C17 | C17 |
| D0 | |
| J6 | |
| R46 | |
| RH12 | |
| U3 | |
| U48 | |
| X5 | |

| RAM CHIPS | | | |
|-----------|--------------|---------|---------|
| START | LAST ADDRESS | BIT 7-4 | BIT 3-0 |
| 000K | 00FFFF | U5 | U15 |
| 5-AC | 01FFFF | U21 | U19 |
| 120K | 02FFFF | U4 | U14 |
| 180K | 03FFFF | U20 | U8 |
| 200K | 04FFFF | U3 | U13 |
| 300K | 05FFFF | U19 | U4 |
| 360K | 06FFFF | U2 | U12 |
| 400K | 07FFFF | U18 | U7 |
| 512K | 08FFFF | U1 | U11 |
| 576K | 09FFFF | U17 | U6 |

| DIP SWITCH | | |
|------------|-----------------------|----------------------------|
| SW | DN | OFF |
| 1 | RESET SUB-CPU | NORMAL OPERATION |
| 2 | NORMAL | SPARE |
| 3 | SPEAKER LOW VOLUME | NORMAL |
| 4 | NORMAL | PC SPEAKER OFF |
| 5 | NORMAL | LOW BATT/SHUT ALARM OFF |

| JUMPER | | | |
|----------|---|------------------------------|---------------------------------|
| LOCATION | FUNCTION | NORMAL SETTING | SPECIAL SETTING |
| J1 | SELECT LED ILLUMINATION SOURCE | DUAL FDD - FD HD/FDD - HD | |
| J2 | SUPPRESS SHIP SIGNAL WHEN HD FDD IS INSTALLED | DUAL FDD - 0 HD/FDD - X | |
| J3 | SELECT KEYBOARD SIZE | MTN 10 KEY | (OUT TRACED) W/O 10 KEY |
| J4 | FDD WRITE PRE-COMP. PRELUDE | 25000 | (OUT 6 JWP) LEADS |
| J5 | FDD MOTOR CONTROL | ALWAYS ON | (OUT 6 JWP) AUTO POWER UP |
| J6 | FDD TYPE SELECT | 750K | (OUT 6 JWP) 1.4M |

EDN FOR REV2 PCB

10-12-1988

- SNAP PIN 1 AND PIN 2 OF U27 (74HC125) -
- CONNECT PIN 2 OF U24 (74C595) TO VCC.
- ENLARGE ANGLE BRACKET PAD ON COMP. SIDE BY 0.5MM ON EACH SIDE.
- ATTACH ON SOLDER SIDE, CLCD1..6 (4/PF) TO CN1-7..14

EDN FOR REV2B PCB

10-12-1988

- ENLARGE ANGLE BRACKET PAD ON COMP. SIDE BY 0.5MM ON EACH SIDE.
- ATTACH ON SOLDER SIDE, CLCD1..6 (4/PF) TO CN1-7..14

EDN FOR REV3 PCB

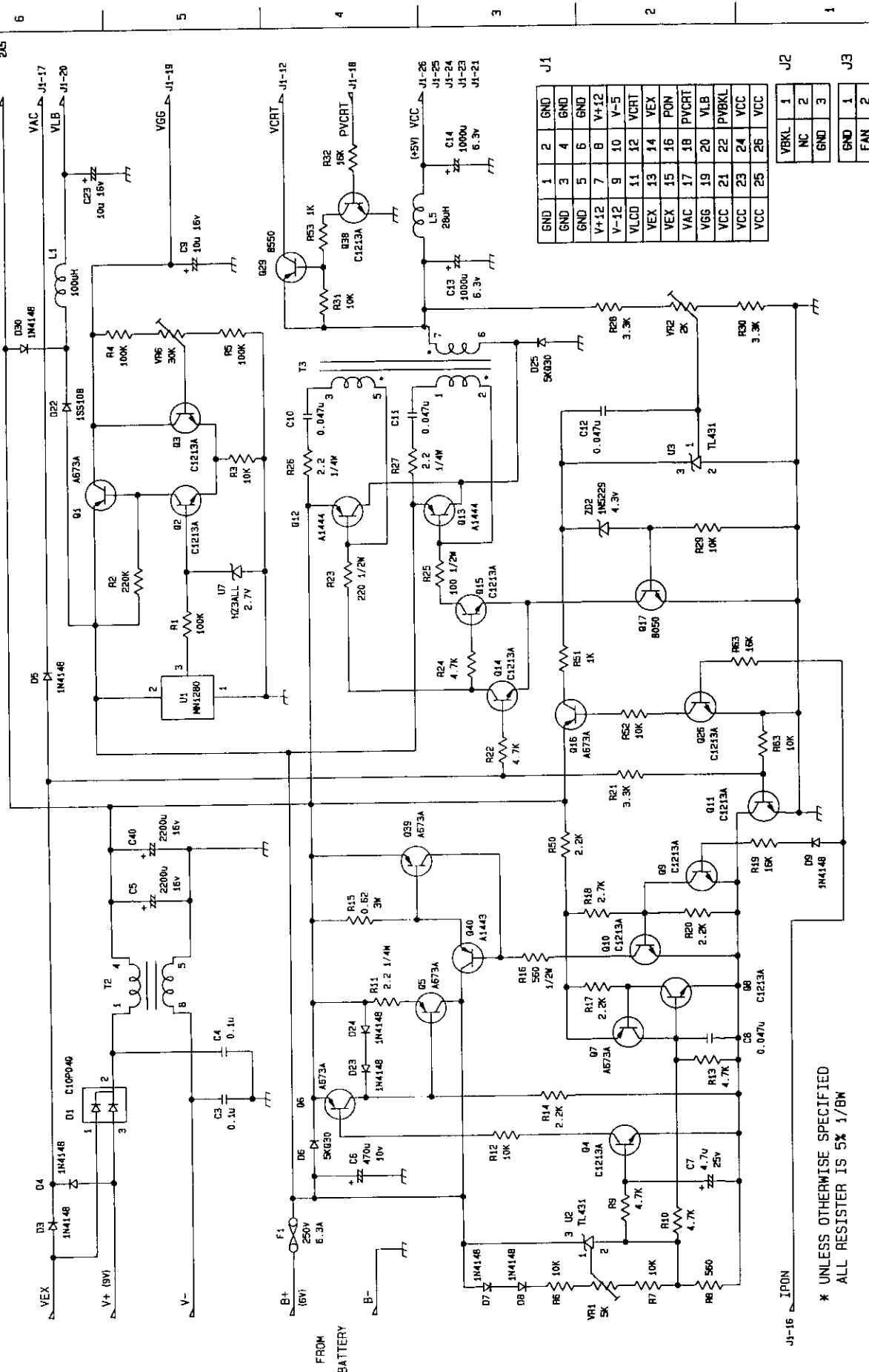
11-8-1988

- ATTACH ON SOLDER SIDE, CLCD1..6 (4/PF) TO CN1-7..14

| DUAL FDD PCB VS SINGLE FDD/HDD PCB | | | |
|------------------------------------|---------------------|--------------------|--|
| ITEM | DUAL FDD VERSION | HDD/FDD VERSION | |
| R9 | 97.8K | 100K | |
| R15 | NIL | 50K | |
| C13 | NIL | 0.1uF | |
| J1 | FD SIDE | HD SIDE | |
| J2 | INSTALL | NIL | |
| CH4 | NIL | INSTALL | |
| CH5 | NIL | INSTALL | |
| J5 | NIL | CUT & JWP | |

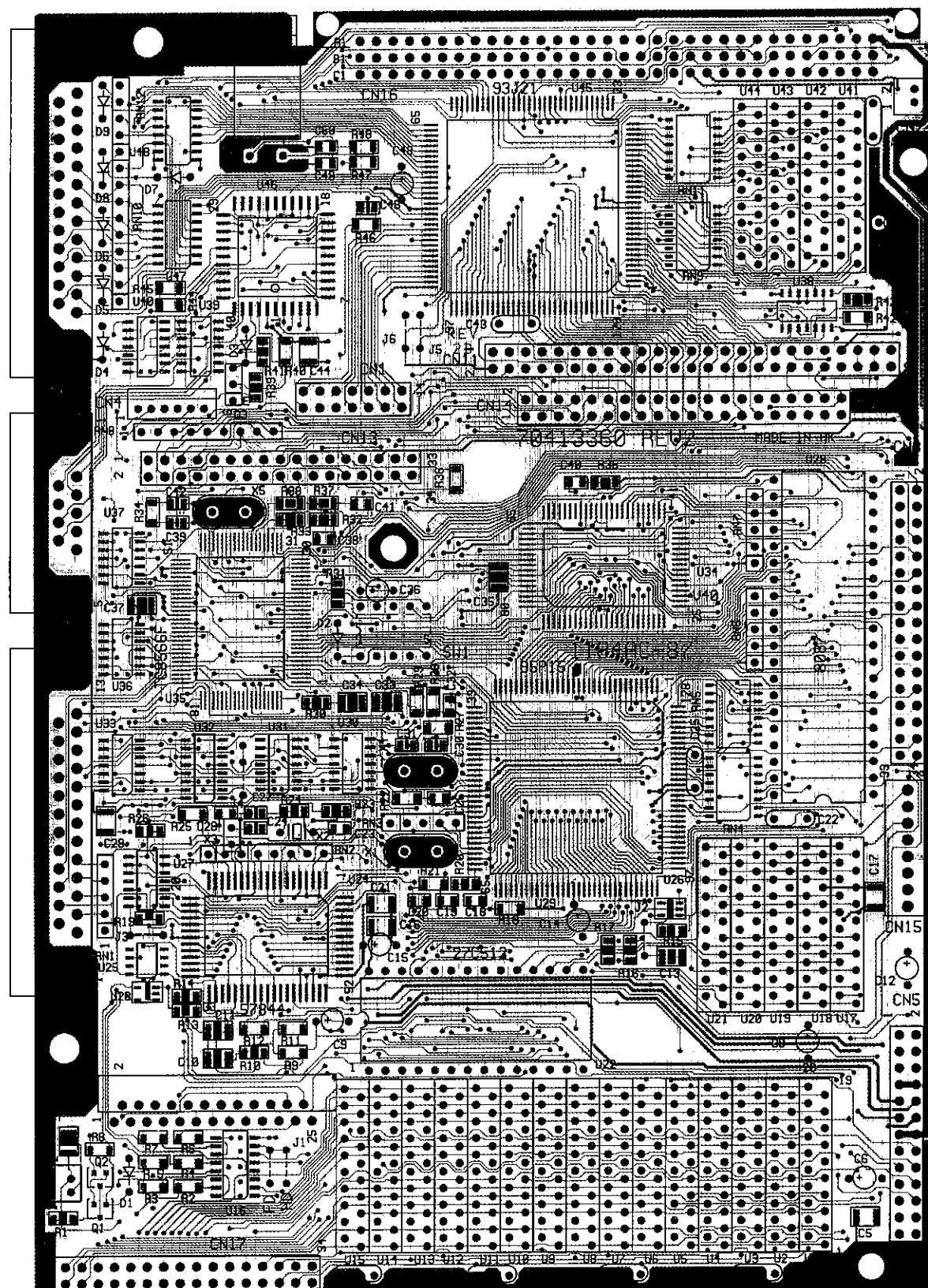
ONLY FOR REV2 PCB

POWER SUPPLY (11/12)

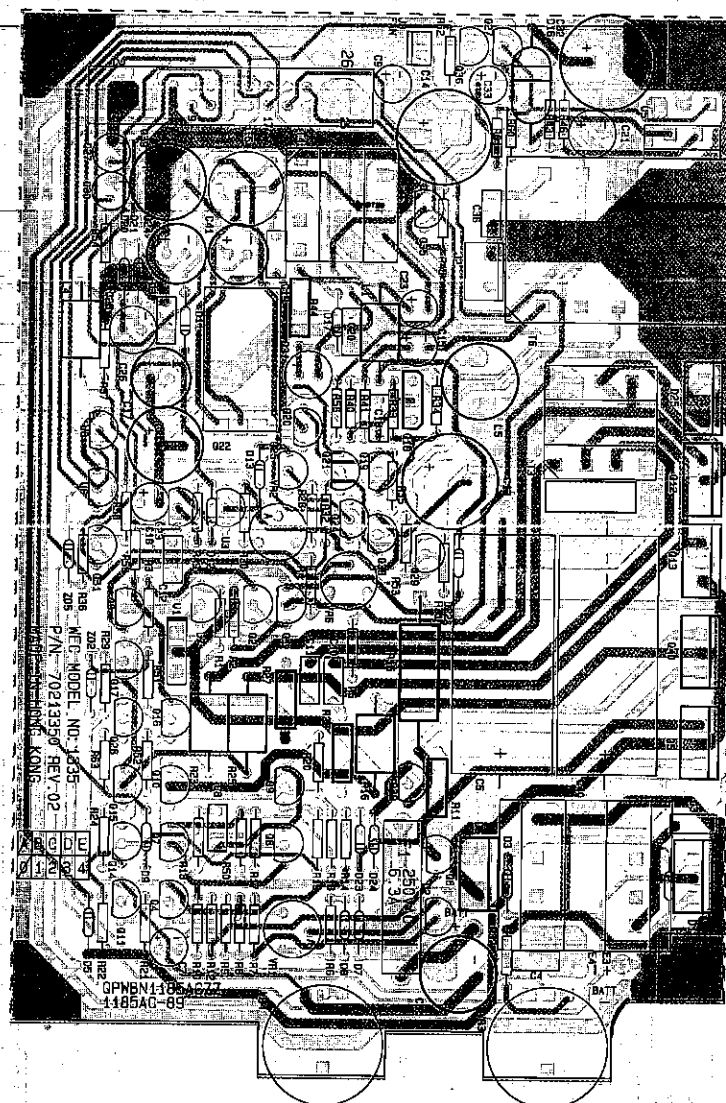


-64-

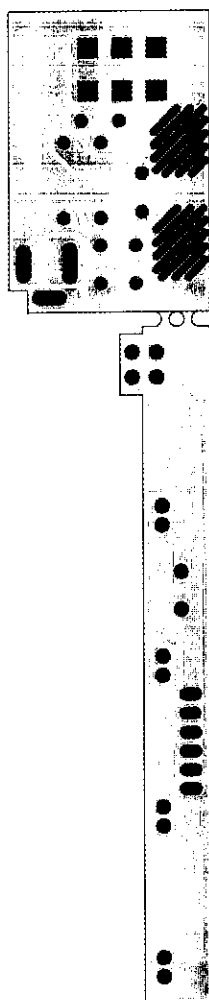




POWER CIRCUIT PARTS LAYOUT



LED P.W.B. & SWITCH P.W.B.



11-00000

SHARP PARTS GUIDE

PC-4602 MODEL PC-4641

CONTENTS

- 1 Exteriors
- 2 Keyboard
- 3 AC adaptor
- 4 FDD ass'y
- 5 Power supply ass'y
- 6 Packing material & Accessories
- 7 Key top kit
- 8 Main logic PWB ass'y
- 9 CE-451A CRT adaptor board (USA-----standard, others-----option)

DESTINATION TABLE

| | | | | |
|---|-----------------------|---|------|--------------|
| U | USA | E | EJ | Korea |
| Y | Canada | | ESC | Venezuela |
| G | Germany, Austria | | ESCI | Taiwan |
| H | U.Kingdom | | EQ | New Zealand |
| Q | Australia | | EH | Malaysia |
| K | Hong Kong | | ESG | Indonesia |
| S | Singapore | | ISGI | Philippines |
| W | Switzerland (Germany) | | ESB | Saudi Arabia |

DEFINITION

The definition of each Rank is as follows and also noted in the list

A: Parts necessary to be stocked as High usage parts.

B: Parts necessary to be stocked as Standard usage parts.

C: Low usage parts.

D: Parts necessary for refurbish.

E: Unit parts recommended to be stocked for efficient after sales service.

Please note that the lead time for the said parts may be longer than normal parts.

S: Consumable parts.

Please note that the following parts used in Copier under the same description are classified into A or B Rank depending upon the place used.

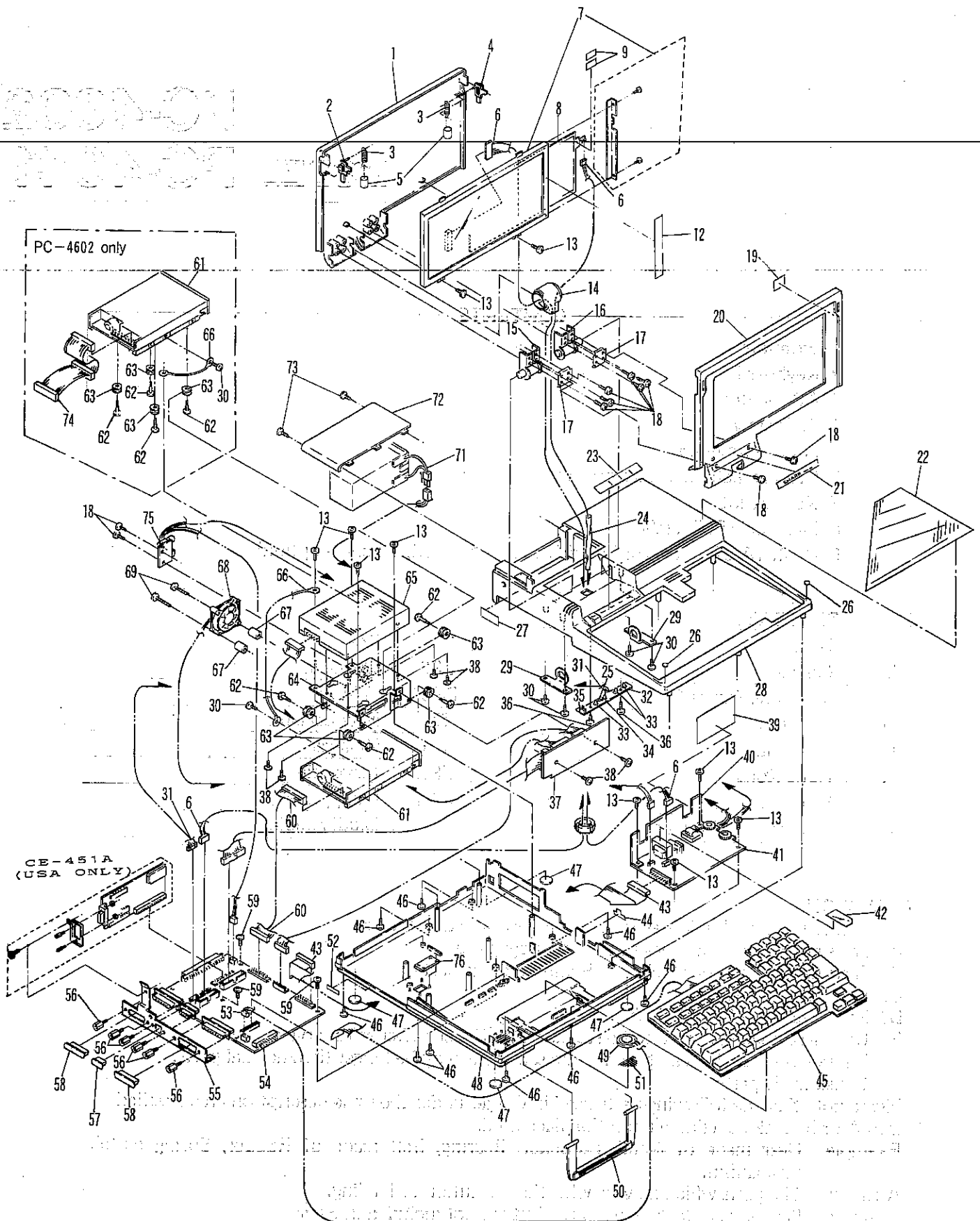
Example: Gear made of Metal, Sprocket, Bearing, Belt made of Rubber, Spring clutch mechanism.

A Rank: The parts which may be with the revolution or loading.

B Rank: Parts similar to A Rank parts, but are not included in Rank A.

Parts marked with "△" are important for maintaining the safety of the set. Be sure to replace these parts with specified ones for maintaining the safety and performance of the set.

1 Exteriors



1 Exteriors

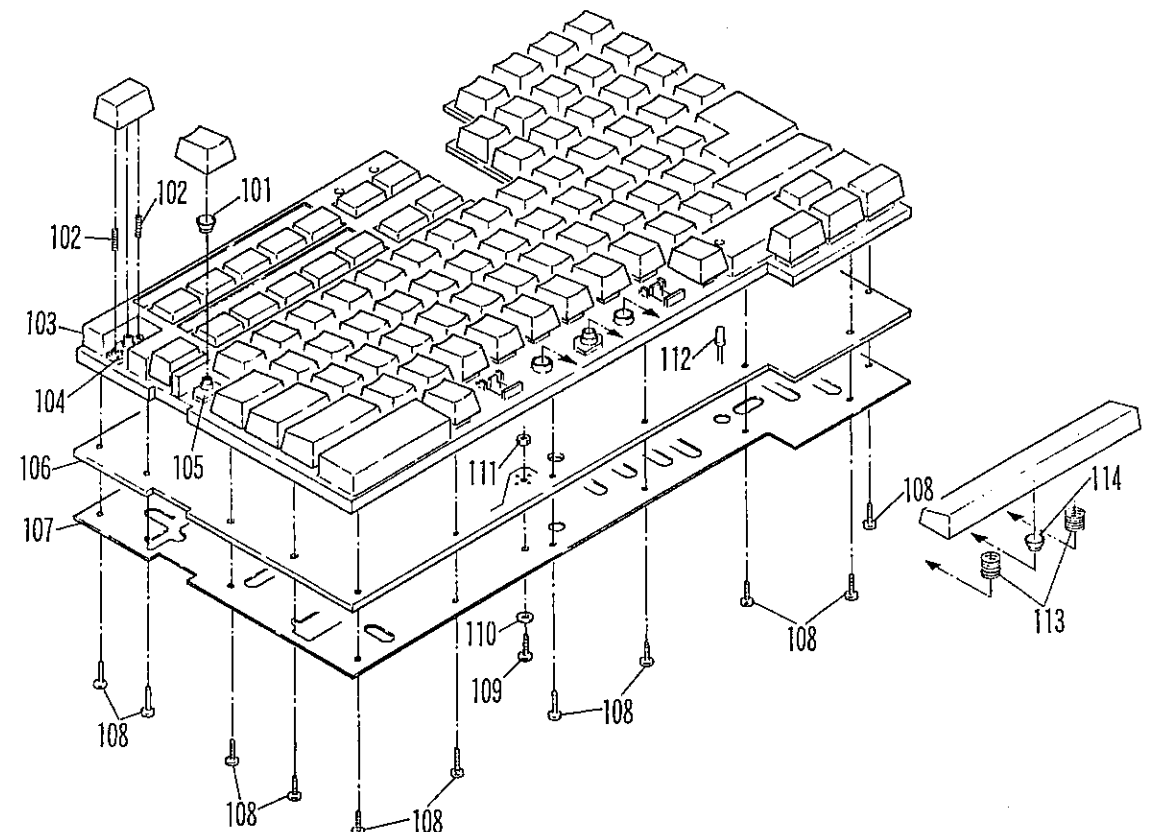
| NO. | PARTS CODE | PRICE RANK | NEW MARK | PART RANK | DESCRIPTION |
|-----|---------------|------------|----------|-----------|--|
| 1 | 0GM73133603 | BA | N | D | CAB-C/White (G,W) |
| | 0GM73133613 | BA | N | D | CAB-C/Black (U,Y,H,Q,K,S,E) |
| 2 | 0GM73133606 | AC | N | C | Hook (L)/White (G,W) |
| | 0GM73133616 | AC | N | C | Hook (L)/Black (U,Y,H,Q,K,S,E) |
| 3 | 0GM44700065 | AC | N | C | Extension spring (G,W) |
| 4 | 0GM73133607 | AC | N | C | Hook (R)/White (U,Y,H,Q,K,S,E) |
| | 0GM73133617 | AC | N | C | Hook (R)/Black |
| 5 | 0GM81100051 | AD | N | C | Sound proofing tube |
| 6 | 0GM91133623 | AZ | N | C | Ass'y,LCD/EL connection (with shrink tube) |
| 7 | DUNT-2229ACZZ | CE | N | E | LCD display ass'y (35200026) |
| 8 | VHPPW17-256A1 | BM | N | D | EL Panel (PW17-256A1)(92133602) |
| 9 | PZETV1042ACZZ | AE | N | C | Insulation sheet 2 (8×15)(81400082) |
| 12 | 0GM60201508 | AD | N | C | Caution label 12×93mm |
| 13 | XUPSD30P08000 | AA | N | C | Screw (3×8)(41200274) |
| | 0GM73133609 | AD | N | C | Cover A/White (G,W) |
| | 0GM73133619 | AD | N | C | Cover A/Black (U,Y,H,Q,K,S,E) |
| 15 | 0GM92133603 | AT | N | C | Roll damper left |
| 16 | 0GM92133604 | AT | N | C | Roll damper right |
| 17 | 0GM40133600 | AC | N | C | Hold angle |
| 18 | XBPSD30P08000 | AA | N | C | Screw (3×8)(41100506) |
| 19 | PZETV1041ACZZ | AE | N | C | Insulation sheet 1 (20×25)(81400081) |
| | 0GM73133604 | AW | N | D | CAB-D/White (G,W) |
| 20 | 0GM73133614 | AW | N | D | CAB-D/Black (U,Y,H,Q,K,S,E) |
| | 0GM60201515 | AE | N | C | Decol sheet/White (G,W) |
| 21 | 0GM60201516 | AE | N | C | Decol sheet/Black (U,Y,H,Q,K,S,E) |
| 22 | 0GM60201541 | AH | N | C | Pop label (PC-4641 only) |
| | 0GM60201519 | AF | N | C | LED panel,cabinet unit/White (PC-4641·G,W) |
| 23 | 0GM60201520 | AF | N | C | LED panel,cabinet unit/Black (PC-4641·U,Y,H,Q,K,S,E) |
| | 0GM60201517 | AF | N | C | LED panel,cabinet unit/White (PC-4602·G,W) |
| | 0GM60201518 | AF | N | C | LED panel,cabinet unit/Black (PC-4602·U,Y,H,Q,K,S,E) |
| 24 | 0GM81200102 | AD | N | C | Heat shrinkable tube |
| 25 | VRD-RC2EY102J | AA | N | C | Resistor (1/4W 1.0KΩ ±5%)(10910252) |
| 26 | GLEGG1024CCZZ | AA | N | C | Rubber foot (80400060) |
| 27 | 0GM60261540 | AB | N | C | DBP NO label (G,W) |
| 28 | 0GM73133602 | BE | N | D | Cab-B/White (U,Y,H,Q,K,S,E) |
| | 0GM73133612 | BE | N | D | Cab-B/Black |
| 29 | 0GM40133604 | AD | N | C | Install angle,roll damper |
| 30 | XBPSD30P06000 | AA | N | C | Screw (3×6)(41100504) |
| 31 | 0GM92126219 | AE | N | C | Cable ass'y |
| 32 | 0GM70113360 | AC | N | C | PWB,for LED (without parts) |
| 33 | VHPL3NG43-1 | AA | N | B | LED(Green) (GL3NG43)(33499901) |
| 34 | VHPL3HD43-1 | AB | N | B | LED(Red) (GL3HD43)(33499902) |
| 35 | QSW-P1067ACZZ | AD | N | B | Push switch (51700216) |
| 36 | LX-BZ1147CCZZ | AA | N | C | Screw (41200335) |
| 37 | DUNTK2232ACZZ | CC | N | C | HDD controller with core (92133757) (PC-4641 only) |
| 38 | XBPSD30P04000 | AA | N | C | Screw (3×4)(41100512) (PC-4641 only) |
| 39 | 0GM81400081 | AH | N | C | Fish paper (PC-4641 only) |
| 40 | 0GM40133500 | AL | N | C | Heatsink,power supply |
| 41 | 0GM1335 | BZ | N | E | Power supply unit |
| 42 | PZETV1043ACZZ | AE | N | C | Insulation sheet 4 (25×34)(81400084) |
| 43 | 0GM92133600 | AW | N | C | Power cable |
| 44 | TLABP1317ACSA | AB | N | C | VR-IND label/Black (60201074-2) (U,Y,H,Q,K,S,E) |
| | TLABP1317ACZZ | AB | N | C | VR-IND label/White (60201074-1) (G,W) |
| 45 | DUNT-2228ACZZ | BK | N | E | Ass'y,keyboard (92133642) (G) |
| | DUNT-2226ACZZ | BK | N | E | Ass'y,keyboard (92133641) (U,Y,Q,S,K,E) |
| | DUNT-2227ACZZ | BK | N | E | Ass'y,keyboard (92133643) (H) |
| | DUNT-2307ACZZ | BK | N | E | Ass'y,keyboard (92133644) (W) |
| 46 | XBPSD30P08000 | AA | N | C | Screw (3×8)(41100510) (G,W) |
| | XBPSF30P08000 | AA | N | C | Screw (M3×8)(41100568) (U,Y,H,Q,K,S,E) |
| 47 | GLEGG1019CCZZ | AB | N | C | Rubber foot (80400039) |
| 48 | 0GM73133601 | BC | N | D | Cab-A/White (G,W) |
| | 0GM73133611 | BC | N | D | Cab-A/Black (U,Y,H,Q,K,S,E) |
| 49 | RALMB1007HCZZ | AK | N | C | Alarm (80)(56100033) |
| 50 | JHNDP1005ACZZ | AF | N | D | Handle/White (73126235-1) (G,W) |
| | JHNDP1005ACSA | AF | N | D | Handle/Black (73126235-2) (U,Y,H,Q,K,S,E) |
| 51 | 0GM40133610 | AD | N | C | Mesh plate (G,W) |
| 52 | 0GM60201513 | AD | N | C | SIO label (G,W) |
| | 0GM60201514 | AD | N | C | SIO label (U,Y,H,Q,K,S,E) |
| 53 | 0GM92130811 | AD | N | C | Speaker OR SW cable |
| 54 | DUNTK2296RHZZ | ** | N | E | Main logic PWB ass'y (PC-4602·U,Y,S,K,E) |
| | DUNTK2295RHZZ | ** | N | E | Main logic PWB ass'y (PC-4602·H,Q) |
| | DUNTK2333RHZZ | ** | N | E | Main logic PWB ass'y (PC-4602·G,W) |
| | DUNTK2294RHZZ | ** | N | E | Main logic PWB ass'y (PC-4641·U,Y,S,K,E) |
| | DUNTK2253RHZZ | ** | N | E | Main logic PWB ass'y (PC-4641·H,Q) |
| | DUNTK2332RHZZ | ** | N | E | Main logic PWB ass'y (PC-4641·G,W) |
| 55 | 0GM40133605 | AG | N | C | Conn angle,cab unit |
| 56 | LX-BZ1141CCZZ | AA | N | C | Screw (40133609) |
| 57 | 0GM81600013 | AD | N | C | CONN cover,9P |
| 58 | 0GM81600012 | AD | N | C | CONN cover,25P |
| 59 | XUPSD30P06000 | AA | N | C | Screw (3×6)(41200271) |

1 Exteriors

| NO. | PARTS CODE | PRICE RANK | NEW MARK | PART RANK | DESCRIPTION |
|-----|---------------|------------|----------|-----------|--|
| 60 | 0GM92133756 | AY | N | C | Single FDD cable (PC-4641 only) |
| | DUNTK2230ACZZ | BU | N | E | FDD(office gray) (92133695) (G,W) |
| 61 | DUNTK2230ACSA | BU | N | E | FDD(asphalt gray) (92133605) (U,Y,H,Q,K,S,E) |
| 62 | LX-BZ1182CCZZ | AB | N | C | Screw (41100517) |
| 63 | PGUMM1562CCZZ | AE | N | C | Rubber (80400062) |
| 64 | 0GM40133606 | AP | N | C | Intall angle |
| 65 | DUNTK2231ACZZ | ** | N | D | Hard disk 40MH (92133750) (PC-4641 only) |
| 66 | QCNW-1239ACZZ | AB | N | C | FDD GD cable (92126226) |
| 67 | 0GM81300095 | AB | N | C | Spacer (PC-4641 only) |
| 68 | 0GM54300020 | BC | N | B | Fan (PC-4641 only) |
| 69 | 0GM41100613 | AD | N | C | Screw (3×23) (PC-4641 only) |
| 71 | UBATZ1003ACZA | BA | N | A | Battery (83400012) |
| 72 | 0GM73133605 | AN | N | C | Battery cover/White (G,W) |
| | 0GM73133615 | AN | N | C | Battery cover/Black (U,Y,H,Q,K,S,E) |
| 73 | LX-BZ1027ACSA | AB | N | C | Screw (41100570) (U,Y,H,Q,K,S,E) |
| | LX-BZ1027ACZZ | AB | N | C | Screw (41100508) (G,W) |
| 74 | 0GM92133670 | AY | N | C | Double FDD cable (PC-4602 only) |
| 75 | 0GM70113361 | AC | N | C | PWB for S/S switch & AC adaptor jack (without parts) |
| | 0GM40133611 | AC | N | C | Cover plate/White (G,W) |
| 76 | 0GM40133612 | AC | N | C | Cover plate/Black (U,Y,H,Q,S,K,E) |

2 Keyboard

| | | | | | | | | | | | | | | |
|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | | | 87 | 88 | 71 | 70 | |
| | | | | | | | | | | 83 | 84 | 85 | 86 | 90 |
| 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 | | | 79 | 80 | 81 | 82 | 89 |
| 17 | 18 | 19 | 20 | 21 | 22 | 23 | 24 | 25 | 26 | 27 | 28 | 29 | 30 | 31 |
| 32 | 33 | 34 | 35 | 36 | 37 | 38 | 39 | 40 | 41 | 42 | 43 | 44 | | |
| 46 | 47 | 48 | 49 | 50 | 51 | 52 | 53 | 54 | 55 | 56 | 57 | | 45 | |
| 58 | 59 | 60 | 61 | 62 | 63 | 64 | 65 | 66 | 67 | 68 | | 69 | | |
| 71 | | 72 | | 73 | | | | 74 | | | | 75 | | |
| | | | | | | | | | | | | 76 | 77 | 78 |



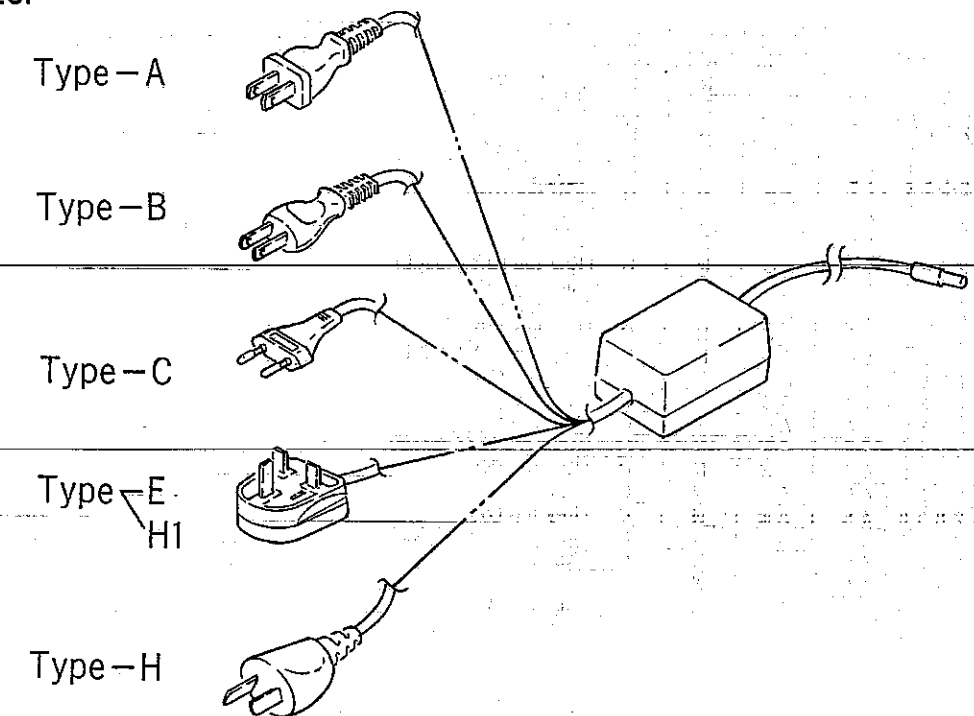
2 Keyboard

| NO. | PARTS CODE | PRICE RANK | NEW MARK | PART RANK | DESCRIPTION |
|-----|---------------|------------|----------|-----------|-----------------------|
| 21 | 0CFR562761/21 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/21 | AG | N | C | Key top (H) |
| | 0CFR562763/21 | AG | N | C | Key top (G) |
| | 0CFR562830-21 | AG | N | C | Key top (W) |
| 22 | 0CFR562761/22 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/22 | AG | N | C | Key top (H) |
| | 0CFR562763/22 | AG | N | C | Key top (G) |
| | 0CFR562830-22 | AG | N | C | Key top (W) |
| 23 | 0CFR562761/23 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/23 | AG | N | C | Key top (H) |
| | 0CFR562763/23 | AG | N | C | Key top (G) |
| | 0CFR562830-23 | AG | N | C | Key top (W) |
| 24 | 0CFR562761/24 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/24 | AG | N | C | Key top (H) |
| | 0CFR562763/24 | AG | N | C | Key top (G) |
| | 0CFR562830-24 | AG | N | C | Key top (W) |
| 25 | 0CFR562761/25 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/25 | AG | N | C | Key top (H) |
| | 0CFR562763/25 | AG | N | C | Key top (G) |
| | 0CFR562830-25 | AG | N | C | Key top (W) |
| 26 | 0CFR562761/26 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/26 | AG | N | C | Key top (H) |
| | 0CFR562763/26 | AG | N | C | Key top (G) |
| | 0CFR562830-26 | AG | N | C | Key top (W) |
| 27 | 0CFR562761/27 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/27 | AG | N | C | Key top (H) |
| | 0CFR562763/27 | AG | N | C | Key top (G) |
| | 0CFR562830-27 | AG | N | C | Key top (W) |
| 28 | 0CFR562761/28 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/28 | AG | N | C | Key top (H) |
| | 0CFR562763/28 | AG | N | C | Key top (G) |
| | 0CFR562830-28 | AG | N | C | Key top (W) |
| 29 | 0CFR562761/29 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/29 | AG | N | C | Key top (H) |
| | 0CFR562763/29 | AG | N | C | Key top (G) |
| | 0CFR562830-29 | AG | N | C | Key top (W) |
| 30 | 0CFR562761/30 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/30 | AG | N | C | Key top (H) |
| | 0CFR562763/30 | AG | N | C | Key top (G) |
| | 0CFR562830-30 | AG | N | C | Key top (W) |
| 31 | 0CFR562761/31 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/31 | AG | N | C | Key top (H) |
| | 0CFR562763/31 | AG | N | C | Key top (G) |
| | 0CFR562830-31 | AG | N | C | Key top (W) |
| 32 | 0CFR562761/32 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/32 | AG | N | C | Key top (H) |
| | 0CFR562763/32 | AG | N | C | Key top (G) |
| | 0CFR562830-32 | AG | N | C | Key top (W) |
| 33 | 0CFR562761/33 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/33 | AG | N | C | Key top (H) |
| | 0CFR562763/33 | AG | N | C | Key top (G) |
| | 0CFR562830-33 | AG | N | C | Key top (W) |
| 34 | 0CFR562761/34 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/34 | AG | N | C | Key top (H) |
| | 0CFR562763/34 | AG | N | C | Key top (G) |
| | 0CFR562830-34 | AG | N | C | Key top (W) |
| 35 | 0CFR562761/35 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/35 | AG | N | C | Key top (H) |
| | 0CFR562763/35 | AG | N | C | Key top (G) |
| | 0CFR562830-35 | AG | N | C | Key top (W) |
| 36 | 0CFR562761/36 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/36 | AG | N | C | Key top (H) |
| | 0CFR562763/36 | AG | N | C | Key top (G) |
| | 0CFR562830-36 | AG | N | C | Key top (W) |
| 37 | 0CFR562761/37 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/37 | AG | N | C | Key top (H) |
| | 0CFR562763/37 | AG | N | C | Key top (G) |
| | 0CFR562830-37 | AG | N | C | Key top (W) |
| 38 | 0CFR562761/38 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/38 | AG | N | C | Key top (H) |
| | 0CFR562763/38 | AG | N | C | Key top (G) |
| | 0CFR562830-38 | AG | N | C | Key top (W) |
| 39 | 0CFR562761/39 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/39 | AG | N | C | Key top (H) |
| | 0CFR562763/39 | AG | N | C | Key top (G) |
| | 0CFR562830-39 | AG | N | C | Key top (W) |
| 40 | 0CFR562761/40 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/40 | AG | N | C | Key top (H) |
| | 0CFR562763/40 | AG | N | C | Key top (G) |
| | 0CFR562830-40 | AG | N | C | Key top (W) |

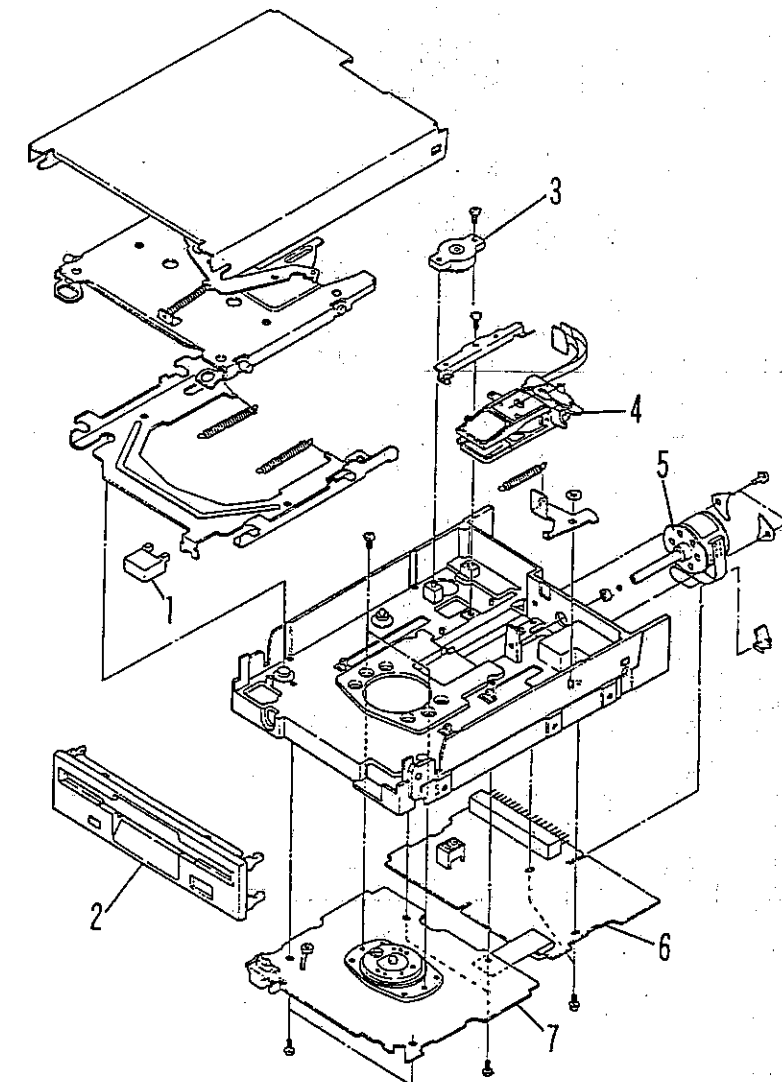
2 Keyboard

| NO. | PARTS CODE | PRICE RANK | NEW MARK | PART RANK | DESCRIPTION |
|-----|---------------|------------|----------|-----------|---------------------------|
| 81 | 0CFR562761/81 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/81 | AG | N | C | Key top (H) |
| | 0CFR562763/81 | AG | N | C | Key top (G) |
| | 0CFR562830-81 | AG | N | C | Key top (W) |
| 82 | 0CFR562761/82 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/82 | AG | N | C | Key top (H) |
| | 0CFR562763/82 | AG | N | C | Key top (G) |
| | 0CFR562830-82 | AG | N | C | Key top (W) |
| 83 | 0CFR562761/83 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/83 | AG | N | C | Key top (H) |
| | 0CFR562763/83 | AG | N | C | Key top (G) |
| | 0CFR562830-83 | AG | N | C | Key top (W) |
| 84 | 0CFR562761/84 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/84 | AG | N | C | Key top (H) |
| | 0CFR562763/84 | AG | N | C | Key top (G) |
| | 0CFR562830-84 | AG | N | C | Key top (W) |
| 85 | 0CFR562761/85 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/85 | AG | N | C | Key top (H) |
| | 0CFR562763/85 | AG | N | C | Key top (G) |
| | 0CFR562830-85 | AG | N | C | Key top (W) |
| 86 | 0CFR562761/86 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/86 | AG | N | C | Key top (H) |
| | 0CFR562763/86 | AG | N | C | Key top (G) |
| | 0CFR562830-86 | AG | N | C | Key top (W) |
| 87 | 0CFR562761/87 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/87 | AG | N | C | Key top (H) |
| | 0CFR562763/87 | AG | N | C | Key top (G) |
| | 0CFR562830-87 | AG | N | C | Key top (W) |
| 88 | 0CFR562761/88 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/88 | AG | N | C | Key top (H) |
| | 0CFR562763/88 | AG | N | C | Key top (G) |
| | 0CFR562830-88 | AG | N | C | Key top (W) |
| 89 | 0CFR562761/89 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/89 | AG | N | C | Key top (H) |
| | 0CFR562763/89 | AG | N | C | Key top (G) |
| | 0CFR562830-89 | AG | N | C | Key top (W) |
| 90 | 0CFR562761/90 | AG | N | C | Key top (U,Y,Q,S,K,E) |
| | 0CFR562762/90 | AG | N | C | Key top (H) |
| | 0CFR562763/90 | AG | N | C | Key top (G) |
| | 0CFR562830-90 | AG | N | C | Key top (W) |
| 101 | 0CF567664C | AA | N | C | Rubber RT |
| 102 | 0CF56A185F | AA | N | C | Spring for half key |
| 103 | 0CF56B036A | AQ | N | C | Frame (G,W) |
| | 0CF56B036B | AQ | N | C | Frame (U,Y,Q,S,K,E,H) |
| 104 | 0CF565665A | AB | N | C | Switch for half key |
| 105 | 0CF565524B | AB | N | C | Switch |
| 106 | 0CF56H089B | BD | N | C | PWB (G,H,W) |
| | 0CF56H089A | BD | N | C | PWB (U,Y,Q,S,K,E) |
| 107 | 0CF56A514B | AK | N | C | Shield plate |
| 108 | 0CF564965C | AA | N | C | Screw (M2×6) |
| 109 | 0CF560088B | AA | N | C | Screw (M3×5) |
| 110 | 0CF561565A | AA | N | C | Washer (M3) |
| 111 | 0CF560940A | AA | N | C | Nut (M3×0.5) |
| 112 | 0CF565033M | AD | N | B | LED-R |
| 113 | 0CF567955A | AA | N | C | Spring C for space key |
| 114 | 0CF567664D | AA | N | C | Rubber RT for space key |
| | (Unit) | | | | |
| 901 | DUNT-2228ACZZ | BK | N | E | Ass'y,keyboard (92133642) |
| | DUNT-2226ACZZ | BK | N | E | Ass'y,keyboard (92133641) |
| | DUNT-2227ACZZ | BK | N | E | Ass'y,keyboard (92133643) |
| | DUNT-2307ACZZ | BK | N | E | Ass'y,keyboard (92133644) |

3 AC adaptor



4 FDD ass'y



4 FDD ass'y

| NO. | PARTS CODE | PRICE RANK | NEW MARK | PART RANK | DESCRIPTION |
|-----|---------------|------------|----------|-----------|---|
| 1 | 00G1678803909 | AC | N | D | Button(office gray) (For DUNTK2230ACZZ) |
| | 00G1678803910 | AC | N | D | Button(asphalt gray) (For DUNTK2230ACSA) |
| 2 | 00G1796769609 | AH | N | D | Front bezel ass'y(office gray) (For DUNTK2230ACZZ) |
| | 00G1796769610 | AH | N | D | Front bezel ass'y(asphalt gray) (For DUNTK2230ACSA) |
| 3 | 00G17967693 | AH | N | E | Damper ass'y |
| 4 | 00G1796772900 | BP | N | E | Head carriage ass'y(Note 1) |
| 5 | 00G1476943000 | AY | N | E | Stepping motor ass'y |
| 6 | 00G1553211005 | BL | N | E | PCBA MFD control T |
| 7 | 00G1473403432 | BM | N | E | Spindle motor ass'y |
| 101 | 00G1490051603 | CP | N | D | Alignment disk |
| 102 | 00G1490051701 | CE | N | D | Level disk |
| | (Unit) | | | | |
| 901 | DUNTK2230ACZZ | BU | N | E | FDD(office gray) (G.W) |
| | DUNTK2230ACSA | BU | N | E | FDD(asphalt gray) (U,Y,H,Q,K,S,E) |

5 Power supply ass'y

| NO. | PARTS CODE | PRICE RANK | NEW MARK | PART RANK | DESCRIPTION |
|-----|---------------|------------|----------|-----------|--|
| 1 | VRD-HT2EY122J | AA | | C | Resistor (1/4W 1.2KΩ ±5%)(10112251) [R54] |
| 2 | VRD-HT2EY2R2J | AA | N | C | Resistor (1/4W 2.2Ω ±5%)(10122851) [R11,26,27] |
| 3 | VRD-HT2EY101J | AA | | C | Resistor (1/2W 100Ω ±5%)(10210151) [R25] |
| 4 | VRD-HT2HY221J | AB | | C | Resistor (1/2W 220Ω ±5%)(10222151) [R23] |
| 5 | VRD-HT2EY102J | AA | | C | Resistor (1/4W 1KΩ ±5%)(10510251) [R44,51,53,61] |
| 6 | VRD-HT2EY103J | AA | | C | Resistor (1/4W 10KΩ ±5%)(10510351) [R3,6,7,12,29,31,45,52,59,64] |
| 7 | VRD-HT2EY104J | AA | | C | Resistor (1/4W 100KΩ ±5%)(10510451) [R1,4,5] |
| 8 | VRD-HT2EY120J | AA | | C | Resistor (1/4W 12Ω ±5%)(10512051) [R41] |
| 9 | VRD-HT2EY163J | AA | | C | Resistor (1/4W 16KΩ ±5%)(10516351) [R19,32,49,56,63] |
| 10 | VRD-HT2EY222J | AA | | C | Resistor (1/4W 2.2KΩ ±5%)(10522251) [R14,17,20,36,50] |
| 11 | VRD-HT2EY224J | AA | | C | Resistor (1/4W 220KΩ ±5%)(10522451) [R2] |
| 12 | VRD-HT2EY271J | AA | | C | Resistor (1/4W 270Ω ±5%)(10527151) [R35] |
| 13 | VRD-HT2EY332J | AA | | C | Resistor (1/4W 3.3KΩ ±5%)(10533251) [R21,28,30,34,37] |
| 14 | VRD-HT2EY272J | AA | N | C | Resistor (1/4W 2.7KΩ ±5%)(10547251) [R18] |
| 15 | VRD-HT2EY472J | AA | | C | Resistor (1/4W 4.7KΩ ±5%)(10547251) [R9,10,13,22,24,58] |
| 16 | VRD-HT2EY561J | AA | | C | Resistor (1/4W 560Ω ±5%)(10556151) [R8] |
| 17 | VRD-HT2EY562J | AA | | C | Resistor (1/4W 5.6KΩ ±5%)(10556251) [R40] |
| 18 | VRD-HT2EY822J | AA | | C | Resistor (1/4W 8.2KΩ ±5%)(10582251) [R33] |
| 19 | VRNHT2EK1072F | AA | N | C | Resistor (1/4W 10.7KΩ ±1%)(11010721) [R43] |
| 20 | VRNHT2EK1241F | AA | N | C | Resistor (1/4W 1.24KΩ ±1%)(11012411) [R46] |
| 21 | VRNHT2EK4122F | AA | N | C | Resistor (1/4W 41.2KΩ ±1%)(11041221) [R57] |
| 22 | 0GM13362950 | AD | N | C | Resistor (3W 0.62R 5%) [R15] |
| 23 | 0GM18120220 | AF | N | C | Variable resistor (2KΩ) [VR2] |
| 24 | RVR-P1009ACZZ | AE | N | B | Variable resistor (20KΩ)(18120390) [VR3,4] |
| 25 | 0GM18130301 | AF | N | C | Variable resistor (30KΩ) [VR6] |
| 26 | 0GM18150202 | AF | N | B | Variable resistor (5KΩ) [VR1] |
| 27 | 0GM20210359 | AB | N | C | Capacitor (0.01μF) [C20] |
| 28 | 0GM20247302 | AB | N | C | Capacitor (0.047μF) [C8,10,11,12] |
| 29 | 0GM20256105 | AB | N | C | Capacitor (560pF 500V) [C36] |
| 30 | RC-KZ1054CCZZ | AB | | C | Capacitor (0.1μF 50V)(20310400) [C1~4,38] |
| 31 | VCQYNU1HM473K | AB | | C | Capacitor (0.047μF)(22147302) [C16,19] |
| 32 | 0GM24122800 | AG | N | C | Capacitor (2200μF 16V) [C5,40] |
| 33 | VCEAEU1HW105M | AA | N | C | Capacitor (1μF 50V)(24210525) [C33] |
| 34 | 0GM24210618 | AC | N | C | Capacitor (10μF 16V) [C9,23] |
| 35 | 0GM24210631 | AC | N | C | Capacitor (10μF 6.3V) [C18] |
| 36 | 0GM24210827 | AD | N | C | Capacitor (1000μF 6.3V) [C13,14] |
| 37 | VHi79M12AUC-1 | AP | N | B | IC (79L12) [C24] |
| 38 | 0GM24222619 | AC | N | C | Capacitor (22μF 50V) [C17,32] |
| 39 | 0GM24222702 | AB | N | C | Capacitor (220μF 16V) [C15,21,27] |
| 40 | 0GM24233603 | AB | N | C | Capacitor (33μF 16V) [C25,26] |
| 41 | 0GM24233611 | AC | N | C | Capacitor (33μF 35V) [C41] |
| 42 | 0GM24233612 | AC | N | C | Capacitor (33μF 25V) [C7] |
| 43 | 0GM24247501 | AB | N | C | Capacitor (4.7μF 25V) [C6] |
| 44 | 0GM24247715 | AB | N | C | Capacitor (470μF 10V) [U2,3,7] |
| 45 | 0GM31104310 | AF | N | B | Shunt regulator (UA431) [U5] |
| 46 | 0GM31110700 | BB | N | B | SA switching(LT1071) [U1] |
| 47 | VHiMN1280T/-1 | AE | | B | IC regulator (MN1280T)(31112800) [U6] |
| 48 | 0GM31179052 | AF | N | B | IC (79L05) [Q18] |
| 49 | 0GM32102000 | AG | N | B | Transistor (NPN MJE200) [Q2~4,8~11,14,15,19,20,21,25,26,38] |
| 50 | 0GM32112131 | AC | N | B | Transistor (2SC1213A NPN) [Q17,35] |
| 51 | 0GM32180500 | AB | N | B | Transistor (8050 NPN) [Q22] |
| 52 | 0GM32204505 | AL | N | B | Transistor (D45H5 TO-220) [Q1,5,6,7,16,23,39] |
| 53 | VS2SA673AB/-1 | AE | | B | Transistor (2SA673A)(32206730) [Q40] |
| 54 | 0GM32214430 | AP | N | B | Transistor (PNP 2SA1443) [Q12,13] |
| 55 | 0GM32214440 | AQ | N | B | Transistor (PNP 2SA1444) [Q24,29,31] |
| 56 | 0GM32285500 | AB | N | B | Transistor (LM8550 PNP) [D11,13,17,20,21] |
| 57 | 0GM33101004 | AB | N | B | Diode (1F1 1A) [D1] |
| 58 | 0GM33101040 | AR | N | B | Dual diode (S10SC4M) |

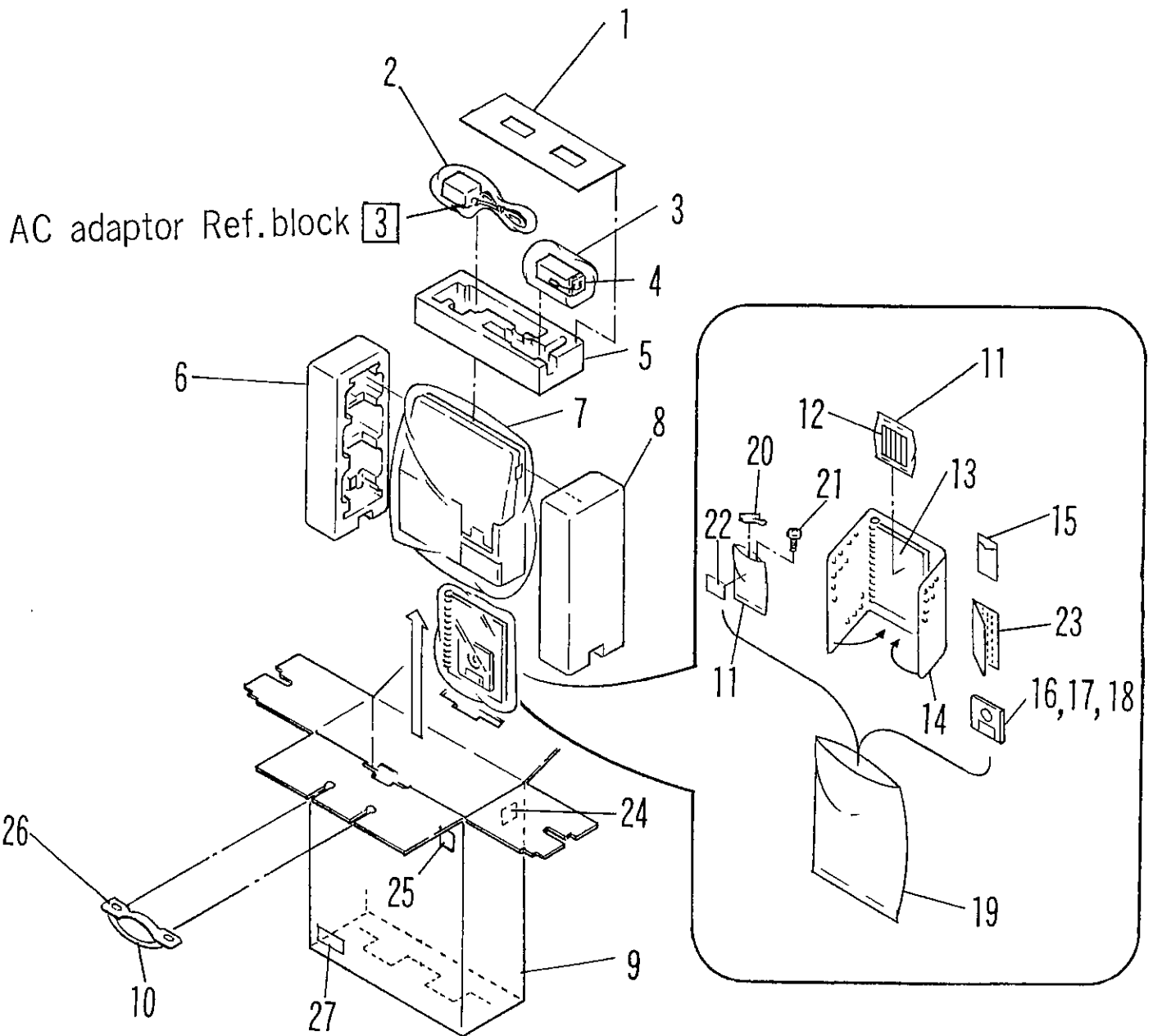
5 Power supply ass'y

| NO. | PARTS CODE | PRICE RANK | NEW MARK | PART RANK | DESCRIPTION |
|-----|---------------|------------|----------|-----------|---|
| 59 | 0GM33103035 | AH | N | B | Schottky diode (SR303) |
| 60 | 0GM33105301 | AQ | N | B | Schottky diode (5A 30V) [D16] |
| 61 | VHD1N4148 | AA | | B | Diode (1N4148)(33241480) [D6,25] |
| 62 | VHEHZ3ALL | AC | | B | Zener diode (HZ3ALL)(33300030) [D3~5,7,8,9,12,23,24,30] |
| 63 | 0GM33352290 | AB | N | B | Diode (IN5229B) |
| 64 | VHD1SS108 | AB | | B | Diode (1SS108) [ZD2] |
| 65 | 0GM33352501 | AB | N | B | Zener diode (IN5250B) [D22] |
| 66 | 0GM40133500 | AL | N | C | Heatsink, power supply [ZD5] |
| 67 | XBPSD30P06000 | AA | | C | Screw (3X6)(41100504) |
| 68 | 0GM42200085 | AA | N | C | Flat-WGS-ZNH4 |
| 69 | QCNCM5016SC0B | AA | | C | Connector (Fan) (2pin)(50400244) |
| 70 | 0GM50400364 | AC | N | C | Connector (3pin) [J3] |
| 71 | 0GM50402627 | AN | N | C | Connector header SO pin [J2] |
| 72 | 0GM50700007 | AD | N | C | Adaptor jack 2mm SMK (S-G9312) [J1] |
| 73 | 0GM51400006 | AM | N | C | SW mini slide C&K : L111 series |
| 74 | 0GM52100030 | AC | N | C | Inductor (100μH) |
| 75 | 0GM52100171 | AF | N | C | Choke (28μH L-5020) [L14] |
| 76 | 0GM52113351 | AH | N | C | Common-mode choke [L5] |
| 77 | 0GM52113352 | AM | N | C | Common mode choke [T1] |
| 78 | 0GM52313353 | AQ | N | B | +5V power transformer [T2] |
| 79 | 0GM52313354 | AP | N | B | +12V power transformer [T3] |
| 80 | 0GM52313355 | AG | N | B | Power transformer [T4] |
| 81 | 0GM52313356 | AT | N | B | Power transformer [T5] |
| 82 | 0GM53113350 | AD | N | A | Fuse (7A 125V) [T6] |
| 83 | 0GM57113350 | AA | N | C | Wire (190mm)(Orange) [F1] |
| 84 | 0GM57113351 | AA | N | C | Wire (190mm)(White) |
| 85 | 0GM70113361 | AC | N | B | PWB, for S/S switch & AC adaptor jack (without parts) |
| 86 | PCOVP6633RCZZ | AB | | C | Fuse cap(TUV regulation) for F1 (73133630) |
| 87 | 0GM81000002 | AB | N | C | Insulator TO-220 |
| 88 | 0GM81300012 | AC | N | C | Nylon insulator |
| 89 | PZETV1043ACZZ | AE | N | C | Insulation sheet 4 (25X34)(81400084) |
| 90 | 0GM92133502 | AG | N | C | Battery cable |
| 91 | 0GM92133510 | AC | N | C | Switch wire ass'y |
| 92 | 0GM92133600 | AW | N | C | Power cable |
| 93 | 0GM991000 | AA | N | C | Heatsink compound #340 |
| 94 | VCEAEU1AW336M | AA | N | C | Capacitor (33μF 10V) |
| 95 | VCEAGU1EW476M | AB | | C | Capacitor (47μF 25V) [C30] |
| 96 | VCSAVU1CE476M | AH | N | C | Capacitor (47μF 16V) [C31] |
| | (Unit) | | | | Capacitor (47μF 16V) [C39] |
| 901 | 0GM1335 | BZ | N | E | Power supply unit |

6 Packing material & Accessories

| NO. | PARTS CODE | PRICE RANK | NEW MARK | PART RANK | DESCRIPTION |
|-----|---------------|------------|----------|-----------|---|
| 1 | 0GM61400728 | AC | N | D | Packing add |
| 2 | SSAKH5002CCZZ | AA | | D | Vinyl bag (160X380mm)(61200873) |
| 3 | SSAKA0019SCZZ | AA | | D | Vinyl bag (120X180mm)(61200866) |
| 4 | UBATZ1003ACZA | BA | | A | Battery (83400012) |
| 5 | 0GM61336003 | AK | N | D | EPS, accessory (Polyform add) |
| 6 | 0GM61336002 | AK | N | D | EPS END, Right (Polyform add) |
| 7 | SSAKA0006WCZZ | AB | | D | Vinyl bag (400X500mm)(61200865) |
| 8 | 0GM61336001 | AK | N | D | EPS END, Left (Polyform add) |
| 9 | 0GM61501020 | AS | N | D | Packing case series |
| | 0GM61501019 | AN | N | D | Packing case series (PC-4641..U,Y) |
| | 0GM61501017 | AS | N | D | Packing case series (PC-4641..H,Q,G,K,S,E,W) |
| | 0GM61501016 | AN | N | D | Packing case series (PC-4602..U,Y) |
| 10 | JHNDP5003SCZZ | AB | | C | Carrying handle (73126260) (PC-4602..H,Q,G,K,S,E,W) |
| 11 | SSAKH0011HCZZ | AA | | D | Vinyl bag (60X140mm)(61200872) |
| 12 | LPLTP1017ACZZ | AB | | C | Ten plate (60200960) |
| 13 | 0GM60300123 | BA | N | D | Operation manual(ENG 3) |
| | 0GM60300121 | AX | N | D | Operation manual(ENG 1) (H,Q,S,K,E) |
| | 0GM60300122 | BG | N | D | Operation manual(ENG 2) (U) |
| 14 | SPAKA1982ACZZ | AE | | D | Packing cushion for inst.book (61200874) (Y) |
| 15 | PCASZ2005HCZA | AC | | D | Reply post envelope (60100235) (U,Y,H,Q,S,K,E) |
| 16 | 0GM60201530 | AC | N | C | Floppy disk label (U) |
| 17 | GCASP5017SCZZ | AE | N | D | Floppy disk case (73126255) |
| 18 | DFLP-1134ACZZ | BF | N | D | Diskette 3-1/2" (85100004) |
| 19 | SSAKH0015HCZZ | AA | | D | Vinly bag (180X280mm)(61200867) |
| 20 | 0GM40133607 | AF | N | C | Modern conn angle(for CE-451M-462M) |
| 21 | 0GM41100611 | AA | N | C | Screw(for CE-451M-462M) (M3X6) |
| 22 | 0GM60201524 | AB | N | C | Explanation label |
| 23 | 0GM60300124 | AG | N | C | Warranty sheet |
| 24 | 0GM60201509 | AD | N | C | UPC label(Bar code) (Q only) |
| | 0GM60201510 | AB | N | C | UPC label(Bar code) (PC-4602..Y only) |
| 25 | TLABM1338ACZZ | AB | N | C | Destination label (60201094) (PC-4641..Y only) |
| 26 | SPAKA5416SCZZ | AB | | D | Handle packing cushion (61400675) (W) |
| 27 | 0GM60201522 | AC | N | C | Address label |
| 101 | 0GM61501018 | AK | N | D | Master packing carton (Y only) |
| | 0GM61501015 | AK | N | D | Master packing carton (PC-4641 only) |
| | | | | | (PC-4602 only) |

6 Packing material & Accessories



7 Key top kit

| NO. | PARTS CODE | PRICE RANK | NEW MARK | PART RANK | DESCRIPTION |
|-----|---------------|------------|----------|-----------|---|
| 1 | DUNT-2238ACZZ | — | N | E | CE-460KE Key top kit(English)service parts is not available. only available as sales item |
| | DUNT-2239ACZZ | — | N | E | CE-460KF Key top kit(France)service parts is not available. only available as sales item |
| | DUNT-2240ACZZ | — | N | E | CE-460KW Key top kit(Italy,Switzerland)service parts is not available. only available as sales item |
| | DUNT-2241ACZZ | — | N | E | CE-460KS Key top kit(Scandinavia)service parts is not available. only available as sales item |
| | DUNT-2242ACZZ | — | N | E | CE-460KM Key top kit(Spain)service parts is not available. only available as sales item |

8 Main logic PWB ass'y

| NO. | PARTS CODE | PRICE RANK | NEW MARK | PART RANK | DESCRIPTION |
|-----|---------------|------------|----------|-----------|--|
| 1 | VRS-TP2BD100J | AA | | C | Resistor (1/8W 10Ω ±5%)(10010052) [R22,28] |
| 2 | VRS-TP2BD102J | AA | | C | Resistor(1/8W 1.0KΩ ±5%)(10010252) [R2~7,16,26,37,38] |
| 3 | VRS-TP2BD103J | AA | | C | Resistor (1/8W 10KΩ ±5%)(10010352) [R40] |
| 4 | VRS-TP2BD104F | AA | N | C | Resistor(1/8W 100KΩ ±1%)(10010412) [R9,10] |
| 6 | VRS-TP2BD104J | AA | | C | Resistor (1/8W 100KΩ ±5%)(10010452) [R14,31,41] |
| 7 | VRS-TP2BD105J | AA | | C | Resistor(1/8W 1MΩ ±5%)(10010552) [R21,24,27,34,48] |
| 8 | VRS-TP2BD152J | AA | | C | Resistor (1/8W 1.5KΩ ±5%)(10015252) [R42,43,47] |
| 9 | VRS-TP2BD153J | AA | | C | Resistor (1/8W 15KΩ ±5%)(10015352) [R33] |
| 10 | VRS-TP2BD222J | AA | | C | Resistor (1/8W 2.2KΩ ±5%)(10022252) [R17,19] |
| 11 | VRS-TP2BD303F | AA | N | C | Resistor (1/8W 30KΩ ±1%)(10030312) [R11] |
| 12 | VRS-TP2BD333F | AA | N | C | Resistor (1/8W 33KΩ ±1%)(10033312) [R12] |
| 13 | VRS-TP2BD333J | AA | | C | Resistor (1/8W 33KΩ ±5%)(10033352) [R13] |
| 14 | VRS-TP2BD392J | AA | | C | Resistor (1/8W 3.9KΩ ±5%)(10039252) [R39] |
| 15 | VRS-TP2BD470J | AA | | C | Resistor (1/8W 47Ω ±5%)(10047052) [R18,20,35,46] |
| 16 | VRS-TP2BD471J | AA | | C | Resistor (1/8W 470Ω ±5%)(10047152) [R23] |
| 17 | VRS-TP2BD474J | AA | | C | Resistor (1/8W 470KΩ ±5%)(10047452) [R8] |
| 18 | VRS-TP2BD560J | AA | | C | Resistor (1/8W 56Ω ±5%)(10056052) [R1] |
| 19 | VRS-TP2BD562J | AA | | C | Resistor (1/8W 5.6KΩ ±5%)(10056252) [R25] |
| 20 | VRS-TP2BD563J | AA | | C | Resistor(1/8W 56KΩ ±5%)(10056352) [R29,30,36,44,45] |
| | VRS-TP2BD563J | AA | | C | Resistor(1/8W 56KΩ ±5%)(10056352)(PC-4641 only) [R15] |
| 21 | VRS-TP2BD683J | AB | | C | Resistor (1/8W 68KΩ ±5%)(10068352) [R32] |
| | VRD-RC2EY000J | AA | | C | Resistor (1/4W 0Ω ±5%)(10900052) [J1] |
| 22 | VRD-RC2EY000J | AA | | C | Resistor(1/4W 0Ω ±5%)(10900052)(PC-4602 only) [J2] |
| | VRD-RC2EY000J | AA | | C | Resistor(1/4W 0Ω ±5%)(10900052)(PC-4641 only) [J5] |
| 23 | RMPTC4102QCJB | AB | | B | Resistor array (1KΩ×4 1/8W ±5%)(14010253) [RN1,3] |
| 24 | RMPTC7123QCJB | AC | N | B | Resistor array (12KΩ×7 1/8W ±5%)(14012353) [RN2] |
| 25 | RMPTC4152QCJB | AC | N | B | Resistor farray (1.5KΩ×4 1/8W ±5%)(14015200) [RN6] |
| 26 | RMPTC8472QCJB | AB | N | B | Resistor ntwek (4.7KΩ×8 1/8W ±5%)(14047257) [RN10] |
| 27 | RMPTC4472QCJB | AB | | B | Resistor net (4.7KΩ×4 1/8W ±5%)(14047265) [RN12] |
| 28 | RMPTC8563QCJB | AC | | B | Resistor array bus (S) (56KΩ×8 1/8W ±5%)(14056251) [RN8] |
| 29 | RMPTC4563QCJB | AB | | B | Resistor array (56KΩ×4 1/8W ±5%)(14056350) [RN7] |
| 30 | 0GM14147051// | AM | N | B | Resistor array (47R 2×8 SMD) [RN4,5,9,11] |
| 31 | VCCCTS1HH100J | AA | N | C | Capacitor (10pF 50V)(20210021) [C23,27] |
| 32 | VCKYTS1HB102K | AA | N | C | Capacitor (1000pF 50V)(20210224) [C38] |
| 33 | VCKYTS1HB103K | AA | N | C | Capacitor (0.01μF 50V)(20210384) [C41] |
| 34 | 0GM20210486// | AC | N | C | Capacitor(0.1μF) [C5,7,10,11,16,17,21,29,33,34,35,37,44] |
| | 0GM20210486// | AC | N | C | Capacitor (0.1μF)(PC-4641 only) [C13] |
| 35 | VCCCTS1HH150J | AA | N | C | Capacitor(15pF 50V)(20215007) [C19,20,30,31,39,42] |
| 36 | VCCCTS1HH180J | AA | N | C | Capacitor (18pF 50V)(20218003) [C28] |
| 37 | VCCCTS1HH220J | AA | N | C | Capacitor (22pF 50V)(20222009) [C24,50] |
| 38 | VCCCTS1HH330J | AA | N | C | Capacitor (33pF 50V)(20233009) [C26,32] |
| | VCCCTS1HH330J | AA | N | C | Capacitor (33pF 50V)(20233009)(U,Y,S,K,E) [CBS2] |
| 39 | VCCCTS1HH470J | AA | | C | Capacitor (47pF 50V)(20247012) [C18,40,46,49,CLCD0~7] |
| | VCCCTS1HH470J | AA | | C | Capacitor (47pF 50V)(20247012)(U,Y,S,K,E) [CS2] |
| 40 | RC-KZ1054CCZZ | AB | | C | Capacitor(MN 50V 0.1μF)(20310400) [C1~4,22,25,43,47] |
| 41 | VCEAEU1HW105M | AA | N | C | Capacitor (1μF 50V)(24210525) [C36] |
| 42 | VCEAEA1CW106M | AC | N | C | Capacitor(10μF 16V)(24210609) [C6,8,9,12,14,15,45,48] |
| 43 | 0GM30274383// | AE | N | B | IC (74LS38) [U33,36] |
| 44 | VHiTC4S71F/-1 | AC | | B | IC (TC4S71F)(30640713) [U26] |
| 45 | VHiTC4S81F/-1 | AC | | B | IC (TC4S81F)(30640810) [U23] |
| 46 | VHiM4464-12PZ | AU | N | B | IC(M4464-12PZ)(30704642) [U1~15,17~21,41~44] |
| 47 | VHiLU57844P-1 | AU | N | B | IC (LU57844P)(30857840) [U24] |
| 48 | 0GM30870201// | BU | N | B | IC (UPD70208-10) [U34] |
| 49 | 0GM30882503// | BK | N | B | IC (82C50A) [U46] |
| 50 | VHiLZ95H12/-1 | BA | N | B | IC (LZ95H12)(30913360) [U29] |
| 51 | VHiLZ93J21/-1 | BC | N | B | IC (LZ93J21)(30913361) [U45] |
| 52 | VHiTC8566F/-1 | BB | | B | IC (TC8566F)(30927940) [U35] |
| 53 | 0GM31514886// | AQ | N | B | IC (14C88) [U40] |
| 54 | 0GM31514894// | AQ | N | B | IC (14C89A) [U39] |
| 55 | VHiBA6251AF-1 | AE | N | B | TR.Array (BA6251F)(31862510) [U16,47,48] |
| 56 | 0GM31904311// | AF | N | B | IC (TL431C) [U25] |
| 57 | VS2SC2021-/-1 | AB | | B | Transistor (2SC2021)(32120210) [Q3] |
| 58 | 0GM32127120// | AB | N | B | XTOR SMD IC (100MA HFE=10D C2712Y) [Q1,2] |
| 59 | VHD1SS108// | AB | | B | Diode (1SS108)(33001080) [D4~9] |
| 60 | VHDDSS133HV-1 | AA | | B | Diode (1SS133)(33001330) [D1~3] |
| 61 | VHi27C51AAA0A | BF | N | B | IC EP ROM (27C51AAA0A)(U,Y,S,K,E) [U22] |
| | VHi27C51AAA1A | BF | N | B | IC EPROM (27C51AAA1A)(G,H,Q,W) [U22] |

8 Main logic PWB ass'y

| NO. | PARTS CODE | PRICE RANK | NEW MARK | PART RANK | DESCRIPTION | |
|-----|----------------|------------|----------|-----------|--|-----------------------------|
| 62 | 0GM37641253// | AG | N | B | IC (74HC125) | [U27] |
| 63 | 0GM37641573// | AG | N | B | IC (74HC157) | [U32] |
| 64 | 0GM37674003// | AF | N | B | IC (74HC00) | [U31] |
| 65 | 0GM37674043// | AE | N | B | IC (74HC04) | [U30,37] |
| 66 | 0GM37674323// | AF | N | B | IC (74HC32) | [U38] |
| 67 | 0GM50102500// | AK | N | C | CONN Edge 1x25 header | [CN6(KEYB)] |
| 68 | QSOCC26428ACZZ | AE | | C | IC socket 28P (50202802) | [U22] |
| 69 | QSOCC26440ACZZ | AG | | C | IC socket 40pin LOW profile (50204005) | [U28] |
| 70 | 0GM50300917// | AK | N | C | Connector (DB9M) | [CN12(SIO)] |
| 71 | 0GM50302518// | AN | N | C | Connector (25pin) | [CN9(EXT FDL)CN10(PRINTER)] |
| 72 | QCNCM5016SC0B | AA | | C | Connector header(2pin) (50400244) | [CN2(SW)SN3(SPKR)] |
| 73 | QCNCM5016SC0F | AB | | C | Connector 1x6 ST Header (6pin)(50400664) | [CN4(LED)] |
| 74 | QCNCM2303SC0H | AB | | C | Connector 1x8 ST HDR(8pin)(50400834)(PC-4641 only) | [CN15(HDD PWR)] |
| 75 | 0GM50401414// | AD | N | C | Connector header STR 14pin | [CN1(LCD)] |
| 76 | 0GM50402625// | AE | N | C | Connector header STR 26pin | [CN5(PSU)] |
| 77 | 0GM50403433// | AM | N | C | Connector 2x17 header pan type | [CN17(EMS)] |
| 78 | 0GM50403434// | AQ | N | C | Connector header RT 2x17 shrouded | [CN13(MODEM)] |
| 79 | 0GM50403435// | AF | N | C | Connector 2x17 header | [CN8(FDD)] |
| 80 | QCNCM2346SC4J | AL | | C | Connector HDR 2x20(40pin)(50404022)(PC-4641 only) | [CN14(HDD)] |
| 81 | QCNCM000NSSC50 | AM | | C | Connector 2x25 header (50pin)(50405020) | [CN11(CRT)] |
| 82 | QCNCM1120AC9F | AQ | | C | Connector (96pin)(50409605) | [CN16(EXP BUS)] |
| 83 | QSW-Z1069ACZZ | AG | | B | Switch,DIP (51505001) | [SW1] |
| 84 | RCRSQ2044HCZZ | AH | | B | Crystal (16MHz)(55100001) | [X5] |
| 85 | RCRSP1039CCZZ | AG | | B | Crystal (32.768KHz)(55100023) | [X3] |
| 86 | 0GM55100116// | AM | N | B | Crystal (20MHz) | [X4] |
| 87 | RCRSQ1017ACZZ | AP | | B | Crystal (1.8432MHz)(55100131) | [X6] |
| 88 | RCRSQ2045HCZZ | AH | | B | Crystal (14.31818MHz)(55114318) | [X1] |
| 89 | RCRSP1034ACZZ | AD | | B | Ceramic OSC (3.84MHz)(55200042) | [X2] |
| | (Unit) | | | | | |
| 901 | DUNTK2296RHZZ | ** | N | E | Main logic PWB ass'y | (PC-4602..U.Y.S.K.E.) |
| | DUNTK2295RHZZ | ** | N | E | Main logic PWB ass'y | (PC-4602..H.Q) |
| | DUNTK2333RHZZ | ** | N | E | Main logic PWB ass'y | (PC-4602..G.W) |
| | DUNTK2294RHZZ | ** | N | E | Main logic PWB ass'y | (PC-4641..U.Y.S.K.E.) |
| | DUNTK2253RHZZ | ** | N | E | Main logic PWB ass'y | (PC-4641..H.Q) |
| | DUNTK2332RHZZ | ** | N | E | Main logic PWB ass'y | (PC-4641..G.W) |

9 CE-451A CRT adaptor board(USA..standard,others..option)

| NO. | PARTS CODE | PRICE RANK | NEW MARK | PART RANK | DESCRIPTION | |
|-----|----------------|------------|----------|-----------|--|------------|
| 1 | LANGT1156ACZZ | AE | | C | Angle | |
| 2 | LX-BZ1141CCZZ | AA | | C | Screw | |
| 3 | MSPRP1007ACZZ | AL | N | C | Plate spring | |
| 4 | PCAPH1012ACZZ | AC | | C | 9P cap | [J1] |
| 5 | QCNCM1060AC03 | AB | | B | Connector(short pin)(3pin) | |
| 6 | QCNCW1057ACZZ | AB | | C | Connector(short socket) | [CN2] |
| 7 | QCNCW1119AC01 | AK | | C | Connector(9pin) | [CN1] |
| 8 | QCNCW2415RC5J | AV | | C | Connector(50pin) | [C4~9] |
| 9 | RC-KZ1054CCZZ | AB | | C | Capacitor (50WV 0.1μF) | [B1~7] |
| 10 | RCORF6632RCZZ | AC | | C | Core | [X2] |
| 11 | RCRSQ2045HCZZ | AH | | B | Crystal (14.31818MHz) | [X1] |
| 12 | RCRSQ2046HCZZ | AH | | B | Crystal (16.257MHz) | [C10~13] |
| 13 | VCCCPU1HH150J | AA | | C | Capacitor (50WV 15pF) | [C3,14~16] |
| 14 | VCKYPU1HB102K | AA | | C | Capacitor (50WV 1000pF) | [C12] |
| 15 | VCSAVU1AE336M | AD | | C | Capacitor (10WV 33μF) | [IC2] |
| 16 | VHILZ93D13/-1 | AQ | | B | IC (LZ93D13) | [IC3] |
| 17 | VHISC4720//--1 | BE | | B | IC (SC4720) | [IC4,5] |
| 18 | VHITC5563-15L | AU | | B | IC (TC5563-15L) | [IC6] |
| 19 | VHIT74LS244-C | AK | | B | IC (T74LS244) | [IC1] |
| 20 | VH157128AAA0B | BF | | B | IC (57128AAA0B) | [R1] |
| 21 | VRD-RC2EY103J | AA | | C | Resistor (1/4W 10KΩ ±5%) | [R2] |
| 22 | VRD-RC2EY470J | AA | | C | Resistor (1/4W 47Ω ±5%) | |
| 23 | XBPSD30P04000 | AA | | C | Screw (3x4) | |
| 101 | TINSM1021HCZZ | AD | | D | Operation manual(E,F,G,S) (Option..except USA) | |
| 102 | PSPAG1038ACZZ | AB | | C | Rubber spacer (Option..except USA) | |
| 103 | SPAKA1958ACZZ | AG | | D | Packing cushion (Option..except USA) | |
| 104 | SPAKC1944ACZZ | AK | | D | Packing case (Option..except USA) | |
| 105 | SPAKP2417HCZZ | AK | | D | Vinyl bag (90x220mm)(Option..except USA) | |
| 106 | SSAKA0006UCZZ | AA | | D | Vinyl bag (50x60mm)(Option..except USA) | |
| 107 | TCAUH1018ACZZ | AN | | C | Caution label (Option..except USA) | |
| 108 | XBSSC30P08000 | AA | | C | Screw/White (3x8)(Option..except USA) | |
| 109 | XBSSF30P08000 | AA | | C | Screw/Black (3x8)(Option..except USA) | |
| | (Unit) | | | | | |
| 901 | DUNT-2280ACZZ | BS | N | E | CRT adaptor (92133620)(This includes No1~23) | (U only) |

Index

| PARTS CODE | NO. | PRICE RANK | NEW MARK | PART RANK |
|----------------|--------|---------------|-------------|--------------|
| [C] | | | | |
| CADPA1005AC01 | 3- 1 | BQ | | B |
| [D] | | | | |
| DFLP-1134ACZZ | 6- 18 | BF | N | D |
| DUNT-2226ACZZ | 1- 45 | BK | N | E |
| " | 2- 901 | BK | N | E |
| DUNT-2227ACZZ | 1- 45 | BK | N | E |
| " | 2- 901 | BK | N | E |
| DUNT-2228ACZZ | 1- 45 | BK | N | E |
| " | 2- 901 | BK | N | E |
| DUNT-2229ACZZ | 1- 7 | CE | N | E |
| DUNT-2238ACZZ | 7- 1 | | N | E |
| DUNT-2239ACZZ | 7- 1 | | N | E |
| DUNT-2240ACZZ | 7- 1 | | N | E |
| DUNT-2241ACZZ | 7- 1 | | N | E |
| DUNT-2242ACZZ | 7- 1 | | N | E |
| DUNT-2280ACZZ | 9- 901 | BS | N | E |
| DUNT-2307ACZZ | 1- 45 | BK | N | E |
| " | 2- 901 | BK | N | E |
| DUNTK2230ACSA | 1- 61 | BU | N | E |
| " | 4- 901 | BU | N | E |
| DUNTK2230ACZZ | 1- 61 | BU | N | E |
| " | 4- 901 | BU | N | E |
| DUNTK2231ACZZ | 1- 65 | ** | N | D |
| DUNTK2232ACZZ | 1- 37 | CC | N | C |
| DUNTK2253RHZZ | 1- 54 | ** | N | E |
| " | 8- 901 | ** | N | E |
| DUNTK2294RHZZ | 1- 54 | ** | N | E |
| " | 8- 901 | ** | N | E |
| DUNTK2295RHZZ | 1- 54 | ** | N | E |
| " | 8- 901 | ** | N | E |
| DUNTK2296RHZZ | 1- 54 | ** | N | E |
| " | 8- 901 | ** | N | E |
| DUNTK2332RHZZ | 1- 54 | ** | N | E |
| " | 8- 901 | ** | N | E |
| DUNTK2333RHZZ | 1- 54 | ** | N | E |
| " | 8- 901 | ** | N | E |
| [G] | | | | |
| GCASP5017SCZZ | 6- 17 | AE | N | D |
| GLEGG1019CCZZ | 1- 47 | AB | | C |
| GLEGG1024CCZZ | 1- 26 | AA | | C |
| [J] | | | | |
| JHNDP1005ACSA | 1- 50 | AF | | D |
| JHNDP1005ACZZ | 1- 50 | AF | | D |
| JHNDP5003SCZZ | 6- 10 | AB | | C |
| [L] | | | | |
| LANGT1156ACZZ | 9- 1 | AE | | C |
| LPLTP1017ACZZ | 6- 12 | AB | | C |
| LX-BZ1027ACSA | 1- 73 | AB | | C |
| LX-BZ1027ACZZ | 1- 73 | AB | | C |
| LX-BZ1141CCZZ | 1- 56 | AA | | C |
| " | 9- 2 | AA | | C |
| LX-BZ1147CCZZ | 1- 36 | AA | | C |
| LX-BZ1182CCZZ | 1- 62 | AB | | C |
| [M] | | | | |
| MSPRP1007ACZZ | 9- 3 | AL | N | C |
| [P] | | | | |
| PCAPH1012ACZZ | 9- 4 | AC | | C |
| PCASZ2005HCZA | 6- 15 | AC | | D |
| PC0VP6633RCZZ | 5- 86 | AB | | C |
| PQUMM1562CCZZ | 1- 63 | AE | | C |
| PSPAG1038ACZZ | 9- 102 | AB | | C |
| PZETV1041ACZZ | 1- 19 | AE | N | C |
| PZETV1042ACZZ | 1- 9 | AE | N | C |
| PZETV1043ACZZ | 1- 42 | AE | N | C |
| " | 5- 89 | AE | N | C |
| [Q] | | | | |
| QCNCM00NSSC50 | 8- 81 | AM | | C |
| QCNCM1060AC03 | 9- 5 | AB | | B |
| QCNCM1120AC9F | 8- 82 | AQ | | C |
| QCNCM2303SC0H | 8- 74 | AB | | C |
| QCNCM2346SC4J | 8- 80 | AL | | C |
| QCNCM5016SC0B | 5- 69 | AA | | C |
| " | 8- 72 | AA | | C |
| QCNCM5016SC0F | 8- 73 | AB | | C |
| QCNCW1057ACZZ | 9- 6 | AB | | C |
| QCNCW1119AC0i | 9- 7 | AK | | C |
| QCNCW2415RC5J | 9- 8 | AV | | C |
| QCNCW-1239ACZZ | 1- 66 | AB | | C |

| PARTS CODE | NO. | PRICE RANK | NEW MARK | PART RANK |
|---------------|--------|---------------|-------------|--------------|
| [R] | | | | |
| QS0CZ6428ACZZ | 8- 68 | AE | | C |
| QS0CZ6440ACZZ | 8- 69 | AG | | C |
| QSW-P1067ACZZ | 1- 35 | AD | | B |
| QSW-Z1069ACZZ | 8- 83 | AG | | B |
| [R] | | | | |
| RADPA1004ACZZ | 3- 1 | BP | | B |
| " | 3- 1 | BP | | B |
| RADPA1006ACZZ | 3- 1 | BQ | | B |
| " | 3- 1 | BQ | | B |
| RADPA1007ACZZ | 3- 1 | BP | | B |
| " | 3- 1 | BP | | B |
| RADPA1008ACZA | 3- 1 | BP | | B |
| " | 3- 1 | BP | | B |
| RADPA1009ACZZ | 3- 1 | BP | | B |
| RADPA1010ACZZ | 3- 1 | BP | | B |
| RADPA1011ACZZ | 3- 1 | BQ | | B |
| RADPA1012ACZZ | 3- 1 | BQ | | B |
| RADPA1013ACZZ | 3- 1 | BQ | N | B |
| RALMB1007HCZZ | 1- 49 | AK | | C |
| RC-KZ1054CCZZ | 5- 30 | AB | | C |
| " | 8- 40 | AB | | C |
| " | 9- 9 | AB | | C |
| RCORF6632RCZZ | 9- 10 | AC | | C |
| RCRSP1034ACZZ | 8- 89 | AD | | B |
| RCRSP1039CCZZ | 8- 85 | AG | | B |
| RCRSQ1017ACZZ | 8- 87 | AP | | B |
| RCRSQ2044HCZZ | 8- 84 | AH | | B |
| RCRSQ2045HCZZ | 8- 88 | AH | | B |
| " | 9- 11 | AH | | B |
| RCRSQ2046HCZZ | 9- 12 | AH | | B |
| RMPTC4102QCJB | 8- 23 | AB | | B |
| RMPTC4152QCJB | 8- 25 | AC | N | B |
| RMPTC4472QCJB | 8- 27 | AB | | B |
| RMPTC4563QCJB | 8- 29 | AB | | B |
| RMPTC7123QCJB | 8- 24 | AC | N | B |
| RMPTC8472QCJB | 8- 26 | AB | N | B |
| RMPTC8563QCJB | 8- 28 | AC | | B |
| RVR-P1009ACZZ | 5- 24 | AE | N | B |
| [S] | | | | |
| SPAKA1958ACZZ | 9- 103 | AG | | D |
| SPAKA1982ACZZ | 6- 14 | AE | | D |
| SPAKA5416SCZZ | 6- 26 | AB | | D |
| SPAKC1944ACZZ | 9- 104 | AK | | D |
| SPAKP2417HCZZ | 9- 105 | AK | | D |
| SSAKA0006UCZZ | 9- 106 | AA | | D |
| SSAKA0006WCZZ | 6- 7 | AB | | D |
| SSAKA0019SCZZ | 6- 3 | AA | | D |
| SSAKH0011HCZZ | 6- 11 | AA | | D |
| SSAKH0015HCZZ | 6- 19 | AA | | D |
| SSAKH5002CCZZ | 6- 2 | AA | | D |
| [T] | | | | |
| TCAUH1018ACZZ | 9- 107 | AN | | C |
| TINSM1021HCZZ | 9- 101 | AD | | D |
| TLABM1338ACZZ | 6- 25 | AB | N | C |
| TLABP1317ACSA | 1- 44 | AB | | C |
| TLABP1317ACZZ | 1- 44 | AB | | C |
| [U] | | | | |
| UBATZ1003ACZA | 1- 71 | BA | | A |
| " | 6- 4 | BA | | A |
| [V] | | | | |
| VCCCPUIHH150J | 9- 13 | AA | | C |
| VCCCTSIHH100J | 8- 31 | AA | N | C |
| VCCCTSIHH150J | 8- 35 | AA | N | C |
| VCCCTSIHH180J | 8- 36 | AA | N | C |
| VCCCTSIHH220J | 8- 37 | AA | N | C |
| VCCCTSIHH330J | 8- 38 | AA | N | C |
| " | 8- 38 | AA | N | C |
| VCCCTSIHH470J | 8- 39 | AA | | C |
| " | 8- 39 | AA | | C |
| VCEAEA1CW106M | 8- 42 | AC | N | C |
| VCEAEU1AW336M | 5- 94 | AA | N | C |
| VCEAEU1HW105M | 5- 33 | AA | N | C |
| " | 8- 41 | AA | N | C |
| VCEAGU1EW476M | 5- 95 | AB | | C |
| VCKYPU1HB102K | 9- 14 | AA | | C |
| VCKYTS1HB102K | 8- 32 | AA | N | C |
| VCKYTS1HB103K | 8- 33 | AA | N | C |
| VCOYNU1HM473K | 5- 31 | AB | | C |
| VCSAVU1AE336M | 9- 15 | AD | | C |
| VCSAVU1CE476M | 5- 96 | AH | N | C |

| PARTS CODE | NO. | PRICE RANK | NEW MARK | PART RANK | |
|---------------|-------|------------|----------|-----------|--|
| VHDDSS133HV-1 | 8- 60 | AA | | B | |
| VHD1N4148//1 | 5- 61 | AA | | B | |
| VHD1SS108//1 | 5- 64 | AB | | B | |
| // | 8- 59 | AB | | B | |
| VHEHZ3ALL//1 | 5- 62 | AC | | B | |
| VHIBA6251AF-1 | 8- 55 | AE | N | B | |
| VHILU57844P-1 | 8- 47 | AU | N | B | |
| VHILZ93D13/-1 | 9- 16 | AQ | | B | |
| VHILZ93J21/-1 | 8- 51 | BC | N | B | |
| VHILZ95H12/-1 | 8- 50 | BA | N | B | |
| VHIMN1280T/-1 | 5- 47 | AE | | B | |
| VHIM4464-12PZ | 8- 46 | AU | N | B | |
| VHISC4720//1 | 9- 17 | BE | | B | |
| VHITC4S71F/-1 | 8- 44 | AC | | B | |
| VHITC4S81F/-1 | 8- 45 | AC | | B | |
| VHITC5563-15L | 9- 18 | AU | | B | |
| VHITC8566F/-1 | 8- 52 | BB | | B | |
| VHIT74LS244-C | 9- 19 | AK | | B | |
| VHI27C51AAA0A | 8- 61 | BF | N | B | |
| VHI27C51AAA1A | 8- 61 | BF | N | B | |
| VHI57128AAA0B | 9- 20 | BF | | B | |
| VHI79M12AUC-1 | 5- 37 | AP | N | B | |
| VHPGL3HD43/-1 | 1- 34 | AB | | B | |
| VHPGL3NG43/-1 | 1- 33 | AA | | B | |
| VHPPW17-256A1 | 1- 8 | BM | N | D | |
| VRD-HT2EY101J | 5- 3 | AA | | C | |
| VRD-HT2EY102J | 5- 5 | AA | | C | |
| VRD-HT2EY103J | 5- 6 | AA | | C | |
| VRD-HT2EY104J | 5- 7 | AA | | C | |
| VRD-HT2EY120J | 5- 8 | AA | | C | |
| VRD-HT2EY122J | 5- 1 | AA | | C | |
| VRD-HT2EY163J | 5- 9 | AA | | C | |
| VRD-HT2EY2R2J | 5- 2 | AA | N | C | |
| VRD-HT2EY222J | 5- 10 | AA | | C | |
| VRD-HT2EY224J | 5- 11 | AA | | C | |
| VRD-HT2EY271J | 5- 12 | AA | | C | |
| VRD-HT2EY272J | 5- 14 | AA | N | C | |
| VRD-HT2EY332J | 5- 13 | AA | | C | |
| VRD-HT2EY472J | 5- 15 | AA | | C | |
| VRD-HT2EY561J | 5- 16 | AA | | C | |
| VRD-HT2EY562J | 5- 17 | AA | | C | |
| VRD-HT2EY822J | 5- 18 | AA | | C | |
| VRD-HT2HY221J | 5- 4 | AB | | C | |
| VRD-RC2EY000J | 8- 22 | AA | | C | |
| // | 8- 22 | AA | | C | |
| // | 8- 22 | AA | | C | |
| VRD-RC2EY102J | 1- 25 | AA | | C | |
| VRD-RC2EY103J | 9- 21 | AA | | C | |
| VRD-RC2EY470J | 9- 22 | AA | | C | |
| VRNHT2EK1072F | 5- 19 | AA | N | C | |
| VRNHT2EK1241F | 5- 20 | AA | N | C | |
| VRNHT2EK4122F | 5- 21 | AA | N | C | |
| VRS-TP2BD100J | 8- 1 | AA | | C | |
| VRS-TP2BD102J | 8- 2 | AA | | C | |
| VRS-TP2BD103J | 8- 3 | AA | | C | |
| VRS-TP2BD104F | 8- 4 | AA | N | C | |
| VRS-TP2BD104J | 8- 6 | AA | | C | |
| VRS-TP2BD105J | 8- 7 | AA | | C | |
| VRS-TP2BD152J | 8- 8 | AA | | C | |
| VRS-TP2BD153J | 8- 9 | AA | | C | |
| VRS-TP2BD222J | 8- 10 | AA | | C | |
| VRS-TP2BD303F | 8- 11 | AA | N | C | |
| VRS-TP2BD333F | 8- 12 | AA | N | C | |
| VRS-TP2BD333J | 8- 13 | AA | | C | |
| VRS-TP2BD392J | 8- 14 | AA | | C | |
| VRS-TP2BD470J | 8- 15 | AA | | C | |
| VRS-TP2BD471J | 8- 16 | AA | | C | |
| VRS-TP2BD474J | 8- 17 | AA | | C | |
| VRS-TP2BD560J | 8- 18 | AA | | C | |
| VRS-TP2BD562J | 8- 19 | AA | | C | |
| VRS-TP2BD563J | 8- 20 | AA | | C | |
| // | 8- 20 | AA | | C | |
| VRS-TP2BD683J | 8- 21 | AB | | C | |
| VS2SA673AB/-1 | 5- 53 | AE | | B | |
| VS2SC2021/-1 | 8- 57 | AB | | B | |
| [X] | | | | | |
| XBPSD30P08000 | 1- 46 | AA | | C | |
| XBPSD30P04000 | 1- 38 | AA | | C | |
| // | 9- 23 | AA | | C | |
| XBPSD30P06000 | 1- 30 | AA | | C | |

| PARTS CODE | NO. | PRICE RANK | NEW MARK | PART RANK | |
|---------------|--------|------------|----------|-----------|--|
| XBPSD30P06000 | 5- 67 | AA | | C | |
| XBPSD30P08000 | 1- 18 | AA | | C | |
| XBPSF30P08000 | 1- 46 | AA | | C | |
| XBSSC30P08000 | 9- 108 | AA | | C | |
| XBSSF30P08000 | 9- 109 | AA | | C | |
| XUPSD30P06000 | 1- 59 | AA | | C | |
| XUPSD30P08000 | 1- 13 | AA | | C | |
| [0] | | | | | |
| OCFR562761/01 | 2- 1 | AH | N | C | |
| OCFR562761/02 | 2- 2 | AH | N | C | |
| OCFR562761/03 | 2- 3 | AH | N | C | |
| OCFR562761/04 | 2- 4 | AH | N | C | |
| OCFR562761/05 | 2- 5 | AH | N | C | |
| OCFR562761/06 | 2- 6 | AH | N | C | |
| OCFR562761/07 | 2- 7 | AH | N | C | |
| OCFR562761/08 | 2- 8 | AH | N | C | |
| OCFR562761/09 | 2- 9 | AH | N | C | |
| OCFR562761/10 | 2- 10 | AH | N | C | |
| OCFR562761/11 | 2- 11 | AH | N | C | |
| OCFR562761/12 | 2- 12 | AH | N | C | |
| OCFR562761/13 | 2- 13 | AH | N | C | |
| OCFR562761/14 | 2- 14 | AH | N | C | |
| OCFR562761/15 | 2- 15 | AH | N | C | |
| OCFR562761/16 | 2- 16 | AH | N | C | |
| OCFR562761/17 | 2- 17 | AG | N | C | |
| OCFR562761/18 | 2- 18 | AG | N | C | |
| OCFR562761/19 | 2- 19 | AG | N | C | |
| OCFR562761/20 | 2- 20 | AG | N | C | |
| OCFR562761/21 | 2- 21 | AG | N | C | |
| OCFR562761/22 | 2- 22 | AG | N | C | |
| OCFR562761/23 | 2- 23 | AG | N | C | |
| OCFR562761/24 | 2- 24 | AG | N | C | |
| OCFR562761/25 | 2- 25 | AG | N | C | |
| OCFR562761/26 | 2- 26 | AG | N | C | |
| OCFR562761/27 | 2- 27 | AG | N | C | |
| OCFR562761/28 | 2- 28 | AG | N | C | |
| OCFR562761/29 | 2- 29 | AG | N | C | |
| OCFR562761/30 | 2- 30 | AG | N | C | |
| OCFR562761/31 | 2- 31 | AG | N | C | |
| OCFR562761/32 | 2- 32 | AG | N | C | |
| OCFR562761/33 | 2- 33 | AG | N | C | |
| OCFR562761/34 | 2- 34 | AG | N | C | |
| OCFR562761/35 | 2- 35 | AG | N | C | |
| OCFR562761/36 | 2- 36 | AG | N | C | |
| OCFR562761/37 | 2- 37 | AG | N | C | |
| OCFR562761/38 | 2- 38 | AG | N | C | |
| OCFR562761/39 | 2- 39 | AG | N | C | |
| OCFR562761/40 | 2- 40 | AG | N | C | |
| OCFR562761/41 | 2- 41 | AG | N | C | |
| OCFR562761/42 | 2- 42 | AG | N | C | |
| OCFR562761/43 | 2- 43 | AG | N | C | |
| OCFR562761/44 | 2- 44 | AG | N | C | |
| OCFR562761/45 | 2- 45 | AN | N | C | |
| OCFR562761/46 | 2- 46 | AH | N | C | |
| OCFR562761/47 | 2- 47 | AG | N | C | |
| OCFR562761/48 | 2- 48 | AG | N | C | |
| OCFR562761/49 | 2- 49 | AG | N | C | |
| OCFR562761/50 | 2- 50 | AG | N | C | |
| OCFR562761/51 | 2- 51 | AG | N | C | |
| OCFR562761/52 | 2- 52 | AG | N | C | |
| OCFR562761/53 | 2- 53 | AG | N | C | |
| OCFR562761/54 | 2- 54 | AG | N | C | |
| OCFR562761/55 | 2- 55 | AG | N | C | |
| OCFR562761/56 | 2- 56 | AG | N | C | |
| OCFR562761/57 | 2- 57 | AG | N | C | |
| OCFR562761/58 | 2- 58 | AH | N | C | |
| OCFR562761/59 | 2- 59 | AG | N | C | |
| OCFR562761/60 | 2- 60 | AG | N | C | |
| OCFR562761/61 | 2- 61 | AG | N | C | |
| OCFR562761/62 | 2- 62 | AG | N | C | |
| OCFR562761/63 | 2- 63 | AG | N | C | |
| OCFR562761/64 | 2- 64 | AG | N | C | |
| OCFR562761/65 | 2- 65 | AG | N | C | |
| OCFR562761/66 | 2- 66 | AG | N | C | |
| OCFR562761/67 | 2- 67 | AG | N | C | |
| OCFR562761/68 | 2- 68 | AG | N | C | |
| OCFR562761/69 | 2- 69 | AK | N | C | |
| OCFR562761/70 | 2- 70 | AG | N | C | |
| OCFR562761/71 | 2- 71 | AG | N | C | |
| OCFR562761/72 | 2- 72 | AG | N | C | |

| PARTS CODE | NO. | PRICE RANK | NEW MARK | PART RANK |
|---------------|-------|------------|----------|-----------|
| OCFR562761/73 | 2- 73 | AM | N | C |
| OCFR562761/74 | 2- 74 | AG | N | C |
| OCFR562761/75 | 2- 75 | AH | N | C |
| OCFR562761/76 | 2- 76 | AH | N | C |
| OCFR562761/77 | 2- 77 | AH | N | C |
| OCFR562761/78 | 2- 78 | AH | N | C |
| OCFR562761/79 | 2- 79 | AG | N | C |
| OCFR562761/80 | 2- 80 | AG | N | C |
| OCFR562761/81 | 2- 81 | AG | N | C |
| OCFR562761/82 | 2- 82 | AG | N | C |
| OCFR562761/83 | 2- 83 | AG | N | C |
| OCFR562761/84 | 2- 84 | AG | N | C |
| OCFR562761/85 | 2- 85 | AG | N | C |
| OCFR562761/86 | 2- 86 | AG | N | C |
| OCFR562761/87 | 2- 87 | AG | N | C |
| OCFR562761/88 | 2- 88 | AG | N | C |
| OCFR562761/89 | 2- 89 | AG | N | C |
| OCFR562761/90 | 2- 90 | AG | N | C |
| OCFR562762/01 | 2- 1 | AH | N | C |
| OCFR562762/02 | 2- 2 | AH | N | C |
| OCFR562762/03 | 2- 3 | AH | N | C |
| OCFR562762/04 | 2- 4 | AH | N | C |
| OCFR562762/05 | 2- 5 | AH | N | C |
| OCFR562762/06 | 2- 6 | AH | N | C |
| OCFR562762/07 | 2- 7 | AH | N | C |
| OCFR562762/08 | 2- 8 | AH | N | C |
| OCFR562762/09 | 2- 9 | AH | N | C |
| OCFR562762/10 | 2- 10 | AH | N | C |
| OCFR562762/11 | 2- 11 | AH | N | C |
| OCFR562762/12 | 2- 12 | AH | N | C |
| OCFR562762/13 | 2- 13 | AH | N | C |
| OCFR562762/14 | 2- 14 | AH | N | C |
| OCFR562762/15 | 2- 15 | AH | N | C |
| OCFR562762/16 | 2- 16 | AH | N | C |
| OCFR562762/17 | 2- 17 | AG | N | C |
| OCFR562762/18 | 2- 18 | AG | N | C |
| OCFR562762/19 | 2- 19 | AG | N | C |
| OCFR562762/20 | 2- 20 | AG | N | C |
| OCFR562762/21 | 2- 21 | AG | N | C |
| OCFR562762/22 | 2- 22 | AG | N | C |
| OCFR562762/23 | 2- 23 | AG | N | C |
| OCFR562762/24 | 2- 24 | AG | N | C |
| OCFR562762/25 | 2- 25 | AG | N | C |
| OCFR562762/26 | 2- 26 | AG | N | C |
| OCFR562762/27 | 2- 27 | AG | N | C |
| OCFR562762/28 | 2- 28 | AG | N | C |
| OCFR562762/29 | 2- 29 | AG | N | C |
| OCFR562762/30 | 2- 30 | AG | N | C |
| OCFR562762/31 | 2- 31 | AG | N | C |
| OCFR562762/32 | 2- 32 | AG | N | C |
| OCFR562762/33 | 2- 33 | AG | N | C |
| OCFR562762/34 | 2- 34 | AG | N | C |
| OCFR562762/35 | 2- 35 | AG | N | C |
| OCFR562762/36 | 2- 36 | AG | N | C |
| OCFR562762/37 | 2- 37 | AG | N | C |
| OCFR562762/38 | 2- 38 | AG | N | C |
| OCFR562762/39 | 2- 39 | AG | N | C |
| OCFR562762/40 | 2- 40 | AG | N | C |
| OCFR562762/41 | 2- 41 | AG | N | C |
| OCFR562762/42 | 2- 42 | AG | N | C |
| OCFR562762/43 | 2- 43 | AG | N | C |
| OCFR562762/44 | 2- 44 | AG | N | C |
| OCFR562762/45 | 2- 45 | AN | N | C |
| OCFR562762/46 | 2- 46 | AH | N | C |
| OCFR562762/47 | 2- 47 | AG | N | C |
| OCFR562762/48 | 2- 48 | AG | N | C |
| OCFR562762/49 | 2- 49 | AG | N | C |
| OCFR562762/50 | 2- 50 | AG | N | C |
| OCFR562762/51 | 2- 51 | AG | N | C |
| OCFR562762/52 | 2- 52 | AG | N | C |
| OCFR562762/53 | 2- 53 | AG | N | C |
| OCFR562762/54 | 2- 54 | AG | N | C |
| OCFR562762/55 | 2- 55 | AG | N | C |
| OCFR562762/56 | 2- 56 | AG | N | C |
| OCFR562762/57 | 2- 57 | AG | N | C |
| OCFR562762/58 | 2- 58 | AH | N | C |
| OCFR562762/59 | 2- 59 | AG | N | C |
| OCFR562762/60 | 2- 60 | AG | N | C |
| OCFR562762/61 | 2- 61 | AG | N | C |
| OCFR562762/62 | 2- 62 | AG | N | C |

| PARTS CODE | NO. | PRICE RANK | NEW MARK | PART RANK |
|---------------|-------|------------|----------|-----------|
| OCFR562762/63 | 2- 63 | AG | N | C |
| OCFR562762/64 | 2- 64 | AG | N | C |
| OCFR562762/65 | 2- 65 | AG | N | C |
| OCFR562762/66 | 2- 66 | AG | N | C |
| OCFR562762/67 | 2- 67 | AG | N | C |
| OCFR562762/68 | 2- 68 | AG | N | C |
| OCFR562762/69 | 2- 69 | AK | N | C |
| OCFR562762/70 | 2- 70 | AG | N | C |
| OCFR562762/71 | 2- 71 | AG | N | C |
| OCFR562762/72 | 2- 72 | AG | N | C |
| OCFR562762/73 | 2- 73 | AM | N | C |
| OCFR562762/74 | 2- 74 | AG | N | C |
| OCFR562762/75 | 2- 75 | AH | N | C |
| OCFR562762/76 | 2- 76 | AH | N | C |
| OCFR562762/77 | 2- 77 | AH | N | C |
| OCFR562762/78 | 2- 78 | AH | N | C |
| OCFR562762/79 | 2- 79 | AG | N | C |
| OCFR562762/80 | 2- 80 | AG | N | C |
| OCFR562762/81 | 2- 81 | AG | N | C |
| OCFR562762/82 | 2- 82 | AG | N | C |
| OCFR562762/83 | 2- 83 | AG | N | C |
| OCFR562762/84 | 2- 84 | AG | N | C |
| OCFR562762/85 | 2- 85 | AG | N | C |
| OCFR562762/86 | 2- 86 | AG | N | C |
| OCFR562762/87 | 2- 87 | AG | N | C |
| OCFR562762/88 | 2- 88 | AG | N | C |
| OCFR562762/89 | 2- 89 | AG | N | C |
| OCFR562762/90 | 2- 90 | AG | N | C |
| OCFR562763/01 | 2- 1 | AH | N | C |
| OCFR562763/02 | 2- 2 | AH | N | C |
| OCFR562763/03 | 2- 3 | AH | N | C |
| OCFR562763/04 | 2- 4 | AH | N | C |
| OCFR562763/05 | 2- 5 | AH | N | C |
| OCFR562763/06 | 2- 6 | AH | N | C |
| OCFR562763/07 | 2- 7 | AH | N | C |
| OCFR562763/08 | 2- 8 | AH | N | C |
| OCFR562763/09 | 2- 9 | AH | N | C |
| OCFR562763/10 | 2- 10 | AH | N | C |
| OCFR562763/11 | 2- 11 | AH | N | C |
| OCFR562763/12 | 2- 12 | AH | N | C |
| OCFR562763/13 | 2- 13 | AH | N | C |
| OCFR562763/14 | 2- 14 | AH | N | C |
| OCFR562763/15 | 2- 15 | AH | N | C |
| OCFR562763/16 | 2- 16 | AH | N | C |
| OCFR562763/17 | 2- 17 | AG | N | C |
| OCFR562763/18 | 2- 18 | AG | N | C |
| OCFR562763/19 | 2- 19 | AG | N | C |
| OCFR562763/20 | 2- 20 | AG | N | C |
| OCFR562763/21 | 2- 21 | AG | N | C |
| OCFR562763/22 | 2- 22 | AG | N | C |
| OCFR562763/23 | 2- 23 | AG | N | C |
| OCFR562763/24 | 2- 24 | AG | N | C |
| OCFR562763/25 | 2- 25 | AG | N | C |
| OCFR562763/26 | 2- 26 | AG | N | C |
| OCFR562763/27 | 2- 27 | AG | N | C |
| OCFR562763/28 | 2- 28 | AG | N | C |
| OCFR562763/29 | 2- 29 | AG | N | C |
| OCFR562763/30 | 2- 30 | AG | N | C |
| OCFR562763/31 | 2- 31 | AG | N | C |
| OCFR562763/32 | 2- 32 | AG | N | C |
| OCFR562763/33 | 2- 33 | AG | N | C |
| OCFR562763/34 | 2- 34 | AG | N | C |
| OCFR562763/35 | 2- 35 | AG | N | C |
| OCFR562763/36 | 2- 36 | AG | N | C |
| OCFR562763/37 | 2- 37 | AG | N | C |
| OCFR562763/38 | 2- 38 | AG | N | C |
| OCFR562763/39 | 2- 39 | AG | N | C |
| OCFR562763/40 | 2- 40 | AG | N | C |
| OCFR562763/41 | 2- 41 | AG | N | C |
| OCFR562763/42 | 2- 42 | AG | N | C |
| OCFR562763/43 | 2- 43 | AG | N | C |
| OCFR562763/44 | 2- 44 | AG | N | C |
| OCFR562763/45 | 2- 45 | AN | N | C |
| OCFR562763/46 | 2- 46 | AH | N | C |
| OCFR562763/47 | 2- 47 | AG | N | C |
| OCFR562763/48 | 2- 48 | AG | N | C |
| OCFR562763/49 | 2- 49 | AG | N | C |
| OCFR562763/50 | 2- 50 | AG | N | C |
| OCFR562763/51 | 2- 51 | AG | N | C |
| OCFR562763/52 | 2- 52 | AG | N | C |

| PARTS CODE | NO. | PRICE RANK | NEW MARK | PART RANK | |
|---------------|-------|---------------|-------------|--------------|--|
| 0CFR562763/53 | 2- 53 | AG | N | C | |
| 0CFR562763/54 | 2- 54 | AG | N | C | |
| 0CFR562763/55 | 2- 55 | AG | N | C | |
| 0CFR562763/56 | 2- 56 | AG | N | C | |
| 0CFR562763/57 | 2- 57 | AG | N | C | |
| 0CFR562763/58 | 2- 58 | AH | N | C | |
| 0CFR562763/59 | 2- 59 | AG | N | C | |
| 0CFR562763/60 | 2- 60 | AG | N | C | |
| 0CFR562763/61 | 2- 61 | AG | N | C | |
| 0CFR562763/62 | 2- 62 | AG | N | C | |
| 0CFR562763/63 | 2- 63 | AG | N | C | |
| 0CFR562763/64 | 2- 64 | AG | N | C | |
| 0CFR562763/65 | 2- 65 | AG | N | C | |
| 0CFR562763/66 | 2- 66 | AG | N | C | |
| 0CFR562763/67 | 2- 67 | AG | N | C | |
| 0CFR562763/68 | 2- 68 | AG | N | C | |
| 0CFR562763/69 | 2- 69 | AK | N | C | |
| 0CFR562763/70 | 2- 70 | AG | N | C | |
| 0CFR562763/71 | 2- 71 | AG | N | C | |
| 0CFR562763/72 | 2- 72 | AG | N | C | |
| 0CFR562763/73 | 2- 73 | AM | N | C | |
| 0CFR562763/74 | 2- 74 | AG | N | C | |
| 0CFR562763/75 | 2- 75 | AH | N | C | |
| 0CFR562763/76 | 2- 76 | AH | N | C | |
| 0CFR562763/77 | 2- 77 | AH | N | C | |
| 0CFR562763/78 | 2- 78 | AH | N | C | |
| 0CFR562763/79 | 2- 79 | AG | N | C | |
| 0CFR562763/80 | 2- 80 | AG | N | C | |
| 0CFR562763/81 | 2- 81 | AG | N | C | |
| 0CFR562763/82 | 2- 82 | AG | N | C | |
| 0CFR562763/83 | 2- 83 | AG | N | C | |
| 0CFR562763/84 | 2- 84 | AG | N | C | |
| 0CFR562763/85 | 2- 85 | AG | N | C | |
| 0CFR562763/86 | 2- 86 | AG | N | C | |
| 0CFR562763/87 | 2- 87 | AG | N | C | |
| 0CFR562763/88 | 2- 88 | AG | N | C | |
| 0CFR562763/89 | 2- 89 | AG | N | C | |
| 0CFR562763/90 | 2- 90 | AG | N | C | |
| 0CFR562830-01 | 2- 1 | AH | N | C | |
| 0CFR562830-02 | 2- 2 | AH | N | C | |
| 0CFR562830-03 | 2- 3 | AH | N | C | |
| 0CFR562830-04 | 2- 4 | AH | N | C | |
| 0CFR562830-05 | 2- 5 | AH | N | C | |
| 0CFR562830-06 | 2- 6 | AH | N | C | |
| 0CFR562830-07 | 2- 7 | AH | N | C | |
| 0CFR562830-08 | 2- 8 | AH | N | C | |
| 0CFR562830-09 | 2- 9 | AH | N | C | |
| 0CFR562830-10 | 2- 10 | AH | N | C | |
| 0CFR562830-11 | 2- 11 | AH | N | C | |
| 0CFR562830-12 | 2- 12 | AH | N | C | |
| 0CFR562830-13 | 2- 13 | AH | N | C | |
| 0CFR562830-14 | 2- 14 | AH | N | C | |
| 0CFR562830-15 | 2- 15 | AH | N | C | |
| 0CFR562830-16 | 2- 16 | AH | N | C | |
| 0CFR562830-17 | 2- 17 | AG | N | C | |
| 0CFR562830-18 | 2- 18 | AG | N | C | |
| 0CFR562830-19 | 2- 19 | AG | N | C | |
| 0CFR562830-20 | 2- 20 | AG | N | C | |
| 0CFR562830-21 | 2- 21 | AG | N | C | |
| 0CFR562830-22 | 2- 22 | AG | N | C | |
| 0CFR562830-23 | 2- 23 | AG | N | C | |
| 0CFR562830-24 | 2- 24 | AG | N | C | |
| 0CFR562830-25 | 2- 25 | AG | N | C | |
| 0CFR562830-26 | 2- 26 | AG | N | C | |
| 0CFR562830-27 | 2- 27 | AG | N | C | |
| 0CFR562830-28 | 2- 28 | AG | N | C | |
| 0CFR562830-29 | 2- 29 | AG | N | C | |
| 0CFR562830-30 | 2- 30 | AG | N | C | |
| 0CFR562830-31 | 2- 31 | AG | N | C | |
| 0CFR562830-32 | 2- 32 | AG | N | C | |
| 0CFR562830-33 | 2- 33 | AG | N | C | |
| 0CFR562830-34 | 2- 34 | AG | N | C | |
| 0CFR562830-35 | 2- 35 | AG | N | C | |
| 0CFR562830-36 | 2- 36 | AG | N | C | |
| 0CFR562830-37 | 2- 37 | AG | N | C | |
| 0CFR562830-38 | 2- 38 | AG | N | C | |
| 0CFR562830-39 | 2- 39 | AG | N | C | |
| 0CFR562830-40 | 2- 40 | AG | N | C | |
| 0CFR562830-41 | 2- 41 | AG | N | C | |
| 0CFR562830-42 | 2- 42 | AG | N | C | |

| PARTS CODE | NO. | PRICE RANK | NEW MARK | PART RANK | |
|----------------|--------|---------------|-------------|--------------|--|
| 0CFR562830-43 | 2- 43 | AG | N | C | |
| 0CFR562830-44 | 2- 44 | AG | N | C | |
| 0CFR562830-45 | 2- 45 | AN | N | C | |
| 0CFR562830-46 | 2- 46 | AH | N | C | |
| 0CFR562830-47 | 2- 47 | AG | N | C | |
| 0CFR562830-48 | 2- 48 | AG | N | C | |
| 0CFR562830-49 | 2- 49 | AG | N | C | |
| 0CFR562830-50 | 2- 50 | AG | N | C | |
| 0CFR562830-51 | 2- 51 | AG | N | C | |
| 0CFR562830-52 | 2- 52 | AG | N | C | |
| 0CFR562830-53 | 2- 53 | AG | N | C | |
| 0CFR562830-54 | 2- 54 | AG | N | C | |
| 0CFR562830-55 | 2- 55 | AG | N | C | |
| 0CFR562830-56 | 2- 56 | AG | N | C | |
| 0CFR562830-57 | 2- 57 | AG | N | C | |
| 0CFR562830-58 | 2- 58 | AH | N | C | |
| 0CFR562830-59 | 2- 59 | AG | N | C | |
| 0CFR562830-60 | 2- 60 | AG | N | C | |
| 0CFR562830-61 | 2- 61 | AG | N | C | |
| 0CFR562830-62 | 2- 62 | AG | N | C | |
| 0CFR562830-63 | 2- 63 | AG | N | C | |
| 0CFR562830-64 | 2- 64 | AG | N | C | |
| 0CFR562830-65 | 2- 65 | AG | N | C | |
| 0CFR562830-66 | 2- 66 | AG | N | C | |
| 0CFR562830-67 | 2- 67 | AG | N | C | |
| 0CFR562830-68 | 2- 68 | AG | N | C | |
| 0CFR562830-69 | 2- 69 | AK | N | C | |
| 0CFR562830-70 | 2- 70 | AG | N | C | |
| 0CFR562830-71 | 2- 71 | AG | N | C | |
| 0CFR562830-72 | 2- 72 | AG | N | C | |
| 0CFR562830-73 | 2- 73 | AM | N | C | |
| 0CFR562830-74 | 2- 74 | AG | N | C | |
| 0CFR562830-75 | 2- 75 | AH | N | C | |
| 0CFR562830-76 | 2- 76 | AH | N | C | |
| 0CFR562830-77 | 2- 77 | AH | N | C | |
| 0CFR562830-78 | 2- 78 | AH | N | C | |
| 0CFR562830-79 | 2- 79 | AG | N | C | |
| 0CFR562830-80 | 2- 80 | AG | N | C | |
| 0CFR562830-81 | 2- 81 | AG | N | C | |
| 0CFR562830-82 | 2- 82 | AG | N | C | |
| 0CFR562830-83 | 2- 83 | AG | N | C | |
| 0CFR562830-84 | 2- 84 | AG | N | C | |
| 0CFR562830-85 | 2- 85 | AG | N | C | |
| 0CFR562830-86 | 2- 86 | AG | N | C | |
| 0CFR562830-87 | 2- 87 | AG | N | C | |
| 0CFR562830-88 | 2- 88 | AG | N | C | |
| 0CFR562830-89 | 2- 89 | AG | N | C | |
| 0CFR562830-90 | 2- 90 | AG | N | C | |
| 0CF56A185F/// | 2- 102 | AA | | C | |
| 0CF56A514B/// | 2- 107 | AK | N | C | |
| 0CF56B036A/// | 2- 103 | AQ | N | C | |
| 0CF56B036B/// | 2- 103 | AQ | N | C | |
| 0CF56H089A/// | 2- 106 | BD | N | C | |
| 0CF56H089B/// | 2- 106 | BD | N | C | |
| 0CF560088B/// | 2- 109 | AA | | C | |
| 0CF560940A/// | 2- 111 | AA | | C | |
| 0CF561565A/// | 2- 110 | AA | | C | |
| 0CF564965C/// | 2- 108 | AA | | C | |
| 0CF565033M/// | 2- 112 | AD | N | B | |
| 0CF565524B/// | 2- 105 | AB | N | C | |
| 0CF565665A/// | 2- 104 | AB | | C | |
| 0CF567664C/// | 2- 101 | AA | N | C | |
| 0CF567664D/// | 2- 114 | AA | N | C | |
| 0CF567955A/// | 2- 113 | AA | N | C | |
| 0GM1335/// | 1- 41 | BZ | N | E | |
| 0GM1335/// | 5- 901 | BZ | N | E | |
| 0GM13362950/// | 5- 22 | AD | N | C | |
| 0GM14147051/// | 8- 30 | AM | N | B | |
| 0GM18120220/// | 5- 23 | AF | N | C | |
| 0GM18130301/// | 5- 25 | AF | N | C | |
| 0GM18150202/// | 5- 26 | AF | N | B | |
| 0GM20210359/// | 5- 27 | AB | N | C | |
| 0GM20210486/// | 8- 34 | AC | N | C | |
| 0GM20210486/// | 8- 34 | AC | N | C | |
| 0GM20247302/// | 5- 28 | AB | N | C | |
| 0GM20256105/// | 5- 29 | AB | N | C | |
| 0GM24122800/// | 5- 32 | AG | N | C | |
| 0GM24210618/// | 5- 34 | AC | N | C | |
| 0GM24210631/// | 5- 35 | AC | N | C | |
| 0GM24210827/// | 5- 36 | AD | N | C | |

| PARTS CODE | NO. | PRICE RANK | NEW MARK | PART RANK |
|----------------|-------|------------|----------|-----------|
| 0GM24222619// | 5- 38 | AC | N | C |
| 0GM24222702// | 5- 39 | AB | N | C |
| 0GM24233603// | 5- 40 | AB | N | C |
| 0GM24233611// | 5- 41 | AC | N | C |
| 0GM24233612// | 5- 42 | AC | N | C |
| 0GM24247501// | 5- 43 | AB | N | C |
| 0GM24247715// | 5- 44 | AB | N | C |
| 0GM30274383// | 8- 43 | AE | N | B |
| 0GM30870201// | 8- 48 | BU | N | B |
| 0GM30882503// | 8- 49 | BK | N | B |
| 0GM31104310// | 5- 45 | AF | N | B |
| 0GM31110700// | 5- 46 | BB | N | B |
| 0GM31179052// | 5- 48 | AF | N | B |
| 0GM31514886// | 8- 53 | AQ | N | B |
| 0GM31514894// | 8- 54 | AQ | N | B |
| 0GM31904311// | 8- 56 | AF | N | B |
| 0GM321022000// | 5- 49 | AG | N | B |
| 0GM32112131// | 5- 50 | AC | N | B |
| 0GM32127120// | 8- 58 | AB | N | B |
| 0GM32180500// | 5- 51 | AB | N | B |
| 0GM32204505// | 5- 52 | AL | N | B |
| 0GM32214430// | 5- 54 | AP | N | B |
| 0GM32214440// | 5- 55 | AQ | N | B |
| 0GM32285500// | 5- 56 | AB | N | B |
| 0GM33101004// | 5- 57 | AB | N | B |
| 0GM33101040// | 5- 58 | AR | N | B |
| 0GM33103035// | 5- 59 | AH | N | B |
| 0GM33105301// | 5- 60 | AQ | N | B |
| 0GM33352290// | 5- 63 | AB | N | B |
| 0GM33352501// | 5- 65 | AB | N | B |
| 0GM37641253// | 8- 62 | AG | N | B |
| 0GM37641573// | 8- 63 | AG | N | B |
| 0GM37674003// | 8- 64 | AF | N | B |
| 0GM37674043// | 8- 65 | AE | N | B |
| 0GM37674323// | 8- 66 | AF | N | B |
| 0GM40133500// | 1- 40 | AL | N | C |
| // | 5- 66 | AL | N | C |
| 0GM40133600// | 1- 17 | AC | N | C |
| 0GM40133604// | 1- 29 | AD | N | C |
| 0GM40133605// | 1- 55 | AG | N | C |
| 0GM40133606// | 1- 64 | AP | N | C |
| 0GM40133607// | 6- 20 | AF | N | C |
| 0GM40133610// | 1- 51 | AD | N | C |
| 0GM40133611// | 1- 76 | AC | N | C |
| 0GM40133612// | 1- 76 | AC | N | C |
| 0GM41100611// | 6- 21 | AA | N | C |
| 0GM41100613// | 1- 69 | AD | N | C |
| 0GM42200085// | 5- 68 | AA | N | C |
| 0GM44700065// | 1- 3 | AC | N | C |
| 0GM50102500// | 8- 67 | AK | N | C |
| 0GM50300917// | 8- 70 | AK | N | C |
| 0GM50302518// | 8- 71 | AN | N | C |
| 0GM50400364// | 5- 70 | AC | N | C |
| 0GM50401414// | 8- 75 | AD | N | C |
| 0GM50402625// | 8- 76 | AE | N | C |
| 0GM50402627// | 5- 71 | AN | N | C |
| 0GM50403433// | 8- 77 | AM | N | C |
| 0GM50403434// | 8- 78 | AQ | N | C |
| 0GM50403435// | 8- 79 | AF | N | C |
| 0GM50700007// | 5- 72 | AD | N | C |
| 0GM51400006// | 5- 73 | AM | N | C |
| 0GM52100030// | 5- 74 | AC | N | C |
| 0GM52100171// | 5- 75 | AF | N | C |
| 0GM52113351// | 5- 76 | AH | N | C |
| 0GM52113352// | 5- 77 | AM | N | C |
| 0GM52313353// | 5- 78 | AQ | N | B |
| 0GM52313354// | 5- 79 | AP | N | B |
| 0GM52313355// | 5- 80 | AG | N | B |
| 0GM52313356// | 5- 81 | AT | N | B |
| 0GM53113350// | 5- 82 | AD | N | A |
| 0GM54300020// | 1- 68 | BC | N | B |
| 0GM55100116// | 8- 86 | AM | N | B |
| 0GM57113350// | 5- 83 | AA | N | C |
| 0GM57113351// | 5- 84 | AA | N | C |
| 0GM60201508// | 1- 12 | AD | N | C |
| 0GM60201509// | 6- 24 | AD | N | C |
| 0GM60201510// | 6- 24 | AB | N | C |
| 0GM60201513// | 1- 52 | AD | N | C |
| 0GM60201514// | 1- 52 | AD | N | C |
| 0GM60201515// | 1- 21 | AE | N | C |

| PARTS CODE | NO. | PRICE RANK | NEW MARK | PART RANK |
|---------------|--------|------------|----------|-----------|
| 0GM60201516// | 1- 21 | AE | N | C |
| 0GM60201517// | 1- 23 | AF | N | C |
| 0GM60201518// | 1- 23 | AF | N | C |
| 0GM60201519// | 1- 23 | AF | N | C |
| 0GM60201520// | 1- 23 | AF | N | C |
| 0GM60201522// | 6- 27 | AC | N | C |
| 0GM60201524// | 6- 22 | AB | N | C |
| 0GM60201530// | 6- 16 | AC | N | C |
| 0GM60201541// | 1- 22 | AH | N | C |
| 0GM60261540// | 1- 27 | AB | N | C |
| 0GM60300121// | 6- 13 | AX | N | D |
| 0GM60300122// | 6- 13 | BG | N | D |
| 0GM60300123// | 6- 13 | BA | N | D |
| 0GM60300124// | 6- 23 | AG | N | C |
| 0GM61336001// | 6- 8 | AK | N | D |
| 0GM61336002// | 6- 6 | AK | N | D |
| 0GM61336003// | 6- 5 | AK | N | D |
| 0GM61400728// | 6- 1 | AC | N | D |
| 0GM61501015// | 6- 101 | AK | N | D |
| 0GM61501016// | 6- 9 | AN | N | D |
| 0GM61501017// | 6- 9 | AS | N | D |
| 0GM61501018// | 6- 101 | AK | N | D |
| 0GM61501019// | 6- 9 | AN | N | D |
| 0GM61501020// | 6- 9 | AS | N | D |
| 0GM70113360// | 1- 32 | AC | N | C |
| 0GM70113361// | 1- 75 | AC | N | C |
| // | 5- 85 | AC | N | B |
| 0GM73133601// | 1- 48 | BC | N | D |
| 0GM73133602// | 1- 28 | BE | N | D |
| 0GM73133603// | 1- 1 | BA | N | D |
| 0GM73133604// | 1- 20 | AW | N | D |
| 0GM73133605// | 1- 72 | AN | N | C |
| 0GM73133606// | 1- 2 | AC | N | C |
| 0GM73133607// | 1- 4 | AC | N | C |
| 0GM73133609// | 1- 14 | AD | N | C |
| 0GM73133611// | 1- 48 | BC | N | D |
| 0GM73133612// | 1- 28 | BE | N | D |
| 0GM73133613// | 1- 1 | BA | N | D |
| 0GM73133614// | 1- 20 | AW | N | D |
| 0GM73133615// | 1- 72 | AN | N | C |
| 0GM73133616// | 1- 2 | AC | N | C |
| 0GM73133617// | 1- 4 | AC | N | C |
| 0GM73133619// | 1- 14 | AD | N | C |
| 0GM81000002// | 5- 87 | AB | N | C |
| 0GM81100051// | 1- 5 | AD | N | C |
| 0GM81200102// | 1- 24 | AD | N | C |
| 0GM81300012// | 5- 88 | AC | N | C |
| 0GM81300095// | 1- 67 | AB | N | C |
| 0GM81400081// | 1- 39 | AH | N | C |
| 0GM81600012// | 1- 58 | AD | N | C |
| 0GM81600013// | 1- 57 | AD | N | C |
| 0GM91133623// | 1- 6 | AZ | N | C |
| 0GM92126219// | 1- 31 | AE | N | C |
| 0GM92130811// | 1- 53 | AD | N | C |
| 0GM92133502// | 5- 90 | AG | N | C |
| 0GM92133510// | 5- 91 | AC | N | C |
| 0GM92133600// | 1- 43 | AW | N | C |
| // | 5- 92 | AW | N | C |
| 0GM92133603// | 1- 15 | AT | N | C |
| 0GM92133604// | 1- 16 | AT | N | C |
| 0GM92133670// | 1- 74 | AY | N | C |
| 0GM92133756// | 1- 60 | AY | N | C |
| 0GM991000// | 5- 93 | AA | N | C |
| 00G1473403432 | 4- 7 | BM | N | E |
| 00G1476943000 | 4- 5 | AY | N | E |
| 00G1490051603 | 4- 101 | CP | N | D |
| 00G1490051701 | 4- 102 | CE | N | D |
| 00G1553211005 | 4- 6 | BL | N | E |
| 00G1678803909 | 4- 1 | AC | N | D |
| 00G1678803910 | 4- 1 | AC | N | D |
| 00G17967693// | 4- 3 | AH | N | E |
| 00G1796769609 | 4- 2 | AH | N | D |
| 00G1796769610 | 4- 2 | AH | N | D |
| 00G1796772900 | 4- 4 | BP | N | E |

SHARP

COPYRIGHT © 1989 BY SHARP CORPORATION

All rights reserved.

Printed in Japan.

**No part of this publication may be reproduced,
stored in a retrieval system, or transmitted,
in any form or by any means,
electronic, mechanical, photocopying, recording, or otherwise,
without prior written permission of the publisher.**

SHARP CORPORATION
Information Systems Group
Quality & Reliability Control Center
Yamatokoriyama, Nara 639-11, Japan
1989 February Printed in Japan ©